

PHILIPS

Data handbook



Electronic
components
and materials

Semiconductors

Part 10 September 1981

WIDEBAND TRANSISTORS AND
WIDEBAND HYBRID IC MODULES

SEMICONDUCTORS

PART 10 - SEPTEMBER 1981

WIDEBAND TRANSISTORS AND WIDEBAND HYBRID IC MODULES

DATA HANDBOOK SYSTEM
SEMICONDUCTOR INDEX

GENERAL

WIDEBAND TRANSISTORS

HYBRID IC MODULES:

CATV AMPLIFIER MODULES (V.H.F.)

WIDEBAND AMPLIFIERS (V.H.F. & U.H.F.)



DATA HANDBOOK SYSTEM

Our Data Handbook System is a comprehensive source of information on electronic components, sub-assemblies and materials; it is made up of four series of handbooks each comprising several parts.

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The several parts contain all pertinent data available at the time of publication, and each is revised and reissued periodically.

Where ratings or specifications differ from those published in the preceding edition they are pointed out by arrows. Where application information is given it is advisory and does not form part of the product specification.

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SEMICONDUCTORS (RED SERIES)

Starting in 1980, new part numbers and corresponding codes are being introduced. The former code of the preceding issue is given in brackets under the new code.

| | | | |
|---------|----------------|--|---|
| Part 1 | March 1980 | S1 03-80 (SC1b 05-77) | Diodes Small-signal germanium diodes, small-signal silicon diodes, special diodes, voltage regulator diodes (< 1,5 W), voltage reference diodes, tuner diodes, rectifier diodes |
| Part 2 | May 1980 | S2 05-80 (SC1a 08-78) | Power diodes, thyristors, triacs Rectifier diodes, voltage regulator diodes (> 1,5 W), rectifier stacks, thyristors, triacs |
| Part 3 | April 1980 | S3 04-80 (SC2 11-77, partly) (SC3 01-78, partly) | Small-signal transistors |
| Part 4 | September 1981 | S4 09-81 (SC2 06-79) | Low-frequency power transistors |
| Part 4a | December 1978 | SC4a12-78 | Transmitting transistors and modules |
| Part 5 | October 1980 | S5 10-80 (SC3 01-78, partly) | Field-effect transistors |
| Part 7 | December 1980 | S7 12-80 (SC4c 07-78) | Microminiature semiconductors for hybrid circuits |
| Part 8 | April 1980 | S8 06-81 (SC4b 09-78) | Devices for optoelectronics Photosensitive diodes and transistors, light-emitting diodes, displays, photocouplers, infrared sensitive devices, photoconductive devices |
| Part 10 | September 1981 | S10 09-81 (SC3 01-78, partly) | Wideband transistors and wideband hybrid IC modules |

INTEGRATED CIRCUITS (PURPLE SERIES)

Starting in 1980, new part numbers and corresponding codes are being introduced. The former code of the preceding issue is given in brackets under the new code. Books with the purple cover will replace existing red covered editions as each is revised.

| | | | |
|-------------------------------|---------------|---------------------------|---|
| Part 1 | May 1980 | IC1 05-80 (SC5b 03-77) | Bipolar ICs for radio and audio equipment |
| Part 2 | May 1980 | IC2 05-80 (SC5b 03-77) | Bipolar ICs for video equipment |
| Part 5a | November 1976 | SC5a 11-76 | Professional analogue integrated circuits |
| Part 4 | October 1980 | IC4 10-80 (SC6 10-77) | Digital integrated circuits LOCMOS HE4000B family |
| Part 6b | August 1979 | SC6b 08-79 | ICs for digital systems in radio and television receivers |
| Signetics integrated circuits | | | Bipolar and MOS memories 1979 Bipolar and MOS microprocessors 1978 Analogue circuits 1979 Logic - TTL 1978 |

COMPONENTS AND MATERIALS (GREEN SERIES)

Starting in 1980, new part numbers and corresponding codes are being introduced. The former code of the preceding issue is given in brackets under the new code.

| | | | |
|---------|---------------|---------------------------|--|
| Part 1 | July 1979 | CM1 07-79 | Assemblies for industrial use PLC modules, high noise immunity logic FZ/30 series, NORbits 60-series, 61-series, 90-series, input devices, hybrid integrated circuits, peripheral devices. |
| Part 2 | June 1981 | C2 06-81 (CM3a 09-78) | FM tuners, television tuners, video modulators, surface acoustic wave filters |
| Part 3 | January 1981 | C3 01-81 (CM3b 10-78) | Loudspeakers |
| Part 4a | November 1978 | CM4a 11-78 | Soft Ferrites Ferrites for radio, audio and television, beads and chokes, Ferroxcube potcores and square cores, Ferroxcube transformer cores |
| Part 4b | February 1979 | CM4b 02-79 | Piezoelectric ceramics, permanent magnet materials |
| Part 6 | May 1981 | C6 05-81 (CM6 04-77) | Electric motors and accessories Permanent magnet synchronous motors, stepping motors, direct current motors |
| Part 7a | January 1979 | CM7a 01-79 | Assemblies Circuit blocks 40-series and CSA70 (L), counter modules 50-series, input/output devices |
| Part 8 | June 1979 | CM8 06-79 | Variable mains transformers |
| Part 9 | August 1979 | CM9 08-79 | Piezoelectric quartz devices Quartz crystal units, temperature compensated crystal oscillators |
| Part 10 | October 1980 | C10 10-80 | Connectors |
| Part 11 | December 1979 | CM11 12-79 | Non-linear resistors Voltage dependent resistors (VDR), light dependent resistors (LDR), negative temperature coefficient thermistors (NTC), positive temperature coefficient thermistors (PTC) |
| Part 12 | November 1979 | CM12 11-79 | Variable resistors and test switches |
| Part 13 | December 1979 | CM13 12-79 | Fixed resistors |
| Part 14 | April 1980 | C14 04-80 (CM2b 02-78) | Electrolytic and solid capacitors |
| Part 15 | May 1980 | C15 05-80 (CM2b 02-78) | Film capacitors, ceramic capacitors, variable capacitors |

ELECTRON TUBES (BLUE SERIES)

Starting in 1980, new part numbers and corresponding codes are being introduced. The former code of the preceding issue is given in brackets under the new code.

| | | | |
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| Part 1 | February 1980 | T1 02-80 (ET1a 12-75) | Tubes for r.f. heating |
| Part 2 | April 1980 | T2 04-80 (ET1b 08-77) | Transmitting tubes for communications |
| Part 2b | May 1978 | ET2b 05-78 | Microwave semiconductors and components Gunn, Impatt and noise diodes, mixer and detector diodes, backward diodes, varactor diodes, Gunn oscillators, sub-assemblies, circulators and isolators. |
| Part 3 | June 1980 | T3 06-80 (ET2a 11-77) | Klystrons, travelling-wave tubes, microwave diodes |
| Part 3 | January 1975 | ET3 01-75 | Special Quality tubes, miscellaneous devices |
| Part 4 | September 1980 | T4 09-80 (ET2a 11-77) | Magnetrons |
| Part 5 | August 1981 | T5 08-81 | Cathode-ray tubes Instrument tubes, monitor and display tubes, C.R. tubes for special applications. |
| Part 6 | July 1980 | T6 07-80 (ET6 01-77) | Geiger-Müller tubes |
| Part 7a | March 1977 | ET7a 03-77 | Gas-filled tubes Thyratrons, industrial rectifying tubes, ignitrons, high-voltage rectifying tubes. |
| Part 7b | May 1979 | ET7b 05-79 | Gas-filled tubes Segment indicator tubes, indicator tubes, switching diodes, dry reed contact units. |
| Part 8 | July 1979 | ET8 07-79 | Picture tubes and components Colour TV picture tubes, black and white TV picture tubes, monitor tubes, components for colour television, components for black and white television. |
| Part 9 | June 1980 | T9 06-80 (ET9 03-78) | Photo and electron multipliers Photomultiplier tubes, phototubes, single channel electron multipliers, channel electron multiplier plates. |
| Part 10 | May 1981 | T10 05-81 (ET5b 12-78) | Camera tubes and accessories, image intensifiers |

INDEX OF TYPE NUMBERS

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The inclusion of a type number in this publication does not necessarily imply its availability.

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| AAZ13 | S1 | GB | BAT17 | S7 | Mm | BB119 | S1 | T |
| AAZ15 | S1 | GB | BAT18 | S7 | Mm | BB204B | S1 | T |
| AAZ17 | S1 | GB | BAV10 | S1 | WD | BB204G | S1 | T |
| AAZ18 | S1 | GB | BAV18 | S1 | WD | BB212 | S1 | T |
| BA182 | S1 | T | BAV19 | S1 | WD | BB405B | S1 | T |
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| BA223 | S1 | T | BAV45 | S1 | Sp | BBY40 | S7 | Mm |
| BA243 | S1 | T | BAV70 | S7 | Mm | BC107 | S3 | Sm |
| BA244 | S1 | T | BAV99 | S7 | Mm | BC108 | S3 | Sm |
| BA280 | S1 | T | BAW56 | S7 | Mm | BC109 | S3 | Sm |
| BA314 | S1 | Vrg | BAW62 | S1 | WD | BC140 | S3 | Sm |
| BA315 | S1 | Vrg | BAX12 | S1 | WD | BC141 | S3 | Sm |
| BA316 | S1 | WD | BAX12A | S1 | WD | BC146 | S3 | Sm |
| BA317 | S1 | WD | BAX13 | S1 | WD | BC147 | S3 | Sm |
| BA318 | S1 | WD | BAX14A | S1 | WD | BC148 | S3 | Sm |
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| BAS16 | S7 | Mm | BB105G | S1 | T | BC160 | S3 | Sm |
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GB = Germanium gold bonded diodes
Mm = Microminiature semiconductors
for hybrid circuits
PC = Germanium point contact diodes
Sm = Small-signal transistors

Sp = Special diodes
T = Tuner diodes
Vrg = Voltage regulator diodes
WD = Silicon whiskerless diodes

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* = series

FET = Field-effect transistors

Mm = Microminiature semiconductors
for hybrid circuits

P = Low-frequency power transistors

Sm = Small-signal transistors

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P = Low-frequency power transistors

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FET = Field-effect transistors
Mm = Microminiature semiconductors
for hybrid circuits

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| BF623 | S7 | Mm | BFQ53 | S10 | WBT | BFW12 | S5 | FET |
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| BFQ22S | S10 | WBT | BFS28 | S5 | FET | BGY50 | S10 | WBM |
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FET = Field-effect transistors
Mm = Microminiature semiconductors
for hybrid circuits
P = Low-frequency power transistors

Sm = Small-signal transistors
Tra = Transmitting transistors and modules
WBM = Wideband hybrid IC modules
WBT = Wideband transistors

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Mm = Microminiature semiconductors
for hybrid circuits
PDT = Photodiodes or transistors
Sm = Small-signal transistors

Th = Thyristors
Tra = Transmitting transistors and modules
WBM = Wideband hybrid IC modules

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* = series

FET = Field-effect transistors

Mm = Microminiature semiconductors
for hybrid circuits

P = Low-frequency power transistors

R = Rectifier diodes

Sm = Small-signal transistors

Th = Thyristors

Tri = Triacs

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* = series

D = Displays

FET = Field-effect transistors

GB = Germanium gold bonded diodes

I = Infrared devices

LED = Light-emitting diodes

Mm = Microminiature semiconductors
for hybrid circuits

P = Low-frequency power transistors

PC = Germanium point contact diodes

Ph = Photoconductive devices

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PhC = Photocouplers
 R = Rectifier diodes
 Sm = Small-signal transistors
 St = Rectifier stacks
 TS = Transient suppressor diodes

Vrf = Voltage reference diodes
 Vrg = Voltage regulator diodes
 WBM = Wideband hybrid IC modules
 WBT = Wideband transistors
 WD = Silicon whiskerless diodes

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A = Accessories

DH = Diecast heatsinks

FET = Field-effect transistors

HE = Heatsink extrusions

I = Infrared devices

PDT = Photodiodes or transistors

Sm = Small-signal transistors

Tra = Transmitting transistors and modules

GENERAL

Type designation
Rating systems
Letter symbols
s-parameters



PRO ELECTRON TYPE DESIGNATION CODE
FOR SEMICONDUCTOR DEVICES

This type designation code applies to discrete semiconductor devices — as opposed to integrated circuits —, multiples of such devices and semiconductor chips.

A basic type number consists of:

TWO LETTERS FOLLOWED BY A SERIAL NUMBER

FIRST LETTER

The first letter gives information about the material used for the active part of the devices.

- A. GERMANIUM or other material with band gap of 0,6 to 1,0 eV.
- B. SILICON or other material with band gap of 1,0 to 1,3 eV.
- C. GALLIUM-ARSENIDE or other material with band gap of 1,3 eV or more.
- R. COMPOUND MATERIALS (e.g. Cadmium-Sulphide).

SECOND LETTER

The second letter indicates the function for which the device is primarily designed.

- A. DIODE; signal, low power
- B. DIODE; variable capacitance
- C. TRANSISTOR; low power, audio frequency ($R_{th\ j-mb} > 15\text{ }^{\circ}\text{C/W}$)
- D. TRANSISTOR; power, audio frequency ($R_{th\ j-mb} \leq 15\text{ }^{\circ}\text{C/W}$)
- E. DIODE; tunnel
- F. TRANSISTOR; low power, high frequency ($R_{th\ j-mb} > 15\text{ }^{\circ}\text{C/W}$)
- G. MULTIPLE OF DISSIMILAR DEVICES — MISCELLANEOUS; e.g. oscillator
- H. DIODE; magnetic sensitive
- L. TRANSISTOR; power, high frequency ($R_{th\ j-mb} \leq 15\text{ }^{\circ}\text{C/W}$)
- N. PHOTO-COUPLER
- P. RADIATION DETECTOR; e.g. high sensitivity phototransistor
- Q. RADIATION GENERATOR; e.g. light-emitting diode (LED)
- R. CONTROL AND SWITCHING DEVICE; e.g. thyristor, low power ($R_{th\ j-mb} > 15\text{ }^{\circ}\text{C/W}$)
- S. TRANSISTOR; low power, switching ($R_{th\ j-mb} > 15\text{ }^{\circ}\text{C/W}$)
- T. CONTROL AND SWITCHING DEVICE; e.g. thyristor, power ($R_{th\ j-mb} \leq 15\text{ }^{\circ}\text{C/W}$)
- U. TRANSISTOR; power, switching ($R_{th\ j-mb} \leq 15\text{ }^{\circ}\text{C/W}$)
- X. DIODE: multiplier, e.g. varactor, step recovery
- Y. DIODE; rectifying, booster
- Z. DIODE; voltage reference or regulator (transient suppressor diode, with third letter W)

SERIAL NUMBER

Three figures, running from 100 to 999, for devices primarily intended for consumer equipment. One letter (Z, Y, X, etc.) and two figures, running from 10 to 99, for devices primarily intended for industrial/professional equipment.

This letter has no fixed meaning except W, which is used for transient suppressor diodes.

VERSION LETTER

It indicates a minor variant of the basic type either electrically or mechanically. The letter never has a fixed meaning, except letter R, indicating reverse voltage, e.g. collector to case or anode to stud.

SUFFIX

Sub-classification can be used for devices supplied in a wide range of variants called associated types. Following sub-coding suffixes are in use:

1. VOLTAGE REFERENCE and VOLTAGE REGULATOR DIODES: *ONE LETTER and ONE NUMBER*

The LETTER indicates the nominal tolerance of the Zener (regulation, working or reference) voltage

- A. 1% (according to IEC 63: series E96)
- B. 2% (according to IEC 63: series E48)
- C. 5% (according to IEC 63: series E24)
- D. 10% (according to IEC 63: series E12)
- E. 20% (according to IEC 63: series E6)

The number denotes the typical operating (Zener) voltage related to the nominal current rating for the whole range.

The letter 'V' is used instead of the decimal point.

2. TRANSIENT SUPPRESSOR DIODES: *ONE NUMBER*

The NUMBER indicates the maximum recommended continuous reversed (stand-off) voltage V_R . The letter 'V' is used as above.

3. CONVENTIONAL and CONTROLLED AVALANCHE RECTIFIER DIODES and THYRISTORS: *ONE NUMBER*

The NUMBER indicates the rated maximum repetitive peak reverse voltage (V_{RRM}) or the rated repetitive peak off-state voltage (V_{DRM}), whichever is the lower. Reversed polarity is indicated by letter R, immediately after the number.

4. RADIATION DETECTORS: *ONE NUMBER*, preceded by a hyphen (—)

The NUMBER indicates the depletion layer in μm . The resolution is indicated by a version LETTER.

5. ARRAY OF RADIATION DETECTORS and GENERATORS: *ONE NUMBER*, preceded by a stroke (/).

The NUMBER indicates how many basic devices are assembled into the array.

RATING SYSTEMS

The rating systems described are those recommended by the International Electrotechnical Commission (IEC) in its Publication 134.

DEFINITIONS OF TERMS USED

Electronic device. An electronic tube or valve, transistor or other semiconductor device.

Note

This definition excludes inductors, capacitors, resistors and similar components.

Characteristic. A characteristic is an inherent and measurable property of a device. Such a property may be electrical, mechanical, thermal, hydraulic, electro-magnetic, or nuclear, and can be expressed as a value for stated or recognized conditions. A characteristic may also be a set of related values, usually shown in graphical form.

Bogey electronic device. An electronic device whose characteristics have the published nominal values for the type. A bogey electronic device for any particular application can be obtained by considering only those characteristics which are directly related to the application.

Rating. A value which establishes either a limiting capability or a limiting condition for an electronic device. It is determined for specified values of environment and operation, and may be stated in any suitable terms.

Note

Limiting conditions may be either maxima or minima.

Rating system. The set of principles upon which ratings are established and which determine their interpretation.

Note

The rating system indicates the division of responsibility between the device manufacturer and the circuit designer, with the object of ensuring that the working conditions do not exceed the ratings.

ABSOLUTE MAXIMUM RATING SYSTEM

Absolute maximum ratings are limiting values of operating and environmental conditions applicable to any electronic device of a specified type as defined by its published data, which should not be exceeded under the worst probable conditions.

These values are chosen by the device manufacturer to provide acceptable serviceability of the device, taking no responsibility for equipment variations, environmental variations, and the effects of changes in operating conditions due to variations in the characteristics of the device under consideration and of all other electronic devices in the equipment.

The equipment manufacturer should design so that, initially and throughout life, no absolute maximum value for the intended service is exceeded with any device under the worst probable operating conditions with respect to supply voltage variation, equipment component variation, equipment control adjustment, load variations, signal variation, environmental conditions, and variations in characteristics of the device under consideration and of all other electronic devices in the equipment.

DESIGN MAXIMUM RATING SYSTEM

Design maximum ratings are limiting values of operating and environmental conditions applicable to a bogey electronic device of a specified type as defined by its published data, and should not be exceeded under the worst probable conditions.

These values are chosen by the device manufacturer to provide acceptable serviceability of the device, taking responsibility for the effects of changes in operating conditions due to variations in the characteristics of the electronic device under consideration.

The equipment manufacturer should design so that, initially and throughout life, no design maximum value for the intended service is exceeded with a bogey device under the worst probable operating conditions with respect to supply voltage variation, equipment component variation, variation in characteristics of all other devices in the equipment, equipment control adjustment, load variation, signal variation and environmental conditions.

DESIGN CENTRE RATING SYSTEM

Design centre ratings are limiting values of operating and environmental conditions applicable to a bogey electronic device of a specified type as defined by its published data, and should not be exceeded under normal conditions.

These values are chosen by the device manufacturer to provide acceptable serviceability of the device in average applications, taking responsibility for normal changes in operating conditions due to rated supply voltage variation, equipment component variation, equipment control adjustment, load variation, signal variation, environmental conditions, and variations in the characteristics of all electronic devices.

The equipment manufacturer should design so that, initially, no design centre value for the intended service is exceeded with a bogey electronic device in equipment operating at the stated normal supply voltage.



LETTER SYMBOLS FOR TRANSISTORS AND SIGNAL DIODES

based on IEC Publication 148

LETTER SYMBOLS FOR CURRENTS, VOLTAGES AND POWERS

Basic letters

The basic letters to be used are:

I, i = current
V, v = voltage
P, p = power.

Lower-case basic letters shall be used for the representation of instantaneous values which vary with time.

In all other instances upper-case basic letters shall be used.

Subscripts

| | |
|--------------|--|
| A, a | Anode terminal |
| (AV), (av) | Average value |
| B, b | Base terminal, for MOS devices: Substrate |
| (BR) | Breakdown |
| C, c | Collector terminal |
| D, d | Drain terminal |
| E, e | Emitter terminal |
| F, f | Forward |
| G, g | Gate terminal |
| K, k | Cathode terminal |
| M, m | Peak value |
| O, o | As third subscript: The terminal not mentioned is open circuited |
| R, r | As first subscript: Reverse. As second subscript: Repetitive. |
| | As third subscript: With a specified resistance between the terminal not mentioned and the reference terminal. |
| (RMS), (rms) | R. M. S. value |
| S, s | As first or second subscript: Source terminal (for FETS only) |
| | As second subscript: Non-repetitive (not for FETS) |
| | As third subscript: Short circuit between the terminal not mentioned and the reference terminal |
| X, x | Specified circuit |
| Z, z | Replaces R to indicate the actual working voltage, current or power of voltage reference and voltage regulator diodes. |

Note: No additional subscript is used for d. c. values.

Upper-case subscripts shall be used for the indication of:

- a) continuous (d. c.) values (without signal)
Example I_B
- b) instantaneous total values
Example i_B
- c) average total values
Example $I_{B(AV)}$
- d) peak total values
Example I_{BM}
- e) root-mean-square total values
Example $I_{B(RMS)}$

Lower-case subscripts shall be used for the indication of values applying to the varying component alone:

- a) instantaneous values
Example i_b
- b) root-mean-square values
Example $I_{b(rms)}$
- c) peak values
Example I_{bm}
- d) average values
Example $I_{b(av)}$

Note: If more than one subscript is used, subscript for which both styles exist shall either be all upper-case or all lower-case.

Additional rules for subscripts

Subscripts for currents

Transistors: If it is necessary to indicate the terminal carrying the current, this should be done by the first subscript (conventional current flow from the external circuit into the terminal is positive).

Examples: I_B , i_B , i_b , I_{bM}

Diodes: To indicate a forward current (conventional current flow into the anode terminal) the subscript F or f should be used; for a reverse current (conventional current flow out of the anode terminal) the subscript R or r should be used.

Examples: I_F , I_R , i_F , $I_{f(rms)}$

Subscripts for voltages

Transistors: If it is necessary to indicate the points between which a voltage is measured, this should be done by the first two subscripts. The first subscript indicates the terminal at which the voltage is measured and the second the reference terminal or the circuit node. Where there is no possibility of confusion, the second subscript may be omitted.

Examples: V_{BE} , v_{BE} , v_{be} , V_{bem}

Diodes: To indicate a forward voltage (anode positive with respect to cathode), the subscript F or f should be used; for a reverse voltage (anode negative with respect to cathode) the subscript R or r should be used.

Examples: V_F , V_R , v_F , V_{rm}

Subscripts for supply voltages or supply currents

Supply voltages or supply currents shall be indicated by repeating the appropriate terminal subscript.

Examples: V_{CC} , I_{EE}

Note: If it is necessary to indicate a reference terminal, this should be done by a third subscript

Example: V_{CCE}

Subscripts for devices having more than one terminal of the same kind

If a device has more than one terminal of the same kind, the subscript is formed by the appropriate letter for the terminal followed by a number; in the case of multiple subscripts, hyphens may be necessary to avoid misunderstanding.

Examples: I_{B2} = continuous (d.c.) current flowing into the second base terminal

V_{B2-E} = continuous (d.c.) voltage between the terminals of second base and emitter

Subscripts for multiple devices

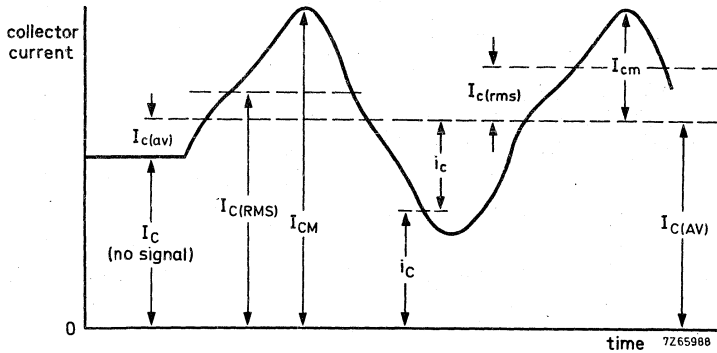
For multiple unit devices, the subscripts are modified by a number preceding the letter subscript; in the case of multiple subscripts, hyphens may be necessary to avoid misunderstanding.

Examples: I_{2C} = continuous (d.c.) current flowing into the collector terminal of the second unit

V_{1C-2C} = continuous (d.c.) voltage between the collector terminals of the first and the second unit.

Application of the rules

The figure below represents a transistor collector current as a function of time. It consists of a continuous (d.c.) current and a varying component.



LETTER SYMBOLS FOR ELECTRICAL PARAMETERS

Definition

For the purpose of this Publication, the term "electrical parameter" applies to four-pole matrix parameters, elements of electrical equivalent circuits, electrical impedances and admittances, inductances and capacitances.

Basic letters

The following is a list of the most important basic letters used for electrical parameters of semiconductor devices.

- B, b = susceptance; imaginary part of an admittance
- C = capacitance
- G, g = conductance; real part of an admittance
- H, h = hybrid parameter
- L = inductance
- R, r = resistance; real part of an impedance
- X, x = reactance; imaginary part of an impedance
- Y, y = admittance;
- Z, z = impedance;

Upper-case letters shall be used for the representation of:

- a) electrical parameters of external circuits and of circuits in which the device forms only a part;
- b) all inductances and capacitances.

Lower-case letters shall be used for the representation of electrical parameters inherent in the device (with the exception of inductances and capacitances).

Subscripts

General subscripts

The following is a list of the most important general subscripts used for electrical parameters of semiconductor devices:

| | |
|-------------|-----------------------------|
| F, f | = forward; forward transfer |
| I, i (or 1) | = input |
| L, l | = load |
| O, o (or 2) | = output |
| R, r | = reverse; reverse transfer |
| S, s | = source |

Examples: Z_S , h_I , h_F

The upper-case variant of a subscript shall be used for the designation of static (d.c.) values.

Examples: h_{FE} = static value of forward current transfer ratio in common-emitter configuration (d.c. current gain)
 R_E = d.c. value of the external emitter resistance.

Note: The static value is the slope of the line from the origin to the operating point on the appropriate characteristic curve, i.e. the quotient of the appropriate electrical quantities at the operating point.

The lower-case variant of a subscript shall be used for the designation of small-signal values.

Examples: h_{fe} = small-signal value of the short-circuit forward current transfer ratio in common-emitter configuration

$Z_e = R_e + jX_e$ = small-signal value of the external impedance

Note: If more than one subscript is used, subscripts for which both styles exist shall either be all upper-case or all lower-case

Examples: h_{FE} , y_{RE} , h_{fe}

Subscripts for four-pole matrix parameters

The first letter subscript (or double numeric subscript) indicates input, output, forward transfer or reverse transfer

Examples: h_i (or h_{11})
 h_o (or h_{22})
 h_f (or h_{21})
 h_r (or h_{12})

A further subscript is used for the identification of the circuit configuration. When no confusion is possible, this further subscript may be omitted.

Examples: h_{fe} (or h_{21e}), h_{FE} (or h_{21E})

Distinction between real and imaginary parts

If it is necessary to distinguish between real and imaginary parts of electrical parameters, no additional subscripts should be used. If basic symbols for the real and imaginary parts exist, these may be used.

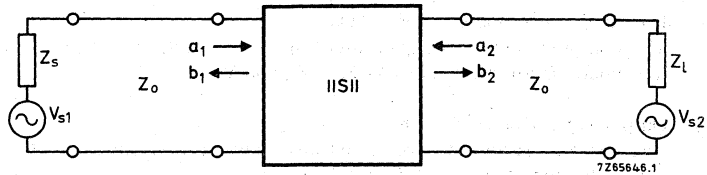
Examples: $Z_i = R_i + jX_i$
 $y_{fe} = g_{fe} + jb_{fe}$

If such symbols do not exist or if they are not suitable, the following notation shall be used:

Examples: $\text{Re}(h_{ib})$ etc. for the real part of h_{ib}
 $\text{Im}(h_{ib})$ etc. for the imaginary part of h_{ib}

SCATTERING PARAMETERS

In distinction to the conventional h, y and z-parameters, s-parameters relate to traveling wave conditions. The figure below shows a two-port network with the incident and reflected waves a_1 , b_1 , a_2 and b_2 .



$$a_1 = \frac{V_{i1}}{\sqrt{Z_o}}$$

$$a_2 = \frac{V_{i2}}{\sqrt{Z_o}}$$

$$b_1 = \frac{V_{r1}}{\sqrt{Z_o}}$$

$$b_2 = \frac{V_{r2}}{\sqrt{Z_o}}$$

1)

Z_o = characteristic impedance of the transmission line in which the two-port is connected.

V_i = incident voltage

V_r = reflected (generated) voltage

The four-pole equations for s-parameters are:

$$b_1 = s_{11}a_1 + s_{12}a_2$$

$$b_2 = s_{21}a_1 + s_{22}a_2$$

Using the subscripts i for 11, r for 12, f for 21 and o for 22, it follows that:

$$s_i = s_{11} = \left. \frac{b_1}{a_1} \right|_{a_2 = 0}$$

$$s_r = s_{12} = \left. \frac{b_1}{a_2} \right|_{a_1 = 0}$$

$$s_f = s_{21} = \left. \frac{b_2}{a_1} \right|_{a_2 = 0}$$

$$s_o = s_{22} = \left. \frac{b_2}{a_2} \right|_{a_1 = 0}$$

1) The squares of these quantities have the dimension of power.

S-PARAMETERS

The s-parameters can be named and expressed as follows:

- $s_i = s_{11}$ = Input reflection coefficient.
The complex ratio of the reflected wave and the incident wave at the input, under the conditions $Z_1 = Z_0$ and $V_{s2} = 0$.
- $s_r = s_{12}$ = Reverse transmission coefficient.
The complex ratio of the generated wave at the input and the incident wave at the output, under the conditions $Z_s = Z_0$ and $V_{s1} = 0$.
- $s_f = s_{21}$ = Forward transmission coefficient.
The complex ratio of the generated wave at the output and the incident wave at the input, under the conditions $Z_1 = Z_0$ and $V_{s2} = 0$.
- $s_o = s_{22}$ = Output reflection coefficient.
The complex ratio of the reflected wave and the incident wave at the output, under the conditions $Z_s = Z_0$ and $V_{s1} = 0$.

WIDEBAND TRANSISTORS

Type number survey

Selection guide

Soldering recommendations SOT-37

Soldering recommendations SOT-48

and SOT-122

Accessories



TYPE NUMBER SURVEY



| | polarity | | envelope | | RATINGS | | | | CHARACTERISTICS (typical values unless otherwise specified) | | | | | | |
|--------|----------|-------|------------------|----------------|------------------|----------------|------|------|---|------|------------------|----------------|-----------------|--|--|
| | n-p-n | p-n-p | V _{CEO} | I _C | P _{tot} | f _T | F | f | GUM | f | V _O * | I _C | V _{CE} | | |
| | | | V | mA | mW | GHz | dB | MHz | dB | MHz | mV | mA | V | | |
| BFO22 | • | | 12 | 35 | 150 | 5 | 1,9 | 500 | 16 | 500 | 300 | 30 | 5 | | |
| BFO22S | • | | 12 | 35 | 150 | 5 | 1,9 | 500 | 16 | 500 | 300 | 30 | 5 | | |
| BFO23 | | • | 12 | 35 | 180 | 5 | 2,4 | 500 | 16,5 | 500 | 300 | 30 | 5 | | |
| BFO24 | | • | 12 | 35 | 150 | 5 | 2,4 | 500 | 15 | 500 | 300 | 30 | 5 | | |
| BFO32 | | • | 15 | 75 | 500 | 4,2 | 3,75 | 500 | 14 | 500 | 500 | 50 | 10 | | |
| BFO33 | | • | 7 | 20 | 140 | 12 | 2,5 | 2000 | 13 | 2000 | 1200 | 14 | 5 | | |
| BFO34 | | • | 18 | 150 | 2250 | 3,9 | 8 | 500 | 16,3 | 500 | 150 | 120 | 15 | | |
| BFO51 | | • | 15 | 25 | 180 | 5 | 2,7 | 500 | 19 | 500 | 150 | 14 | 10 | | |
| BFO52 | | • | 15 | 25 | 150 | 5 | 2,7 | 500 | 17 | 500 | 150 | 14 | 10 | | |
| BFO53 | | • | 15 | 25 | 150 | 5 | 2,4 | 500 | 18 | 500 | 150 | 14 | 10 | | |
| BFO63 | | • | 15 | 75 | 250 | 4,5 | <3,0 | 200 | 11,5 | 500 | 500 | 50 | 10 | | |
| BFO68 | | • | 18 | 300 | 4500 | 4 | — | — | 13 | 800 | 1600 | 240 | 15 | | |
| BFR49 | | • | 15 | 25 | 180 | 5 | 2,5 | 1000 | 17 | 1000 | — | 14 | 10 | | |
| BFR64 | | • | 25 | 200 | 3500 | 1 | 6 | 200 | — | — | — | — | — | | |
| BFR65 | | • | 25 | 400 | 5000 | >1 | — | — | — | — | — | — | — | | |
| BFR90 | | • | 15 | 25 | 180 | 5 | 2,4 | 500 | 19,5 | 500 | 150 | 14 | 10 | | |
| BFR90A | | • | 15 | 25 | 180 | 5 | 1,8 | 800 | 20 | 500 | 150 | 14 | 10 | | |
| BFR91 | | • | 12 | 35 | 180 | 5 | 1,9 | 500 | 18 | 500 | 300 | 30 | 5 | | |
| BFR91A | | • | 12 | 35 | 300 | 6 | 1,6 | 800 | 14 | 800 | 425 | 30 | 8 | | |
| BFR94 | | • | 25 | 150 | 3500 | 3,5 | 5 | 500 | 13,5 | 500 | 700 | 90 | 20 | | |
| BFR95 | | • | 25 | 150 | 1500 | 3,5 | 9 | 200 | — | — | 1000 | 80 | 18 | | |
| BFR96 | | • | 15 | 75 | 500 | 5 | 3,3 | 500 | 15,2 | 500 | 500 | 50 | 10 | | |
| BFR96S | | • | 15 | 100 | 700 | 5 | 4 | 800 | 11,5 | 800 | 700 | 70 | 10 | | |
| BFT24 | | • | 5 | 2,5 | 30 | 2,3 | 3,8 | 500 | 17 | 500 | — | — | — | | |
| BFW16A | | • | 25 | 150 | 1500 | 1,2 | <6 | 200 | — | — | — | — | — | | |
| BFW17A | | • | 25 | 150 | 1500 | 1,1 | — | — | — | — | — | — | — | | |
| BFW30 | | • | 10 | 50 | 250 | 1,6 | <5 | 500 | — | — | 100 | 30 | 6 | | |
| BFW92 | | • | 15 | 25 | 190 | 1,6 | 4 | 500 | — | — | — | — | — | | |
| BFW93 | | • | 10 | 50 | 190 | 1,7 | <5 | 500 | 10,5 | 800 | 100 | 30 | 5 | | |
| BFX89 | | • | 15 | 25 | 200 | 1,2 | 3,3 | 200 | — | — | — | — | — | | |
| BFY90 | | • | 15 | 25 | 200 | 1,4 | 2,5 | 200 | — | — | — | — | — | | |
| 2N918 | | • | 15 | 50 | 200 | >0,9 | <6 | 60 | 36 | 200 | — | — | — | | |

* Typical reference value.

This table shows the preferred types of n-p-n transistors and their complements for wideband applications. It shows the types in sequence of linear output voltage capability in each type of envelope. The values of V_o are only given as a typical reference.
For detailed information see relevant data sheet.

| envelope | polarity | | I_C (mA) | V_{CE} (V) | V_o^* (mV) | 14 10 | 30 5 | 30 8 | 50 10 | 70 10 | 80 10 | 120 15 | 240 15 |
|----------|----------|-------|------------|-----------------|-----------------|----------|---------|---------|----------|----------|----------|-----------|-----------|
| | n-p-n | p-n-p | | | | | | | | | | | |
| | | | | | | | | | | | | | |
| SOT-23 | • | | | | | 150 | 300 | 425 | 500 | 700 | | | |
| | • | | BFT25 | BFR92 BFR92A | BFR93 BFR93A | BFR92A | BFR93A | BFR93A | | | | | |
| | | • | | BFT92 | BFT93 | | | | | | | | |
| SOT-37 | • | | | | | | | | BFR96 | BFR96S | | | |
| | • | | BFT24 | BFR90 BFR90A | BFR91 BFR91A | BFR90A | BFR91A | | BFR96 | BFR96S | | | |
| | | • | | BFO51 | BFO23 | | | | BFO32 | | | | |
| SOT-89 | • | | | | | | | BFO19 | | BFO18A | | | |
| SOT-122 | • | | | | | | | | | | | BFO34 | BFO68 |
| | • | | | BFO53 | BFO22S | | | | BFO63 | | | | |
| TO-72 | • | | | BFO52 | BFO24 | | | | | | | | |
| | | • | | | | | | | | | | | |

* Typical output voltage at $d_{im} = -60$ dB (DIN 45004B, par. 6.3: 3-tone).



SOLDERING RECOMMENDATIONS SOT-37

Transistors in SOT-37 envelopes may be mounted with leads flat (Fig. 1) or bent (Figs 2 and 3). Different soldering procedures apply for the different styles of mounting.

FLAT-LEAD MOUNTING

Soldering by hand

Avoid putting any force on the leads during or just after soldering.

Solder the three leads one at a time, *not* simultaneously.

Proceed from one lead to the adjacent lead, *not* to the opposite one.

BENT-LEAD MOUNTING

If leads are bent, all three may be soldered simultaneously if desired.

DIP OR WAVE SOLDERING

When dip or wave soldering, the maximum allowable temperature of the solder is 260 °C. This temperature must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds. The device may be mounted up to the lead projections, but the temperature of the body must not exceed the specified storage maximum.

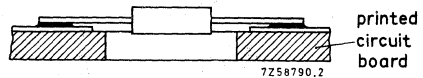


Fig. 1

| | | |
|-------------------------|------|--------|
| Solder temperature | max. | 300 °C |
| Soldering time | max. | 5 s |
| Solder-to-case distance | min. | 2 mm |

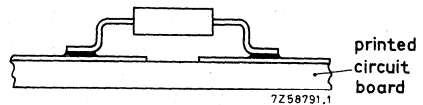


Fig. 2

| | | |
|--------------------|------|--------|
| Solder temperature | max. | 300 °C |
| Soldering time | max. | 10 s |

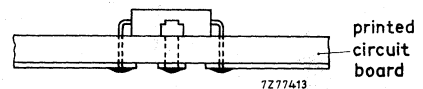


Fig. 3

| | | |
|--------------------|------|--------|
| Solder temperature | max. | 260 °C |
| Soldering time | max. | 5 s |

RECOMMENDATIONS FOR MOUNTING
¼" CAPSTAN ENVELOPES

A brass nut is supplied with each transistor for securing it to a heatsink.

Screw thread, diameter and nuts:

| stud diameter | thread | maximum diameter of threaded stud | nut thickness |
|---------------|---------------|--------------------------------------|---------------------------------|
| ¼" | 8-32UNC-2A(B) | 4,14 mm | 3,5 mm SOT-48 5,0 mm SOT-122 |

To ensure optimum heat transfer and to avoid damage to the threaded stud of the transistor the following recommendations should be observed:

1. Diameter of the mounting hole in the heatsink $4,15 + 0,05; -0$ mm (max. 4,2 mm).
2. Heatsink surfaces at the mounting hole to be flat, parallel, and free of burrs or oxydation.
3. Torque on nut: minimum 0,75 Nm (7,5 kgcm), maximum 0,85 Nm (8,5 kgcm).
4. Recommended distance from the top surface of the heatsink to surface of printed-circuit board: $2,9 + 0; -0,2$ mm.

Tension in the transistor leads sets the limit on spacing between heatsink and printed-circuit board; in general, the leads can withstand more pull in the downward direction than in the upward direction.

Solder the leads to the connection pads with resin-cored tin-lead solder, using an iron of normal temperature. Soldering iron temperatures as high as 350 °C are safely tolerable; the transistor can withstand an interior temperature of 250 °C for about ten minutes.

The leads may be tinned, if required, by dipping them into a solder bath at about 230 °C; each lead may be dipped up to its full length. A flux of the quality of Super-Safe is recommended; after tinning, surplus flux should be rinsed away with tap water.

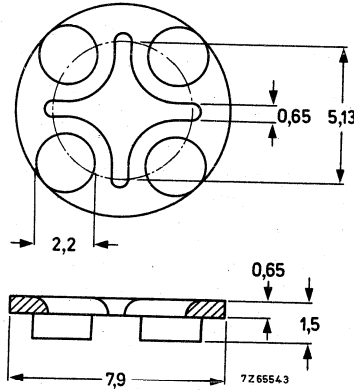
DISTANCE DISCS

MECHANICAL DATA

Fig. 1 56245 for TO-5 or TO-39.

Insulating material;

Dimensions in mm



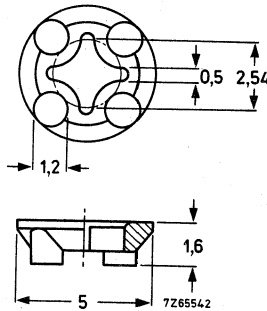
TEMPERATURE

Maximum permissible temperature

Fig. 2 56246 for TO-18 or TO-72.

Insulating material.

T max. 100 °C



TEMPERATURE

Maximum permissible temperature

T max. 100 °C

SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a TO-72 metal envelope with insulated electrodes and a shield lead connected to the case. It is primarily intended for use in u.h.f. and microwave amplifiers such as in aerial amplifiers, radar systems, oscilloscopes, spectrum analysers etc.

The transistor features extremely high power gain coupled with good low noise performance.

P-N-P complement is BFQ24.

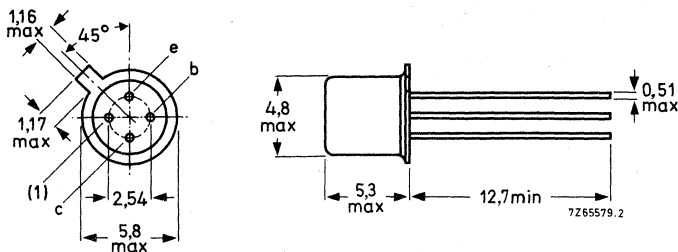
QUICK REFERENCE DATA

| | | | |
|---|-----------|------|----------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 15 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 12 V |
| Collector current (d.c.) | I_C | max. | 35 mA |
| Total power dissipation up to $T_{amb} = 65\text{ }^\circ\text{C}$ | P_{tot} | max. | 150 mW |
| Junction temperature | T_j | max. | 200 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 30\text{ mA}; V_{CE} = 5\text{ V}$ | f_T | typ. | 5 GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $I_C = 0; V_{CE} = 5\text{ V}$ | C_{re} | typ. | 0,7 pF |
| Noise figure at optimum source impedance $I_C = 2\text{ mA}; V_{CE} = 5\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | F | typ. | 1,9 dB |
| Maximum unilateral power gain (see page 2) $I_C = 30\text{ mA}; V_{CE} = 5\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | G_{UM} | typ. | 16,0 dB |

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-72 with insulated electrodes.



(1) shield lead connected to case.

Accessories: 56246 (distance disc).

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|---|-----------|------|----------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 15 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 12 V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2 V |
| Collector current (d.c.) | I_C | max. | 35 mA |
| Collector current (peak value) at $f > 1$ MHz | I_{CM} | max. | 50 mA |
| Total power dissipation up to $T_{amb} = 65$ °C | P_{tot} | max. | 150 mW |
| Storage temperature | T_{stg} | | -65 to +200 °C |
| Junction temperature | T_j | max. | 200 °C |

THERMAL RESISTANCE

| | | | |
|--------------------------------------|---------------|---|----------|
| From junction to ambient in free air | $R_{th\ j-a}$ | = | 0,9 K/mW |
| From junction to case | $R_{th\ j-c}$ | = | 0,6 K/mW |

CHARACTERISTICS

$T_j = 25$ °C unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 5$ V

| | | |
|-----------|---|-------|
| I_{CBO} | < | 50 nA |
|-----------|---|-------|

D.C. current gain (note 1)

$I_C = 30$ mA; $V_{CE} = 5$ V

| | | |
|----------|------|----|
| h_{FE} | > | 25 |
| | typ. | 50 |

Transition frequency (notes 1 and 2)

$I_C = 30$ mA; $V_{CE} = 5$ V; $f = 500$ MHz

| | | |
|-------|------|-------|
| f_T | typ. | 5 GHz |
|-------|------|-------|

Collector capacitance (note 2)

$I_E = I_e = 0; V_{CB} = 5$ V; $f = 1$ MHz

| | | |
|-------|------|--------|
| C_c | typ. | 1,1 pF |
|-------|------|--------|

Emitter capacitance

$I_C = I_c = 0; V_{EB} = 0,5$ V; $f = 1$ MHz

| | | |
|-------|------|--------|
| C_e | typ. | 2,5 pF |
|-------|------|--------|

Feedback capacitance (note 2)

$I_C = 0; V_{CE} = 5$ V; $f = 1$ MHz; $T_{amb} = 25$ °C

| | | |
|----------|------|--------|
| C_{re} | typ. | 0,7 pF |
|----------|------|--------|

Noise figure at optimum source impedance (note 2)

$I_C = 2$ mA; $V_{CE} = 5$ V; $f = 500$ MHz; $T_{amb} = 25$ °C

| | | |
|---|------|--------|
| F | typ. | 1,9 dB |
|---|------|--------|

Maximum unilateral power gain (note 2)

s_{re} assumed to be zero

$$GUM \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$I_C = 30$ mA; $V_{CE} = 5$ V; $f = 500$ MHz; $T_{amb} = 25$ °C

| | | |
|-----|------|---------|
| GUM | typ. | 16,0 dB |
|-----|------|---------|

Notes

1. Measured under pulse conditions.
2. Shield lead grounded.
3. Shield lead not connected.

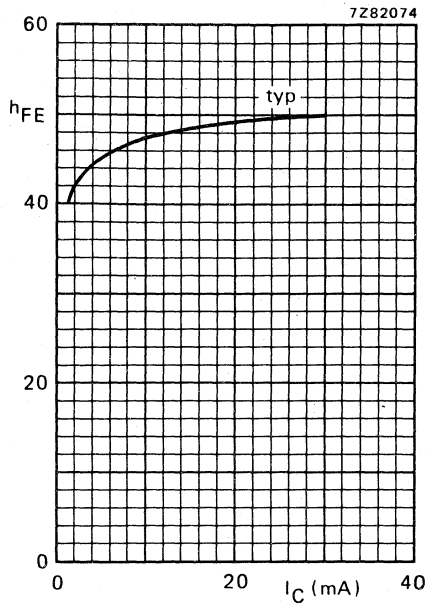


Fig. 2 $V_{CE} = 5$ V; $T_j = 25$ °C.

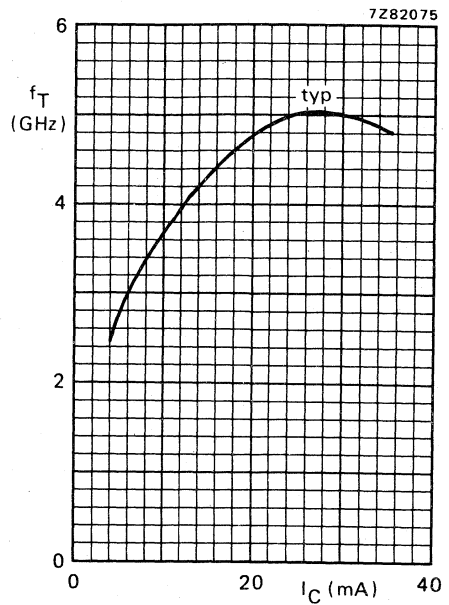


Fig. 3 $V_{CE} = 5$ V; $f = 500$ MHz; $T_j = 25$ °C; shield lead grounded.

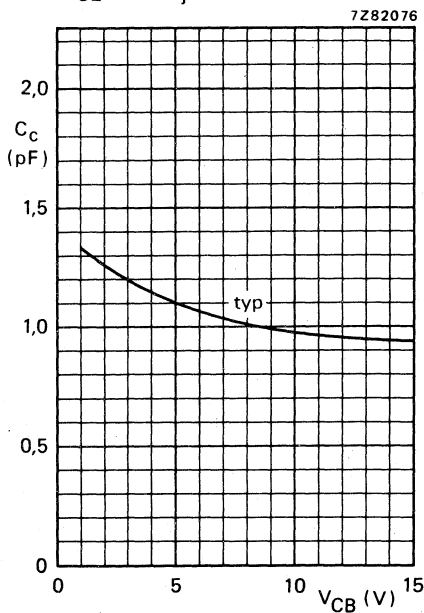


Fig. 4 $I_E = I_e = 0$; $f = 1$ MHz; $T_j = 25$ °C; shield lead not connected.

SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a TO-72 metal envelope with insulated electrodes and a shield lead connected to the case. It is primarily intended for use in u.h.f. and microwave aerial amplifiers, radar systems, oscilloscopes, spectrum analysers etc.

The transistor has extremely high power gain and good low noise performance.

P-N-P complement is BFQ24.

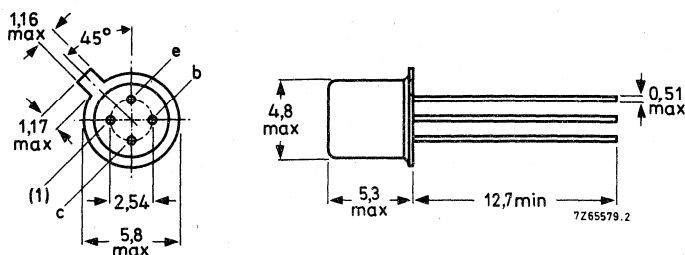
QUICK REFERENCE DATA

| | | | |
|--|-----------|------|----------------------|
| Collector-base voltage (open emitter) | V_{CB0} | max. | 15 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 12 V |
| Collector current (d.c.) | I_C | max. | 35 mA |
| Total power dissipation up to $T_{amb} = 65\text{ }^\circ\text{C}$ | P_{tot} | max. | 150 mW |
| Junction temperature | T_j | max. | 200 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 30\text{ mA}$; $V_{CE} = 5\text{ V}$ | f_T | typ. | 5 GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $I_C = 0$; $V_{CE} = 5\text{ V}$ | C_{re} | typ. | 0,65 pF |
| Noise figure at optimum source impedance $I_C = 2\text{ mA}$; $V_{CE} = 5\text{ V}$; $f = 500\text{ MHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | F | typ. | 1,9 dB |
| Maximum unilateral power gain (see page 2) $I_C = 30\text{ mA}$; $V_{CE} = 5\text{ V}$; $f = 500\text{ MHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | G_{UM} | typ. | 16,0 dB |

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-72 with insulated electrodes.



(1) Shield lead connected to case.

Accessories: 56246 (distance disc).

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|---|-----------|------|-----------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 15 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 12 V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2 V |
| Collector current (d.c.) | I_C | max. | 35 mA |
| Collector current (peak value) at $f > 1$ MHz | I_{CM} | max. | 50 mA |
| Total power dissipation up to $T_{amb} = 65$ °C | P_{tot} | max. | 150 mW |
| Storage temperature | T_{stg} | | -65 to + 200 °C |
| Junction temperature | T_j | max. | 200 °C |

THERMAL RESISTANCE (note 1)

| | | | |
|--------------------------------------|---------------|---|---------|
| From junction to ambient in free air | $R_{th\ j-a}$ | = | 900 K/W |
| From junction to case | $R_{th\ j-c}$ | = | 600 K/W |

CHARACTERISTICS

$T_j = 25$ °C unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 5$ V

| | | |
|-----------|---|-------|
| I_{CBO} | < | 50 nA |
|-----------|---|-------|

D.C. current gain (note 2)

$I_C = 10$ mA; $V_{CE} = 5$ V

| | | |
|----------|--|-----------|
| h_{FE} | | 50 to 150 |
|----------|--|-----------|

Transition frequency (notes 2 and 3)

$I_C = 30$ mA; $V_{CE} = 5$ V; $f = 500$ MHz

| | | |
|-------|------|-------|
| f_T | typ. | 5 GHz |
|-------|------|-------|

Feedback capacitance (note 3)

$I_C = 0; V_{CE} = 5$ V; $f = 1$ MHz; $T_{amb} = 25$ °C

| | | |
|----------|------|---------|
| C_{re} | typ. | 0,65 pF |
|----------|------|---------|

Noise figure at optimum source impedance (note 3)

$I_C = 2$ mA; $V_{CE} = 5$ V; $f = 500$ MHz; $T_{amb} = 25$ °C

$I_C = 10$ mA; $V_{CE} = 5$ V; $f = 200$ MHz; $T_{amb} = 25$ °C

| | | |
|---|------|--------|
| F | typ. | 1,9 dB |
| F | < | 2,5 dB |

Maximum unilateral power gain (note 3)

s_{re} assumed to be zero

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$I_C = 10$ mA; $V_{CE} = 5$ V; $f = 200$ MHz; $T_{amb} = 25$ °C

$I_C = 30$ mA; $V_{CE} = 5$ V; $f = 500$ MHz; $T_{amb} = 25$ °C

| | | |
|----------|------|---------|
| G_{UM} | > | 21,0 dB |
| G_{UM} | typ. | 16,0 dB |

Notes

1. K/W is SI unit for °C/W.
2. Measured under pulse conditions.
3. Shield lead grounded.

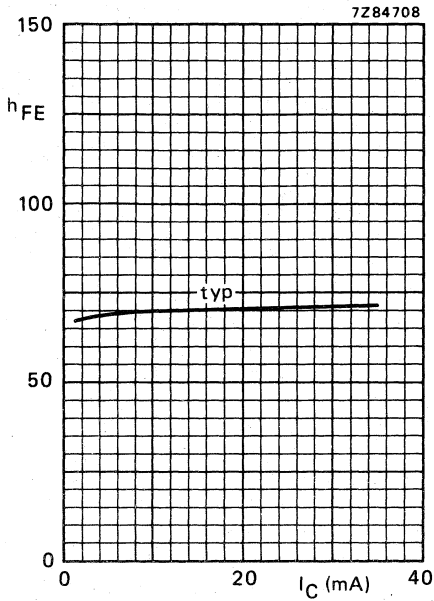


Fig. 2.

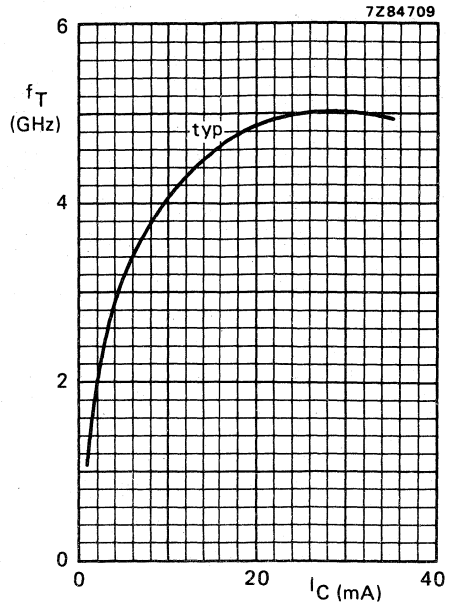


Fig. 3.

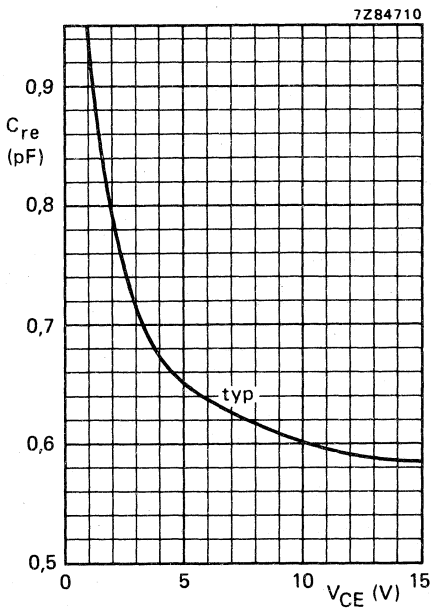


Fig. 4.

Conditions for Figs 2, 3 and 4:

Fig. 2 $V_{CE} = 5$ V; $T_j = 25$ °C.

Fig. 3 $V_{CE} = 5$ V; $f = 500$ MHz; $T_j = 25$ °C;
shield lead grounded.

Fig. 4 $I_C = 0$; $f = 1$ MHz; $T_{amb} = 25$ °C;
shield lead grounded.

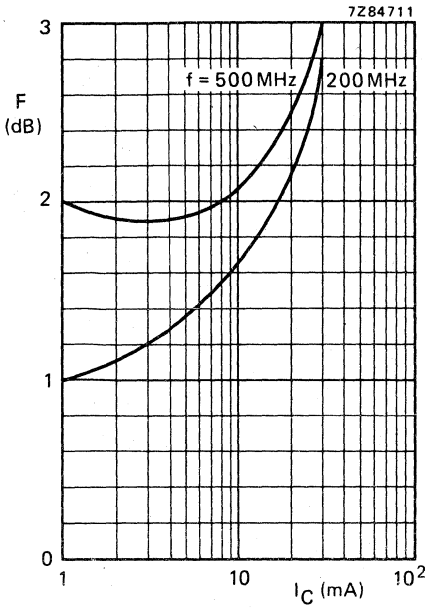


Fig. 5 $V_{CE} = 5 \text{ V}$; $Z_S = \text{optimum}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$; typical values; shield lead grounded.

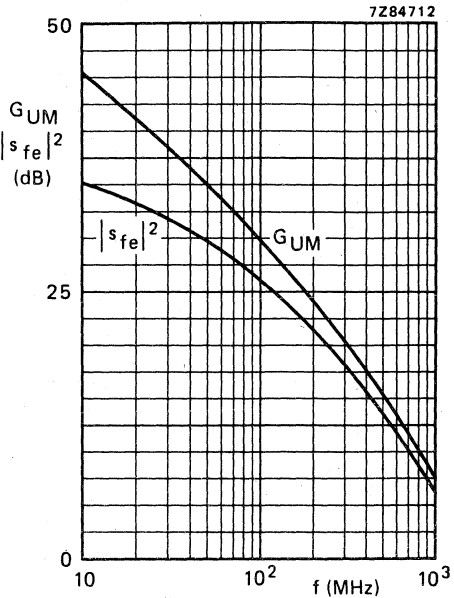


Fig. 6 $V_{CE} = 5 \text{ V}$; $I_C = 30 \text{ mA}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$; typical values; shield lead grounded.

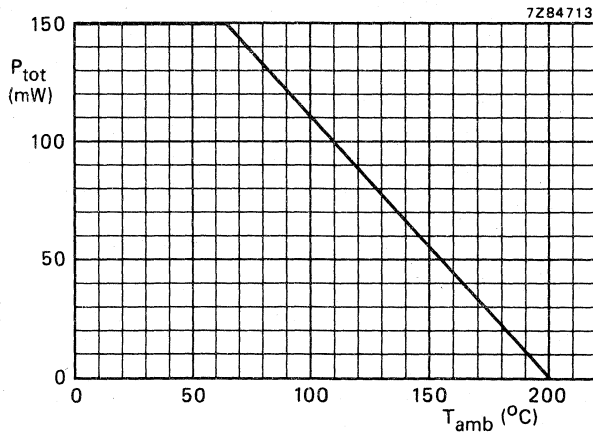


Fig. 7 Power derating curve versus ambient temperature.

SILICON PLANAR EPITAXIAL TRANSISTOR

P-N-P transistor in a subminiature plastic transfer-moulded T-package. It is primarily intended for use in u.h.f. and microwave amplifiers such as in aerial amplifiers, radar systems, oscilloscopes, spectrum analysers etc.

The transistor features low intermodulation distortion and high power gain; thanks to its very high transition frequency, it also has excellent wideband properties and low noise up to high frequencies.

N-P-N complements are BFR91 and BFR91A.

QUICK REFERENCE DATA

| | | | |
|--|------------|------|----------------------|
| Collector-base voltage (open emitter) | $-V_{CBO}$ | max. | 15 V |
| Collector-emitter voltage (open base) | $-V_{CEO}$ | max. | 12 V |
| Collector current (d.c.) | $-I_C$ | max. | 35 mA |
| Total power dissipation up to $T_{amb} = 60\text{ }^\circ\text{C}$ | P_{tot} | max. | 180 mW |
| Junction temperature | T_j | max. | 150 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $-I_C = 30\text{ mA}; -V_{CE} = 5\text{ V}$ | f_T | typ. | 5 GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $-I_C = 2\text{ mA}; -V_{CE} = 5\text{ V}$ | C_{re} | typ. | 0,8 pF |
| Noise figure at optimum source impedance $-I_C = 2\text{ mA}; -V_{CE} = 5\text{ V}; f = 500\text{ MHz}$ | F | typ. | 2,4 dB |

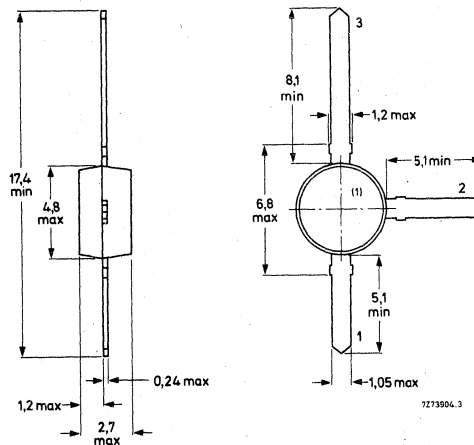
MECHANICAL DATA

Dimensions in mm

Fig. 1 SOT-37.

Connections

1. Base
2. Emitter
3. Collector



(1) = type number marking.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|---|------------|------|-----------------|
| Collector-base voltage (open emitter) | $-V_{CBO}$ | max. | 15 V |
| Collector-emitter voltage (open base) | $-V_{CEO}$ | max. | 12 V |
| Emitter-base voltage (open collector) | $-V_{EBO}$ | max. | 2 V |
| Collector current (d.c.) | $-I_C$ | max. | 35 mA |
| Collector current (peak value) at $f > 1$ MHz | $-I_{CM}$ | max. | 50 mA |
| Total power dissipation up to $T_{amb} = 60$ °C | P_{tot} | max. | 180 mW |
| Storage temperature | T_{stg} | | -65 to + 150 °C |
| Junction temperature | T_j | max. | 150 °C |

THERMAL RESISTANCE

From junction to ambient in free air
mounted on a fibre-glass print
of 40 mm x 25 mm x 1 mm

$$R_{th\ j-a} = 0,5 \text{ °C/mW}$$

CHARACTERISTICS

$T_j = 25$ °C unless otherwise specified

Collector cut-off current

$$I_E = 0; -V_{CB} = 5 \text{ V}$$

$$-I_{CBO} < 50 \text{ nA}$$

D.C. current gain

$$-I_C = 30 \text{ mA}; -V_{CE} = 5 \text{ V}$$

$$h_{FE} > 20 \quad *$$

Transition frequency

$$f = 500 \text{ MHz}; -I_C = 30 \text{ mA}; -V_{CE} = 5 \text{ V}$$

$$f_T \text{ typ. } 5 \text{ GHz} \quad *$$

Collector capacitance

$$f = 1 \text{ MHz}; I_E = I_e = 0; -V_{CB} = 5 \text{ V}$$

$$C_c \text{ typ. } 0,85 \text{ pF}$$

Emitter capacitance

$$f = 1 \text{ MHz}; I_C = I_c = 0; -V_{EB} = 0,5 \text{ V}$$

$$C_e \text{ typ. } 1,8 \text{ pF}$$

Feedback capacitance

$$f = 1 \text{ MHz}; -I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}$$

$$C_{re} \text{ typ. } 0,8 \text{ pF}$$

Noise figure at optimum source impedance

$$-I_C = 2 \text{ mA}; -V_{CE} = 5 \text{ V}; f = 500 \text{ MHz}$$

$$F \text{ typ. } 2,4 \text{ dB}$$

Maximum unilateral power gain

s_{re} assumed to be zero

$$-I_C = 30 \text{ mA}; -V_{CE} = 5 \text{ V}; f = 500 \text{ MHz}$$

$$10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)} = G_{UM} \text{ typ. } 16,5 \text{ dB}$$

* Measured under pulse conditions.

Intermodulation distortion* (see Fig. 2)

$-I_C = 30 \text{ mA}$; $-V_{CE} = 5 \text{ V}$; $R_L = 75 \Omega$; $V_{SWR} < 2$

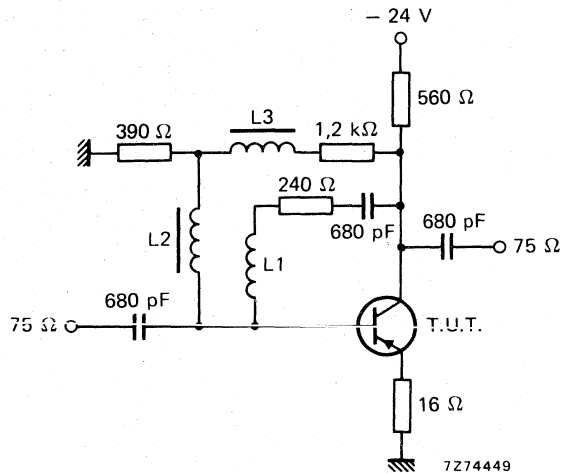
$V_p = V_o = 300 \text{ mV}$ at $f_p = 495,25 \text{ MHz}$

$V_q = V_o - 6 \text{ dB}$ at $f_q = 503,25 \text{ MHz}$

$V_r = V_o - 6 \text{ dB}$ at $f_r = 505,25 \text{ MHz}$

Measured at $f(p + q - r) = 493,25 \text{ MHz}$

d_{im} typ. -60 dB



L1: 4 turns Cu wire (0,35); winding pitch 1 mm; internal diameter 4 mm.

L2 and L3: $5 \mu\text{H}$ (code number 3122 108 20150)

Fig. 2 Intermodulation distortion test circuit.

* Measured under pulse conditions.

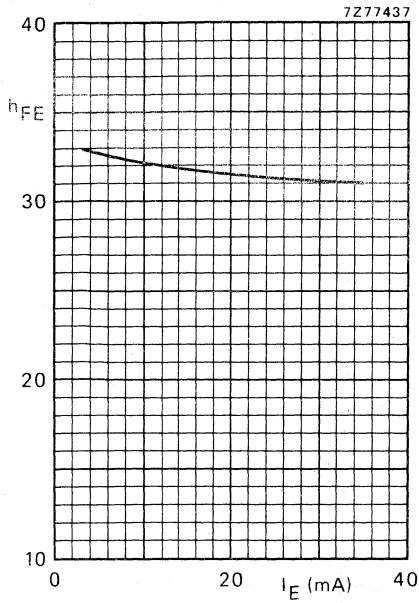


Fig. 3 Typical values; $V_{CB} = 4$ V.

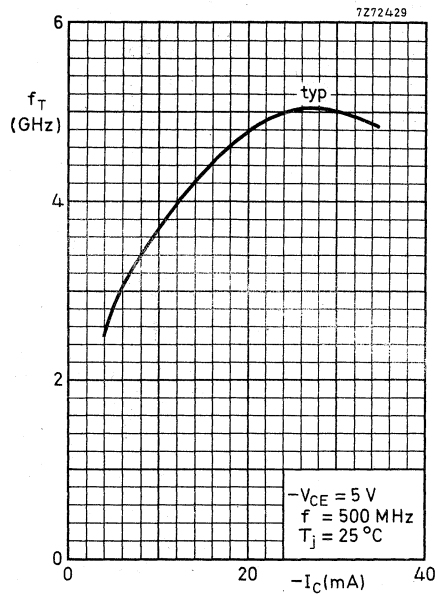


Fig. 4.

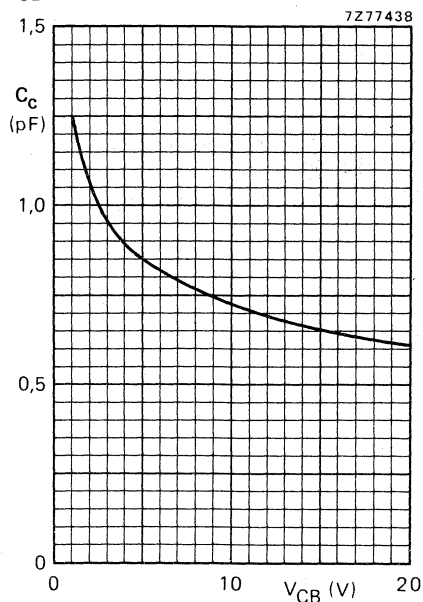


Fig. 5 Typical values; $f = 1$ MHz.

SILICON PLANAR EPITAXIAL TRANSISTOR

P-N-P transistor in a TO-72 metal envelope with insulated electrodes and a shield lead connected to the case. It is primarily intended for use in u.h.f. and microwave amplifiers such as in aerial amplifiers, radar systems, oscilloscopes, spectrum analysers etc.

The transistor features extremely high power gain coupled with good low noise performance.

N-P-N complement is BFQ22S.

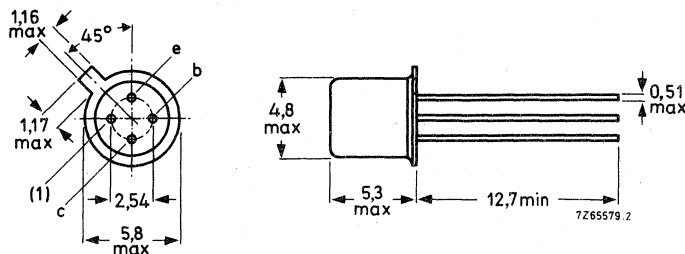
QUICK REFERENCE DATA

| | | |
|---|-----------------|----------------------|
| Collector-base voltage (open emitter) | $-V_{CBO}$ max. | 15 V |
| Collector-emitter voltage (open base) | $-V_{CEO}$ max. | 12 V |
| Collector current (d.c.) | $-I_C$ max. | 35 mA |
| Total power dissipation up to $T_{amb} = 65\text{ }^\circ\text{C}$ | P_{tot} max. | 150 mW |
| Junction temperature | T_j max. | 200 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $-I_C = 30\text{ mA}; -V_{CE} = 5\text{ V}$ | f_T typ. | 5 GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $I_C = 0; -V_{CE} = 5\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$ | C_{re} typ. | 0,8 pF |
| Noise figure at optimum source impedance $-I_C = 2\text{ mA}; -V_{CE} = 5\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | F typ. | 2,4 dB |
| Maximum unilateral power gain (see page 2) $-I_C = 30\text{ mA}; -V_{CE} = 5\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | G_{UM} typ. | 15,0 dB |

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-72 with insulated electrodes.



(1) shield lead connected to case.

Accessories: 56246 (distance disc).

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|---|------------|------|----------------|
| Collector-base voltage (open emitter) | $-V_{CBO}$ | max. | 15 V |
| Collector-emitter voltage (open base) | $-V_{CEO}$ | max. | 12 V |
| Emitter-base voltage (open collector) | $-V_{EBO}$ | max. | 2 V |
| Collector current (d.c.) | $-I_C$ | max. | 35 mA |
| Collector current (peak value) at $f > 1$ MHz | $-I_{CM}$ | max. | 50 mA |
| → Total power dissipation up to $T_{amb} = 65$ °C | P_{tot} | max. | 150 mW |
| Storage temperature | T_{stg} | | -65 to +200 °C |
| Junction temperature | T_j | max. | 200 °C |

THERMAL RESISTANCE

| | | | |
|--------------------------------------|--------------|---|----------|
| From junction to ambient in free air | $R_{th j-a}$ | = | 0,9 K/mW |
| From junction to case | $R_{th j-c}$ | = | 0,6 K/mW |

→ **CHARACTERISTICS**

$T_j = 25$ °C unless otherwise specified

Collector cut-off current

| | | | |
|--------------------------|------------|---|-------|
| $I_E = 0; -V_{CB} = 5$ V | $-I_{CBO}$ | < | 50 nA |
|--------------------------|------------|---|-------|

D.C. current gain (note 1)

| | | | |
|---------------------------------|----------|------|----|
| $-I_C = 30$ mA; $-V_{CE} = 5$ V | h_{FE} | > | 20 |
| | | typ. | 50 |

Transition frequency (notes 1 and 2)

| | | | |
|--|-------|------|-------|
| $-I_C = 30$ mA; $-V_{CE} = 5$ V; $f = 500$ MHz | f_T | typ. | 5 GHz |
|--|-------|------|-------|

Collector capacitance (note 3)

| | | | |
|---|-------|------|--------|
| $I_E = I_e = 0; -V_{CB} = 5$ V; $f = 1$ MHz | C_c | typ. | 1,2 pF |
|---|-------|------|--------|

Emitter capacitance

| | | | |
|---|-------|------|--------|
| $I_C = I_c = 0; -V_{EB} = 0,5$ V; $f = 1$ MHz | C_e | typ. | 2,5 pF |
|---|-------|------|--------|

Feedback capacitance (note 2)

| | | | |
|--|----------|------|--------|
| $I_C = 0; -V_{CE} = 5$ V; $f = 1$ MHz; $T_{amb} = 25$ °C | C_{re} | typ. | 0,8 pF |
|--|----------|------|--------|

Noise figure at optimum source impedance (note 2)

| | | | |
|--|-----|------|--------|
| $-I_C = 2$ mA; $-V_{CE} = 5$ V; $f = 500$ MHz; $T_{amb} = 25$ °C | F | typ. | 2,4 dB |
|--|-----|------|--------|

Maximum unilateral power gain (note 2)

s_{re} assumed to be zero

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

| | | | |
|---|----------|------|---------|
| $-I_C = 30$ mA; $-V_{CE} = 5$ V; $f = 500$ MHz; $T_{amb} = 25$ °C | G_{UM} | typ. | 15,0 dB |
|---|----------|------|---------|

Notes

1. Measured under pulse conditions.
2. Shield lead grounded.
3. Shield lead not connected.

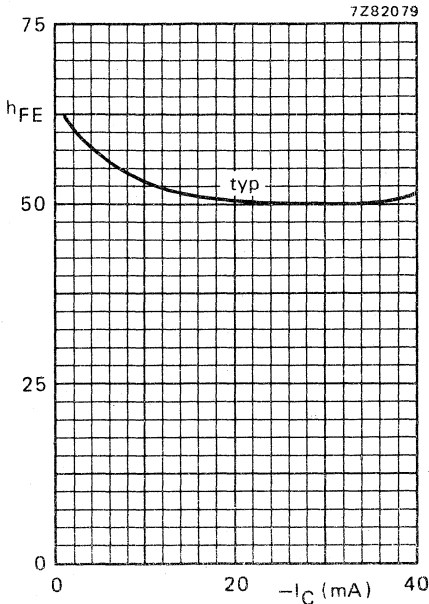


Fig. 2 $-V_{CE} = 5\text{ V}$; $T_j = 25\text{ }^\circ\text{C}$.

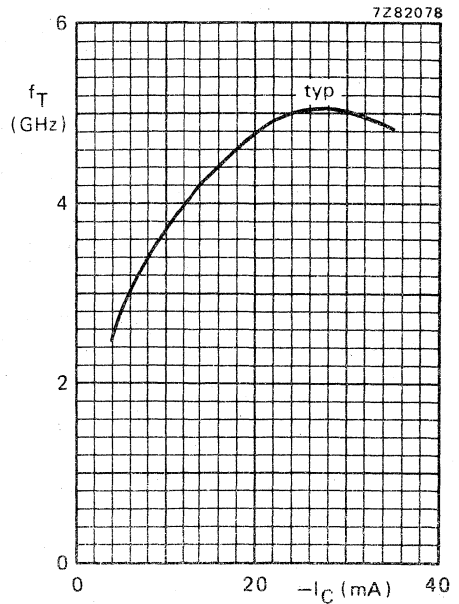


Fig. 3 $-V_{CE} = 5\text{ V}$; $f = 500\text{ MHz}$; $T_j = 25\text{ }^\circ\text{C}$; shield lead grounded.

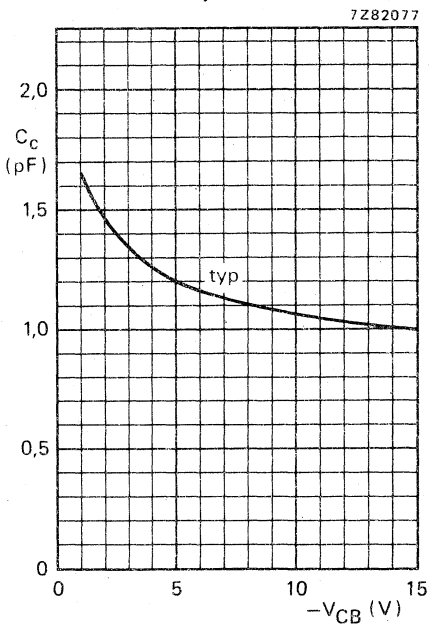


Fig. 4 $I_E = I_e = 0$; $f = 1\text{ MHz}$; $T_j = 25\text{ }^\circ\text{C}$; shield lead not connected.

SILICON PLANAR EPITAXIAL TRANSISTOR

P-N-P transistor in a subminiature plastic transfer-moulded T-package.

It is intended for use in u.h.f. applications such as broadband aerial amplifiers (30 MHz to 860 MHz) and in microwave amplifiers such as radar systems, spectrum analysers etc.

The BFQ32 offers a high transition frequency and a low intermodulation distortion figure over a wide current range.

QUICK REFERENCE DATA

| | | | |
|--|------------|-----|----------------------|
| Collector-base voltage (open emitter) | $-V_{CBO}$ | max | 20 V |
| Collector-emitter voltage (open base) | $-V_{CEO}$ | max | 15 V |
| Collector current (d.c.) | $-I_C$ | max | 75 mA |
| Total power dissipation up to $T_{amb} = 60\text{ }^\circ\text{C}$ | P_{tot} | max | 500 mW |
| Junction temperature | T_j | max | 175 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $-I_C = 50\text{ mA}$; $-V_{CE} = 10\text{ V}$ | f_T | > | 3,6 GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $-I_C = 10\text{ mA}$; $-V_{CE} = 10\text{ V}$ | C_{re} | < | 1,4 pF |
| Noise figure at optimum source impedance $-I_C = 50\text{ mA}$; $-V_{CE} = 10\text{ V}$; $f = 500\text{ MHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | F | typ | 3,75 dB |
| Intermodulation distortion at $T_{amb} = 25\text{ }^\circ\text{C}$ $-I_C = 50\text{ mA}$; $-V_{CE} = 10\text{ V}$; $R_L = 75\text{ }\Omega$; $V_O = 500\text{ mV}$ $f_{(p+q-r)} = 493,25\text{ MHz}$ (see page 4) | d_{im} | typ | -60 dB |

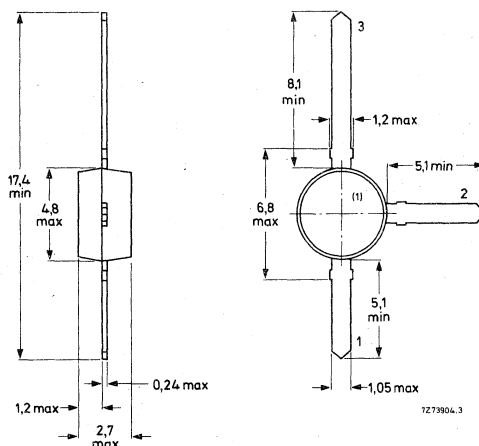
MECHANICAL DATA

Dimensions in mm

Fig. 1 SOT-37.

Connections

1. Base
2. Emitter
3. Collector



(1) = type number marking.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|--|------------|----------|--------|
| Collector-base voltage (open emitter) | $-V_{CBO}$ | max | 20 V |
| Collector-emitter voltage (open base) | $-V_{CEO}$ | max | 15 V |
| Emitter-base voltage (open collector) | $-V_{EBO}$ | max | 3 V |
| Collector current (d.c.) | $-I_C$ | max | 75 mA |
| Collector current (peak value); $f > 1$ MHz | $-I_{CM}$ | max | 150 mA |
| Total power dissipation up to $T_{amb} = 60$ °C mounted on a fibre-glass print of 40 mm x 25 mm x 1 mm | P_{tot} | | 500 mW |
| Storage temperature | T_{stg} | -65 to + | 175 °C |
| Junction temperature | T_j | max | 175 °C |

THERMAL RESISTANCE

From junction to ambient in free air
mounted on a fibre-glass print
of 40 mm x 25 mm x 1 mm

| | | |
|---------------|---|------------|
| $R_{th\ j-a}$ | = | 0,23 °C/mW |
|---------------|---|------------|

CHARACTERISTICS

$T_{amb} = 25$ °C unless otherwise specified

Collector cut-off current

$I_E = 0; -V_{CB} = 10$ V

| | | |
|------------|---|--------|
| $-I_{CBO}$ | < | 100 nA |
|------------|---|--------|

D.C. current gain *

$-I_C = 50$ mA; $-V_{CE} = 10$ V

| | | |
|----------|---|----|
| h_{FE} | > | 20 |
|----------|---|----|

$-I_C = 75$ mA; $-V_{CE} = 10$ V

| | | |
|----------|---|----|
| h_{FE} | > | 20 |
|----------|---|----|

Transition frequency at $f = 500$ MHz *

$-I_C = 50$ mA; $-V_{CE} = 10$ V

| | | |
|-------|-----|---------|
| f_T | > | 3,6 GHz |
| | typ | 4,2 GHz |

$-I_C = 75$ mA; $-V_{CE} = 10$ V

| | | |
|-------|-----|---------|
| f_T | > | 4,0 GHz |
| | typ | 4,6 GHz |

Collector capacitance at $f = 1$ MHz

$I_E = I_e = 0; -V_{CB} = 10$ V

| | | |
|-------|-----|--------|
| C_C | typ | 1,3 pF |
|-------|-----|--------|

Emitter capacitance at $f = 1$ MHz

$I_C = I_c = 0; -V_{EB} = 0,5$ V

| | | |
|-------|-----|------|
| C_e | typ | 6 pF |
|-------|-----|------|

Feedback capacitance at $f = 1$ MHz

$-I_C = 10$ mA; $-V_{CE} = 10$ V

| | | |
|----------|-----|---------|
| C_{re} | < | 1,4 pF |
| | typ | 1,25 pF |

* Measured under pulse conditions.

Noise figure at optimum source impedance
 $-I_C = 50 \text{ mA}; -V_{CE} = 10 \text{ V}; f = 500 \text{ MHz}$

F typ 3,75 dB

Maximum unilateral power gain (s_{re} assumed to be zero)

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$-I_C = 50 \text{ mA}; -V_{CE} = 10 \text{ V}; f = 500 \text{ MHz}$

G_{UM} typ 14 dB

Intermodulation distortion (see fig. 1)

$-I_C = 50 \text{ mA}; -V_{CE} = 10 \text{ V}; R_L = 75 \Omega$

$V_p = V_o = 500 \text{ mV}$ at $f_p = 495,25 \text{ MHz}$

$V_q = V_o - 6 \text{ dB}$ at $f_q = 503,25 \text{ MHz}$

$V_r = V_o - 6 \text{ dB}$ at $f_r = 505,25 \text{ MHz}$

Measured at $f_{(p+q-r)} = 493,25 \text{ MHz}$

d_{im} typ -60 dB

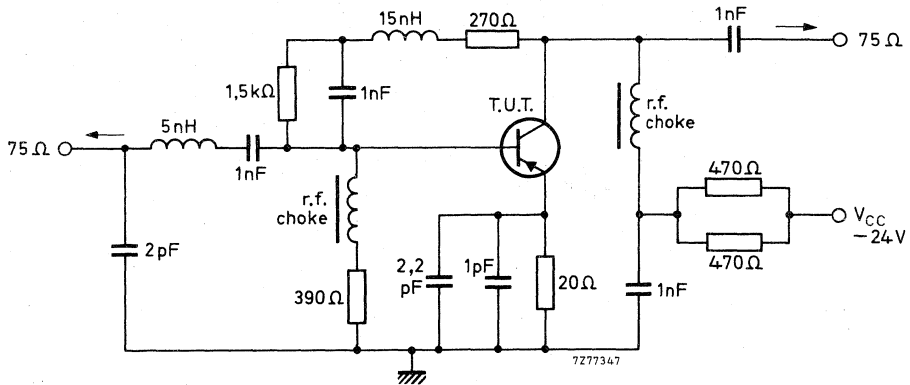
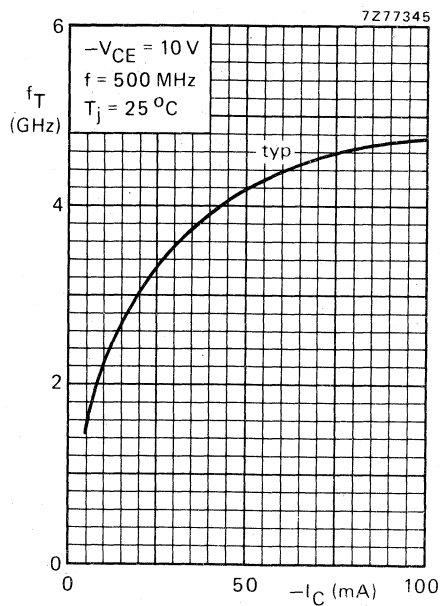
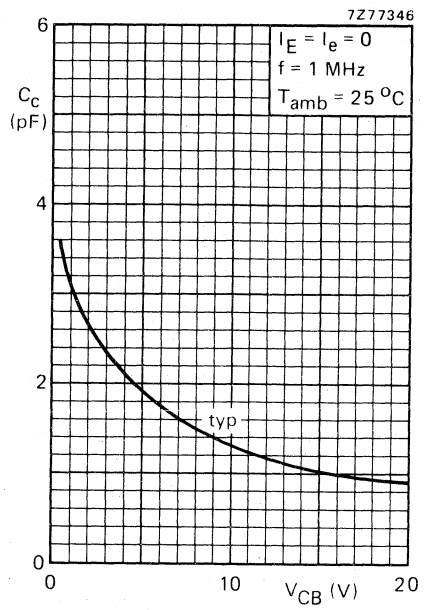
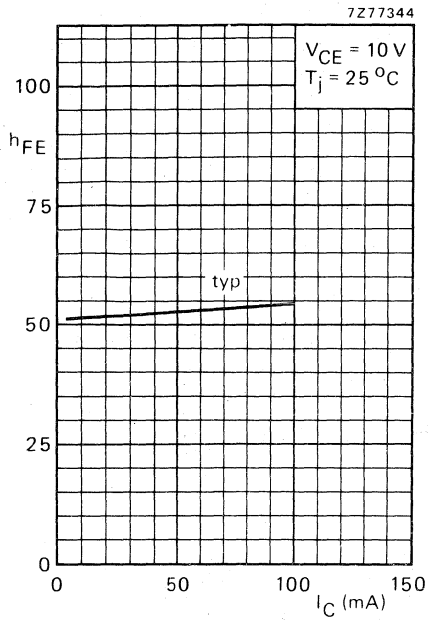


Fig. 1 Intermodulation test circuit.



DEVELOPMENT SAMPLE DATA

This information is derived from development samples made available for evaluation. It does not necessarily imply that the device will go into regular production.

499BFY
(BFQ33)

N-P-N MICROWAVE TRANSISTOR

The BFQ33 is a small-signal silicon planar epitaxial transistor in a miniature hermetically sealed microstripline encapsulation, featuring an extremely high transition frequency and very low noise up to high frequencies.

It is primarily intended for use in microwave amplifier applications.

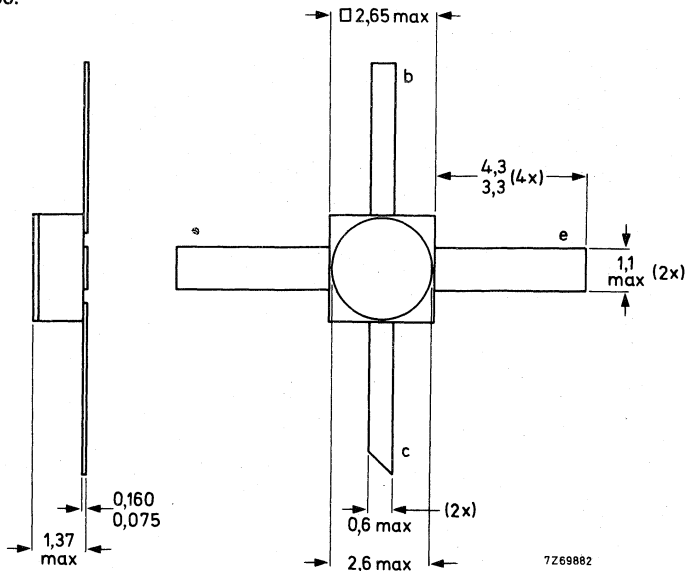
QUICK REFERENCE DATA

| | | | | |
|---|-----------------|------|---------|---|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 9 V | |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 7 V | ← |
| Collector current (d.c.) | I_C | max. | 20 mA | |
| Total power dissipation up to $T_{amb} = 80^\circ\text{C}$ | P_{tot} | max. | 140 mW | ← |
| Transition frequency at $f = 1,5\text{ GHz}$ $I_C = 14\text{ mA}; V_{CE} = 5\text{ V}$ | f_T | typ. | 12 GHz | ← |
| Noise figure at optimum source impedance $I_C = 5\text{ mA}; V_{CE} = 5\text{ V}; f = 2\text{ GHz}$ | F | typ. | 2,5 dB | ← |
| Maximum unilateral power gain (see page 3) $I_C = 14\text{ mA}; V_{CE} = 5\text{ V}; f = 2\text{ GHz}; T_{amb} = 25^\circ\text{C}$ | G _{UM} | typ. | 13,7 dB | ← |

MECHANICAL DATA

Dimensions in mm

Fig. 1 SOT-100.



RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|--|-----------|------|------------------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 9 V |
| → Collector-emitter voltage (open base) | V_{CEO} | max. | 7 V |
| → Emitter-base voltage (open collector) | V_{EBO} | max. | 2 V |
| Collector current (d.c.) | I_C | max. | 20 mA |
| → Total power dissipation up to $T_{amb} = 80\text{ }^\circ\text{C}$ | P_{tot} | max. | 140 mW |
| Storage temperature | T_{stg} | | -65 to +150 $^\circ\text{C}$ |
| Junction temperature | T_j | max. | 150 $^\circ\text{C}$ |

THERMAL RESISTANCE

From junction to ambient in free air
mounted on a fibre-glass print
of 40 mm x 25 mm x 1 mm

$$R_{th\ j-a} = 500\text{ K/W}^*$$

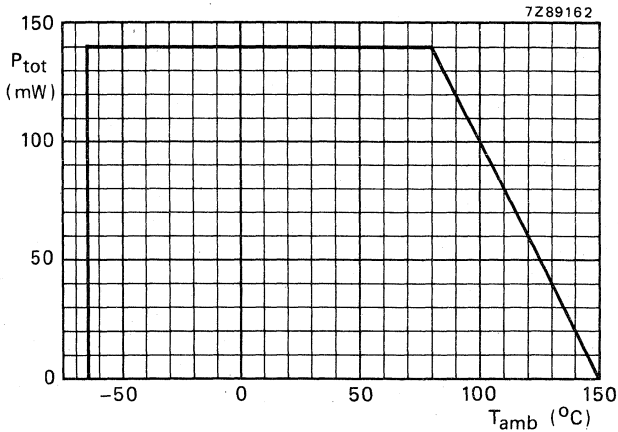


Fig. 2 Power derating curve versus ambient temperature.

* K/W is SI unit for $^\circ\text{C/W}$.

CHARACTERISTICS

$T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 5\text{ V}$

$I_{CBO} < 50\text{ nA}$

D.C. current gain*

$I_C = 14\text{ mA}; V_{CE} = 5\text{ V}$

$h_{FE} > 25$

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 5\text{ V}$

C_c typ. 0,45 pF ←

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 0; V_{CE} = 5\text{ V}$

C_{re} typ. 0,2 pF ←

Transition frequency at $f = 1,5\text{ GHz}^*$

$I_C = 14\text{ mA}; V_{CE} = 5\text{ V}$

f_T typ. 12 GHz ←

Noise figure at optimum source impedance

$I_C = 5\text{ mA}; V_{CE} = 5\text{ V}; f = 2\text{ GHz}$

F typ. 2,5 dB

$I_C = 5\text{ mA}; V_{CE} = 5\text{ V}; f = 4\text{ GHz}$

F typ. 3,8 dB

Maximum unilateral power gain (s_{re} assumed to be zero)

$$GUM \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$I_C = 14\text{ mA}; V_{CE} = 5\text{ V}; f = 2\text{ GHz}$

GUM typ. 13,7 dB ←

$I_C = 14\text{ mA}; V_{CE} = 5\text{ V}; f = 4\text{ GHz}$

GUM typ. 7,4 dB ←

s-parameters (common emitter)

$I_C = 14\text{ mA}; V_{CE} = 5\text{ V}; R_S = R_L = 50\text{ }\Omega; f = 2\text{ GHz}$

Input reflection coefficient

s_{ie} typ. 0,18/ -155°

Reverse transmission coefficient

s_{re} typ. 0,10/ +49°

Forward transmission coefficient

s_{fe} typ. 4,3 / +75°

Output reflection coefficient

s_{oe} typ. 0,43/ -56°

$I_C = 14\text{ mA}; V_{CE} = 5\text{ V}; R_S = R_L = 50\text{ }\Omega; f = 4\text{ GHz}$

Input reflection coefficient

s_{ie} typ. 0,19/+ 171°

Reverse transmission coefficient

s_{re} typ. 0,14/ +34°

Forward transmission coefficient

s_{fe} typ. 2,0 / +48°

Output reflection coefficient

s_{oe} typ. 0,50/ -89°

DEVELOPMENT SAMPLE DATA

* Measured under pulse conditions.

499BFY (BFQ33)

Conditions for Figs 3 and 4:
 $V_{CE} = 5 \text{ V}$; $I_C = 14 \text{ mA}$;
 $T_{amb} = 25 \text{ }^\circ\text{C}$.

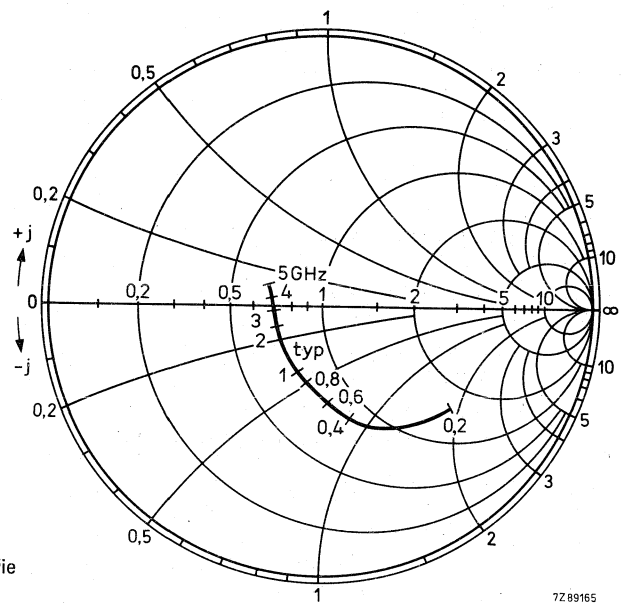


Fig. 3 Input impedance derived from input reflection coefficient s_{ie} co-ordinates in ohm $\times 50$.

72 89165

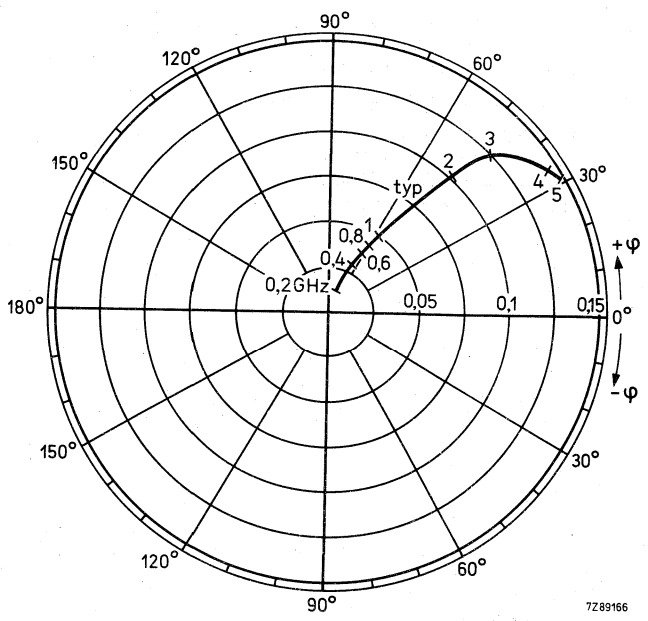


Fig. 4 Reverse transmission coefficient s_{re} .

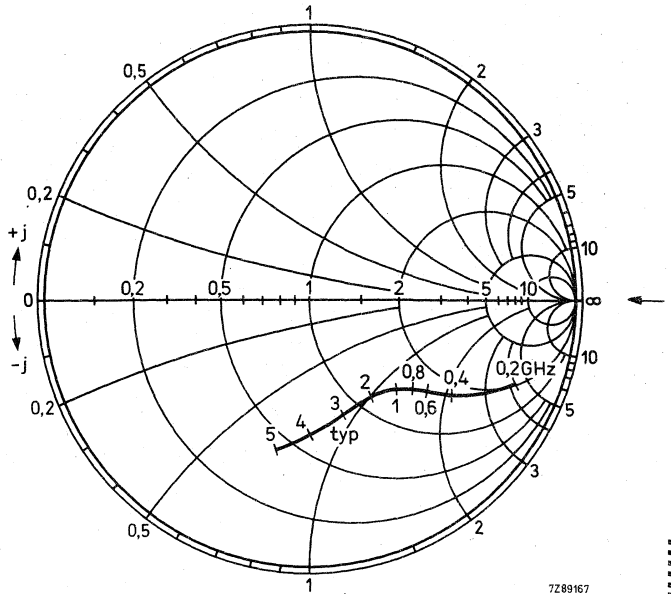
72 89166

Conditions for Figs 5 and 6:

$V_{CE} = 5 \text{ V}$; $I_C = 14 \text{ mA}$;

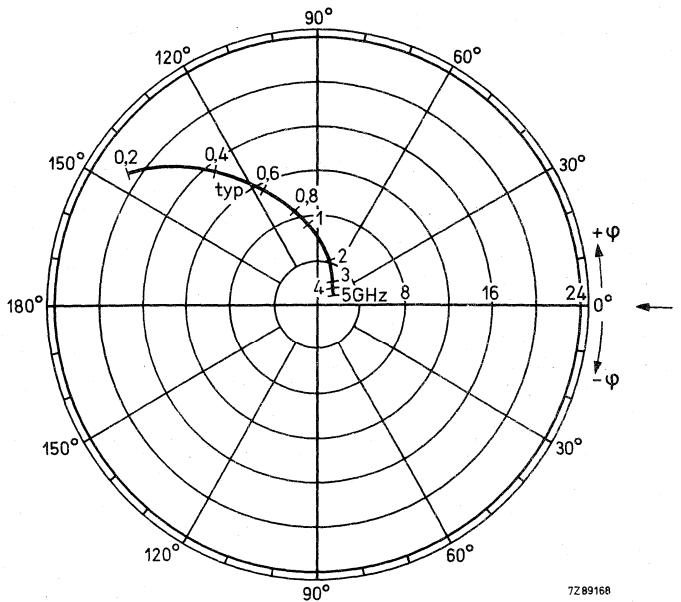
$T_{amb} = 25 \text{ }^\circ\text{C}$.

DEVELOPMENT SAMPLE DATA



7289167

Fig. 5 Output impedance derived from output reflection coefficient s_{oe} co-ordinates in ohm x 50.



7289168

Fig. 6 Forward transmission coefficient s_{fe} .

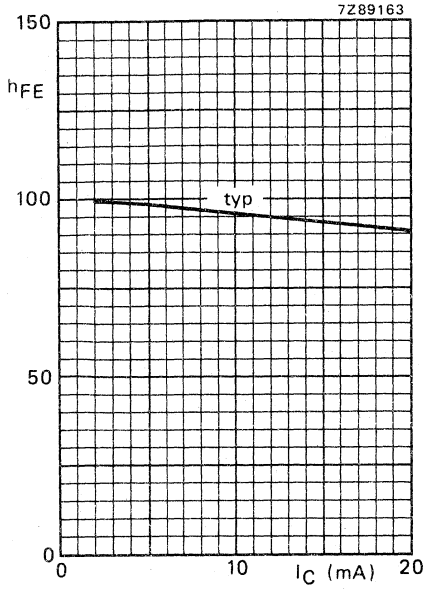


Fig. 7 $V_{CE} = 5\text{ V}$; $T_j = 25\text{ }^\circ\text{C}$.

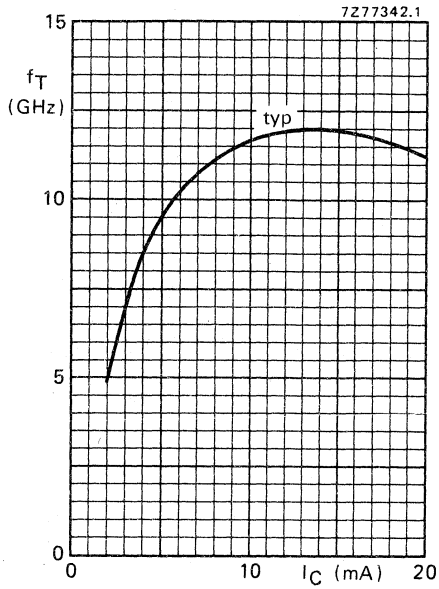


Fig. 8 $V_{CE} = 5\text{ V}$; $f = 1,5\text{ GHz}$; $T_j = 25\text{ }^\circ\text{C}$.

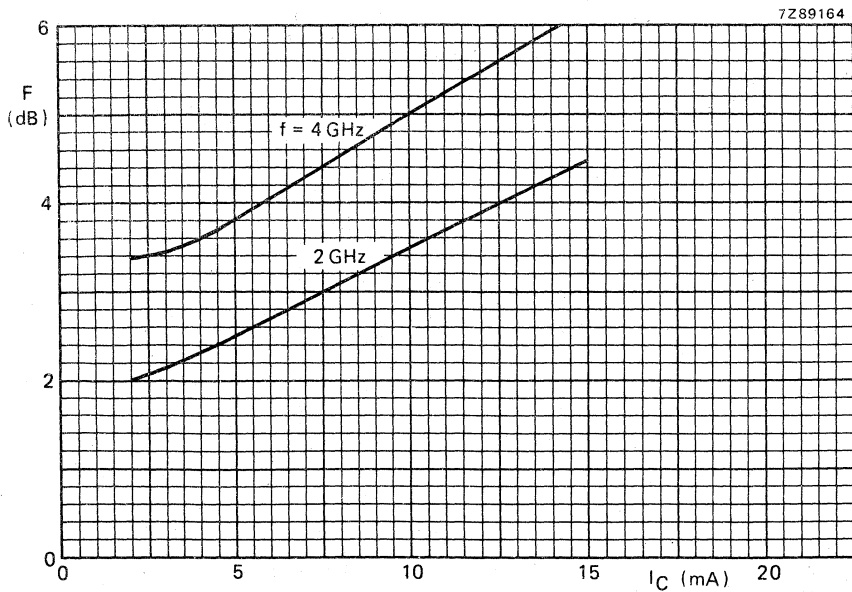


Fig. 9 $V_{CE} = 5\text{ V}$; $Z_S = \text{optimum}$; $T_{\text{amb}} = 25\text{ }^\circ\text{C}$; typical values.

SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor primarily intended for driver and final stages in MATV system amplifiers. This device is also suitable for use in low power band IV and V equipment. Diffused emitter ballasting resistors and the application of gold sandwich metallization ensure an optimum temperature profile and excellent reliability properties.

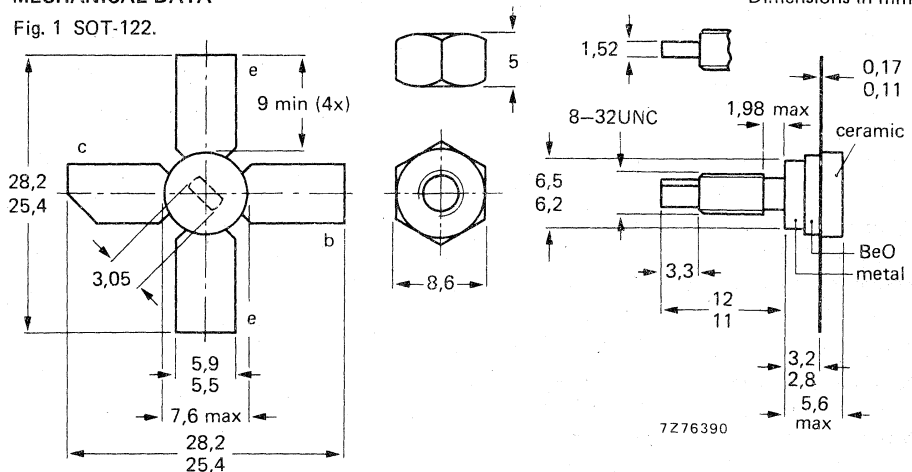
The transistor has a 1/4" capstan envelope with ceramic cap. All leads are isolated from the stud.

QUICK REFERENCE DATA

| | | | |
|--|-----------|------|----------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 25 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 18 V |
| Collector current (d.c.) | I_C | max. | 150 mA |
| Total power dissipation (d.c.) up to $T_{mb} = 125\text{ }^\circ\text{C}$ | P_{tot} | max. | 2,25 W |
| Operating junction temperature | T_j | max. | 200 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 150\text{ mA}$; $V_{CE} = 15\text{ V}$; $T_j = 25\text{ }^\circ\text{C}$ | f_T | > | 3,5 GHz |
| Output voltage at $d_{im} = -60\text{ dB}$ (see Figs 2 and 4) $I_C = 120\text{ mA}$; $V_{CE} = 15\text{ V}$; $R_L = 75\text{ }\Omega$; $T_{amb} = 25\text{ }^\circ\text{C}$ $f_{(p+q-r)} = 793,25\text{ MHz}$ | V_o | typ. | 1,2 V |

MECHANICAL DATA

Fig. 1 SOT-122.



Torque on nut: min. 0,75 Nm
(7,5 kg cm)
max. 0,85 Nm
(8,5 kg cm)

Diameter of clearance hole in heatsink: max. 4,2 mm.
Mounting hole to have no burrs at either end.
De-burring must leave surface flat; do not chamfer or countersink either end of hole.

When locking is required an adhesive is preferred instead of a lock washer.

CAUTION This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|--|-----------|------|------------------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 25 V |
| Collector-emitter voltage (open base) (see Fig. 3) | V_{CEO} | max. | 18 V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2 V |
| Collector current (d.c.) | I_C | max. | 150 mA |
| Total power dissipation (d.c.) up to $T_{mb} = 125\text{ }^\circ\text{C}$ (see Fig. 3) | P_{tot} | max. | 2,25 W |
| Storage temperature | T_{stg} | | -65 to +150 $^\circ\text{C}$ |
| Operating junction temperature | T_j | max. | 200 $^\circ\text{C}$ |

THERMAL RESISTANCE

| | | | |
|--------------------------------|----------------|---|-----------|
| From junction to mounting base | $R_{th\ j-mb}$ | = | 15,0 K/W* |
| From mounting base to heatsink | $R_{th\ mb-h}$ | = | 0,6 K/W* |

CHARACTERISTICS

$T_{amb} = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 15\text{ V}$

| | | |
|-----------|---|-------------------|
| I_{CBO} | < | 100 μA |
|-----------|---|-------------------|

D.C. current gain**

$I_C = 75\text{ mA}; V_{CE} = 15\text{ V}$

| | | |
|----------|---|----|
| h_{FE} | > | 25 |
|----------|---|----|

$I_C = 150\text{ mA}; V_{CE} = 15\text{ V}$

| | | |
|----------|---|----|
| h_{FE} | > | 25 |
|----------|---|----|

Transition frequency at $f = 500\text{ MHz}$ **

$I_C = 75\text{ mA}; V_{CE} = 15\text{ V}$

| | | |
|-------|------|---------|
| f_T | > | 3,0 GHz |
| | typ. | 3,5 GHz |

$I_C = 150\text{ mA}; V_{CE} = 15\text{ V}$

| | | |
|-------|------|---------|
| f_T | > | 3,5 GHz |
| | typ. | 4,0 GHz |

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 15\text{ V}$

| | | |
|-------|------|---------|
| C_c | typ. | 2,0 pF |
| | < | 2,75 pF |

Emitter capacitance at $f = 1\text{ MHz}$

$I_C = I_e = 0; V_{EB} = 0,5\text{ V}$

| | | |
|-------|------|-------|
| C_e | typ. | 11 pF |
|-------|------|-------|

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 10\text{ mA}; V_{CE} = 15\text{ V}$

| | | |
|----------|------|---------|
| C_{re} | typ. | 1,0 pF |
| | < | 1,35 pF |

Collector-stud capacitance

| | | |
|----------|------|------|
| C_{cs} | typ. | 2 pF |
|----------|------|------|

Noise figure measured in MATV test circuit (see Fig. 2)

$I_C = 120\text{ mA}; V_{CE} = 15\text{ V}; f = 500\text{ MHz}$

| | | |
|---|------|------|
| F | typ. | 8 dB |
|---|------|------|

Maximum unilateral power gain (s_{re} assumed to be zero)

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

→ $I_C = 120\text{ mA}; V_{CE} = 15\text{ V}; f = 500\text{ MHz}$

| | | |
|----------|------|---------|
| G_{UM} | typ. | 16,3 dB |
|----------|------|---------|

* K/W is SI unit for $^\circ\text{C}/\text{W}$.

** Measured under pulse conditions.

Output voltage at $d_{im} = -60$ dB (see Figs 2 and 4)
 (DIN 45004B, par. 6.3: 3-tone)

$I_C = 120$ mA; $V_{CE} = 15$ V; $R_L = 75 \Omega$

$V_p = V_o$ at $d_{im} = -60$ dB; $f_p = 795,25$ MHz

$V_q = V_o - 6$ dB ; $f_q = 803,25$ MHz

$V_r = V_o - 6$ dB ; $f_r = 805,25$ MHz

measured at $f_{(p+q-r)} = 793,25$ MHz

V_o typ. 1,2 V

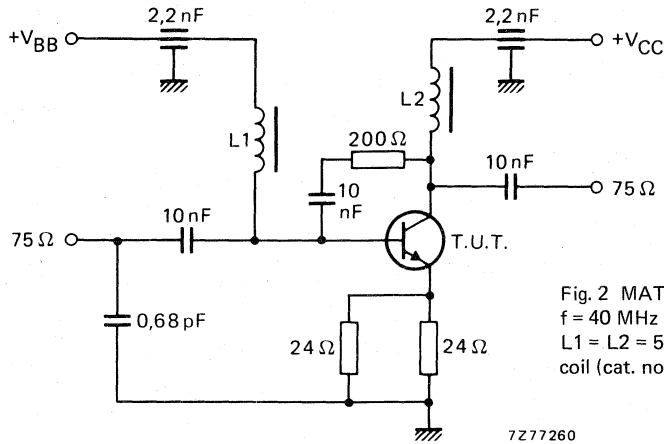


Fig. 2 MATV test circuit
 $f = 40$ MHz to 860 MHz.
 $L1 = L2 = 5 \mu$ H Ferroxcube
 coil (cat. no. 3122 108 20153).

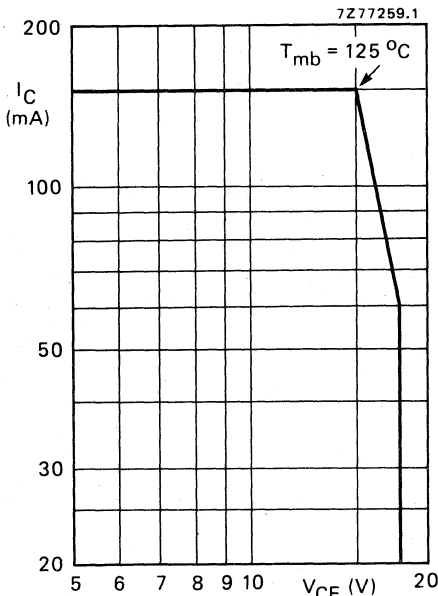


Fig. 3 D.C. SOAR.

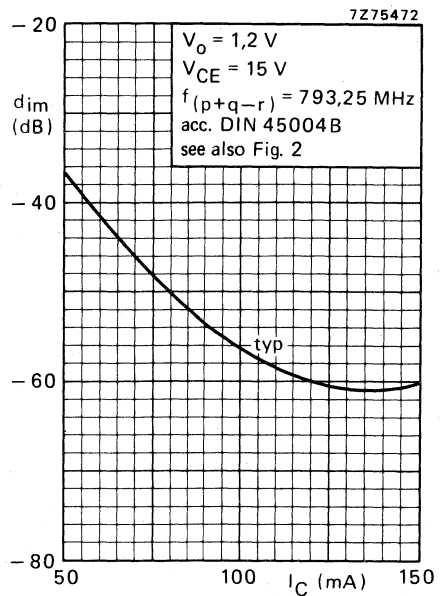


Fig. 4.

→ s-parameters (common emitter) at $V_{CE} = 7,5 \text{ V}$.

| I_C mA | f MHz | s_{ie} | s_{re} | s_{fe} | s_{oe} |
|-------------|----------|-------------|----------|-----------|------------|
| 50 | 40 | 0,47/ -72° | 0,02/64° | 30,5/147° | 0,85/ -34° |
| | 200 | 0,55/-154° | 0,06/52° | 11,3/101° | 0,36/ -84° |
| | 500 | 0,54/+ 177° | 0,08/58° | 4,9/ 78° | 0,25/-104° |
| | 800 | 0,52/+ 160° | 0,12/58° | 3,2/ 63° | 0,25/-113° |
| | 1000 | 0,50/+ 150° | 0,15/57° | 2,6/ 54° | 0,26/-118° |
| | 1200 | 0,48/+ 142° | 0,18/54° | 2,2/ 46° | 0,28/-122° |
| 75 | 40 | 0,45/ -76° | 0,02/64° | 32,1/144° | 0,83/ -36° |
| | 200 | 0,54/-156° | 0,05/53° | 11,6/100° | 0,35/ -90° |
| | 500 | 0,54/+ 176° | 0,08/59° | 5,0/ 78° | 0,24/-112° |
| | 800 | 0,51/+ 160° | 0,13/59° | 3,3/ 63° | 0,24/-121° |
| | 1000 | 0,49/+ 150° | 0,16/57° | 2,7/ 55° | 0,24/-124° |
| | 1200 | 0,46/+ 142° | 0,18/54° | 2,3/ 47° | 0,26/-128° |
| 100 | 40 | 0,44/ -79° | 0,02/63° | 33,0/145° | 0,82/ -37° |
| | 200 | 0,54/-157° | 0,06/54° | 11,8/100° | 0,35/ -93° |
| | 500 | 0,53/+ 175° | 0,09/60° | 5,1/ 78° | 0,23/-117° |
| | 800 | 0,51/+ 159° | 0,13/59° | 3,3/ 64° | 0,23/-126° |
| | 1000 | 0,49/+ 150° | 0,16/57° | 2,7/ 55° | 0,24/-129° |
| | 1200 | 0,46/+ 142° | 0,19/54° | 2,3/ 47° | 0,26/-131° |
| 120 | 40 | 0,43/ -81° | 0,02/63° | 33,5/145° | 0,82/ -38° |
| | 200 | 0,54/-157° | 0,05/55° | 11,9/ 99° | 0,35/ -95° |
| | 500 | 0,53/+ 175° | 0,09/60° | 5,1/ 77° | 0,23/-119° |
| | 800 | 0,51/+ 159° | 0,13/59° | 3,3/ 63° | 0,23/-128° |
| | 1000 | 0,48/+ 149° | 0,16/56° | 2,7/ 55° | 0,24/-131° |
| | 1200 | 0,46/+ 141° | 0,19/53° | 2,3/ 47° | 0,25/-132° |
| 150 | 40 | 0,43/ -82° | 0,02/63° | 33,6/145° | 0,81/ -39° |
| | 200 | 0,54/-158° | 0,05/55° | 11,8/ 99° | 0,34/ -96° |
| | 500 | 0,53/+ 175° | 0,09/60° | 5,1/ 77° | 0,23/-121° |
| | 800 | 0,51/+ 159° | 0,13/59° | 3,3/ 63° | 0,23/-129° |
| | 1000 | 0,49/+ 149° | 0,16/56° | 2,7/ 55° | 0,24/-132° |
| | 1200 | 0,47/+ 141° | 0,19/53° | 2,3/ 47° | 0,25/-134° |

s-parameters (common emitter) at $V_{CE} = 15\text{ V}$.

| I_C mA | f MHz | s_{ie} | s_{re} | s_{fe} | s_{oe} |
|-------------|----------|-------------|----------|-----------|------------|
| 50 | 40 | 0,48/ -65° | 0,02/62° | 31,0/148° | 0,83/ -30° |
| | 200 | 0,53/-149° | 0,04/52° | 12,0/102° | 0,37/ -73° |
| | 500 | 0,52/+ 179° | 0,08/58° | 5,2/ 78° | 0,25/ -89° |
| | 800 | 0,50/+ 162° | 0,12/59° | 3,4/ 64° | 0,26/ -99° |
| | 1000 | 0,47/+ 152° | 0,14/57° | 2,8/ 55° | 0,28/-104° |
| | 1200 | 0,45/+ 144° | 0,17/55° | 2,3/ 47° | 0,31/-109° |
| 75 | 40 | 0,46/ -68° | 0,02/62° | 32,9/148° | 0,82/ -32° |
| | 200 | 0,52/-151° | 0,04/53° | 12,5/101° | 0,36/ -79° |
| | 500 | 0,51/+ 178° | 0,08/59° | 5,4/ 78° | 0,24/ -97° |
| | 800 | 0,48/+ 161° | 0,12/59° | 3,5/ 64° | 0,24/-106° |
| | 1000 | 0,46/+ 152° | 0,15/57° | 2,8/ 56° | 0,26/-110° |
| | 1200 | 0,44/+ 144° | 0,17/55° | 2,4/ 48° | 0,28/-114° |
| 100 | 40 | 0,47/ -69° | 0,02/62° | 33,9/147° | 0,81/ -34° |
| | 200 | 0,51/-151° | 0,04/54° | 12,6/101° | 0,35/ -82° |
| | 500 | 0,50/+ 178° | 0,08/59° | 5,5/ 78° | 0,23/-101° |
| | 800 | 0,48/+ 161° | 0,12/59° | 3,5/ 64° | 0,23/-109° |
| | 1000 | 0,45/+ 152° | 0,15/57° | 2,9/ 56° | 0,25/-113° |
| | 1200 | 0,43/+ 144° | 0,18/54° | 2,4/ 48° | 0,27/-117° |
| 120 | 40 | 0,47/ -69° | 0,02/62° | 34,6/146° | 0,81/ -34° |
| | 200 | 0,51/-151° | 0,04/54° | 12,7/101° | 0,35/ -83° |
| | 500 | 0,50/+ 178° | 0,08/60° | 5,5/ 78° | 0,23/-103° |
| | 800 | 0,48/+ 161° | 0,12/59° | 3,5/ 64° | 0,23/-112° |
| | 1000 | 0,45/+ 152° | 0,15/57° | 2,9/ 56° | 0,24/-115° |
| | 1200 | 0,43/+ 144° | 0,18/54° | 2,4/ 48° | 0,26/-118° |
| 150 | 40 | 0,49/ -70° | 0,02/61° | 34,8/146° | 0,80/ -35° |
| | 200 | 0,52/-152° | 0,04/54° | 12,6/100° | 0,34/ -84° |
| | 500 | 0,50/+ 178° | 0,08/60° | 5,4/ 78° | 0,23/-103° |
| | 800 | 0,48/+ 162° | 0,12/59° | 3,5/ 64° | 0,23/-111° |
| | 1000 | 0,46/+ 152° | 0,15/57° | 2,8/ 55° | 0,24/-114° |
| | 1200 | 0,44/+ 144° | 0,18/54° | 2,4/ 48° | 0,27/-117° |

Conditions for Figs 5 and 6:
 $V_{CE} = 15 \text{ V}$; $I_C = 120 \text{ mA}$;
 $T_{amb} = 25 \text{ }^\circ\text{C}$.

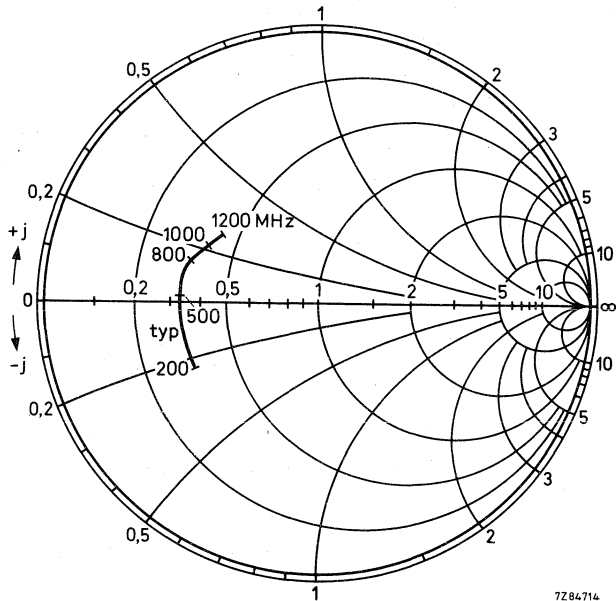


Fig. 5 Input impedance derived from input reflection coefficient s_{ie} co-ordinates in ohm $\times 50$.

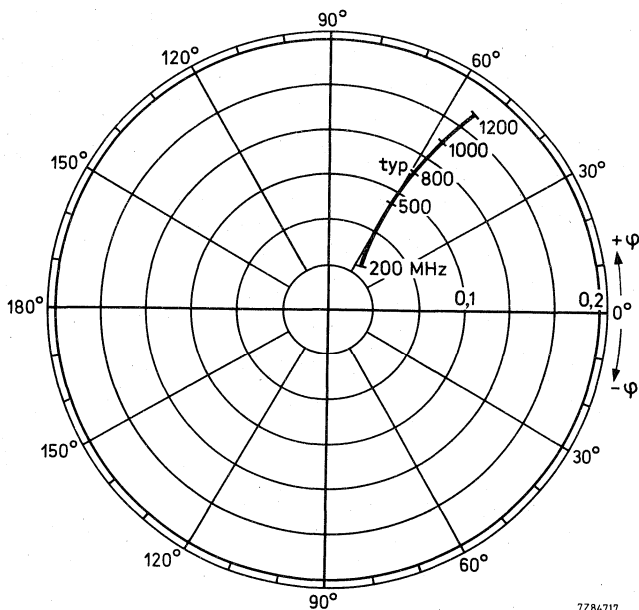


Fig. 6 Reverse transmission coefficient s_{re} .

Conditions for Figs 7 and 8:
 $V_{CE} = 15 \text{ V}$; $I_C = 120 \text{ mA}$;
 $T_{amb} = 25 \text{ }^\circ\text{C}$.

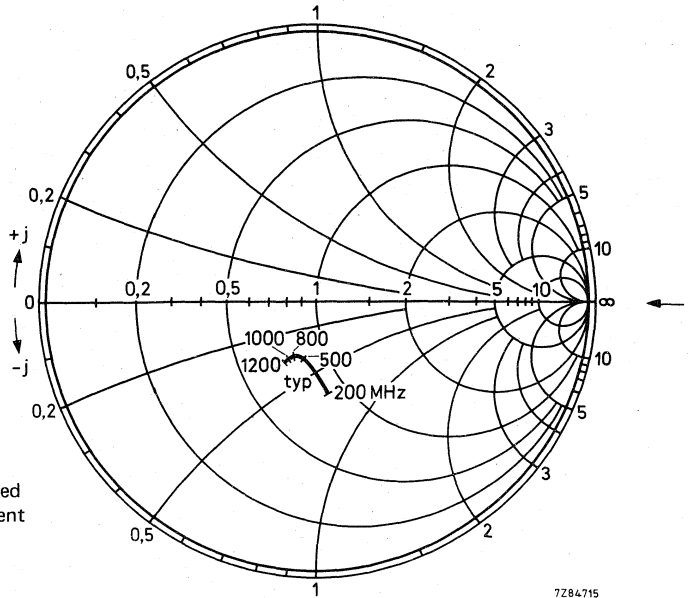


Fig. 7 Output impedance derived from output reflection coefficient s_{oe} co-ordinates in $\text{ohm} \times 50$.

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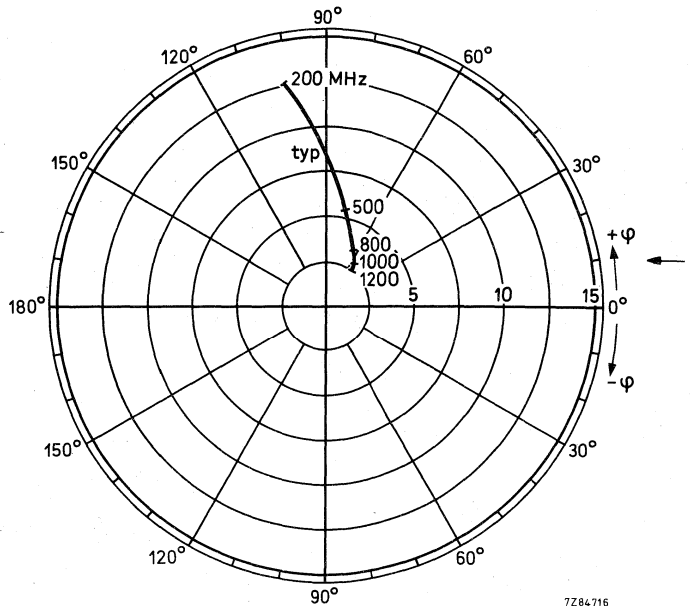


Fig. 8 Forward transmission coefficient s_{fe} .

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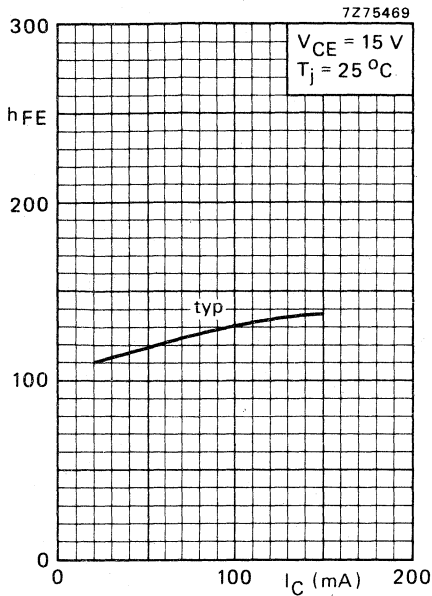


Fig. 9.

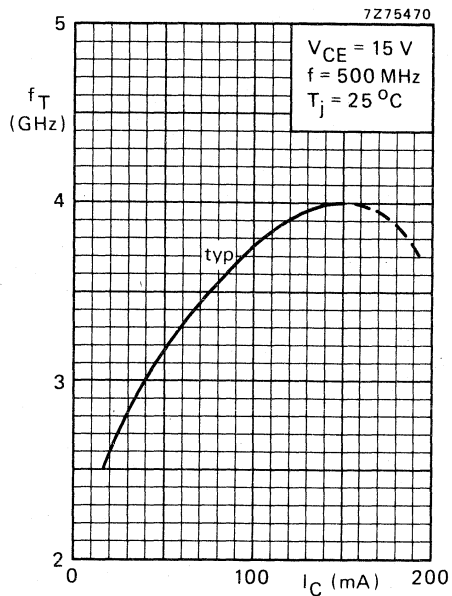


Fig. 10.

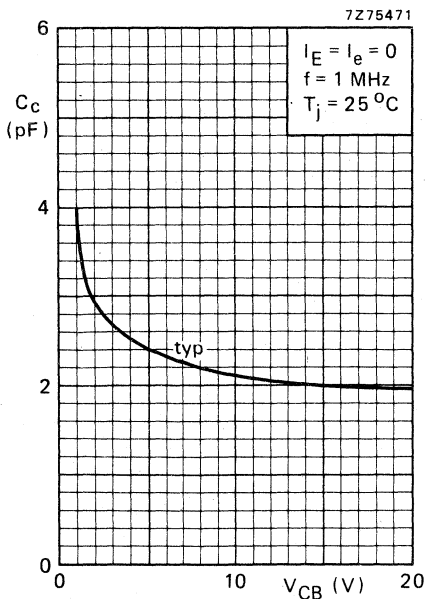


Fig. 11.

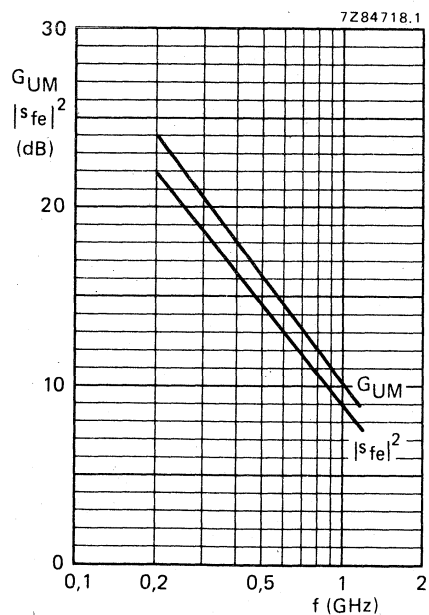


Fig. 12 $V_{CE} = 15\text{ V}$; $I_C = 120\text{ mA}$; $T_{amb} = 25\text{ }^\circ\text{C}$; typical values.

SILICON PLANAR EPITAXIAL TRANSISTOR

P-N-P transistor in a subminiature plastic transfer-moulded T-package. It is primarily intended for use in u.h.f. and microwave amplifiers such as in aerial amplifiers, radar systems, oscilloscopes, spectrum analysers etc.

The transistor features extremely high power gain coupled with good low noise performance.

N-P-N complements are BFR90 and BFR90A.

QUICK REFERENCE DATA

| | | | |
|---|------------|------|----------------------|
| Collector-base voltage (open emitter) | $-V_{CB0}$ | max. | 20 V |
| Collector-emitter voltage (open base) | $-V_{CEO}$ | max. | 15 V |
| Collector current (d.c.) | $-I_C$ | max. | 25 mA |
| Total power dissipation up to $T_{amb} = 60\text{ }^\circ\text{C}$ | P_{tot} | max. | 180 mW |
| Junction temperature | T_j | max. | 150 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $-I_C = 14\text{ mA}; -V_{CE} = 10\text{ V}$ | f_T | typ. | 5 GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $I_C = 0; -V_{CE} = 10\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$ | C_{re} | typ. | 0,45 pF |
| Noise figure at optimum source impedance $-I_C = 2\text{ mA}; -V_{CE} = 10\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | F | typ. | 2,7 dB |

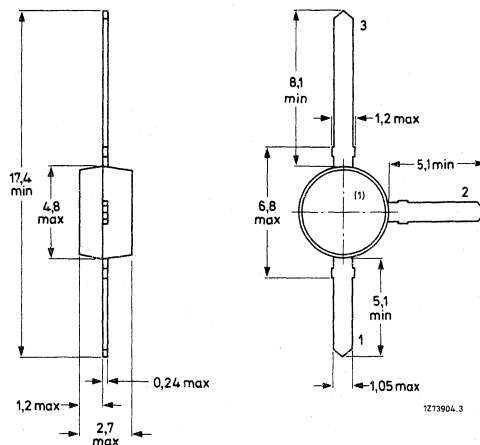
MECHANICAL DATA

Dimensions in mm

Fig. 1 SOT-37.

Connections

1. Base
2. Emitter
3. Collector



(1) = type number marking.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|---|------------|------|----------------|
| Collector-base voltage (open emitter) | $-V_{CB0}$ | max. | 20 V |
| Collector-emitter voltage (open base) | $-V_{CEO}$ | max. | 15 V |
| Emitter-base voltage (open collector) | $-V_{EBO}$ | max. | 2 V |
| Collector current (d.c.) | $-I_C$ | max. | 25 mA |
| Collector current (peak value) at $f > 1$ MHz | $-I_{CM}$ | max. | 35 mA |
| Total power dissipation up to $T_{amb} = 60$ °C | P_{tot} | max. | 180 mW |
| Storage temperature | T_{stg} | | -65 to +150 °C |
| Junction temperature | T_j | max. | 150 °C |

THERMAL RESISTANCE

From junction to ambient in free air
mounted on a fibre-glass print
of 40 mm x 25 mm x 1 mm

$$R_{th\ j-a} = 0,5 \text{ K/mW}$$

CHARACTERISTICS

$T_j = 25$ °C unless otherwise specified

Collector cut-off current

$$I_E = 0; -V_{CB} = 10 \text{ V}$$

$$-I_{CBO} < 50 \text{ nA}$$

D.C. current gain*

$$-I_C = 14 \text{ mA}; -V_{CE} = 10 \text{ V}$$

$$h_{FE} > 20$$

Transition frequency at $f = 500$ MHz*

$$-I_C = 14 \text{ mA}; -V_{CE} = 10 \text{ V}$$

$$f_T \text{ typ. } 5 \text{ GHz}$$

Collector capacitance at $f = 1$ MHz

$$I_E = I_e = 0; -V_{CB} = 10 \text{ V}$$

$$C_C \text{ typ. } 0,65 \text{ pF}$$

Emitter capacitance at $f = 1$ MHz

$$I_C = I_c = 0; -V_{EB} = 0,5 \text{ V}$$

$$C_e \text{ typ. } 1,2 \text{ pF}$$

Feedback capacitance at $f = 1$ MHz

$$I_C = 0; -V_{CE} = 10 \text{ V}; T_{amb} = 25 \text{ °C}$$

$$C_{re} \text{ typ. } 0,45 \text{ pF}$$

Noise figure at optimum source impedance

$$-I_C = 2 \text{ mA}; -V_{CE} = 10 \text{ V}; f = 500 \text{ MHz}; T_{amb} = 25 \text{ °C}$$

$$F \text{ typ. } 2,7 \text{ dB}$$

Maximum unilateral power gain (s_{re} assumed to be zero)

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$$I_C = 14 \text{ mA}; V_{CE} = 10 \text{ V}; f = 500 \text{ MHz}; T_{amb} = 25 \text{ °C}$$

$$G_{UM} \text{ typ. } 19,0 \text{ dB}$$

* Measured under pulse conditions.

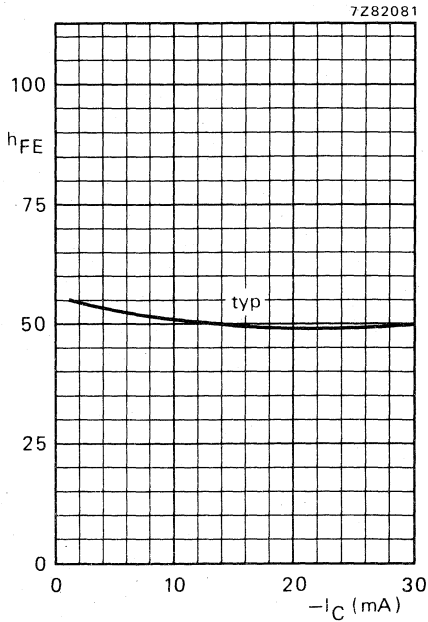


Fig. 2 $-V_{CE} = 10 \text{ V}$; $T_j = 25 \text{ }^\circ\text{C}$.

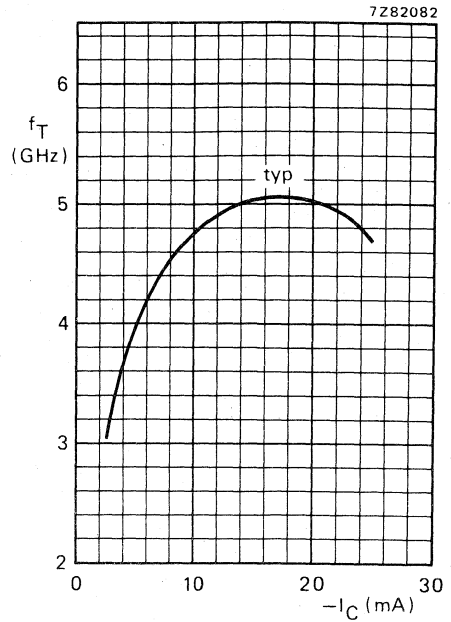


Fig. 3 $-V_{CE} = 10 \text{ V}$; $f = 500 \text{ MHz}$; $T_j = 25 \text{ }^\circ\text{C}$.

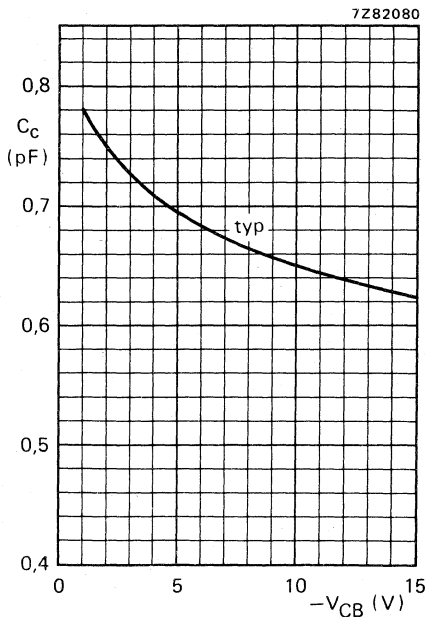


Fig. 4 $I_E = I_e = 0$; $f = 1 \text{ MHz}$; $T_j = 25 \text{ }^\circ\text{C}$.

SILICON PLANAR EPITAXIAL TRANSISTOR

P-N-P transistor in a TO-72 metal envelope with insulated electrodes and a shield lead connected to the case. It is primarily intended for use in u.h.f. and microwave amplifiers such as in aerial amplifiers, radar systems, oscilloscopes, spectrum analysers etc.

The transistor features extremely high power gain coupled with good low noise performance.

N-P-N complement is BFQ53.

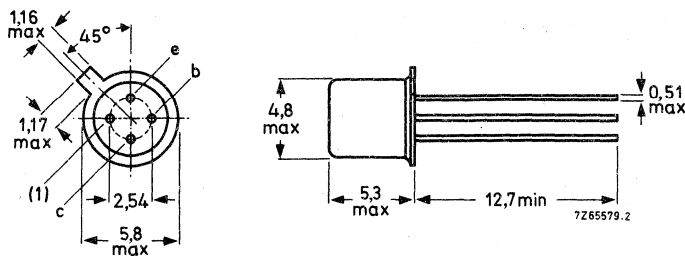
QUICK REFERENCE DATA

| | | | |
|---|------------|------|----------------------|
| Collector-base voltage (open emitter) | $-V_{CBO}$ | max. | 20 V |
| Collector-emitter voltage (open base) | $-V_{CEO}$ | max. | 15 V |
| Collector current (d.c.) | $-I_C$ | max. | 25 mA |
| Total power dissipation up to $T_{amb} = 65\text{ }^\circ\text{C}$ | P_{tot} | max. | 150 mW |
| Junction temperature | T_j | max. | 200 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $-I_C = 14\text{ mA}$; $-V_{CE} = 10\text{ V}$ | f_T | typ. | 5 GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $I_C = 0$; $-V_{CE} = 10\text{ V}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | C_{re} | typ. | 0,5 pF |
| Noise figure at optimum source impedance $-I_C = 2\text{ mA}$; $-V_{CE} = 10\text{ V}$; $f = 500\text{ MHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | F | typ. | 2,7 dB |
| Maximum unilateral power gain (see page 2) $-I_C = 14\text{ mA}$; $-V_{CE} = 10\text{ V}$; $f = 500\text{ MHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | G_{UM} | typ. | 17,0 dB |

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-72 with insulated electrodes.



(1) shield lead connected to case.

Accessories: 56246 (distance disc).

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | |
|--|-----------------|-------------------------------|
| Collector-base voltage (open emitter) | $-V_{CBO}$ max. | 20 V |
| Collector-emitter voltage (open base) | $-V_{CEO}$ max. | 15 V |
| Emitter-base voltage (open collector) | $-V_{EBO}$ max. | 2 V |
| Collector current (d.c.) | $-I_C$ max. | 25 mA |
| Collector current (peak value) at $f > 1$ MHz | $-I_{CM}$ max. | 35 mA |
| Total power dissipation up to $T_{amb} = 65^\circ\text{C}$ | P_{tot} max. | 150 mW |
| Storage temperature | T_{stg} | -65 to $+200^\circ\text{C}$ |
| Junction temperature | T_j max. | 200 $^\circ\text{C}$ |

THERMAL RESISTANCE

| | | |
|--------------------------------------|-----------------|----------|
| From junction to ambient in free air | $R_{th\ j-a}$ = | 0,9 K/mW |
| From junction to case | $R_{th\ j-c}$ = | 0,6 K/mW |

CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; -V_{CB} = 10\text{ V}$

$-I_{CBO} < 50\text{ nA}$

D.C. current gain (note 1)

$-I_C = 14\text{ mA}; -V_{CE} = 10\text{ V}$

$h_{FE} > 20$
typ. 50

Transition frequency (notes 1 and 2)

$-I_C = 14\text{ mA}; -V_{CE} = 10\text{ V}; f = 500\text{ MHz}$

f_T typ. 5 GHz

Collector capacitance (note 3)

$I_E = I_e = 0; -V_{CB} = 10\text{ V}; f = 1\text{ MHz}$

C_c typ. 0,85 pF

Emitter capacitance

$I_C = I_c = 0; -V_{EB} = 0,5\text{ V}; f = 1\text{ MHz}$

C_e typ. 1,2 pF

Feedback capacitance (note 2)

$I_C = 0; -V_{CE} = 10\text{ V}; f = 1\text{ MHz}; T_{amb} = 25^\circ\text{C}$

C_{re} typ. 0,5 pF

Noise figure at optimum source impedance (note 2)

$-I_C = 2\text{ mA}; -V_{CE} = 10\text{ V}; f = 500\text{ MHz}; T_{amb} = 25^\circ\text{C}$

F typ. 2,7 dB

Maximum unilateral power gain (note 2)

s_{re} assumed to be zero

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$-I_C = 14\text{ mA}; -V_{CE} = 10\text{ V}; f = 500\text{ MHz}; T_{amb} = 25^\circ\text{C}$

G_{UM} typ. 17,0 dB

Notes

1. Measured under pulse conditions.
2. Shield lead grounded.
3. Shield lead not connected.

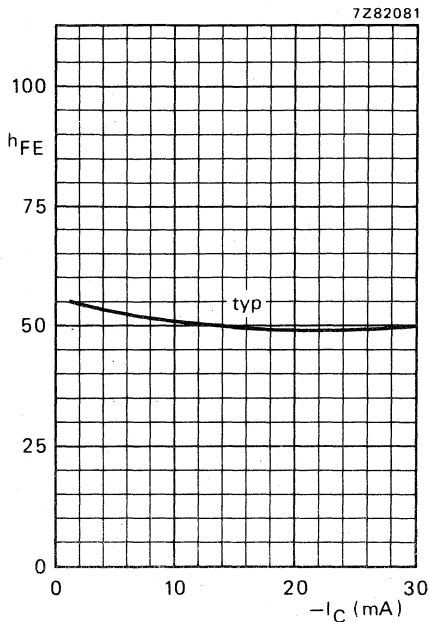


Fig. 2 $-V_{CE} = 10$ V; $T_j = 25$ °C.

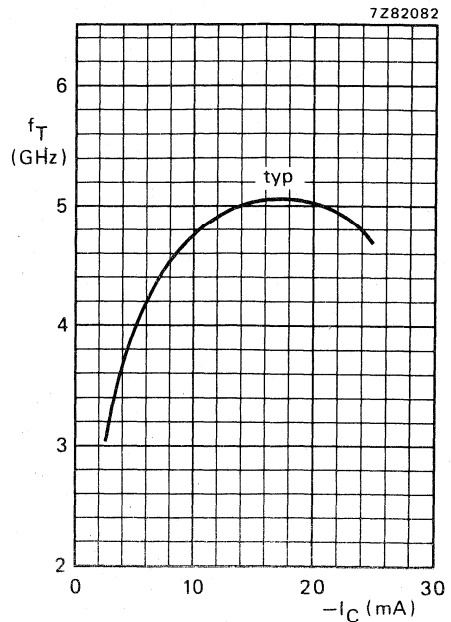


Fig. 3 $-V_{CE} = 10$ V; $f = 500$ MHz; $T_j = 25$ °C; shield lead grounded.

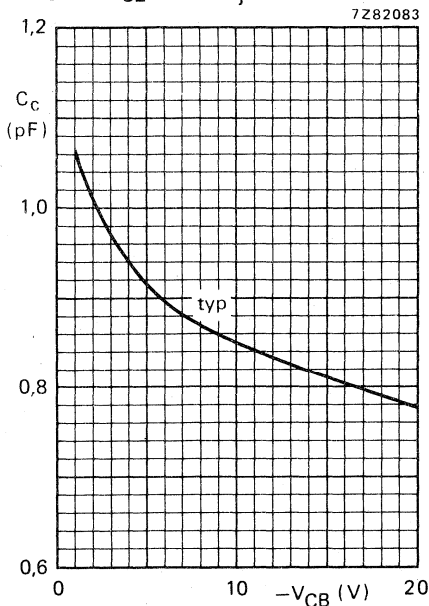


Fig. 4 $I_E = I_e = 0$; $f = 1$ MHz; $T_j = 25$ °C; shield lead not connected.

SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a TO-72 metal envelope with insulated electrodes and a shield lead connected to the case. It is primarily intended for use in u.h.f. and microwave amplifiers such as in aerial amplifiers, radar systems, oscilloscopes, spectrum analysers etc.

The transistor features extremely high power gain coupled with good low noise performance.

P-N-P complement is BFQ52.

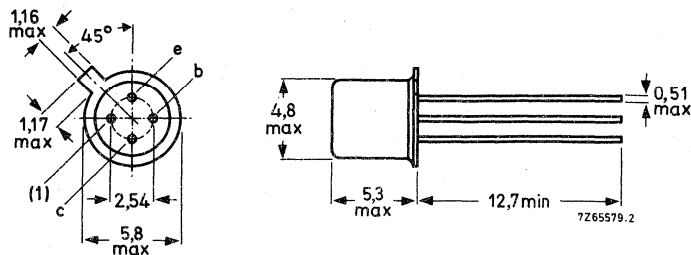
QUICK REFERENCE DATA

| | | | |
|--|-----------|------|----------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 20 V |
| Collector-emitter voltage (open base) | V_{CE0} | max. | 15 V |
| Collector current (d.c.) | I_C | max. | 25 mA |
| Total power dissipation up to $T_{amb} = 65\text{ }^\circ\text{C}$ | P_{tot} | max. | 150 mW |
| Junction temperature | T_j | max. | 200 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 14\text{ mA}; V_{CE} = 10\text{ V}$ | f_T | typ. | 5 GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $I_C = 0; V_{CE} = 10\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$ | C_{re} | typ. | 0,45 pF |
| Noise figure at optimum source impedance $I_C = 2\text{ mA}; V_{CE} = 10\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | F | typ. | 2,4 dB |
| Maximum unilateral power gain (see page 2) $I_C = 14\text{ mA}; V_{CE} = 10\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | G_{UM} | typ. | 18,0 dB |

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-72 with insulated electrodes.



(1) shield lead connected to case.

Accessories: 56246 (distance disc).

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|---|-----------|------|----------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 20 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2 V |
| Collector current (d.c.) | I_C | max. | 25 mA |
| Collector current (peak value) at $f > 1$ MHz | I_{CM} | max. | 35 mA |
| Total power dissipation up to $T_{amb} = 65$ °C | P_{tot} | max. | 150 mW |
| Storage temperature | T_{stg} | | -65 to +200 °C |
| Junction temperature | T_j | max. | 200 °C |

THERMAL RESISTANCE

| | | | |
|--------------------------------------|--------------|---|----------|
| From junction to ambient in free air | $R_{th j-a}$ | = | 0,9 K/mW |
| From junction to case | $R_{th j-c}$ | = | 0,6 K/mW |

CHARACTERISTICS

$T_j = 25$ °C unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 10$ V

$I_{CBO} < 50$ nA

D.C. current gain (note 1)

$I_C = 14$ mA; $V_{CE} = 10$ V

$h_{FE} > 25$
typ. 50

Transition frequency (notes 1 and 2)

$I_C = 14$ mA; $V_{CE} = 10$ V; $f = 500$ MHz

f_T typ. 5 GHz

Collector capacitance (note 3)

$I_E = I_e = 0; V_{CB} = 10$ V; $f = 1$ MHz

C_C typ. 0,75 pF

Emitter capacitance

$I_C = I_c = 0; V_{EB} = 0,5$ V; $f = 1$ MHz

C_e typ. 1,2 pF

Feedback capacitance (note 2)

$I_C = 0; V_{CE} = 10$ V; $f = 1$ MHz; $T_{amb} = 25$ °C

C_{re} typ. 0,45 pF

Noise figure at optimum source impedance (note 2)

$I_C = 2$ mA; $V_{CE} = 10$ V; $f = 500$ MHz; $T_{amb} = 25$ °C

F typ. 2,4 dB

Maximum unilateral power gain (note 2)

s_{re} assumed to be zero

$$G_{UM} \text{ (in dB)} = \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$I_C = 14$ mA; $V_{CE} = 10$ V; $f = 500$ MHz; $T_{amb} = 25$ °C

G_{UM} typ. 18,0 dB

Notes

1. Measured under pulse conditions.
2. Shield lead grounded.
3. Shield lead not connected.

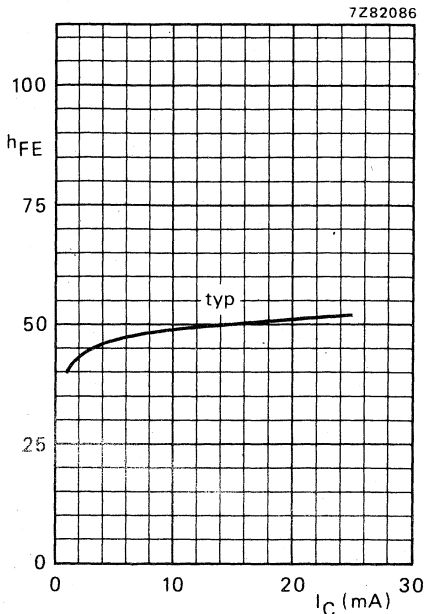


Fig. 2 $V_{CE} = 10$ V; $T_j = 25$ °C.

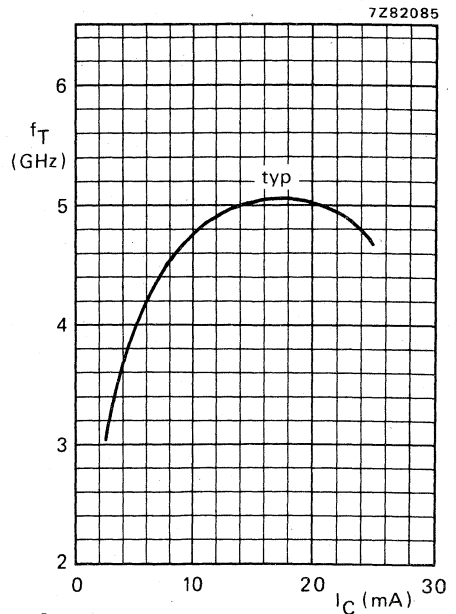


Fig. 3 $V_{CE} = 10$ V; $f = 500$ MHz; $T_j = 25$ °C; shield lead grounded.

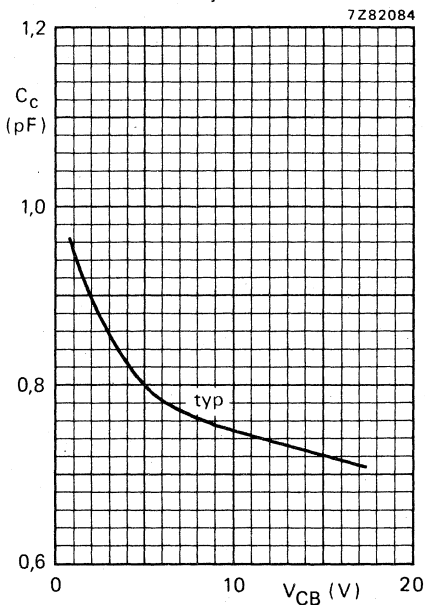


Fig. 4 $I_E = I_e = 0$; $f = 1$ MHz; $T_j = 25$ °C; shield lead not connected.

SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a TO-72 metal envelope with insulated electrodes and a shield lead connected to the case. It is primarily intended for use in u.h.f. and microwave amplifiers such as in aerial amplifiers, radar systems, oscilloscopes, spectrum analysers etc.

The transistor features the combination of high power gain, high transition frequency and low noise up to high frequencies.

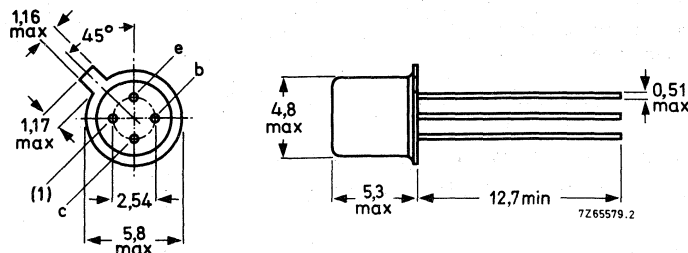
QUICK REFERENCE DATA

| | | | |
|--|-----------|------|----------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 20 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 V |
| Collector current (d.c.) | I_C | max. | 75 mA |
| Total power dissipation up to $T_{amb} = 50\text{ }^\circ\text{C}$ | P_{tot} | max. | 250 mW |
| Junction temperature | T_j | max. | 200 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 50\text{ mA}$; $V_{CE} = 5\text{ V}$ | f_T | typ. | 4,5 GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $I_C = 0$; $V_{CE} = 10\text{ V}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | C_{re} | typ. | 1,0 pF |
| Noise figure at optimum source impedance $I_C = 10\text{ mA}$; $V_{CE} = 5\text{ V}$; $f = 200\text{ MHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | F | < | 3,0 dB |
| Maximum unilateral power gain (see page 2) $I_C = 20\text{ mA}$; $V_{CE} = 5\text{ V}$; $f = 200\text{ MHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | G_{UM} | > | 17,5 dB |

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-72 with insulated electrodes.



(1) shield lead connected to case.

Accessories: 56246 (distance disc).

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|---|-----------|------|----------------|
| Collector-base voltage (open emitter) | V_{CB0} | max. | 20 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 3 V |
| Collector current (d.c.) | I_C | max. | 75 mA |
| Collector current (peak value) at $f > 1$ MHz | I_{CM} | max. | 150 mA |
| Total power dissipation up to $T_{amb} = 50$ °C | P_{tot} | max. | 250 mW |
| Storage temperature | T_{stg} | | -65 to +200 °C |
| Junction temperature | T_j | max. | 200 °C |

THERMAL RESISTANCE

| | | | |
|--------------------------------------|--------------|---|---------|
| From junction to ambient in free air | $R_{th j-a}$ | = | 600 K/W |
| From junction to case | $R_{th j-c}$ | = | 350 K/W |

CHARACTERISTICS

$T_j = 25$ °C unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 10$ V

| | | |
|-----------|---|--------|
| I_{CBO} | < | 100 nA |
|-----------|---|--------|

D.C. current gain (note 1)

$I_C = 20$ mA; $V_{CE} = 5$ V

| | | |
|----------|---|-----|
| h_{FE} | > | 50 |
| | < | 150 |

Transistion frequency (notes 1 and 2)

$I_C = 50$ mA; $V_{CE} = 5$ V; $f = 500$ MHz

| | | |
|-------|------|---------|
| f_T | typ. | 4,5 GHz |
|-------|------|---------|

Collector capacitance (note 3)

$I_C = 0; V_{CB} = 5$ V; $f = 1$ MHz

| | | |
|----------|------|--------|
| C_{cb} | typ. | 1,3 pF |
|----------|------|--------|

Feedback capacitance (note 2)

$I_C = 0; V_{CE} = 10$ V; $f = 1$ MHz; $T_{amb} = 25$ °C

| | | |
|----------|------|--------|
| C_{re} | typ. | 1,0 pF |
| | < | 1,4 pF |

Noise figure at optimum source impedance (note 2)

$I_C = 10$ mA; $V_{CE} = 5$ V; $f = 200$ MHz; $T_{amb} = 25$ °C

| | | |
|---|---|--------|
| F | < | 3,0 dB |
|---|---|--------|

$I_C = 10$ mA; $V_{CE} = 5$ V; $f = 500$ MHz; $T_{amb} = 25$ °C

| | | |
|---|------|--------|
| F | typ. | 2,3 dB |
|---|------|--------|

Maximum unilateral power gain (note 2)

s_{re} assumed to be zero

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$I_C = 20$ mA; $V_{CE} = 5$ V; $f = 200$ MHz; $T_{amb} = 25$ °C

| | | |
|----------|---|---------|
| G_{UM} | > | 17,5 dB |
|----------|---|---------|

$I_C = 50$ mA; $V_{CE} = 5$ V; $f = 500$ MHz; $T_{amb} = 25$ °C

| | | |
|----------|------|---------|
| G_{UM} | typ. | 11,5 dB |
|----------|------|---------|

Notes

1. Measured under pulse conditions.
2. Shield lead grounded.
3. Shield lead and emitter lead connected to bridge earth.

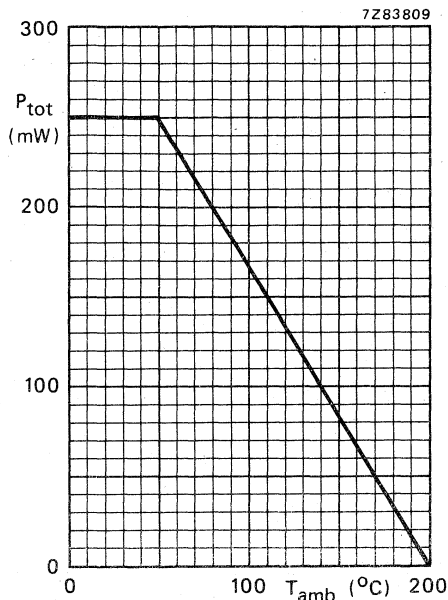


Fig. 2 Maximum permissible power dissipation in free air as a function of ambient temperature.

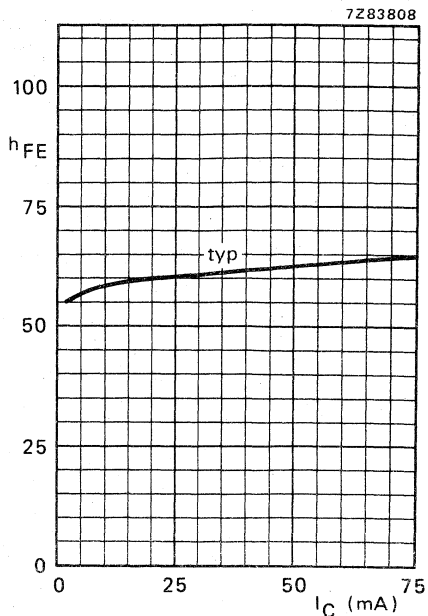


Fig. 3 $V_{CE} = 5$ V; $T_j = 25$ °C.

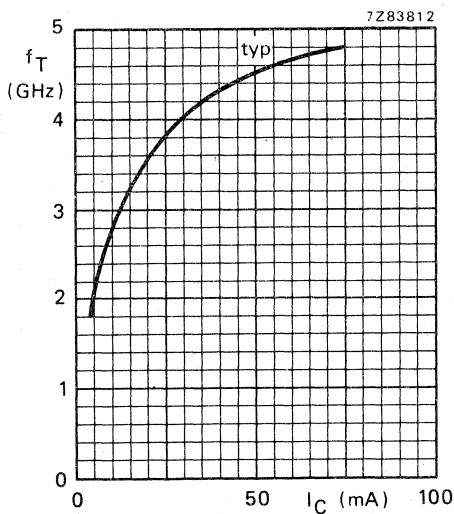


Fig. 4 $V_{CE} = 5$ V; $f = 500$ MHz; $T_j = 25$ °C; shield lead grounded.

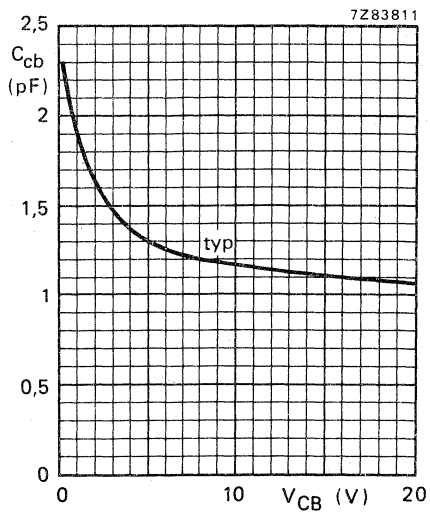


Fig. 5 $I_C = 0$; $f = 1$ MHz; $T_j = 25$ °C; shield lead and emitter lead connected to bridge earth.

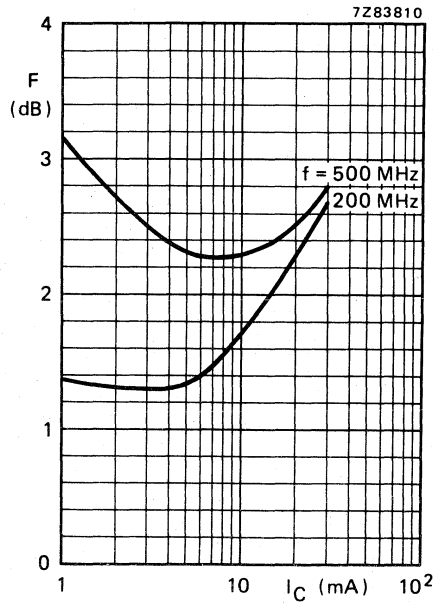


Fig. 6 $V_{CE} = 5 \text{ V}$; $Z_S = \text{optimum}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$; typical values.

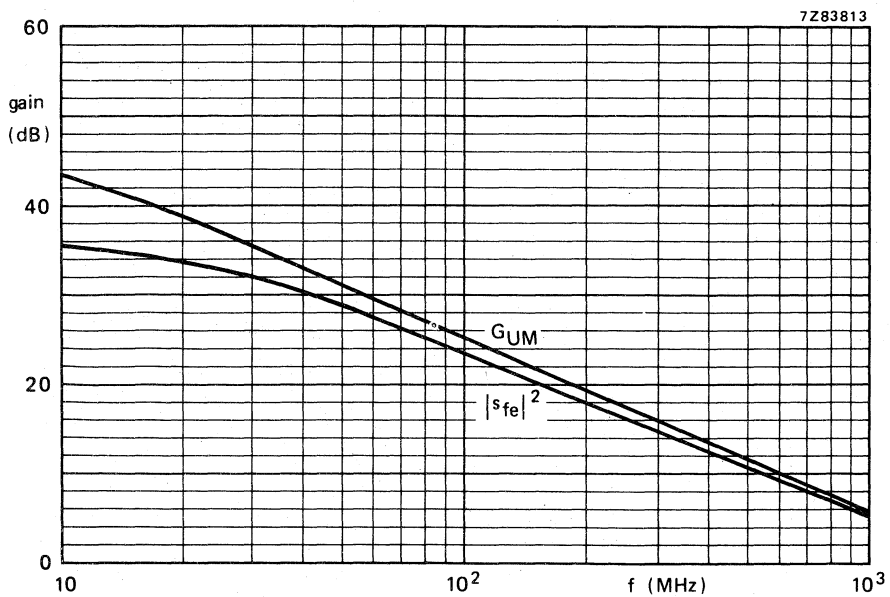


Fig. 7 $V_{CE} = 5 \text{ V}$; $I_C = 50 \text{ mA}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$; typical values.

SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor primarily intended for final stages in MATV system amplifiers. This device is also suitable for use in low power band IV and V equipment. Diffused emitter ballasting resistors and the application of gold sandwich metallization ensure an optimum temperature profile and excellent reliability properties.

The transistor has a ¼" capstan envelope with ceramic cap. All leads are isolated from the stud.

QUICK REFERENCE DATA

| | | | |
|--|-----------|------|----------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 25 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 18 V |
| Collector current (d.c.) | I_C | max. | 300 mA |
| Total power dissipation up to $T_{mb} = 110\text{ }^\circ\text{C}$ | P_{tot} | max. | 4,5 W |
| Operating junction temperature | T_j | max. | 200 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 240\text{ mA}; V_{CE} = 15\text{ V}$ | f_T | typ. | 4 GHz |
| Output voltage at $d_{im} = -60\text{ dB}$ (see Figs 2 and 12) $I_C = 240\text{ mA}; V_{CE} = 15\text{ V}; R_L = 75\text{ }\Omega; T_{amb} = 25\text{ }^\circ\text{C}$ $f_{(p+q-r)} = 793,25\text{ MHz}$ | V_o | typ. | 1,6 V |

MECHANICAL DATA

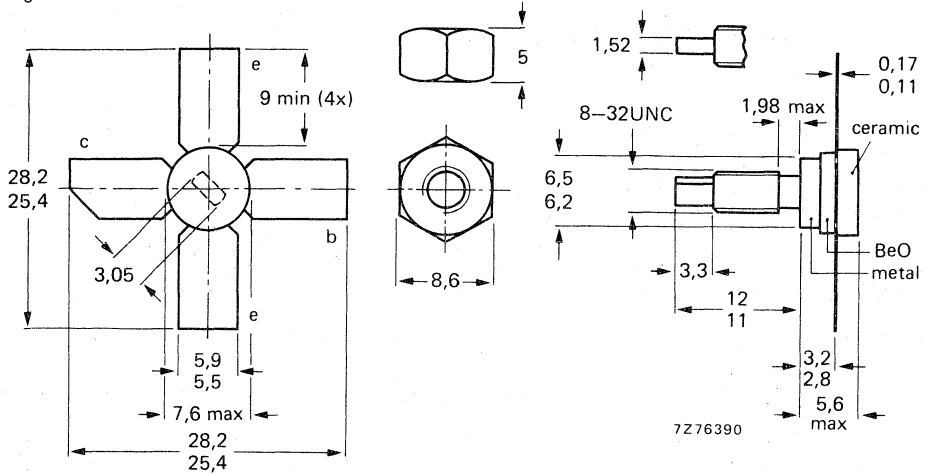
SOT-122 (see Fig. 1).

CAUTION This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

MECHANICAL DATA

Fig. 1 SOT-122.

Dimensions in mm



Torque on nut: min. 0,75 Nm
(7,5 kg cm)
max. 0,85 Nm
(8,5 kg cm)

Diameter of clearance hole in heatsink: max. 4,2 mm.
Mounting hole to have no burrs at either end.
De-burring must leave surface flat; do not chamfer or countersink either end of hole.

When locking is required an adhesive is preferred instead of a lock washer.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|---|-----------|------|-------------------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 25 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 18 V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2 V |
| Collector current (d.c.) | I_C | max. | 300 mA |
| Total power dissipation up to $T_{mb} = 110\text{ }^\circ\text{C}$ (see Fig. 7) | P_{tot} | max. | 4,5 W |
| Storage temperature | T_{stg} | | -65 to + 150 $^\circ\text{C}$ |
| Operating junction temperature | T_j | max. | 200 $^\circ\text{C}$ |

THERMAL RESISTANCE

| | | | |
|--------------------------------|----------------|---|-----------|
| From junction to mounting base | $R_{th\ j-mb}$ | = | 20,0 K/W* |
| From mounting base to heatsink | $R_{th\ mb-h}$ | = | 0,6 K/W* |

* K/W is SI unit for $^\circ\text{C}/\text{W}$.

CHARACTERISTICS

$T_{amb} = 25^{\circ}C$

Collector cut-off current

$I_E = 0; V_{CB} = 15 V$

D.C. current gain*

$I_C = 240 mA; V_{CE} = 15 V$

Transition frequency at $f = 500 MHz^*$

$I_C = 240 mA; V_{CE} = 15 V$

Collector capacitance at $f = 1 MHz$

$I_E = I_e = 0; V_{CB} = 15 V$

Emitter capacitance at $f = 1 MHz$

$I_C = I_c = 0; V_{EB} = 0,5 V$

Feedback capacitance at $f = 1 MHz$

$I_C = 0; V_{CE} = 15 V$

Collector-stud capacitance**

Maximum unilateral power gain (s_{re} assumed to be zero)

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$I_C = 240 mA; V_{CE} = 15 V; f = 800 MHz$

Output voltage at $d_{im} = -60 dB$ (see Figs 2 and 12)
(DIN 45004B, par. 6.3: 3-tone)

$I_C = 240 mA; V_{CE} = 15 V; R_L = 75 \Omega$

$V_p = V_o$ at $d_{im} = -60 dB; f_p = 795,25 MHz$

$V_q = V_o - 6 dB; f_q = 803,25 MHz$

$V_r = V_o - 6 dB; f_r = 805,25 MHz$

measured at $f_{(p+q-r)} = 793,25 MHz$

$I_{CBO} < 50 \mu A$

$h_{FE} > 25$

f_T typ. 4 GHz

C_c typ. 3,8 pF

C_e typ. 20 pF

C_{re} typ. 2,3 pF

C_{cs} typ. 0,8 pF

G_{UM} typ. 13 dB

V_o typ. 1,6 V

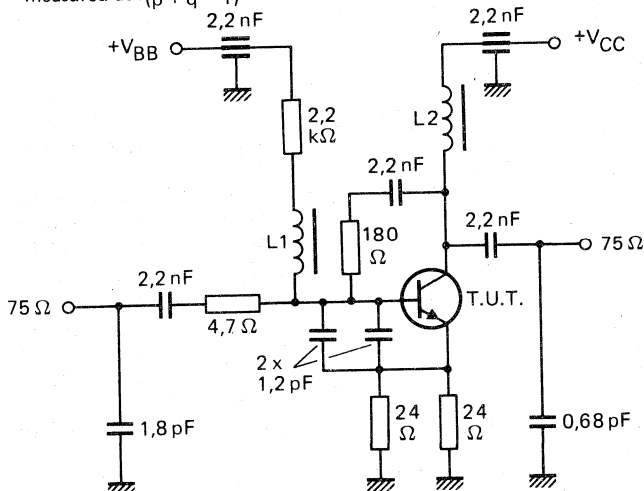


Fig. 2 Intermodulation distortion MATV test circuit. Power gain at $f = 40 MHz$ to $860 MHz$ is typical 7 dB.
 $L1 = L2 = 5 \mu H$ micro choke.

* Measured under pulse conditions.

** Measured with emitter and base grounded.

7Z82760

s-parameters (common emitter) at $V_{CE} = 7,5 \text{ V}$.

| I_C mA | f MHz | S_{ie} | S_{re} | S_{fe} | S_{oe} |
|-------------|----------|--------------|------------|-------------|---------------|
| 50 | 40 | 0,66/-135,7° | 0,02/41,1° | 30,4/124,0° | 0,64/ -79,0° |
| | 100 | 0,77/-164,0° | 0,03/33,6° | 14,8/101,2° | 0,45/-125,3° |
| | 200 | 0,80/-176,3° | 0,03/44,1° | 7,7/ 89,1° | 0,39/-147,9° |
| | 500 | 0,80/ 170,2° | 0,06/55,3° | 3,1/ 70,3° | 0,38/-159,5° |
| | 800 | 0,78/ 157,0° | 0,09/60,5° | 2,0/ 57,2° | 0,42/-165,6° |
| | 1000 | 0,78/ 152,4° | 0,11/61,8° | 1,6/ 48,1° | 0,43/-167,6° |
| | 1200 | 0,75/ 142,7° | 0,13/59,9° | 1,4/ 41,1° | 0,46/-171,2° |
| 100 | 40 | 0,67/-146,1° | 0,02/40,9° | 33,5/121,5° | 0,64/ -90,4° |
| | 100 | 0,78/-167,5° | 0,02/37,2° | 15,6/100,4° | 0,49/-134,4° |
| | 200 | 0,80/-178,3° | 0,03/47,0° | 8,1/ 89,2° | 0,45/-155,5° |
| | 500 | 0,79/ 168,9° | 0,06/60,4° | 3,4/ 72,0° | 0,43/-170,5° |
| | 800 | 0,77/ 156,1° | 0,09/62,0° | 2,2/ 59,5° | 0,44/-174,5° |
| | 1000 | 0,77/ 151,5° | 0,11/61,9° | 1,8/ 51,5° | 0,44/-178,5° |
| | 1200 | 0,74/ 141,8° | 0,14/59,4° | 1,5/ 44,0° | 0,46/-178,5° |
| 150 | 40 | 0,68/-149,0° | 0,02/40,8° | 34,3/120,6° | 0,64/ -94,6° |
| | 100 | 0,78/-168,8° | 0,02/38,8° | 15,9/100,0° | 0,50/-138,0° |
| | 200 | 0,80/-179,0° | 0,03/49,0° | 8,2/ 89,2° | 0,47/-158,2° |
| | 500 | 0,79/ 168,5° | 0,06/61,6° | 3,4/ 72,5° | 0,45/-173,2° |
| | 800 | 0,77/ 155,8° | 0,09/62,5° | 2,2/ 60,3° | 0,46/-177,1° |
| | 1000 | 0,76/ 151,2° | 0,12/62,1° | 1,8/ 52,5° | 0,46/ 177,1° |
| | 1200 | 0,73/ 141,6° | 0,14/59,1° | 1,5/ 45,1° | 0,47/ 177,1° |
| 200 | 40 | 0,68/-150,7° | 0,02/40,5° | 34,7/120,0° | 0,64/ -97,3° |
| | 100 | 0,78/-169,7° | 0,02/39,6° | 15,9/ 99,7° | 0,51/-140,4° |
| | 200 | 0,80/-179,8° | 0,03/50,1° | 8,2/ 89,0° | 0,49/-159,8° |
| | 500 | 0,79/ 168,2° | 0,06/62,1° | 3,4/ 72,6° | 0,47/-174,8° |
| | 800 | 0,77/ 155,6° | 0,09/62,6° | 2,2/ 60,5° | 0,47/-178,6° |
| | 1000 | 0,76/ 150,9° | 0,12/62,1° | 1,8/ 52,9° | 0,46/ 175,5° |
| | 1200 | 0,73/ 141,4° | 0,14/59,0° | 1,5/ 45,3° | 0,47/ 174,6° |
| 250 | 40 | 0,69/-151,9° | 0,02/40,1° | 34,6/119,4° | 0,63/ -99,4° |
| | 100 | 0,79/-170,3° | 0,02/39,9° | 15,8/ 99,5° | 0,52/-141,8° |
| | 200 | 0,80/ 180,0° | 0,03/51,0° | 8,1/ 88,9° | 0,49/-160,9° |
| | 500 | 0,80/ 168,0° | 0,06/62,5° | 3,4/ 72,6° | 0,47/-175,6° |
| | 800 | 0,78/ 155,4° | 0,09/62,8° | 2,2/ 60,6° | 0,48/-179,5° |
| | 1000 | 0,77/ 150,8° | 0,12/62,1° | 1,8/ 53,0° | 0,47/ 174,5° |
| | 1200 | 0,73/ 141,3° | 0,14/58,9° | 1,5/ 45,6° | 0,47/ 173,9° |
| 300 | 40 | 0,69/-152,9° | 0,02/39,7° | 34,4/118,9° | 0,62/-101,2° |
| | 100 | 0,79/-170,8° | 0,02/40,1° | 15,5/ 99,2° | 0,52/-143,2° |
| | 200 | 0,80/ 179,6° | 0,03/51,5° | 8,0/ 88,8° | 0,50/-161,7° |
| | 500 | 0,80/ 167,9° | 0,06/62,8° | 3,4/ 72,5° | 0,48/-176,2° |
| | 800 | 0,78/ 155,3° | 0,09/62,9° | 2,2/ 60,5° | 0,48/+ 179,8° |
| | 1000 | 0,77/ 150,6° | 0,12/62,1° | 1,8/ 53,0° | 0,47/ 173,9° |
| | 1200 | 0,74/ 141,1° | 0,14/59,1° | 1,5/ 45,5° | 0,48/ 173,4° |

s-parameters (common emitter) at $V_{CE} = 15$ V.

| I_C mA | f MHz | S_{ie} | S_{re} | S_{fe} | S_{oe} |
|-------------|----------|--------------|------------|-------------|---------------|
| 50 | 40 | 0,63/-132,3° | 0,02/41,8° | 33,5/126,6° | 0,62/ -72,9° |
| | 100 | 0,75/-161,1° | 0,02/34,0° | 16,4/103,0° | 0,41/-115,2° |
| | 200 | 0,78/-174,8° | 0,03/40,7° | 8,6/ 90,1° | 0,34/-139,4° |
| | 500 | 0,78/ 169,9° | 0,06/56,8° | 3,6/ 71,4° | 0,34/-153,8° |
| | 800 | 0,77/ 157,5° | 0,08/60,9° | 2,3/ 57,6° | 0,37/-157,4° |
| | 1000 | 0,74/ 150,3° | 0,10/61,8° | 1,9/ 48,8° | 0,40/-160,3° |
| | 1200 | 0,73/ 143,2° | 0,12/61,0° | 1,5/ 41,2° | 0,42/-162,9° |
| 100 | 40 | 0,63/-140,5° | 0,02/41,6° | 36,4/125,0° | 0,61/ -82,0° |
| | 100 | 0,76/-164,8° | 0,02/37,3° | 17,5/102,3° | 0,44/-126,8° |
| | 200 | 0,78/-176,8° | 0,03/46,7° | 9,1/ 90,3° | 0,39/-149,8° |
| | 500 | 0,77/ 168,8° | 0,06/60,3° | 3,8/ 72,6° | 0,38/-164,2° |
| | 800 | 0,76/ 156,7° | 0,09/62,1° | 2,4/ 60,0° | 0,39/-168,6° |
| | 1000 | 0,73/ 149,6° | 0,11/61,7° | 2,0/ 51,2° | 0,40/-170,8° |
| | 1200 | 0,72/ 142,6° | 0,13/60,2° | 1,7/ 44,6° | 0,42/-172,6° |
| 150 | 40 | 0,64/-143,2° | 0,02/41,1° | 37,6/123,9° | 0,60/ -86,5° |
| | 100 | 0,76/-166,0° | 0,02/38,3° | 17,9/101,8° | 0,45/-131,0° |
| | 200 | 0,78/-177,5° | 0,03/48,1° | 9,3/ 90,2° | 0,41/-153,1° |
| | 500 | 0,77/ 168,2° | 0,06/61,2° | 3,9/ 73,1° | 0,40/-167,7° |
| | 800 | 0,76/ 156,3° | 0,09/62,2° | 2,5/ 60,6° | 0,40/-172,0° |
| | 1000 | 0,72/ 149,2° | 0,11/61,5° | 2,0/ 52,2° | 0,41/-174,6° |
| | 1200 | 0,72/ 142,2° | 0,13/59,5° | 1,7/ 45,3° | 0,42/-176,1° |
| 200 | 40 | 0,65/-144,0° | 0,02/40,6° | 38,5/122,8° | 0,60/ -90,2° |
| | 100 | 0,76/-166,7° | 0,02/39,0° | 18,0/101,2° | 0,46/-133,7° |
| | 200 | 0,78/-177,9° | 0,03/49,1° | 9,3/ 89,9° | 0,42/-155,2° |
| | 500 | 0,77/ 168,0° | 0,06/61,6° | 3,9/ 73,3° | 0,41/-169,7° |
| | 800 | 0,76/ 156,1° | 0,09/62,3° | 2,5/ 60,9° | 0,41/-174,0° |
| | 1000 | 0,72/ 149,1° | 0,11/61,5° | 2,1/ 52,8° | 0,42/-175,7° |
| | 1200 | 0,71/ 142,1° | 0,13/59,2° | 1,7/ 45,8° | 0,42/-177,3° |
| 250 | 40 | 0,66/-144,9° | 0,02/40,7° | 38,6/122,1° | 0,60/ -91,6° |
| | 100 | 0,76/-167,0° | 0,02/39,2° | 18,0/100,8° | 0,46/-135,4° |
| | 200 | 0,78/-178,1° | 0,03/49,5° | 9,3/ 89,7° | 0,43/-156,2° |
| | 500 | 0,77/ 167,8° | 0,06/62,0° | 3,9/ 73,2° | 0,42/-170,3° |
| | 800 | 0,76/ 156,1° | 0,09/62,4° | 2,5/ 61,0° | 0,41/-174,8° |
| | 1000 | 0,72/ 148,9° | 0,11/61,5° | 2,0/ 52,6° | 0,41/-177,2° |
| | 1200 | 0,72/ 141,8° | 0,14/58,8° | 1,7/ 45,7° | 0,41/-178,3° |
| 300 | 40 | 0,67/-145,2° | 0,02/40,1° | 38,7/121,3° | 0,59/ -93,3° |
| | 100 | 0,77/-167,3° | 0,02/39,0° | 17,9/100,3° | 0,46/-136,5° |
| | 200 | 0,79/-178,2° | 0,03/49,6° | 9,2/ 89,4° | 0,43/-156,8° |
| | 500 | 0,78/ 167,7° | 0,06/62,0° | 3,9/ 72,9° | 0,42/-170,6° |
| | 800 | 0,76/ 156,1° | 0,09/62,4° | 2,5/ 60,8° | 0,41/-174,7° |
| | 1000 | 0,73/ 148,8° | 0,11/61,4° | 2,0/ 52,5° | 0,41/-177,4° |
| | 1200 | 0,72/ 142,0° | 0,14/59,2° | 1,7/ 45,7° | 0,42/+ 177,4° |

|||||

Conditions for Figs 3 and 4:
 $V_{CE} = 15 \text{ V}$; $I_C = 240 \text{ mA}$;
 $T_{amb} = 25 \text{ }^\circ\text{C}$.

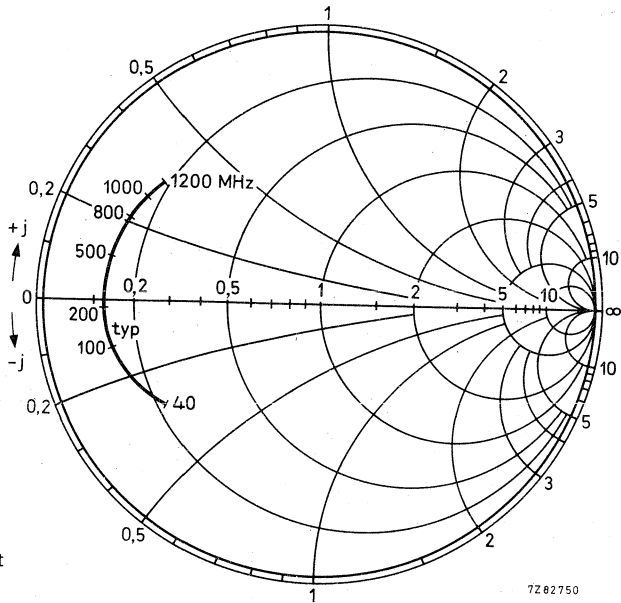


Fig. 3 Input impedance derived from input reflection coefficient s_{ie} co-ordinates in ohm x 50.

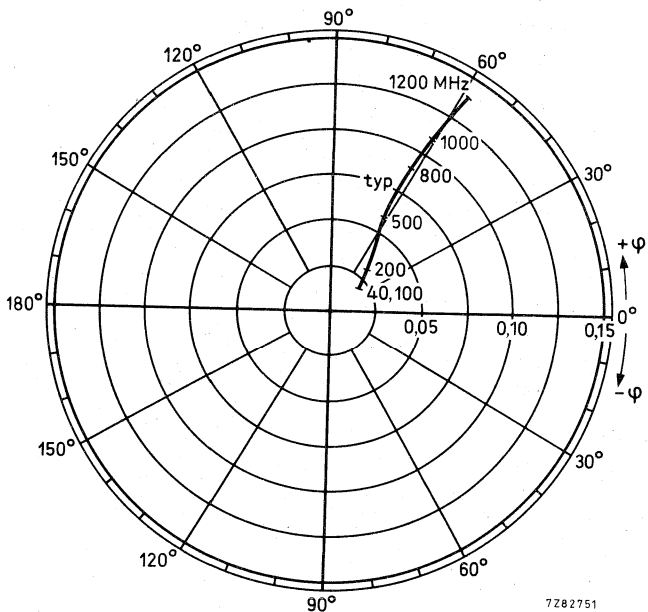


Fig. 4 Reverse transmission coefficient s_{re} .

Conditions for Figs 5 and 6:
 $V_{CE} = 15 \text{ V}$; $I_C = 240 \text{ mA}$;
 $T_{amb} = 25 \text{ }^\circ\text{C}$.

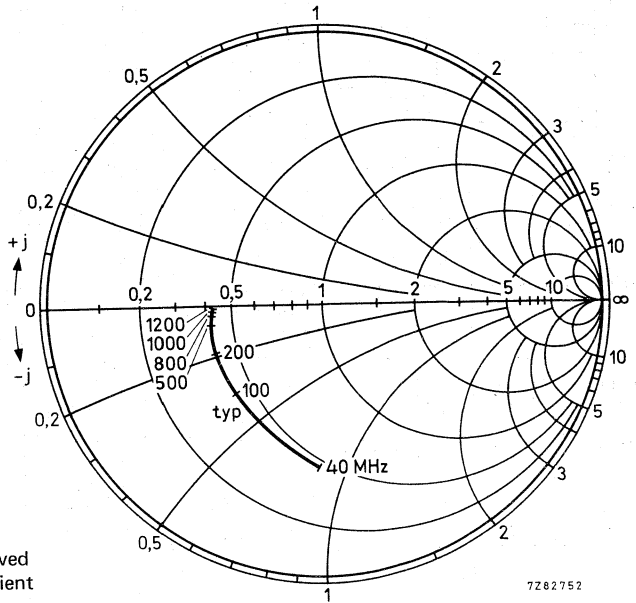


Fig. 5 Output impedance derived from output reflection coefficient s_{oe} co-ordinates in ohm $\times 50$.

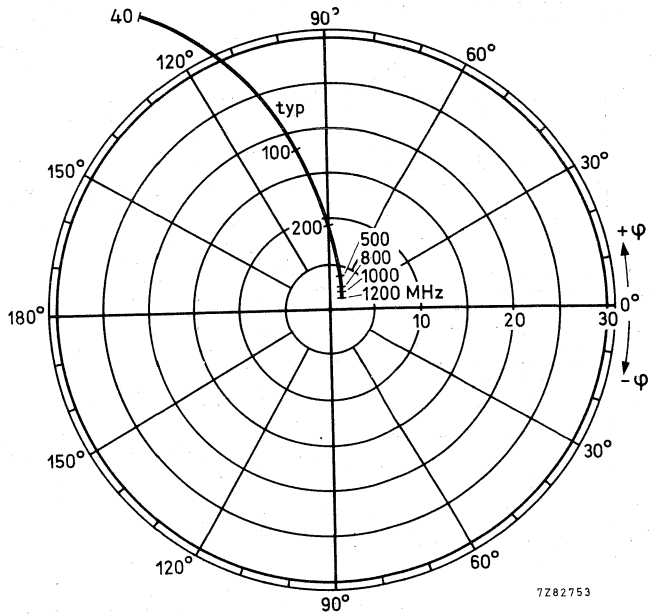


Fig. 6 Forward transmission coefficient s_{fe} .

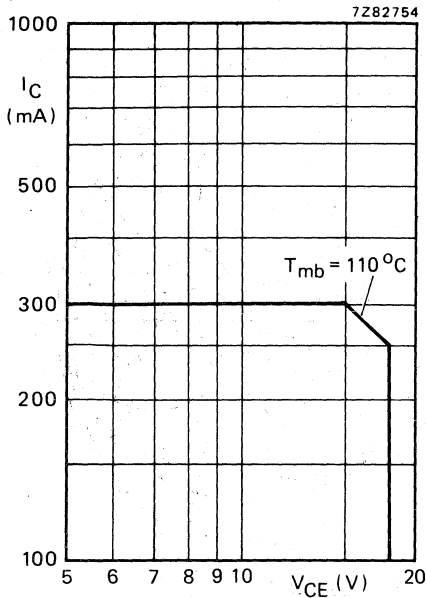


Fig. 7 D.C. SOAR.

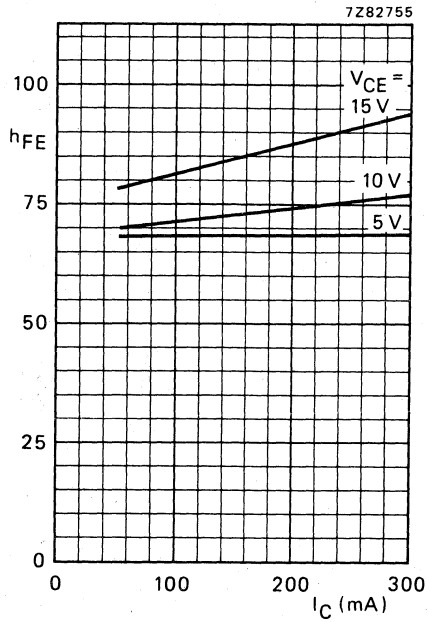


Fig. 8 $T_j = 25^{\circ}\text{C}$; typical values.

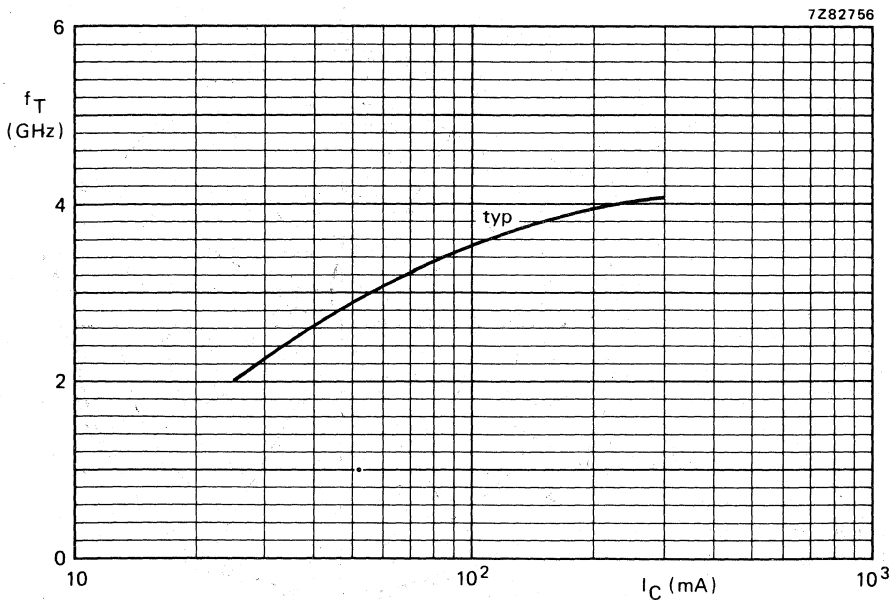


Fig. 9 $V_{CE} = 15\text{ V}$; $f = 500\text{ MHz}$; $T_j = 25^{\circ}\text{C}$.

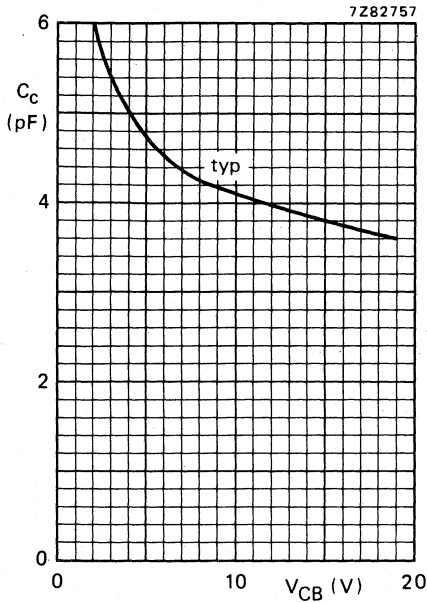


Fig. 10.

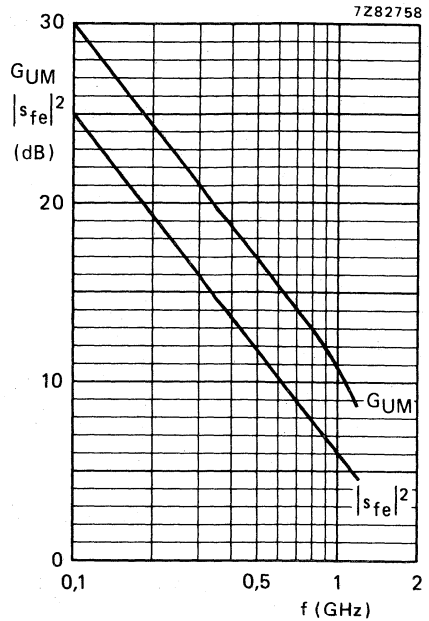


Fig. 11.

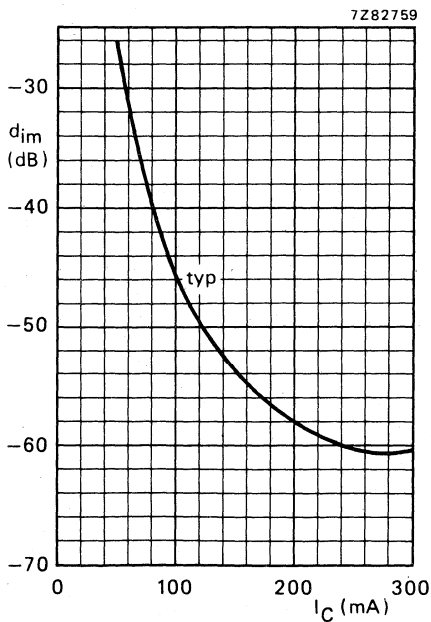


Fig. 12.

Conditions for Figs 10, 11 and 12:

Fig. 10 $I_E = I_e = 0$; $T_{amb} = 25$ °C.

Fig. 11 $V_{CE} = 15$ V; $I_C = 240$ mA;
 $T_{amb} = 25$ °C; typical values.

Fig. 12 $V_{CE} = 15$ V; $V_O = 1,6$ V;
 $f_{(p+q-r)} = 793,25$ MHz; $T_{amb} = 25$ °C;
measured in MATV test circuit (see Fig. 2).

N-P-N SILICON MICROWAVE TRANSISTOR

The BFR49 is a microwave transistor featuring a high transition frequency and low noise. A miniature ceramic encapsulation is used for compatibility with stripline and microwave circuits. It is suitable for amplifiers up to S-band frequencies in instrumentation and microwave systems.

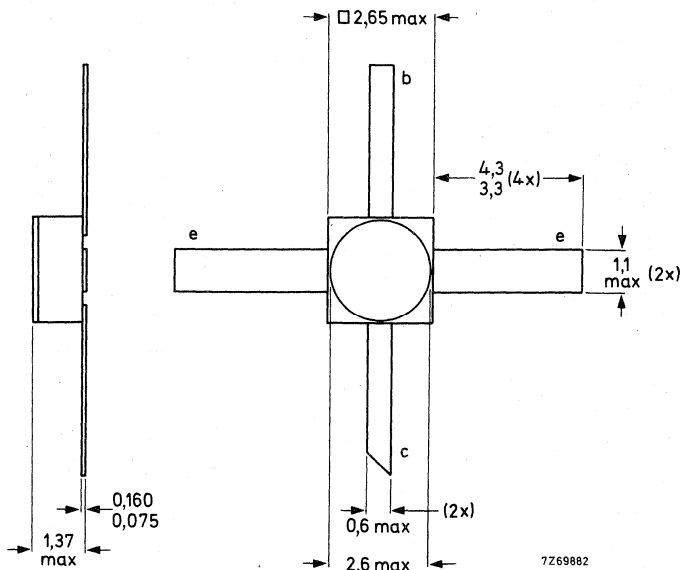
QUICK REFERENCE DATA

| | | | |
|---|--------------|-----|---------|
| Collector-base voltage (open emitter) | V_{CBO} | max | 20 V |
| Collector-emitter voltage (open base) | V_{CEO} | max | 15 V |
| Collector current (d.c.) | I_C | max | 25 mA |
| Total power dissipation up to $T_{amb} = 110\text{ }^\circ\text{C}$ | P_{tot} | max | 180 mW |
| Transition frequency $I_C = 14\text{ mA}; V_{CE} = 10\text{ V}$ | f_T | typ | 5 GHz |
| Noise figure at optimum source impedance $I_C = 2\text{ mA}; V_{CE} = 10\text{ V}; f = 1\text{ GHz}$ | F | typ | 2,5 dB |
| Transducer power gain $I_C = 14\text{ mA}; V_{CE} = 10\text{ V}; f = 1\text{ GHz}$ | $ s_{fe} ^2$ | typ | 15,5 dB |

MECHANICAL DATA

Dimensions in mm

SOT-100



RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|--|-----------|-----|-------------------------|
| Collector-base voltage (open emitter; $I_C = 10 \mu A$) | V_{CBO} | max | 20 V |
| Collector-emitter voltage (open base; $I_C = 10 mA$) | V_{CEO} | max | 15 V |
| Emitter-base voltage (open collector; $I_E = 10 \mu A$) | V_{EBO} | max | 2 V |
| Collector current (d.c.) | I_C | max | 25 mA |
| Total power dissipation up to $T_{amb} = 110 \text{ }^\circ C$ | P_{tot} | max | 180 mW |
| Storage temperature | T_{stg} | | -65 to + 200 $^\circ C$ |
| Junction temperature | T_j | max | 200 $^\circ C$ |

THERMAL RESISTANCE

From junction to ambient in free air
mounted on a fibre-glass print
of 40 mm x 25 mm x 1 mm

$$R_{th j-a} = 0,5 \text{ }^\circ C/mW$$

CHARACTERISTICS

$T_{amb} = 25 \text{ }^\circ C$ unless otherwise specified

Collector cut-off current

$$I_E = 0; V_{CB} = 10 V$$

$$I_{CBO} < 50 \text{ nA}$$

D.C. current gain *

$$I_C = 14 \text{ mA}; V_{CE} = 10 V$$

$$h_{FE} > 25$$

Transition frequency *

$$I_C = 14 \text{ mA}; V_{CE} = 10 V; f = 500 \text{ MHz}$$

$$f_T \text{ typ } 5 \text{ GHz}$$

Collector capacitance at $f = 1 \text{ MHz}$

$$I_E = I_e = 0; V_{CB} = 10 V$$

$$C_c \text{ typ } 0,35 \text{ pF}$$

Emitter capacitance at $f = 1 \text{ MHz}$

$$I_C = I_c = 0; V_{EB} = 0,5 V$$

$$C_e \text{ typ } 1,1 \text{ pF}$$

Feedback capacitance at $f = 1 \text{ MHz}$

$$I_C = 2 \text{ mA}; V_{CE} = 10 V$$

$$C_{re} \text{ typ } 0,3 \text{ pF}$$

Noise figure at optimum source impedance

$$I_C = 2 \text{ mA}; V_{CE} = 10 V; f = 1 \text{ GHz}$$

$$F \text{ typ } 2,5 \text{ dB}$$

$$I_C = 2 \text{ mA}; V_{CE} = 10 V; f = 4 \text{ GHz}$$

$$F \text{ typ } 6,5 \text{ dB}$$

Maximum unilateral power gain (s_{re} assumed to be zero)

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$$I_C = 14 \text{ mA}; V_{CE} = 10 V; f = 1 \text{ GHz}$$

$$G_{UM} \text{ typ } 17,0 \text{ dB}$$

$$I_C = 14 \text{ mA}; V_{CE} = 10 V; f = 4 \text{ GHz}$$

$$G_{UM} \text{ typ } 6,5 \text{ dB}$$

Transducer power gain

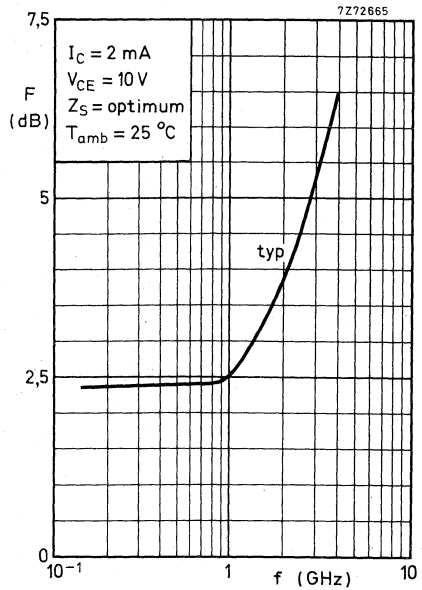
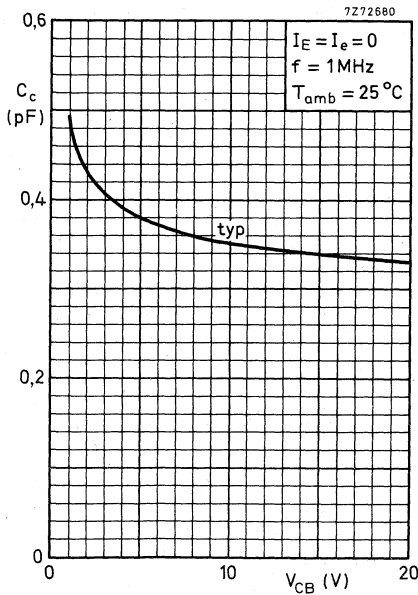
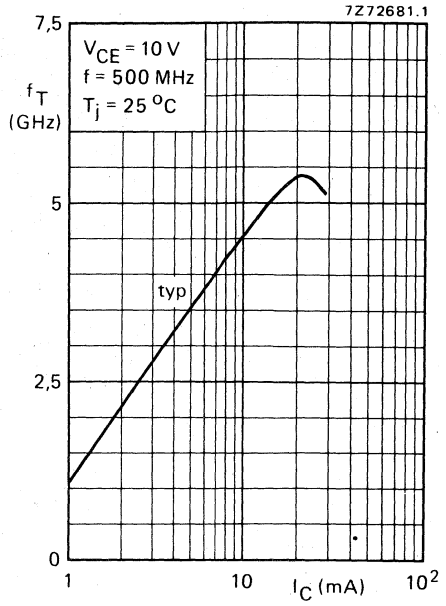
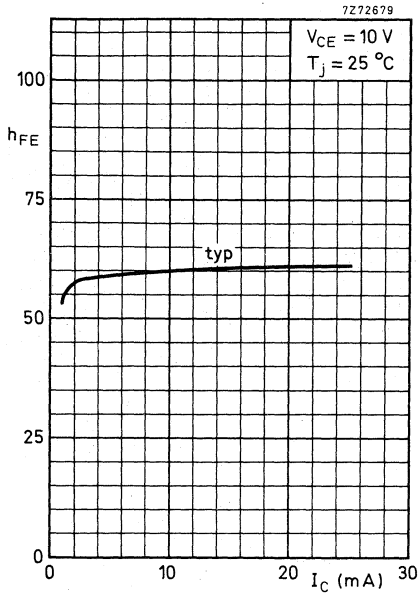
$$I_C = 14 \text{ mA}; V_{CE} = 10 V; f = 1 \text{ GHz}$$

$$|s_{fe}|^2 \text{ typ } 15,5 \text{ dB}$$

$$I_C = 14 \text{ mA}; V_{CE} = 10 V; f = 4 \text{ GHz}$$

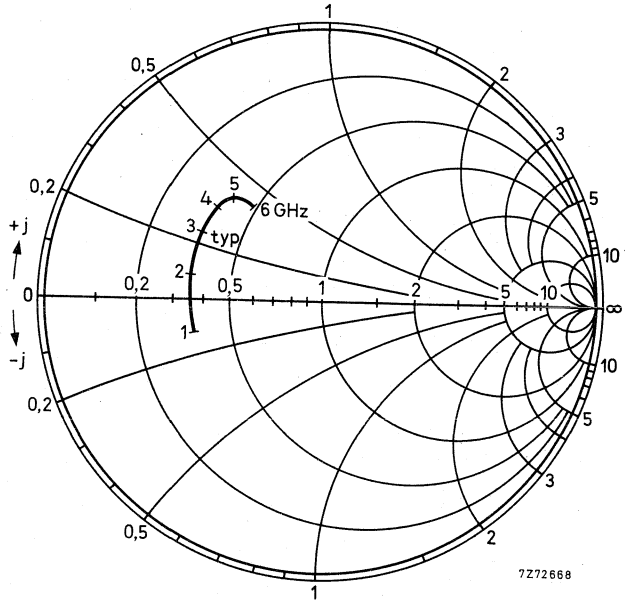
$$|s_{fe}|^2 \text{ typ } 3,5 \text{ dB}$$

* Measured under pulse conditions.

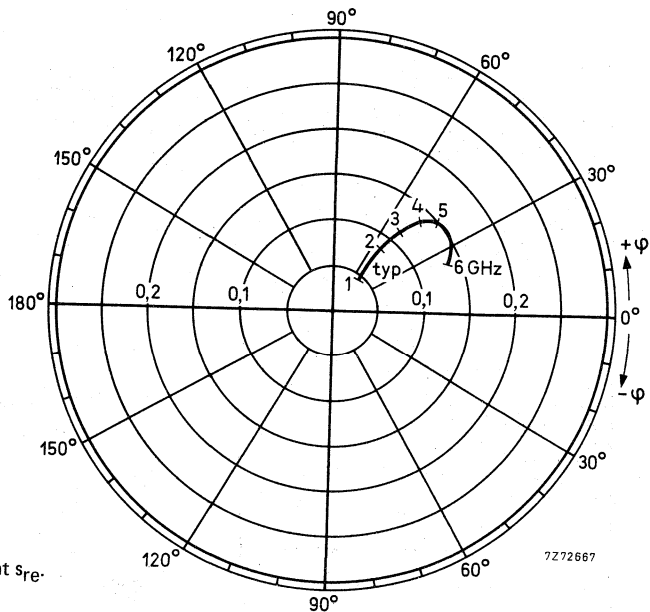


BFR49

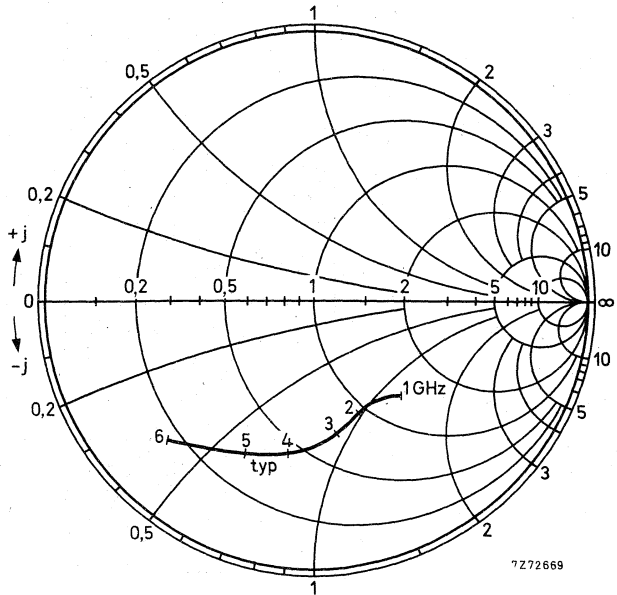
$V_{CE} = 10 \text{ V}$
 $I_C = 14 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$



$V_{CE} = 10 \text{ V}$
 $I_C = 14 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$

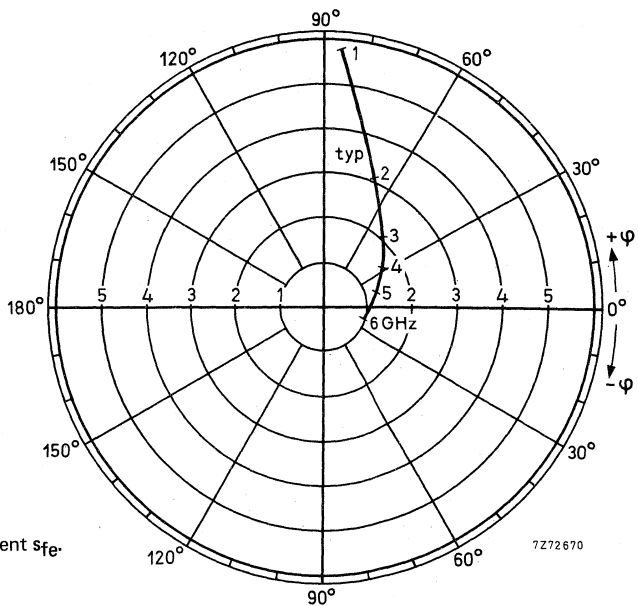


$V_{CE} = 10 \text{ V}$
 $I_C = 14 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$



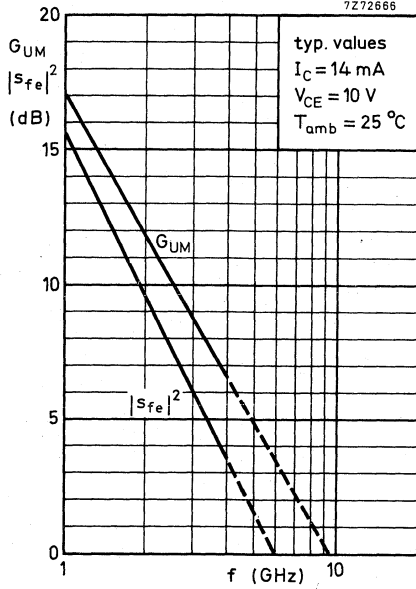
Output impedance derived from output reflection coefficient s_{oe} co-ordinates in ohm x 50.

$V_{CE} = 10 \text{ V}$
 $I_C = 14 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$



Forward transmission coefficient s_{fe} .

7272666



SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N multi-emitter transistor in a capstan envelope. The transistor has extremely good intermodulation properties and high power gain.

The device is primarily intended for:

- a Final and driver stages of channel and band aerial amplifiers with high output power for band I, II, III and IV/V (40-860 MHz).
- b Final and driver stages of wideband amplifiers (40-230 MHz).
- c Final stages of the wideband vertical amplifier in high-speed oscilloscopes.
- d Frequency multiplier and oscillator circuits.

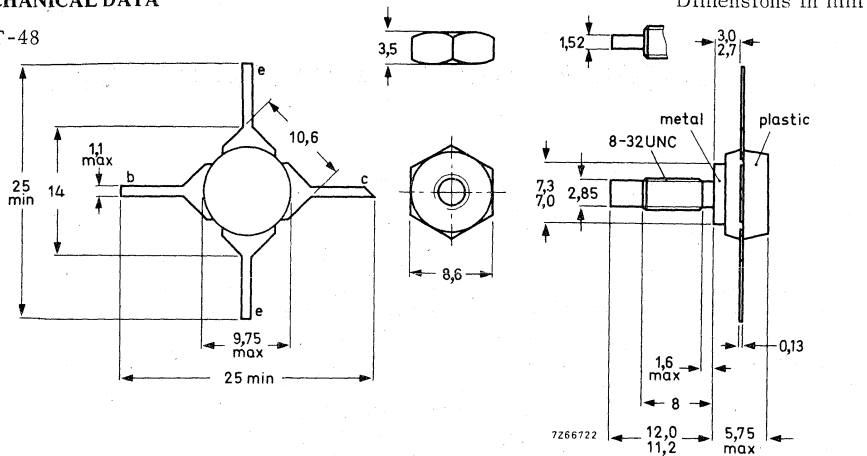
QUICK REFERENCE DATA

| | | | |
|--|------------|------|------------------------|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 40 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 25 V |
| Collector current (peak value) | I_{CM} | max. | 500 mA |
| Total power dissipation up to $T_{mb} = 60\text{ }^{\circ}\text{C}$; $f \geq 1\text{ MHz}$ | P_{tot} | max. | 3,5 W |
| Junction temperature | T_j | max. | 150 $^{\circ}\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 75\text{ mA}$; $V_{CE} = 20\text{ V}$ | f_T | > | 1200 MHz |
| Output power at $f = 200\text{ MHz}$ $I_C = 70\text{ mA}$; $V_{CE} = 20\text{ V}$; $d_{im} = -30\text{ dB}$ | P_o | typ. | 150 mW |
| Power gain at $f = 200\text{ MHz}$ $I_C = 70\text{ mA}$; $V_{CE} = 20\text{ V}$ | G_p | typ. | 16 dB |

MECHANICAL DATA See page 2.

MECHANICAL DATA

SOT-48



When locking is required an adhesive instead of a lock washer is preferred.

Torque on nut: min. 0,75 Nm
(7,5 kg cm)
max. 0,85 Nm
(8,5 kg cm)

Diameter of clearance hole in heatsink: max. 4,17 mm.

Mounting hole to have no burrs at either end.
De-burring must leave surface flat; do not chamfer or countersink either end of hole.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Voltages

| | | | | |
|--|------------|------|-------|----|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 40 V | 1) |
| Collector-emitter voltage ($R_{BE} = 10 \Omega$; peak value) | V_{CERM} | max. | 40 V | 2) |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 25 V | 2) |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 3,5 V | 3) |

Currents

| | | | |
|--|----------|------|--------|
| Collector current (d.c.) | I_C | max. | 200 mA |
| Collector current (peak value) $f > 1$ MHz | I_{CM} | max. | 500 mA |

Power dissipation ($f > 1$ MHz; see SOAR)

| | | | |
|---|-----------|------|-------|
| Total power dissipation up to $T_{mb} = 60^\circ C$ | P_{tot} | max. | 3,5 W |
|---|-----------|------|-------|

Temperatures

| | | | |
|----------------------|-----------|-------------|----------------|
| Storage temperature | T_{stg} | -40 to +150 | $^\circ C$ |
| Junction temperature | T_j | max. | 150 $^\circ C$ |

THERMAL RESISTANCE

| | | | |
|--------------------------------|---------------|---|------------------|
| From junction to mounting base | $R_{th j-mb}$ | = | 25 $^\circ C/W$ |
| From mounting base to heatsink | $R_{th mb-h}$ | = | 0,5 $^\circ C/W$ |

1) at $I_C = 100 \mu A$.

2) at $I_C = 10$ mA.

3) at $I_E = 100 \mu A$.

CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 20\text{ V}$ $I_{CBO} < 10\text{ }\mu\text{A}$

Saturation voltage

$I_C = 100\text{ mA}; I_B = 10\text{ mA}$ $V_{CEsat} < 0,75\text{ V}$

D. C. current gain

$I_C = 50\text{ mA}; V_{CE} = 5\text{ V}$ $h_{FE} > 25$
 $I_C = 150\text{ mA}; V_{CE} = 5\text{ V}$ $h_{FE} > 25$

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 20\text{ V}$ $C_c < 4,5\text{ pF}$

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 10\text{ mA}; V_{CE} = 20\text{ V}; T_{mb} = 25\text{ }^\circ\text{C}$ C_{re} typ. $1,7\text{ pF}$

Noise figure at $f = 200\text{ MHz}$

$I_C = 40\text{ mA}; V_{CE} = 20\text{ V}; R_S = 75\text{ }\Omega; T_{mb} = 25\text{ }^\circ\text{C}$ F typ. 6 dB

Transition frequency at $f = 500\text{ MHz}$

$I_C = 15\text{ mA}; V_{CE} = 20\text{ V}$ f_T typ. 1000 MHz
 $I_C = 75\text{ mA}; V_{CE} = 20\text{ V}$ $f_T > 1200\text{ MHz}$
 $I_C = 150\text{ mA}; V_{CE} = 20\text{ V}$ f_T typ. 1200 MHz

Output power at $f = 200\text{ MHz}; T_{mb} = 25\text{ }^\circ\text{C}$

$I_C = 70\text{ mA}; V_{CE} = 20\text{ V}; V_{SWR}$ at output < 2
 $f_p = 202\text{ MHz}; f_q = 205\text{ MHz}; d_{im} = -30\text{ dB}$
 measured at $f(2q-p) = 208\text{ MHz}$ (channel 9) $P_o > 130\text{ mW}$
typ. 150 mW

Output power at $f = 800\text{ MHz}; T_{mb} = 25\text{ }^\circ\text{C}$

$I_C = 70\text{ mA}; V_{CE} = 20\text{ V}; V_{SWR}$ at output < 2
 $f_p = 798\text{ MHz}; f_q = 802\text{ MHz}; d_{im} = -30\text{ dB}$
 measured at $f(2q-p) = 806\text{ MHz}$ (channel 62) $P_o > 70\text{ mW}$
typ. 90 mW

Power gain (not neutralized) $T_{mb} = 25\text{ }^\circ\text{C}$

$I_C = 70\text{ mA}; V_{CE} = 20\text{ V}; f = 200\text{ MHz}$ $G_p > 15\text{ dB}$
typ. 16 dB
 $I_C = 70\text{ mA}; V_{CE} = 20\text{ V}; f = 800\text{ MHz}$ G_p typ. $6,5\text{ dB}$



CHARACTERISTICS (continued)

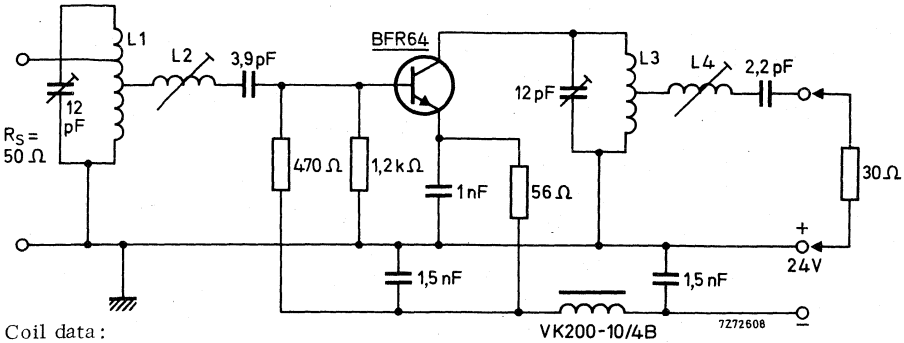
Intermodulation characteristics

1. Output power at $f = 200$ MHz; $T_{mb} = 25$ °C

$I_C = 70$ mA; $V_{CE} = 20$ V; VSWR at output < 2

$f_p = 202$ MHz; $f_q = 205$ MHz; $d_{im} = -30$ dB
measured at $f(2q-p) = 208$ MHz (channel 9)

Test circuit:



Coil data:

L1 = 3 turns silver-plated Cu wire (1,4 mm); winding pitch 2,7 mm; int. dia. 8 mm; taps at 0,5 turn and 1,5 turns from earth.

L2 = 5,5 turns silver-plated Cu wire (1,4 mm); winding pitch 2,2 mm; int. dia. 8 mm

L3 = 3 turns silver-plated Cu wire (1,4 mm); winding pitch 3,3 mm; int. dia. 8 mm

L4 = 5,5 turns silver-plated Cu wire (1,4 mm); winding pitch 2,2 mm; int. dia. 11 mm

CHARACTERISTICS (continued)**Basis of adjustment**

The intermodulation at an intermodulation distortion of -30 dB is caused by h. f. output current-voltage clipping.

The maximum undistorted output power is realized, if

- a. Current and voltage clipping take place concurrently.

This occurs if

$$R_L = \frac{V_{CE} - V_{CEK}}{I_C},$$

in which V_{CEK} is the high-frequency knee voltage.

- b. The h. f. collector current is as small as possible.

This is so if $-C_L = +C_{oe}$,

in which C_{oe} is the output capacitance of the transistor at short-circuited input.

For maximum output power at an intermodulation distortion of -30 dB, the (experimentally found) values of R_L and C_L are:

$R_L = 220 \Omega$; $C_L = -4 \text{ pF}$.

Adjustment procedure

1. Remove the transistor and connect a dummy consisting of a 220Ω resistor in parallel with a 4 pF capacitor between the collector and emitter connections of the output circuit.
2. Tune and match the output circuit for zero reflection at 205 MHz ($V_{SWR} = 1$). After this adjustment, no further change may be made in the output circuit.
3. Replace the dummy by the transistor. Tune and match the input circuit for maximum power gain and good band-pass curve. The V_{SWR} of the output will then, in most cases, be ≤ 2 over the whole channel. Corrections can be made by tuning L2; this will not disturb the band-pass curve.

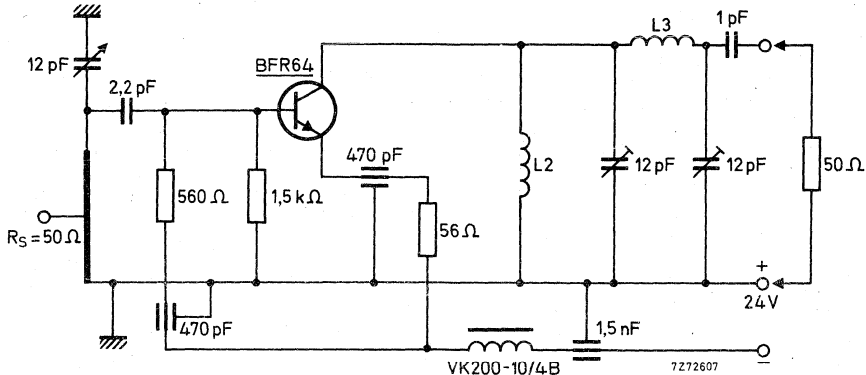
CHARACTERISTICS (continued)

Intermodulation characteristics

2. Output power at $f = 800$ MHz; $T_{mb} = 25$ °C

$I_C = 70$ mA; $V_{CE} = 20$ V; VSWR at output < 2
 $f_p = 798$ MHz; $f_q = 802$ MHz; $d_{im} = -30$ dB
 measured at $f(2q-p) = 806$ MHz (channel 62)

Test circuit:



Coil data:

L1 = 25 mm x 7 mm x 0,85 mm silver-plated Cu strip

Tap of the input at 5 mm from earth.

L2 = 13 turns enamelled Cu wire (0,6 mm); int. dia. 8 mm

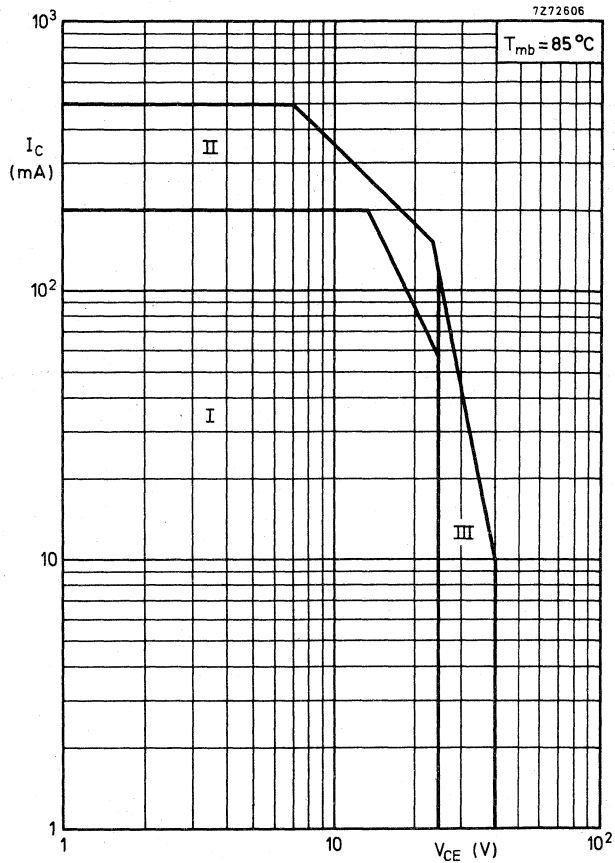
L3 = 1,5 turns Cu wire (1,3 mm); int. dia. 8 mm

Basis of adjustment

At 800 MHz no dummy can be used to adjust for optimum collector load because at these frequencies the impedance transformations of a dummy are too high. A small signal at the mid-channel frequency of 802 MHz is fed to the input and increased until clipping occurs; that is, until the output power no longer increases linearly with the input signal. This clipping can be eliminated by tuning the output circuit, thereby making the output power equal to

$$P_o = \frac{I_C(V_{CE} - V_{CEK})}{2} = 480 \text{ mW.}$$

The output circuit is adjusted for minimum intermodulation if the input signal is as small as possible at $P_o = 480$ mW. With this adjusting method, care must be taken that the transistor is not damaged by second breakdown (the voltage swing may not exceed the rated V_{CER} value). Therefore as soon as clipping occurs, the increase of the input signal should be stopped until the clipping has been eliminated. After this adjustment has been made no further change may be made in the output circuit. Adjust the input circuit for maximum power gain and good band-pass curve. The VSWR of the output is then ≤ 2 over the whole channel.

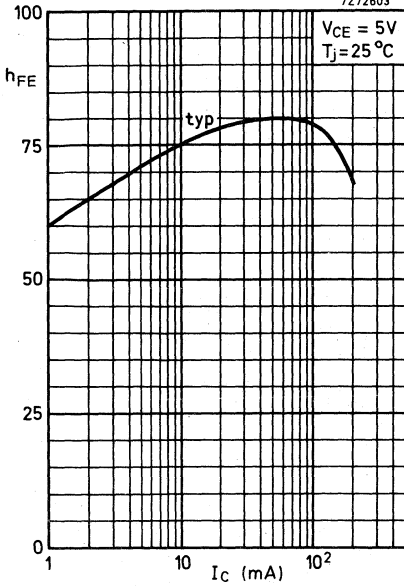


Safe Operating Area with the transistor forward biased

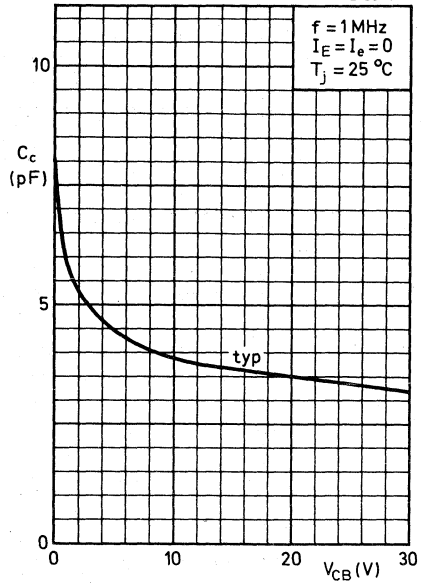
- I Region of permissible d.c. operation
- II Permissible extension for repetitive pulse operation; $f > 1$ MHz
- III Repetitive pulse operation in this region is allowable, provided $R_{BE} < 10 \Omega$ and $f > 1$ MHz

BFR64

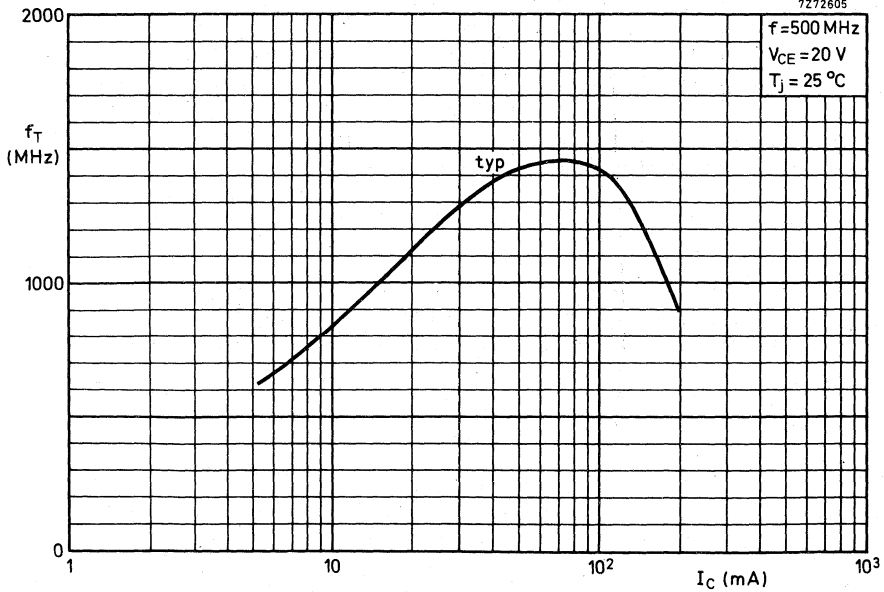
7272603



7272604



7272605



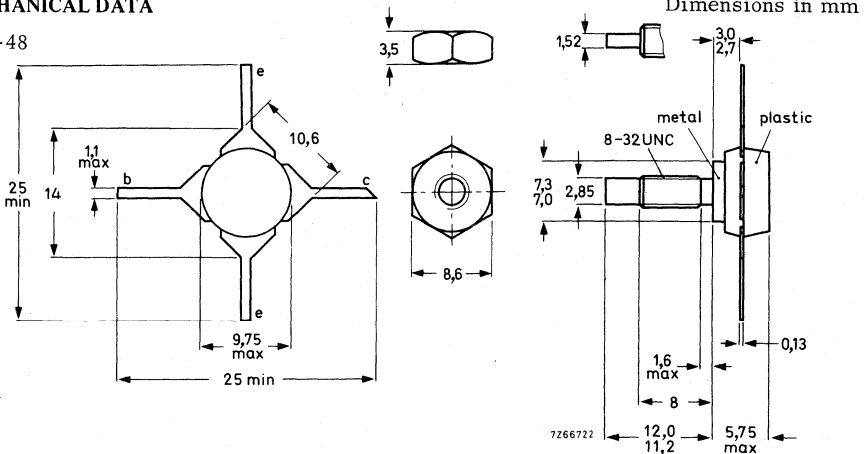
SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N multi-emitter silicon transistor in a capstan envelope. The transistor has extremely good intermodulation properties and high power gain. The device is primarily intended for channel amplifiers in aerial amplifier systems as well as other applications where an excellent f_T linearity and higher signal handling capabilities than available in existing devices are required.

| QUICK REFERENCE DATA | | | |
|---|---------------|------|----------|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 40 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 25 V |
| Collector current (peak value) | I_{CM} | max. | 1000 mA |
| Junction temperature | T_j | max. | 200 °C |
| Thermal resistance from junction to mounting base | $R_{th j-mb}$ | = | 15 °C/W |
| Transition frequency at $f = 500$ MHz $I_C = 200$ mA; $V_{CE} = 20$ V | f_T | > | 1200 MHz |
| Output power at $f = 200$ MHz $I_C = 200$ mA; $V_{CE} = 20$ V; $d_{im} = -30$ dB | P_o | typ. | 450 mW |
| Power gain at $f = 200$ MHz $I_C = 200$ mA; $V_{CE} = 20$ V | G_p | typ. | 19 dB |

MECHANICAL DATA

SOT-48



When locking is required an adhesive instead of a lock washer is preferred.

Torque on nut: min. 0,75 Nm
(7,5 kg cm)
0,85 Nm
(8,5 kg cm)

Diameter of clearance hole in heatsink: max. 4,17 mm.

Mounting hole to have no burrs at either end. De-burring must leave surface flat; do not chamfer or countersink either end of hole.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

| | | | |
|--|-----------------|-----|---|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} max. | 40 | V |
| Collector-emitter voltage ($R_{BE} = 10 \Omega$; peak value) | V_{CERM} max. | 40 | V |
| Collector-emitter voltage (open base) | V_{CEO} max. | 25 | V |
| Emitter-base voltage (open collector) | V_{EBO} max. | 3.5 | V |

Currents

| | | | |
|--|---------------|------|----|
| Collector current (d. c.) | I_C max. | 400 | mA |
| Collector current (peak value) $f > 1$ MHz | I_{CM} max. | 1000 | mA |

Power dissipation

Total power dissipation up to $T_{mb} = 125^\circ\text{C}$

See also page 6

| | | |
|----------------|---|---|
| P_{tot} max. | 5 | W |
|----------------|---|---|

Temperatures

| | | | |
|----------------------|------------|-------------|------------------|
| Storage temperature | T_{stg} | -65 to +200 | $^\circ\text{C}$ |
| Junction temperature | T_j max. | 200 | $^\circ\text{C}$ |

THERMAL RESISTANCE

| | | | | |
|--------------------------------|----------------|---|-----|---------------------------|
| From junction to mounting base | $R_{th\ j-mb}$ | = | 15 | $^\circ\text{C}/\text{W}$ |
| From mounting base to heatsink | $R_{th\ mb-h}$ | = | 0.5 | $^\circ\text{C}/\text{W}$ |



CHARACTERISTICS

$T_j = 25^\circ\text{C}$ unless otherwise specified

Breakdown voltages

| | | | | |
|--|--------------------------------|---|-----|---|
| Collector-base voltage open emitter, $I_C = 1\text{ mA}$ | $V_{(BR)CBO}$ | > | 40 | V |
| Collector-emitter voltage $R_{BE} = 10\ \Omega$, $I_C = 5\text{ mA}$ open base, $I_C = 5\text{ mA}$ | $V_{(BR)CER}$ $V_{(BR)CEO}$ | > | 40 | V |
| Emitter-base voltage open collector; $I_E = 1\text{ mA}$ | $V_{(BR)EBO}$ | > | 3.5 | V |

Collector cut-off current

| | | | | |
|------------------------------------|-----------|---|-----|---------------|
| $I_E = 0$; $V_{CB} = 20\text{ V}$ | I_{CBO} | < | 100 | μA |
|------------------------------------|-----------|---|-----|---------------|

Saturation voltage

| | | | | |
|--|-------------|---|------|---|
| $I_C = 200\text{ mA}$; $I_B = 20\text{ mA}$ | V_{CEsat} | < | 0.75 | V |
|--|-------------|---|------|---|

D.C. current gain

| | | | | |
|--|----------|---|----|--|
| $I_C = 200\text{ mA}$; $V_{CE} = 20\text{ V}$ | h_{FE} | > | 30 | |
| $I_C = 400\text{ mA}$; $V_{CE} = 20\text{ V}$ | h_{FE} | > | 20 | |

Collector capacitance at $f = 1\text{ MHz}$

| | | | | |
|--|-------|---|----|----|
| $I_E = I_e = 0$; $V_{CB} = 20\text{ V}$ | C_c | < | 10 | pF |
|--|-------|---|----|----|

Feedback capacitance at $f = 1\text{ MHz}$

| | | | | |
|---|----------|------|-----|----|
| $I_C = 10\text{ mA}$; $V_{CE} = 20\text{ V}$; $T_{mb} = 25^\circ\text{C}$ | C_{re} | typ. | 3.5 | pF |
|---|----------|------|-----|----|

Collector-stud capacitance

| | | | | |
|--|----------|------|---|----|
| | C_{cs} | typ. | 2 | pF |
|--|----------|------|---|----|

Transition frequency at $f = 500\text{ MHz}$

| | | | | |
|--|-------|---|------|-----|
| $I_C = 200\text{ mA}$; $V_{CE} = 20\text{ V}$ | f_T | > | 1200 | MHz |
| $I_C = 400\text{ mA}$; $V_{CE} = 20\text{ V}$ | f_T | > | 1000 | MHz |

Output power at $f = 200\text{ MHz}$; $T_{mb} = 25^\circ\text{C}$

| | | | | |
|---|-------|------|-----|----|
| $I_C = 200\text{ mA}$; $V_{CE} = 20\text{ V}$; V.S.W.R. at output < 2 $f_p = 202\text{ MHz}$; $f_q = 205\text{ MHz}$; $d_{im} = -30\text{ dB}$ measured at $f(2q-p) = 208\text{ MHz}$ (channel 9) | P_o | typ. | 450 | mW |
|---|-------|------|-----|----|

Power gain (not neutralized) $T_{mb} = 25^\circ\text{C}$

| | | | | |
|---|-------|------|-----|----|
| $I_C = 200\text{ mA}$; $V_{CE} = 20\text{ V}$; $f = 200\text{ MHz}$ | G_p | > | 15 | dB |
| | | typ. | 19 | dB |
| $I_C = 200\text{ mA}$; $V_{CE} = 20\text{ V}$; $f = 800\text{ MHz}$ | G_p | typ. | 4.5 | dB |



CHARACTERISTICS (continued)

Intermodulation characteristics

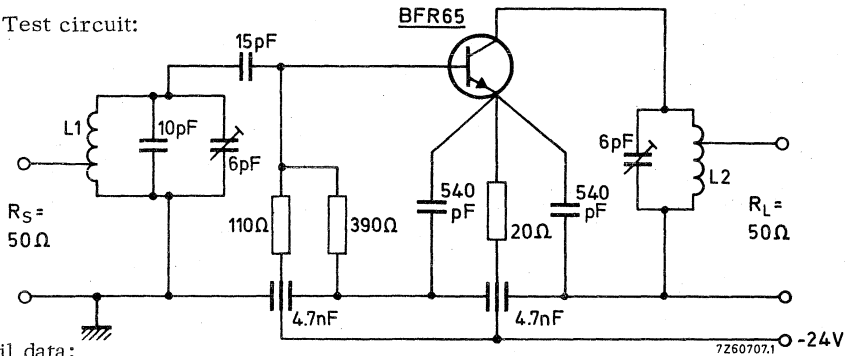
1. Output power at $f = 200$ MHz; $T_{mb} = 25$ °C

$I_C = 200$ mA; $V_{CE} = 20$ V; V.S.W.R. at output < 2

$f_p = 202$ MHz; $f_q = 205$ MHz; $d_{im} = -30$ dB

measured at $f(2q-p) = 208$ MHz (channel 9)

Test circuit:



Coil data:

L1 = 1 turn silver plated Cu wire (1.4 mm); int. diam. 8 mm; tap at 0.75 turn from earth.

L2 = 3 turns silver plated Cu wire (1.4 mm); int. diam. 8 mm; winding pitch 2.7 mm; tap at 2.5 turns from earth.

CHARACTERISTICS (continued)

Basis of adjustment

The intermodulation at an intermodulation distortion of -30 dB is caused by h. f. output current - voltage clipping.

The maximum undistorted output power is realised, if

- a. Current and voltage clipping take place concurrently.

This occurs if

$$R_L = \frac{V_{CE} - V_{CEK}}{I_C},$$

in which V_{CEK} is the high frequency knee voltage.

- b. The h. f. collector current is as small as possible.

This is so if $-C_L = +C_{Oe}$,

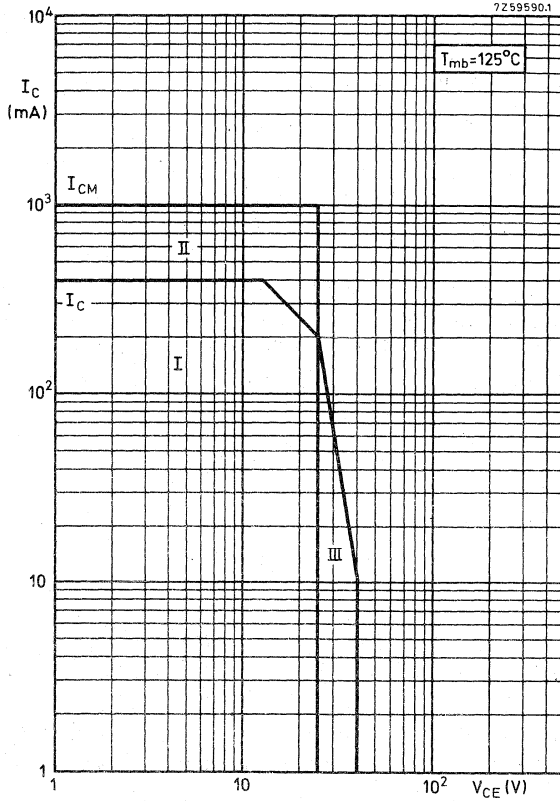
in which C_{Oe} is the output capacitance of the transistor at short circuited input.

For maximum output power at an intermodulation distortion of -30 dB, the (experimentally found) values of R_L and C_L are:

$R_L = 91 \Omega$; $C_L = -6.8 \text{ pF}$.

Adjustment procedure

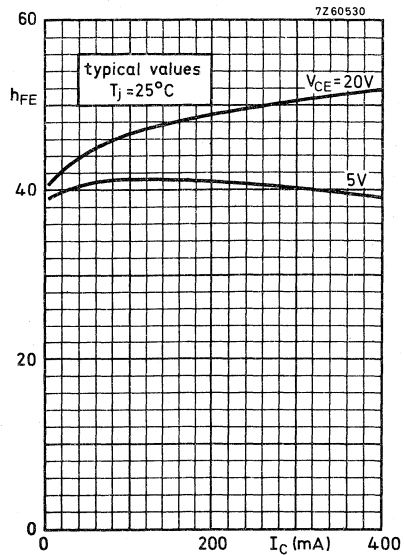
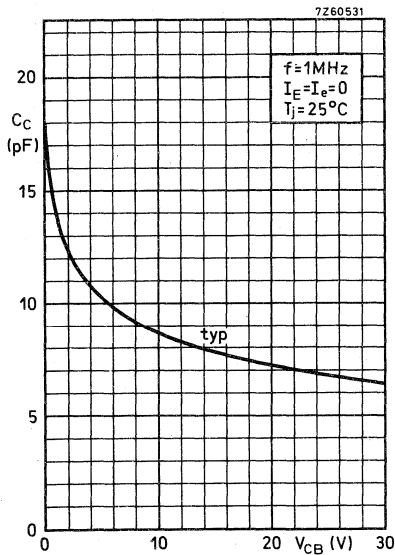
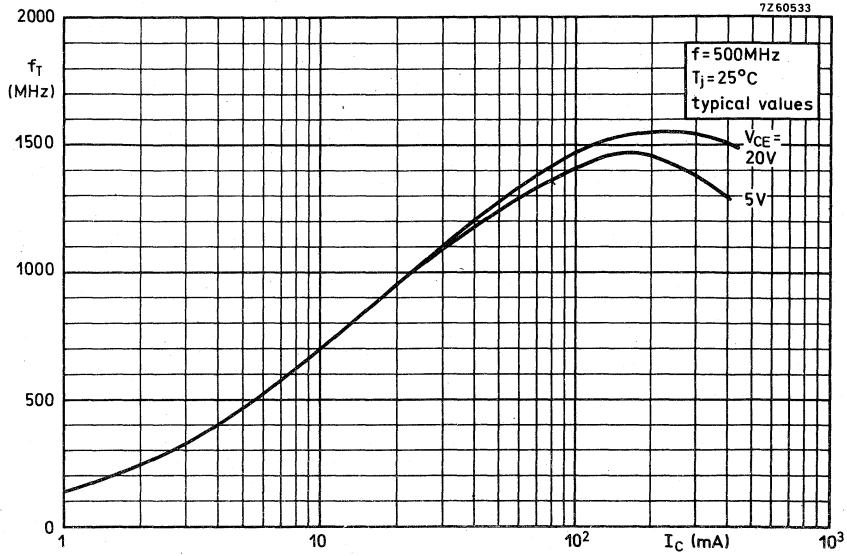
1. Remove the transistor and connect a dummy consisting of a 91Ω resistor in parallel with a 6.8 pF capacitor between the collector and emitter connections of the output circuit.
2. Tune and match the output circuit for zero reflection at 205 MHz (V.S.W.R. = 1). After this adjustment, no further change may be made in the output circuit.
3. Replace the dummy by the transistor. Tune and match the input circuit for maximum power gain and good band pass curve.
The V.S.W.R. of the output will then, in most cases, be ≤ 2 over the whole channel.



Safe Operating Area with the transistor forward biased

- I Region of permissible d. c. operation
- II Permissible extension for repetitive pulse operation; $f > 1\text{MHz}$
- III Repetitive pulsed operation in this region is allowable, provided $f > 1\text{MHz}$; $R_{BE} < 10 \Omega$

BFR65



SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a subminiature plastic transfer-moulded T-package.

It is primarily intended for use in u.h.f. and microwave amplifiers such as in aerial amplifiers, radar systems, oscilloscopes, spectrum analysers etc.

The transistor features low intermodulation distortion and high power gain; thanks to its very high transition frequency, it also has excellent wideband properties and low noise up to high frequencies.

QUICK REFERENCE DATA

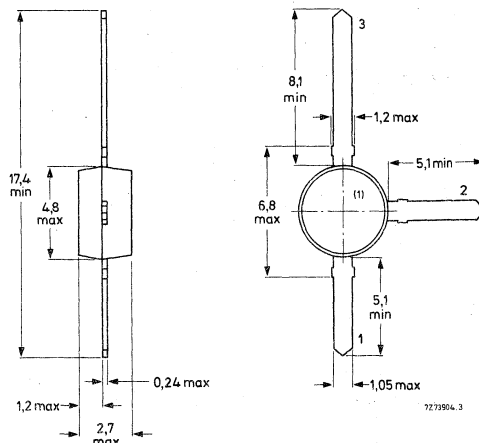
| | | | | |
|--|-----------|------|------|------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 20 | V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 | V |
| Collector current (d. c.) | I_C | max. | 25 | mA |
| Total power dissipation up to $T_{amb} = 60\text{ }^\circ\text{C}$ | P_{tot} | max. | 180 | mW |
| Junction temperature | T_j | max. | 150 | $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 14\text{ mA}$; $V_{CE} = 10\text{ V}$ | f_T | typ. | 5 | GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $I_C = 0$; $V_{CE} = 10\text{ V}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | C_{re} | typ. | 0,4 | pF |
| Noise figure at optimum source impedance $I_C = 2\text{ mA}$; $V_{CE} = 10\text{ V}$; $f = 500\text{ MHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | | typ. | 2,4 | dB |
| Max. unilateral power gain (see page 3) $I_C = 14\text{ mA}$; $V_{CE} = 10\text{ V}$; $f = 500\text{ MHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | GUM | typ. | 19,5 | dB |
| Intermodulation distortion at $T_{amb} = 25\text{ }^\circ\text{C}$ $I_C = 14\text{ mA}$; $V_{CE} = 10\text{ V}$; $R_L = 75\text{ }\Omega$; $V_o = 150\text{ mV}$ | | | | |
| $f(p + q - r) = 493,25\text{ MHz}$ (see page 4) | dim | typ. | -60 | dB |

MECHANICAL DATA

Fig. 1 SOT-37.

Connections

1. Base
2. Emitter
3. Collector



Dimensions in mm

(1) = type number marking.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Voltages

| | | | | |
|---------------------------------------|-----------|------|-----|---|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 20 | V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 | V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2,0 | V |

Current

| | | | | |
|---------------------------|-------|------|----|----|
| Collector current (d. c.) | I_C | max. | 25 | mA |
|---------------------------|-------|------|----|----|

Power dissipation

| | | | | |
|--|-----------|------|-----|----|
| Total power dissipation up to $T_{amb} = 60\text{ }^\circ\text{C}$ | P_{tot} | max. | 180 | mW |
|--|-----------|------|-----|----|

Temperatures

| | | | |
|----------------------|-----------|-------------|----------------------|
| Storage temperature | T_{stg} | -65 to +150 | $^\circ\text{C}$ |
| Junction temperature | T_j | max. | 150 $^\circ\text{C}$ |

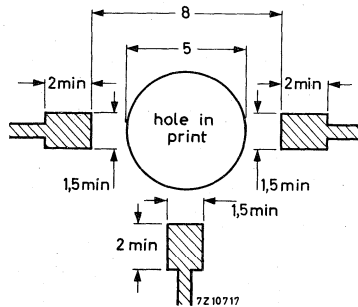
THERMAL RESISTANCE

From junction to ambient in free air
 mounted on a glass-fibre print *)
 of 40 mm x 25 mm x 1 mm

$$R_{th\ j-a} = 0,5\text{ }^\circ\text{C/mW}$$

*) Requirements for glas-fibre print

(dimensions in mm)



CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 10\text{ V}$ $I_{CBO} < 50\text{ nA}$

D. C. current gain ¹⁾

$I_C = 14\text{ mA}; V_{CE} = 10\text{ V}$ $h_{FE} > 40$ ←
typ. 90

Transition frequency at $f = 500\text{ MHz}$ ¹⁾

$I_C = 14\text{ mA}; V_{CE} = 10\text{ V}$ f_T typ. 5 GHz

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 10\text{ V}$ C_c typ. 0,5 pF

Emitter capacitance at $f = 1\text{ MHz}$

$I_C = I_c = 0; V_{EB} = 0,5\text{ V}$ C_e typ. 1,2 pF ←

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 0; V_{CE} = 10\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$ C_{re} typ. 0,4 pF ← 

Noise figure at optimum source impedance

$I_C = 2\text{ mA}; V_{CE} = 10\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ F typ. 2,4 dB

Max. unilateral power gain (s_{re} assumed to be zero)

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$I_C = 14\text{ mA}; V_{CE} = 10\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ G_{UM} typ. 19,5 dB

¹⁾ Measured under pulse conditions.

CHARACTERISTICS (continued)

Intermodulation distortion at $T_{amb} = 25^{\circ}C$

$$I_C = 14 \text{ mA}; V_{CE} = 10 \text{ V}; R_L = 75 \Omega; V.S.W.R. < 2$$

$$V_p = V_o = 150 \text{ mV at } f_p = 493, 25 \text{ MHz}$$

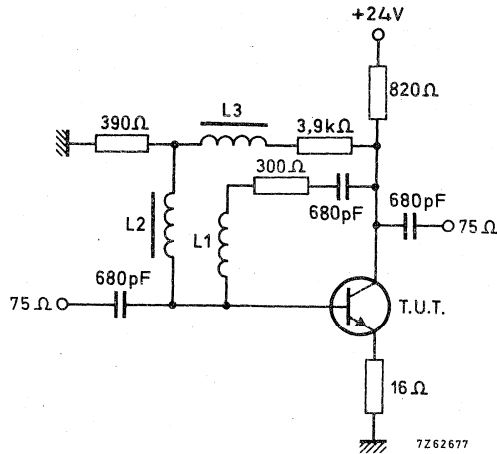
$$V_q = V_o - 6 \text{ dB at } f_q = 503, 25 \text{ MHz}$$

$$V_r = V_o - 6 \text{ dB at } f_r = 505, 25 \text{ MHz}$$

Measured at $f_{(p+q-r)} = 493, 25 \text{ MHz}$

d_{im} typ. -60 dB

Intermodulation test circuit:



L1 = 4 turns Cu wire (0,35 mm); winding pitch 1 mm; int. diam. 4 mm
 L2 and L3 5μH (code number: 3122 108 20150)

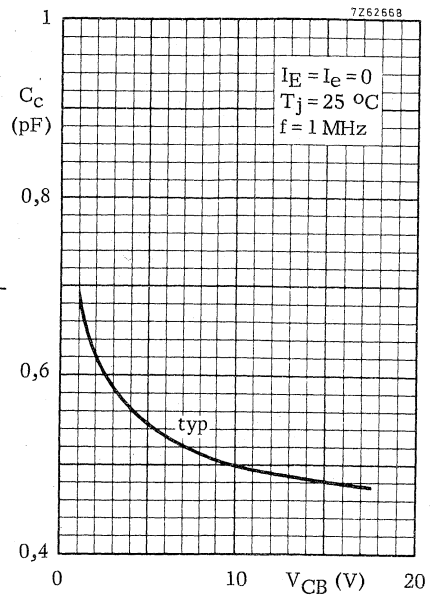
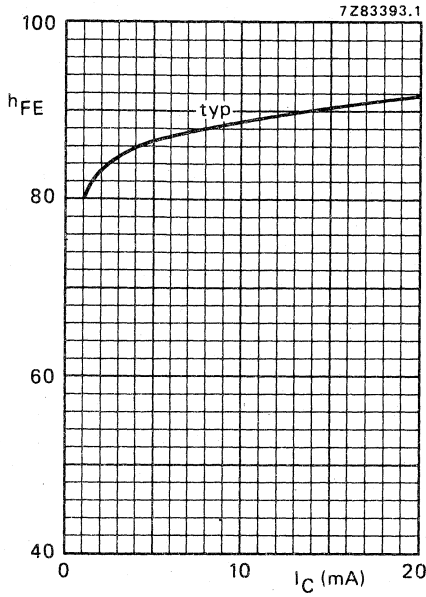
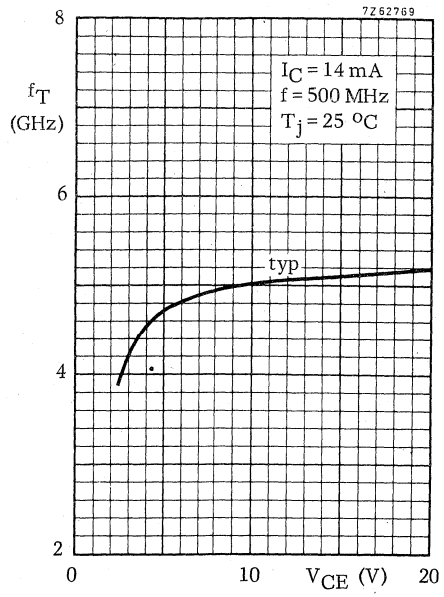
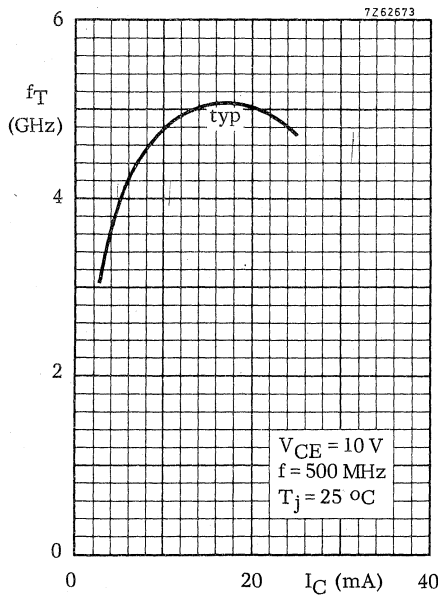
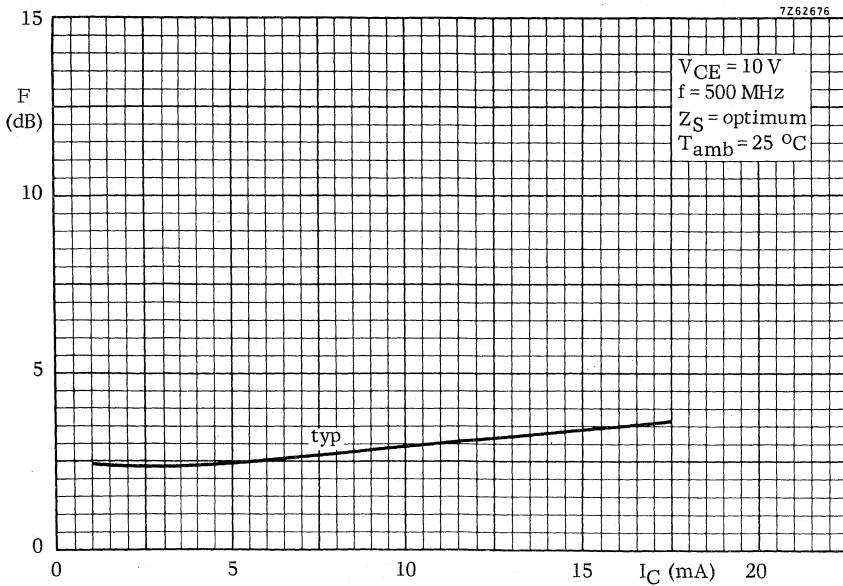
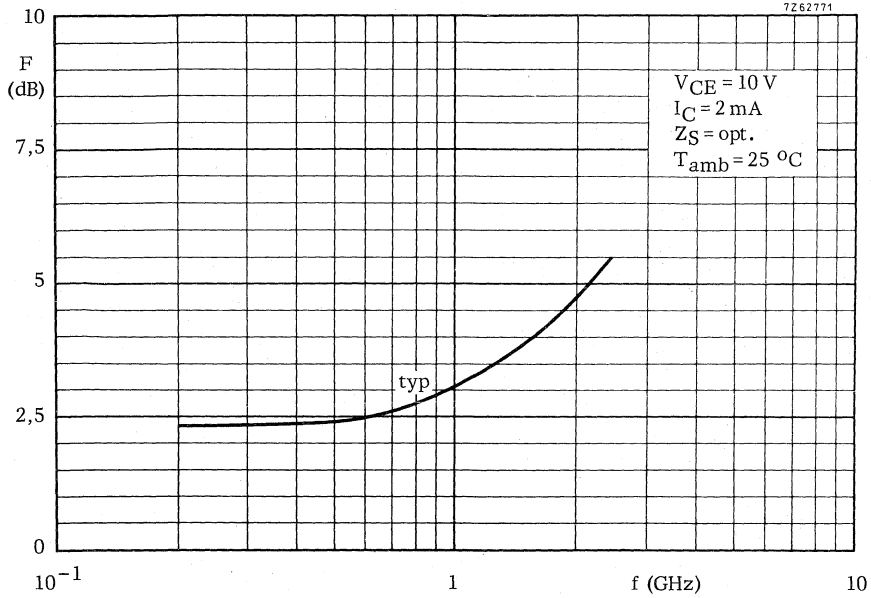


Fig. 4 $V_{CE} = 10\text{ V}$; $T_j = 25\text{ }^\circ\text{C}$.





circles of constant noise figure

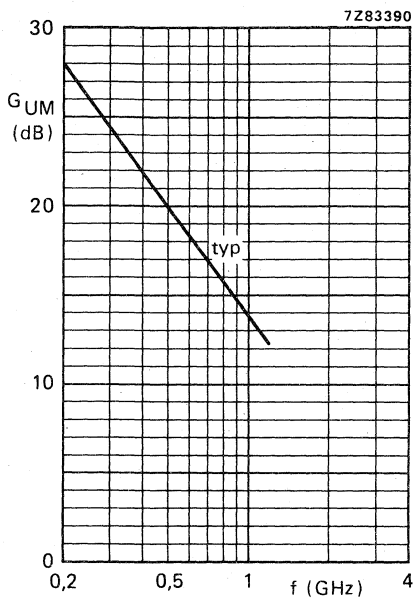
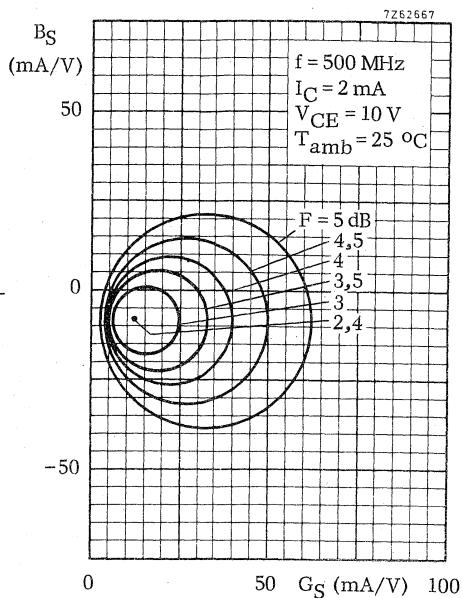


Fig. 10 $V_{CE} = 10 \text{ V}$; $I_C = 14 \text{ mA}$;
 $T_{amb} = 25 \text{ }^\circ\text{C}$.



SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a subminiature plastic transfer-moulded T-package primarily intended for use in v.h.f. and u.h.f. wideband amplifiers.

Features of this product:

- low noise;
- low intermodulation distortion;
- high power gain;
- gold metallization.

QUICK REFERENCE DATA

| | | | |
|--|-----------|------|----------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 20 V |
| Collector-emitter voltage (open-base) | V_{CEO} | max. | 15 V |
| Collector current (d.c.) | I_C | max. | 25 mA |
| Total power dissipation up to $T_{amb} = 60\text{ }^\circ\text{C}$ | P_{tot} | max. | 180 mW |
| Junction temperature | T_j | max. | 150 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 14\text{ mA}; V_{CE} = 10\text{ V}$ | f_T | typ. | 5 GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $I_C = 0; V_{CE} = 10\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$ | C_{re} | typ. | 0,35 pF |
| Noise figure at $R_S = 60\text{ }\Omega$ $I_C = 4\text{ mA}; V_{CE} = 10\text{ V}; f = 800\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | F | typ. | 1,8 dB |
| Output voltage at $d_{im} = -60\text{ dB}$ (see Fig. 3) $I_C = 14\text{ mA}; V_{CE} = 10\text{ V}; R_L = 75\text{ }\Omega; T_{amb} = 25\text{ }^\circ\text{C}$ $f_{(p+q-r)} = 793,25\text{ MHz}$ | V_o | typ. | 150 mV |

MECHANICAL DATA

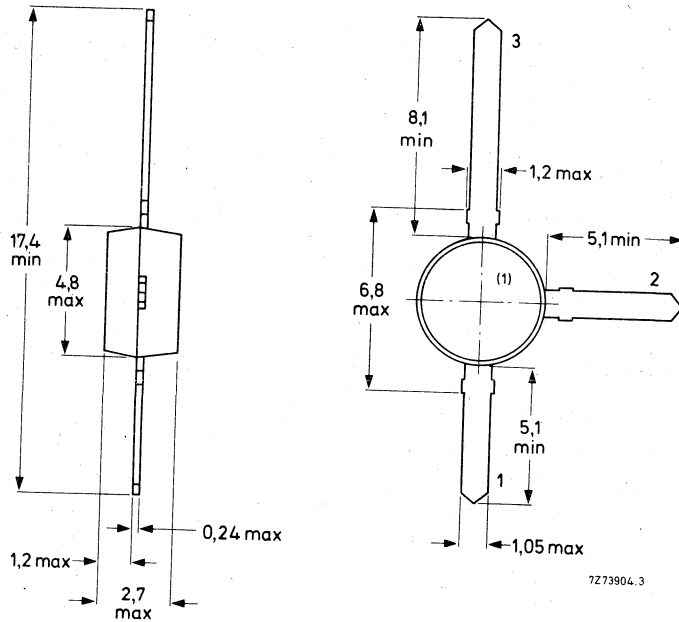
SOT-37 (see Fig. 1).

MECHANICAL DATA

Fig. 1 SOT-37.

- Connections
 1. Base
 2. Emitter
 3. Collector

Dimensions in mm



(1) = type number marking.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|--|-----------|------|---------------------------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 20 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2,0 V |
| Collector current (d.c.) | I_C | max. | 25 mA |
| Total power dissipation up to $T_{amb} = 60\text{ }^\circ\text{C}$ | P_{tot} | max. | 180 mW |
| Storage temperature | T_{stg} | | -65 to $+150\text{ }^\circ\text{C}$ |
| Junction temperature | T_j | max. | 150 $^\circ\text{C}$ |

THERMAL RESISTANCE

From junction to ambient in free air mounted on a fibre-glass print (see Fig. 2) of 40 mm x 25 mm x 1 mm

$$R_{th\ j-a} = 500\text{ K/W}^*$$

* K/W is SI unit for $^\circ\text{C/W}$.

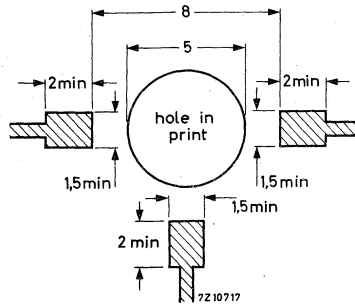


Fig. 2 Requirements for fibre-glass print. (Dimensions in mm.)

CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$$I_E = 0; V_{CB} = 10\text{ V}$$

$$I_{CBO} < 50\text{ nA}$$

D.C. current gain *

$$I_C = 14\text{ mA}; V_{CE} = 10\text{ V}$$

$$h_{FE} > 40$$

typ. 90

Transition frequency at $f = 500\text{ MHz}$ *

$$I_C = 14\text{ mA}; V_{CE} = 10\text{ V}$$

$$f_T \text{ typ. } 5\text{ GHz}$$

Collector capacitance at $f = 1\text{ MHz}$

$$I_E = I_c = 0; V_{CB} = 10\text{ V}$$

$$C_c \text{ typ. } 0,6\text{ pF}$$

Emitter capacitance at $f = 1\text{ MHz}$

$$I_C = I_c = 0; V_{EB} = 0,5\text{ V}$$

$$C_e \text{ typ. } 1,2\text{ pF}$$

Feedback capacitance at $f = 1\text{ MHz}$

$$I_C = 0; V_{CE} = 10\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$$

$$C_{re} \text{ typ. } 0,35\text{ pF}$$

Noise figure at $T_{amb} = 25\text{ }^\circ\text{C}$

$$I_C = 4\text{ mA}; V_{CE} = 10\text{ V}; R_S = 60\text{ }\Omega; f = 800\text{ MHz}$$

$$F \text{ typ. } 1,8\text{ dB}$$

$$I_C = 4\text{ mA}; V_{CE} = 10\text{ V}; Z_S = Z_{Sopt}; f = 2\text{ GHz}$$

$$F \text{ typ. } 3,6\text{ dB}$$

* Measured under pulse conditions.

s-parameters (common emitter)

| V _{CE} V | I _C mA | f MHz | S _{ie} | S _{re} | S _{fe} | S _{oe} |
|----------------------|----------------------|----------|-----------------|-----------------|-----------------|-----------------|
| 5 | 2 | 40 | 0,91/ -7,7° | 0,01/84° | 6,8/173° | 1,00/ -2,7° |
| | | 200 | 0,79/ -37,3° | 0,03/71° | 6,5/143° | 0,93/-12,5° |
| | | 500 | 0,52/ -81,0° | 0,06/59° | 4,6/116° | 0,80/-22,5° |
| | | 800 | 0,34/-114,5° | 0,08/58° | 3,3/ 97° | 0,73/-27,0° |
| | | 1000 | 0,26/-137,6° | 0,09/59° | 2,8/ 87° | 0,70/-30,0° |
| | | 1200 | 0,22/-165,0° | 0,10/61° | 2,4/ 79° | 0,67/-33,0° |
| 5 | 5 | 40 | 0,80/ -11,7° | 0,01/81° | 14,4/169° | 0,99/ -4,5° |
| | | 200 | 0,59/ -51,0° | 0,03/68° | 11,2/134° | 0,85/-17,0° |
| | | 500 | 0,29/ -95,0° | 0,05/66° | 6,3/103° | 0,70/-22,0° |
| | | 800 | 0,16/-130,0° | 0,07/69° | 4,2/ 88° | 0,64/-26,0° |
| | | 1000 | 0,12/-162,0° | 0,09/70° | 3,4/ 81° | 0,63/-28,0° |
| | | 1200 | 0,12/+ 158,0° | 0,10/71° | 2,9/ 74° | 0,61/-31,0° |
| 5 | 10 | 40 | 0,67/ -16,7° | 0,01/80° | 23,3/164° | 0,97/ -6,6° |
| | | 200 | 0,39/ -63,0° | 0,02/70° | 14,5/122° | 0,76/-18,0° |
| | | 500 | 0,15/-109,0° | 0,05/73° | 7,0/ 96° | 0,64/-20,0° |
| | | 800 | 0,09/-152,0° | 0,07/75° | 4,6/ 84° | 0,60/-24,0° |
| | | 1000 | 0,07/+ 155,0° | 0,09/75° | 3,7/ 77° | 0,59/-26,0° |
| | | 1200 | 0,10/+ 124,0° | 0,11/74° | 3,1/ 72° | 0,58/-29,0° |
| 5 | 14 | 40 | 0,58/ -20,0° | 0,01/79° | 28,3/160° | 0,96/ -7,8° |
| | | 200 | 0,30/ -71,0° | 0,02/72° | 15,5/117° | 0,72/-18,0° |
| | | 500 | 0,11/-119,0° | 0,05/75° | 7,2/ 93° | 0,62/-19,0° |
| | | 800 | 0,07/-177,0° | 0,07/77° | 4,6/ 82° | 0,59/-23,0° |
| | | 1000 | 0,08/+ 138,0° | 0,09/76° | 3,8/ 76° | 0,58/-25,0° |
| | | 1200 | 0,12/+ 118,0° | 0,11/76° | 3,2/ 71° | 0,57/-28,0° |
| 5 | 20 | 40 | 0,49/ -25,0° | 0,01/78° | 32,9/157° | 0,94/ -9,0° |
| | | 200 | 0,22/ -82,0° | 0,02/74° | 15,9/112° | 0,69/-17,0° |
| | | 500 | 0,09/-143,0° | 0,05/78° | 7,1/ 91° | 0,61/-18,0° |
| | | 800 | 0,08/+ 160,0° | 0,07/78° | 4,5/ 80° | 0,59/-22,0° |
| | | 1000 | 0,10/+ 130,0° | 0,09/78° | 3,7/ 75° | 0,58/-24,0° |
| | | 1200 | 0,14/+ 115,0° | 0,11/77° | 3,1/ 69° | 0,57/-28,0° |
| 5 | 30 | 40 | 0,36/ -38,9° | 0,01/76° | 31,2/151° | 0,90/-10,3° |
| | | 200 | 0,18/-122,0° | 0,02/75° | 14,0/106° | 0,66/-14,0° |
| | | 500 | 0,15/-175,0° | 0,05/80° | 6,1/ 88° | 0,61/-16,0° |
| | | 800 | 0,17/+ 148,0° | 0,07/80° | 3,9/ 78° | 0,59/-21,0° |
| | | 1000 | 0,19/+ 131,0° | 0,09/79° | 3,1/ 72° | 0,59/-24,0° |
| | | 1200 | 0,23/+ 119,0° | 0,11/79° | 2,7/ 67° | 0,57/-28,0° |

s-parameters (common emitter)

| V_{CE} V | I_C mA | f MHz | s_{1e} | s_{re} | s_{fe} | s_{oe} |
|---------------|-------------|----------|---------------|----------|-----------|-------------|
| 10 | 2 | 40 | 0,91/ -7,5° | 0,01/84° | 7,0/173° | 1,00/ -2,6° |
| | | 200 | 0,81/ -36,0° | 0,03/72° | 6,3/149° | 0,94/-12,0° |
| | | 500 | 0,54/ -78,0° | 0,06/59° | 4,6/118° | 0,82/-21,0° |
| | | 800 | 0,35/-110,0° | 0,08/58° | 3,4/ 98° | 0,74/-26,0° |
| | | 1000 | 0,27/-132,0° | 0,08/59° | 2,8/ 89° | 0,72/-29,0° |
| | | 1200 | 0,22/-159,0° | 0,09/61° | 2,5/ 80° | 0,69/-0,32° |
| 10 | 5 | 40 | 0,81/ -11,1° | 0,01/82° | 14,4/169° | 0,99/ -4,3° |
| | | 200 | 0,61/ -48,0° | 0,03/69° | 11,1/135° | 0,86/-16,0° |
| | | 500 | 0,31/ -90,0° | 0,05/66° | 6,4/105° | 0,71/-22,0° |
| | | 800 | 0,17/-120,0° | 0,07/69° | 4,3/ 90° | 0,66/-25,0° |
| | | 1000 | 0,11/-148,0° | 0,08/70° | 3,5/ 82° | 0,64/-27,0° |
| | | 1200 | 0,10/+ 167,0° | 0,10/71° | 3,0/ 76° | 0,63/-30,0° |
| 10 | 10 | 40 | 0,70/ -15,2° | 0,01/80° | 23,0/164° | 0,97/ -6,1° |
| | | 200 | 0,42/ -58,0° | 0,02/70° | 14,8/124° | 0,78/-17,0° |
| | | 500 | 0,17/ -95,0° | 0,05/73° | 7,3/ 97° | 0,65/-20,0° |
| | | 800 | 0,07/-104,0° | 0,07/75° | 4,7/ 85° | 0,62/-23,0° |
| | | 1000 | 0,04/-174,0° | 0,09/75° | 3,9/ 79° | 0,61/-25,0° |
| | | 1200 | 0,07 + 120,0° | 0,10/75° | 3,3/ 73° | 0,59/-28,0° |
| 10 | 14 | 40 | 0,63/ -18,0° | 0,01/79° | 28,2/161° | 0,96/ -7,2° |
| | | 200 | 0,34/ -63,0° | 0,02/72° | 15,9/119° | 0,74/-17,0° |
| | | 500 | 0,13/ -98,0° | 0,05/75° | 7,5/ 95° | 0,63/-19,0° |
| | | 800 | 0,05/-136,0° | 0,07/77° | 4,8/ 83° | 0,61/-22,0° |
| | | 1000 | 0,04/+ 133,0° | 0,09/76° | 3,9/ 77° | 0,60/-25,0° |
| | | 1200 | 0,08/+ 108,0° | 0,10/76° | 3,3/ 72° | 0,58/-28,0° |



Output voltage at $d_{im} = -60$ dB (see Figs 3 and 15)

(DIN 45004B, par. 6.3: 3-tone)

$I_C = 14$ mA; $V_{CE} = 10$ V; $R_L = 75 \Omega$; $V_{SWR} < 2$; $T_{amb} = 25$ °C

$V_p = V_o$ at $d_{im} = -60$ dB; $f_p = 795,25$ MHz

$V_q = V_o - 6$ dB ; $f_q = 803,25$ MHz

$V_r = V_o - 6$ dB ; $f_r = 805,25$ MHz

Measured at $f_{(p+q-r)} = 793,25$ MHz

V_o typ. 150 mV

Second harmonic distortion (see Figs 3 and 16)

$I_C = 14$ mA; $V_{CE} = 10$ V; $R_L = 75 \Omega$; $V_{SWR} < 2$; $T_{amb} = 25$ °C

$V_p = 60$ mV at $f_p = 250$ MHz

$V_q = 60$ mV at $f_q = 560$ MHz

measured at $f_{(p+q)} = 810$ MHz

d_2 typ. -50 dB

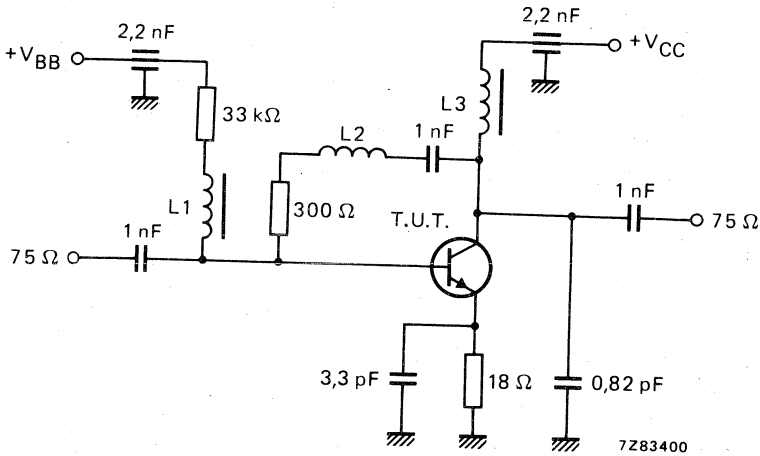


Fig. 3 Intermodulation distortion and second harmonic distortion MATV test circuit.

L1 = L3 = 5 μH micro choke

L2 = 3 turns Cu wire (0,4 mm); internal diameter 3 mm; winding pitch 1 mm

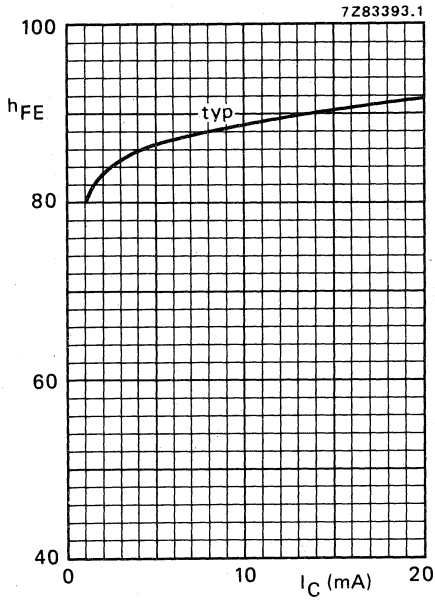


Fig. 4 $V_{CE} = 10$ V; $T_j = 25$ °C.

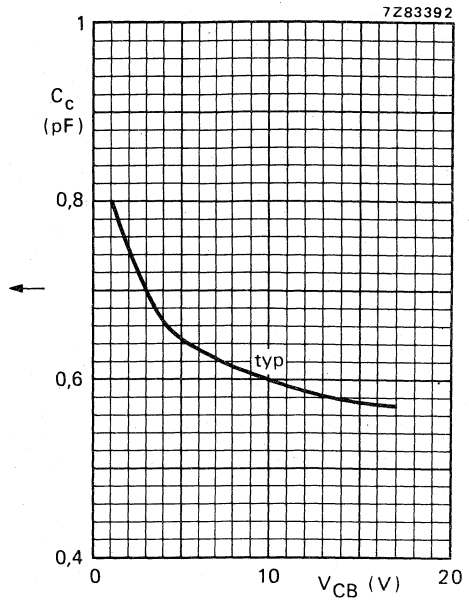


Fig. 5 $I_E = I_e = 0$; $f = 1$ MHz; $T_j = 25$ °C.

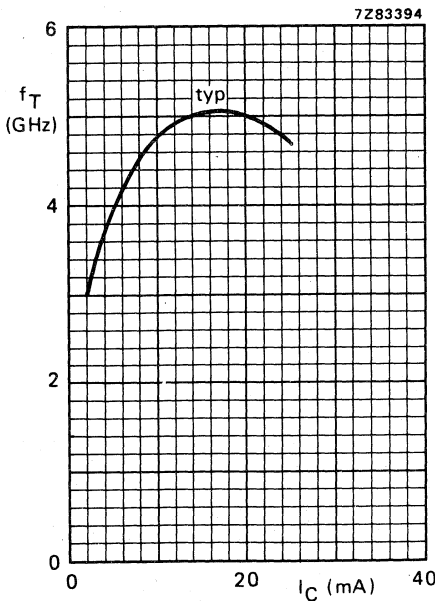


Fig. 6 $V_{CE} = 10$ V; $f = 500$ MHz; $T_j = 25$ °C.

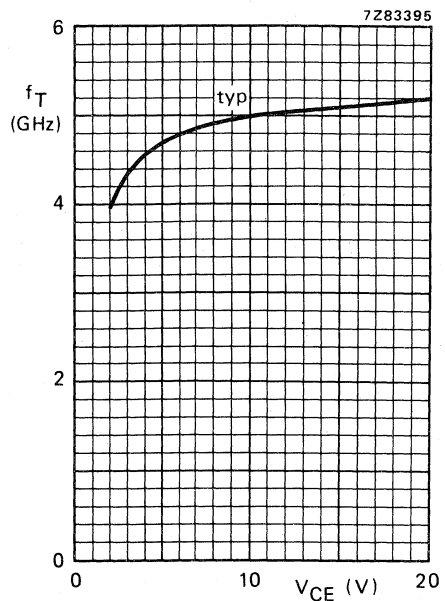


Fig. 7 $I_C = 14$ mA; $f = 500$ MHz; $T_j = 25$ °C.

7Z83398

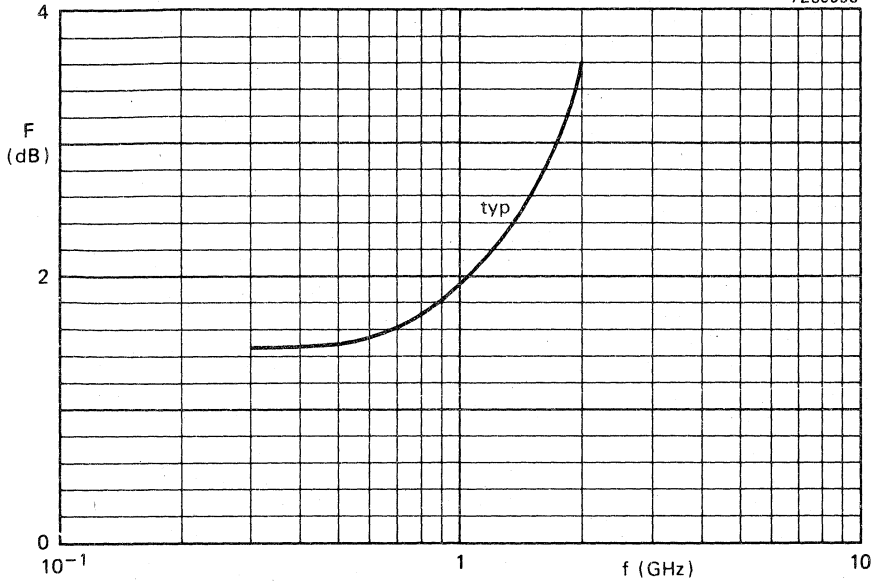


Fig. 8 $V_{CE} = 10 \text{ V}$; $I_C = 4 \text{ mA}$; $Z_S = \text{optimum}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$.

7Z83399

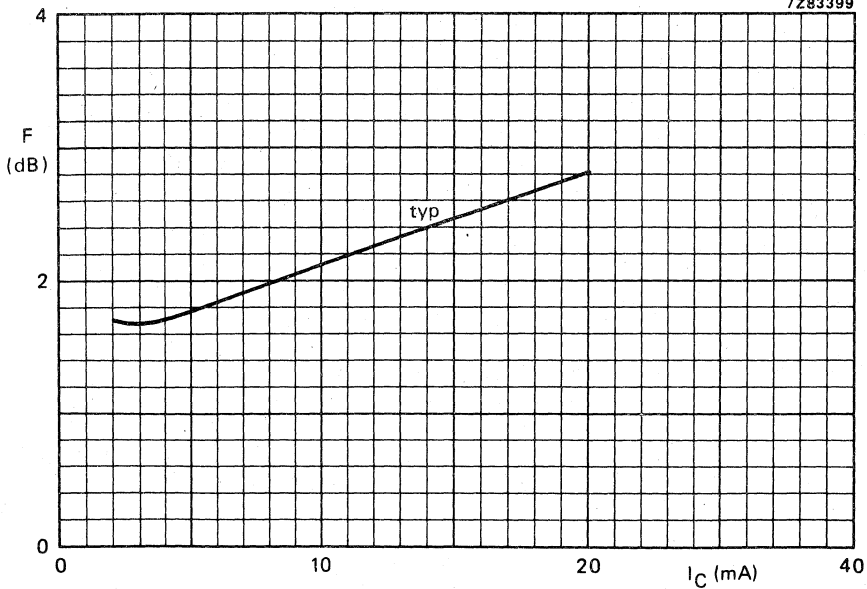


Fig. 9 $V_{CE} = 10 \text{ V}$; $f = 800 \text{ MHz}$; $Z_S = \text{optimum}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$.

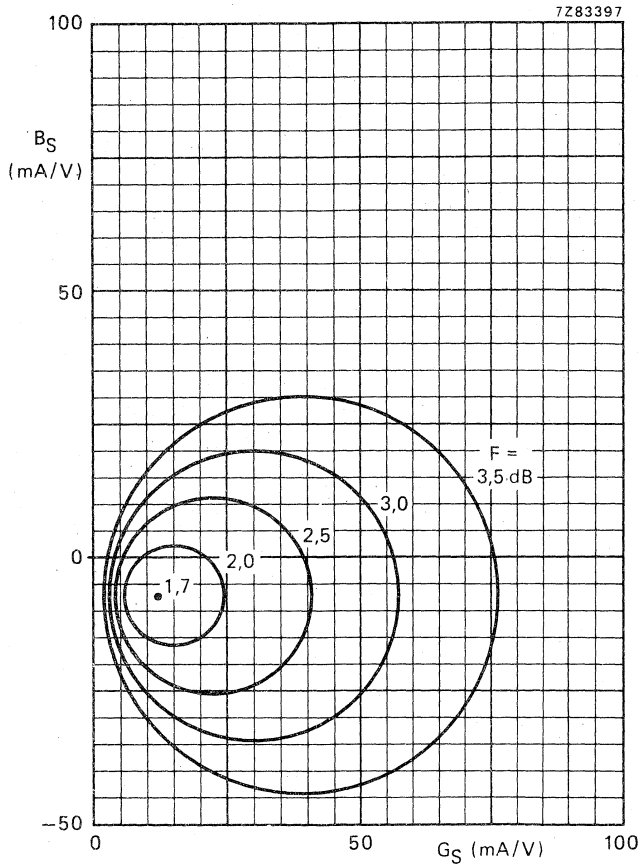


Fig. 10 Circles of constant noise figure.
 $V_{CE} = 10 \text{ V}$; $I_C = 4 \text{ mA}$; $f = 800 \text{ MHz}$; $T_{amb} = 25 \text{ }^\circ\text{C}$;
typical values.

Conditions for Figs 11 and 12:

$V_{CE} = 10 \text{ V}$; $I_C = 14 \text{ mA}$;

$T_{amb} = 25 \text{ }^\circ\text{C}$.

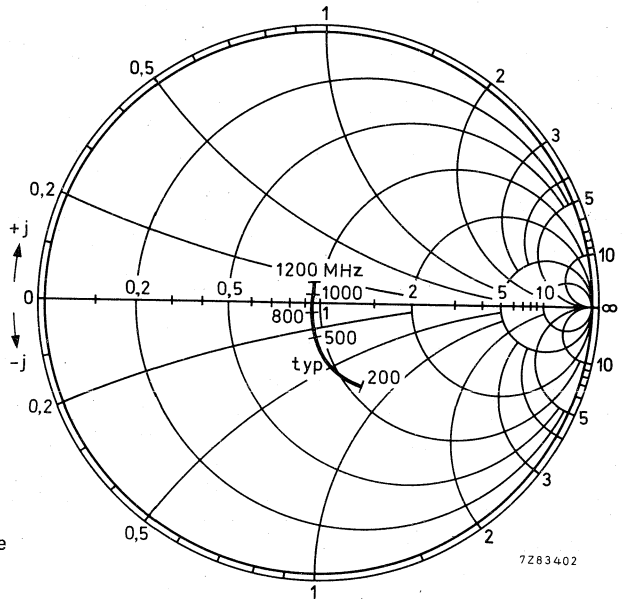


Fig. 11 Input impedance derived from input reflection coefficient s_{ie} co-ordinates in ohm $\times 50$.

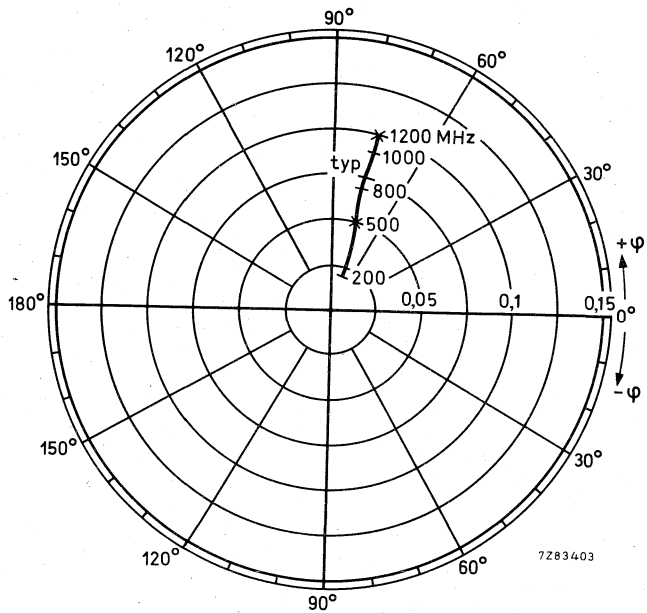


Fig. 12 Reverse transmission coefficient s_{re} .

Conditions for Figs 13 and 14:

$V_{CE} = 10 \text{ V}$; $I_C = 14 \text{ mA}$;

$T_{amb} = 25 \text{ }^\circ\text{C}$.

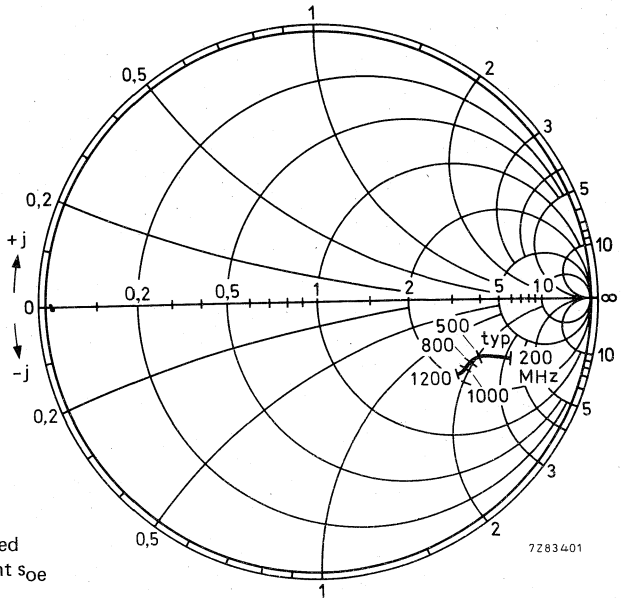


Fig. 13 Output impedance derived from output reflection coefficient s_{oe} co-ordinates in ohm x 50.

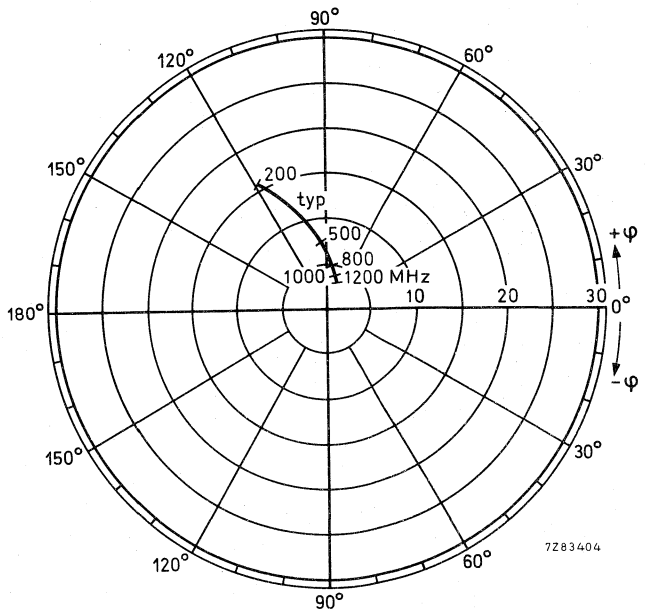


Fig. 14 Forward transmission coefficient s_{fe} .

7Z83396

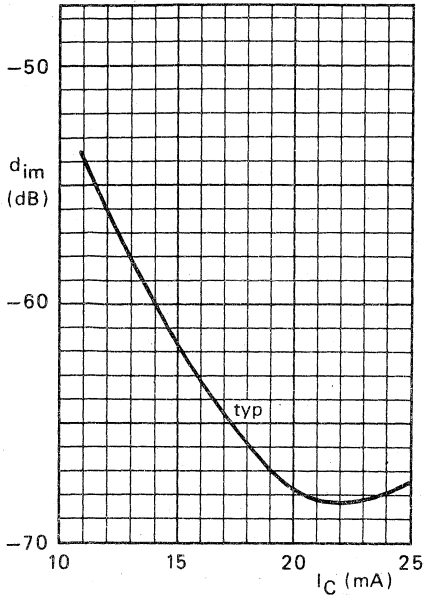


Fig. 15.

7Z83391

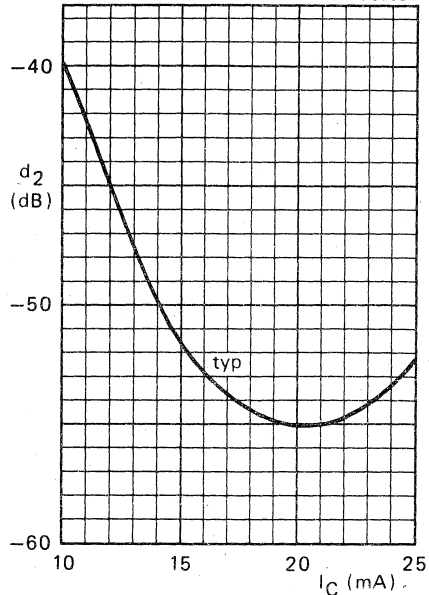


Fig. 16.

7Z83390

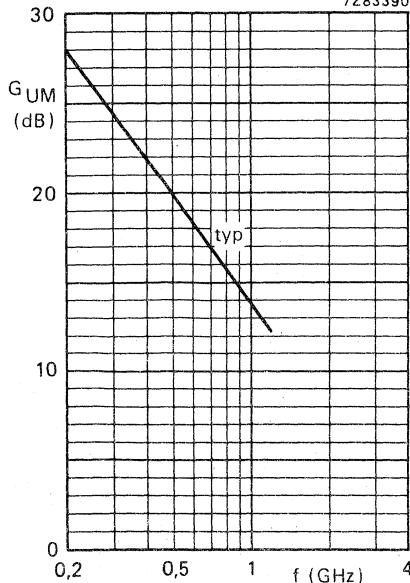


Fig. 17 $V_{CE} = 10 \text{ V}; I_C = 14 \text{ mA}; T_{amb} = 25 \text{ }^\circ\text{C}$.

Fig. 15 $V_{CE} = 10 \text{ V}; V_O = 43,5 \text{ dBmV} = 150 \text{ mV};$
 $f_{(p+q-r)} = 793,25 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C};$
 measured in MATV test circuit (see Fig. 3).

Fig. 16 $V_{CE} = 10 \text{ V}; V_O = 60 \text{ mV};$
 $f_{(p+q)} = 810 \text{ MHz}; T_{amb} = 25 \text{ }^\circ\text{C};$ measured in
 MATV test circuit (see Fig. 3).

SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a subminiature plastic transfer-moulded T-package.

It is primarily intended for use in u.h.f. and microwave amplifiers such as in aerial amplifiers, radar systems, oscilloscopes, spectrum analysers etc.

The transistor features very low intermodulation distortion and high power gain; thanks to its very high transition frequency, it also has excellent wideband properties and low noise up to high frequencies.

QUICK REFERENCE DATA

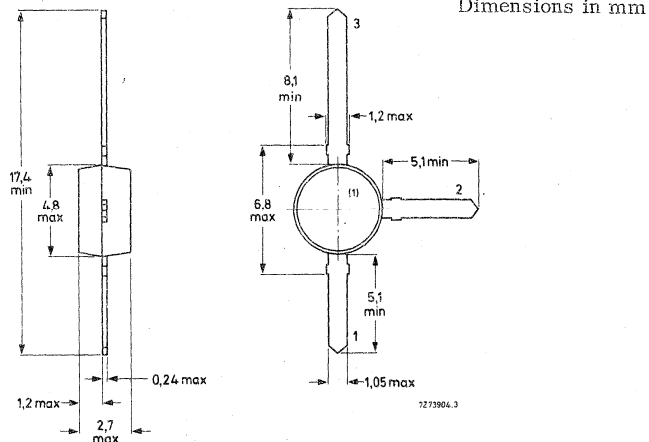
| | | | | |
|---|-----------|------|-----|------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 15 | V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 12 | V |
| Collector current (d. c.) | I_C | max. | 35 | mA |
| Total power dissipation up to $T_{amb} = 60\text{ }^\circ\text{C}$ | P_{tot} | max. | 180 | mW |
| Junction temperature | T_j | max. | 150 | $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ | f_T | typ. | 5 | GHz |
| $I_C = 30\text{ mA}; V_{CE} = 5\text{ V}$ | | | | |
| Feedback capacitance at $f = 1\text{ MHz}$ | C_{re} | typ. | 0,8 | pF |
| $I_C = 0; V_{CE} = 5\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$ | | | | |
| Noise figure at optimum source impedance | F | typ. | 1,9 | dB |
| $I_C = 2\text{ mA}; V_{CE} = 5\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | | | | |
| Max. unilateral power gain (see page 3) | G_{UM} | typ. | 18 | dB |
| $I_C = 30\text{ mA}; V_{CE} = 5\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | | | | |
| Intermodulation distortion at $T_{amb} = 25\text{ }^\circ\text{C}$ | d_{im} | typ. | -60 | dB |
| $I_C = 30\text{ mA}; V_{CE} = 5\text{ V}; R_L = 75\text{ }\Omega; V_o = 300\text{ mV}$ | | | | |
| $f(p + q - r) = 493,25\text{ MHz}$ (see page 4) | | | | |

MECHANICAL DATA

Fig. 1 SOT-37.

Connections

1. Base
2. Emitter
3. Collector



(1) = type number marking.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Voltages

| | | | | |
|---------------------------------------|-----------|------|-----|---|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 15 | V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 12 | V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2,0 | V |

Current

| | | | | |
|---------------------------|-------|------|----|----|
| Collector current (d. c.) | I_C | max. | 35 | mA |
|---------------------------|-------|------|----|----|

Power dissipation

| | | | | |
|--|-----------|------|-----|----|
| Total power dissipation up to $T_{amb} = 60\text{ }^{\circ}\text{C}$ | P_{tot} | max. | 180 | mW |
|--|-----------|------|-----|----|

Temperatures

| | | | |
|----------------------|-----------|-------------|--------------------|
| Storage temperature | T_{stg} | -65 to +150 | $^{\circ}\text{C}$ |
| Junction temperature | T_j | max. 150 | $^{\circ}\text{C}$ |

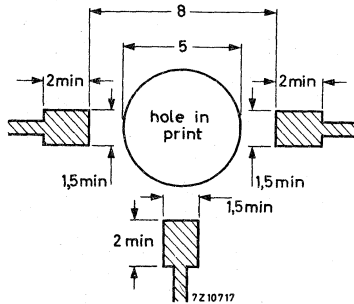
THERMAL RESISTANCE

From junction to ambient in free air
 mounted on a glass-fibre print *)
 of 40 mm x 25 mm x 1 mm

$$R_{th\ j-a} = 0,5\text{ }^{\circ}\text{C/mW}$$

*) Requirements for glass-fibre print

(dimensions in mm)



CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 5\text{ V}$ $I_{CBO} < 50\text{ nA}$

D. C. current gain ¹⁾

$I_C = 30\text{ mA}; V_{CE} = 5\text{ V}$ $h_{FE} > 40$ \leftarrow
 $\text{typ. } 90$

Transition frequency at $f = 500\text{ MHz}$ ¹⁾

$I_C = 30\text{ mA}; V_{CE} = 5\text{ V}$ $f_T \text{ typ. } 5\text{ GHz}$

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 10\text{ V}$ $C_c \text{ typ. } 0,7\text{ pF}$

Emitter capacitance at $f = 1\text{ MHz}$

$I_C = I_c = 0; V_{EB} = 0,5\text{ V}$ $C_e \text{ typ. } 2,5\text{ pF}$ \leftarrow

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 0; V_{CE} = 5\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$ $C_{re} \text{ typ. } 0,8\text{ pF}$ \leftarrow

Noise figure at optimum source impedance

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ $F \text{ typ. } 1,9\text{ dB}$ \leftarrow

Max. unilateral power gain (s_{re} assumed to be zero)

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$I_C = 30\text{ mA}; V_{CE} = 5\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ $G_{UM} \text{ typ. } 18\text{ dB}$ \leftarrow

¹⁾ Measured under pulse conditions.

CHARACTERISTICS (continued)

Intermodulation distortion at $T_{amb} = 25\text{ }^{\circ}\text{C}$

$I_C = 30\text{ mA}$; $V_{CE} = 5\text{ V}$; $R_L = 75\text{ }\Omega$; V. S. W. R. < 2

$V_p = V_o = 300\text{ mV}$ at $f_p = 495,25\text{ MHz}$

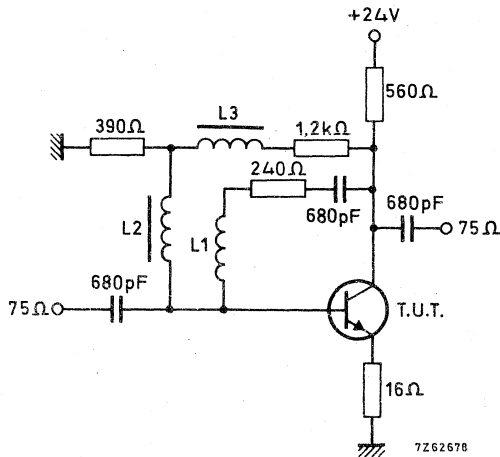
$V_q = V_o - 6\text{ dB}$ at $f_q = 503,25\text{ MHz}$

$V_r = V_o - 6\text{ dB}$ at $f_r = 505,25\text{ MHz}$

Measured at $f_{(p+q-r)} = 493,25\text{ MHz}$

d_{im} typ. -60 dB

Intermodulation test circuit:



L1 = 4 turns Cu wire (0,35); winding pitch 1 mm; int. diam. 4 mm
 L2 and L3 5 μH (code number: 3122 108 20150)

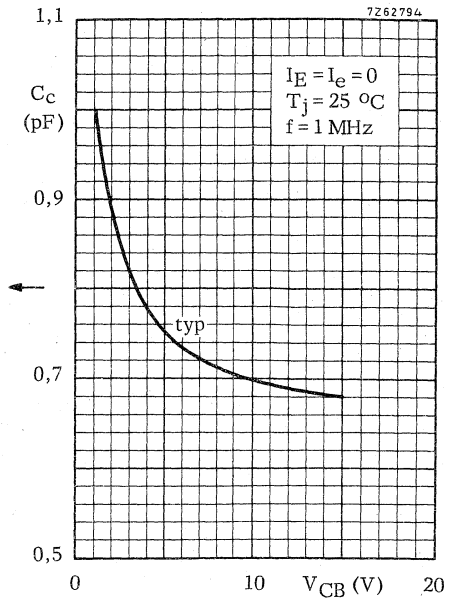
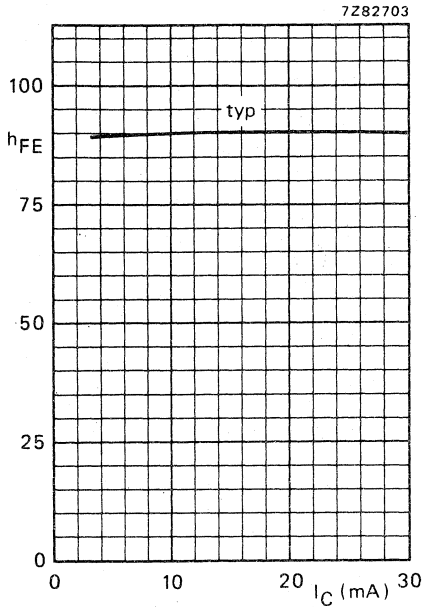
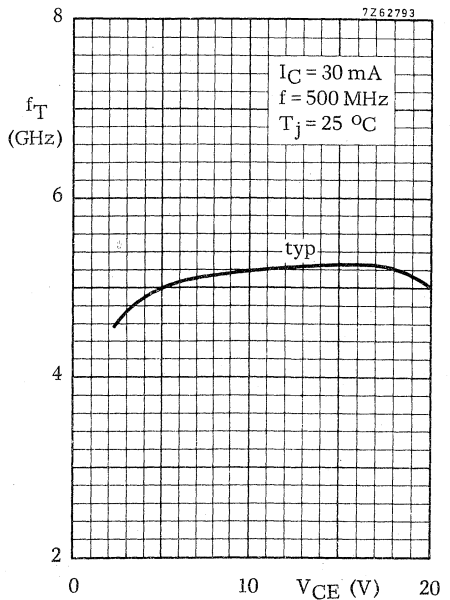
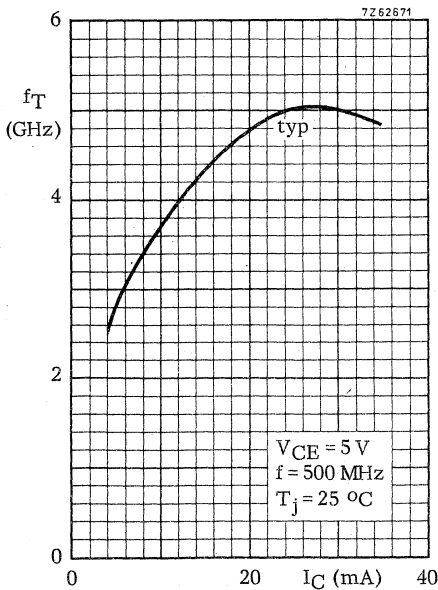
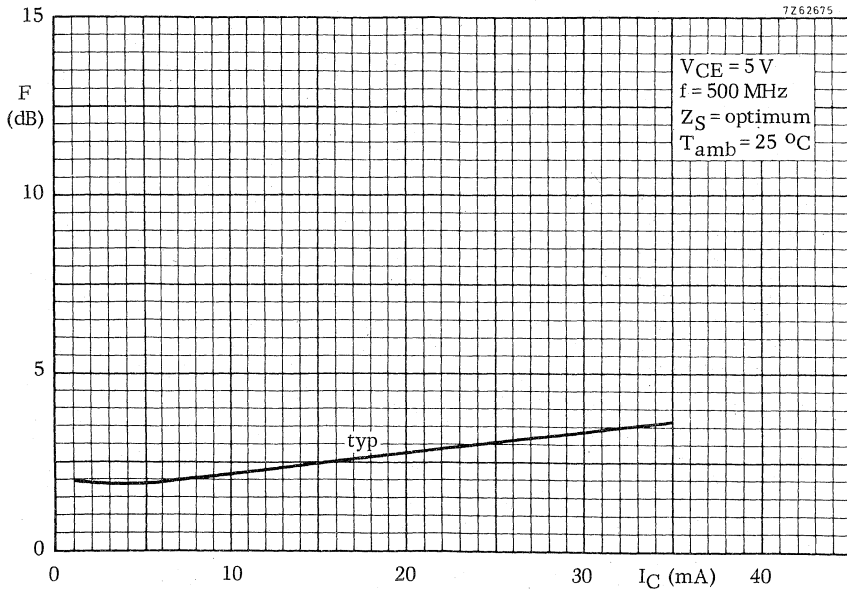
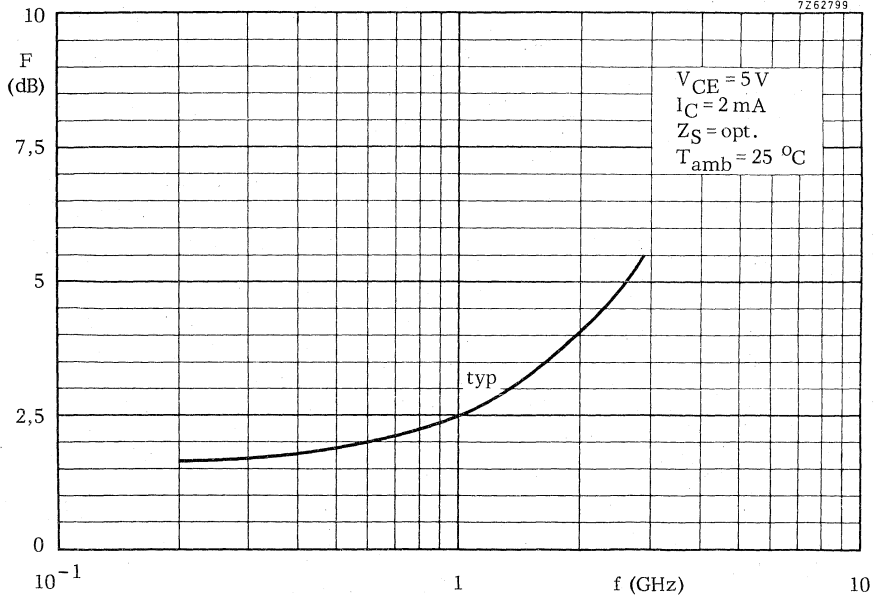


Fig. 4 $V_{CE} = 5\text{ V}$; $T_j = 25\text{ }^\circ\text{C}$.





circles of constant noise figure

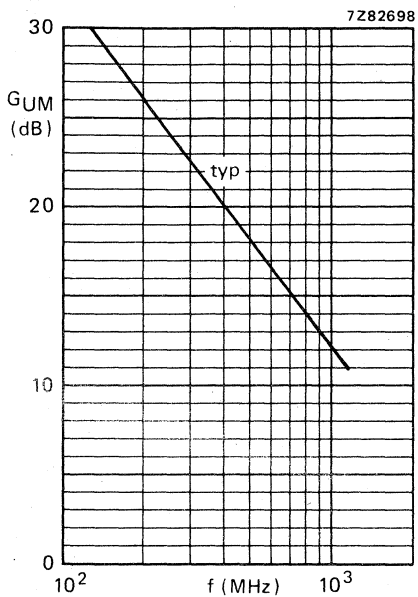
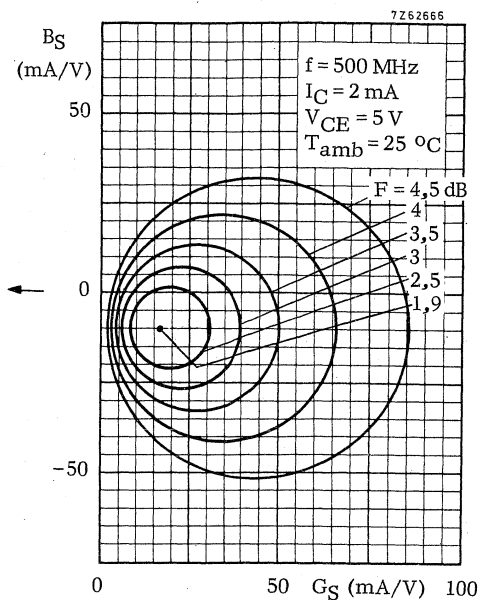


Fig. 10 $V_{CE} = 5 \text{ V}$; $I_C = 30 \text{ mA}$;
 $T_{amb} = 25 \text{ }^\circ\text{C}$.



SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a subminiature plastic transfer-moulded T-package primarily intended for use in u.h.f. and microwave amplifiers.

Features of this product:

- low noise;
- very low intermodulation distortion;
- high power gain;
- gold metallization.

QUICK REFERENCE DATA

| | | | |
|--|-----------|------|----------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 15 V |
| Collector-emitter voltage (open base) | V_{CE0} | max. | 12 V |
| Collector current (d.c.) | I_C | max. | 35 mA |
| Total power dissipation up to $T_{amb} = 60\text{ }^\circ\text{C}$ | P_{tot} | max. | 300 mW |
| Junction temperature | T_j | max. | 150 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 30\text{ mA}$; $V_{CE} = 5\text{ V}$ | f_T | typ. | 6 GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $I_C = 0$; $V_{CE} = 5\text{ V}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | C_{re} | typ. | 0,6 pF |
| Noise figure at optimum source impedance $I_C = 4\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 800\text{ MHz}$ | F | typ. | 1,6 dB |
| Maximum unilateral power gain $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $f = 800\text{ MHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | GUM | typ. | 14 dB |
| Output voltage at $d_{im} = -60\text{ dB}$ (see Fig. 3) $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $R_L = 75\text{ }\Omega$; $T_{amb} = 25\text{ }^\circ\text{C}$ $f_{(p+q-r)} = 793,25\text{ MHz}$ | V_o | typ. | 425 mV |

MECHANICAL DATA

SOT-37 (see Fig. 1).

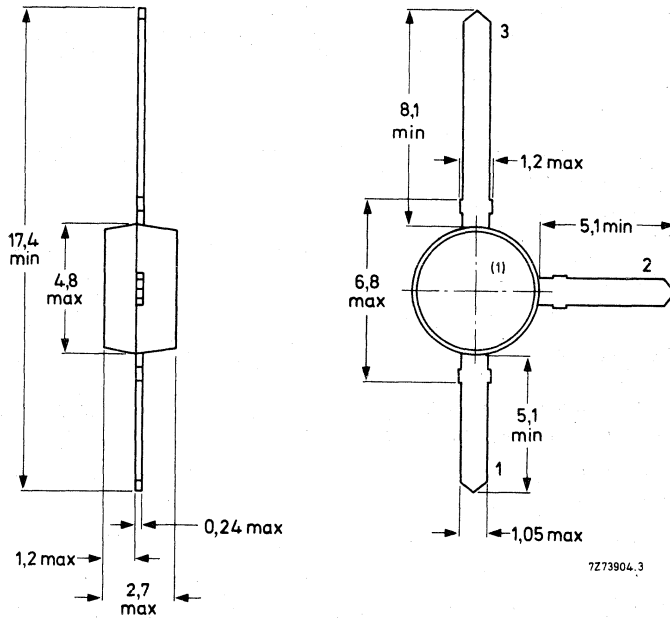
MECHANICAL DATA

Fig. 1 SOT-37.

Connections

- 1. Base
- 2. Emitter
- 3. Collector

Dimensions in mm



(1) = type number marking.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|--|-----------|------|---------------------------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 15 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 12 V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2,0 V |
| Collector current (d.c.) | I_C | max. | 35 mA |
| Total power dissipation up to $T_{amb} = 60\text{ }^\circ\text{C}$ | P_{tot} | max. | 300 mW |
| Storage temperature | T_{stg} | | -65 to $+150\text{ }^\circ\text{C}$ |
| Junction temperature | T_j | max. | $150\text{ }^\circ\text{C}$ |

THERMAL RESISTANCE

From junction to ambient in free air
mounted on a fibre-glass print (see Fig. 2)
of 40 mm x 25 mm x 1 mm

$$R_{th\ j-a} = 300\text{ K/W} *$$

* K/W is SI unit for $^\circ\text{C/W}$.

Output voltage at $d_{im} = -60$ dB (see Figs 3 and 14)

(DIN 45004B, par. 6.3: 3-tone)

$I_C = 30$ mA; $V_{CE} = 8$ V; $R_L = 75 \Omega$; $T_{amb} = 25$ °C

$V_p = V_o$ at $d_{im} = -60$ dB; $f_p = 795,25$ MHz

$V_q = V_o - 6$ dB; $f_q = 803,25$ MHz

$V_r = V_o - 6$ dB; $f_r = 805,25$ MHz

Measured at $f_{(p+q-r)} = 793,25$ MHz

V_o typ. 425 mV

Output voltage at $d_2 = -50$ dB (see Figs 3 and 15)

$I_C = 30$ mA; $V_{CE} = 8$ V; $R_L = 75 \Omega$; $T_{amb} = 25$ °C

$V_p = V_o$ at $d_2 = -50$ dB; $f_p = 250$ MHz

$V_q = V_o$ at $d_2 = -50$ dB; $f_q = 560$ MHz

measured at $f_{(p+q)} = 810$ MHz

V_o typ. 200 mV

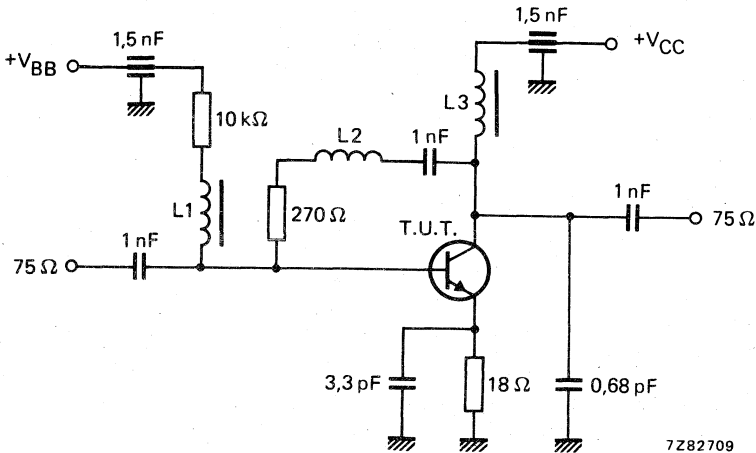


Fig. 3 Intermodulation distortion and second harmonic distortion MATV test circuit.

$L1 = L3 = 5 \mu$ H micro choke

$L2 = 3$ turns Cu wire (0,4 mm); internal diameter 3 mm; winding pitch 1 mm

s-parameters (common emitter) at $V_{CE} = 8 \text{ V}$.

The figures given in the tables below can also be used for operation at $V_{CE} = 5 \text{ V}$. Only slight differences for the s-parameters may occur.

| I_C mA | f MHz | s_{ie} | s_{re} | s_{fe} | s_{oe} |
|-------------|----------|--------------|------------|------------|--------------|
| 2 | 40 | 0,89/ -12,9° | 0,01/75° | 9,5/166° | 0,97/ -6,1° |
| | 100 | 0,85/ -30,7° | 0,03/70,6° | 8,7/155° | 0,94/ -13,5° |
| | 200 | 0,75/ -57,1° | 0,05/61,5° | 7,4/138° | 0,87/ -22,5° |
| | 500 | 0,48/ -113° | 0,08/50,9° | 4,4/106° | 0,72/ -34,2° |
| | 800 | 0,37/ -153° | 0,09/51,9° | 3,0/ 86,3° | 0,64/ -40,0° |
| | 1000 | 0,34/ -178° | 0,10/55,0° | 2,6/ 77,0° | 0,61/ -47,8° |
| | 1200 | 0,34/+ 159° | 0,11/58,5° | 2,2/ 68,0° | 0,58/ -53,9° |
| 5 | 40 | 0,79/ -18,4° | 0,01/74° | 17,8/162° | 0,94/ -9,1° |
| | 100 | 0,71/ -42,1° | 0,03/67,1° | 15,2/146° | 0,87/ -19,5° |
| | 200 | 0,57/ -72,8° | 0,04/60,0° | 11,5/126° | 0,75/ -28,7° |
| | 500 | 0,31/ -127° | 0,07/60,1° | 5,8/ 98,2° | 0,59/ -36,1° |
| | 800 | 0,25/ -168° | 0,09/63,6° | 3,8/ 82,0° | 0,54/ -41,0° |
| | 1000 | 0,25/+ 165° | 0,11/65,2° | 3,2/ 74,4° | 0,51/ -46,7° |
| | 1200 | 0,26/+ 141° | 0,13/66,1° | 2,7/ 66,7° | 0,49/ -52,2° |
| 10 | 40 | 0,67/ -25,3° | 0,01/71° | 27,9/156° | 0,90/ -12,8° |
| | 100 | 0,55/ -55,1° | 0,02/65,1° | 21,8/136° | 0,78/ -25,6° |
| | 200 | 0,40/ -88,2° | 0,04/62,4° | 14,7/116° | 0,62/ -33,4° |
| | 500 | 0,20/ -141° | 0,06/68,3° | 6,7/ 93,0° | 0,51/ -35,9° |
| | 800 | 0,16/+ 177° | 0,09/70,0° | 4,3/ 79,3° | 0,48/ -40,3° |
| | 1000 | 0,18/+ 151° | 0,12/69,7° | 3,5/ 72,5° | 0,46/ -44,2° |
| | 1200 | 0,21/+ 130° | 0,14/68,9° | 3,0/ 65,1° | 0,43/ -50,7° |
| 20 | 40 | 0,51/ -34,7° | 0,01/69° | 39,7/149° | 0,84/ -17,4° |
| | 100 | 0,38/ -70,5° | 0,02/65,8° | 27,7/126° | 0,66/ -29,5° |
| | 200 | 0,26/ -104° | 0,03/68,0° | 16,8/109° | 0,51/ -32,5° |
| | 500 | 0,16/ -158° | 0,06/74,0° | 7,3/ 89,3° | 0,45/ -33,4° |
| | 800 | 0,14/+ 155° | 0,10/73,6° | 4,6/ 77,5° | 0,42/ -39,1° |
| | 1000 | 0,17/+ 133° | 0,12/72,3° | 3,8/ 71,2° | 0,41/ -43,6° |
| | 1200 | 0,21/+ 115° | 0,14/70,5° | 3,2/ 64,4° | 0,39/ -51,0° |
| 30 | 40 | 0,46/ -36,5° | 0,01/73° | 43,3/150° | 0,87/ -16,9° |
| | 100 | 0,32/ -73,7° | 0,02/69,2° | 29,1/124° | 0,66/ -27,2° |
| | 200 | 0,20/ -109° | 0,03/72,0° | 17,1/106° | 0,50/ -28,1° |
| | 500 | 0,14/ -174° | 0,06/75,6° | 7,4/ 87,2° | 0,41/ -31,7° |
| | 800 | 0,15/+ 143° | 0,10/74,7° | 4,8/ 74,9° | 0,39/ -41,0° |
| | 1000 | 0,17/+ 124° | 0,12/72,9° | 3,9/ 70,5° | 0,38/ -42,8° |
| | 1200 | 0,21/+ 111° | 0,15/71,0° | 3,3/ 63,8° | 0,37/ -51,0° |

Conditions for Figs 4 and 5:
 $V_{CE} = 8 \text{ V}$; $I_C = 30 \text{ mA}$;
 $T_{amb} = 25 \text{ }^\circ\text{C}$.

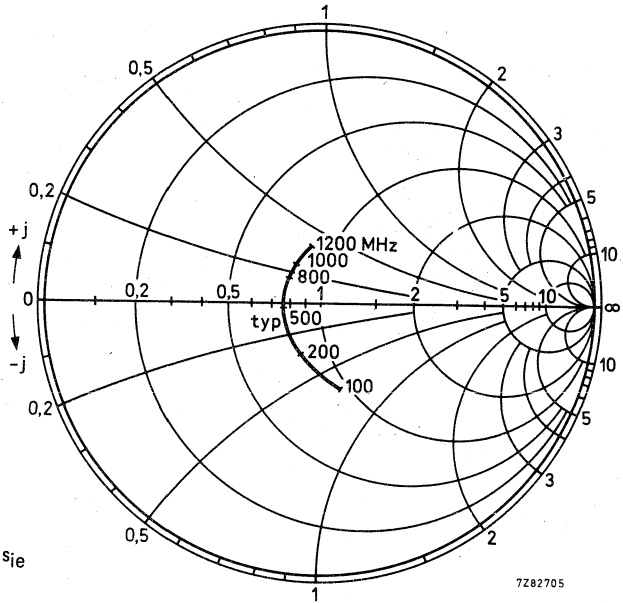


Fig. 4 Input impedance derived from input reflection coefficient s_{ie} co-ordinates in ohm x 50.

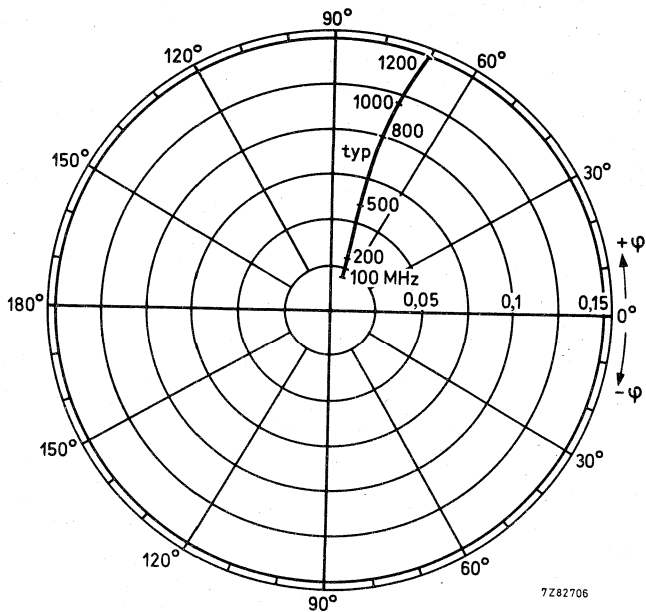


Fig. 5 Reverse transmission coefficient s_{re} .

Conditions for Figs 6 and 7:

$V_{CE} = 8 \text{ V}$; $I_C = 30 \text{ mA}$;
 $T_{amb} = 25 \text{ }^\circ\text{C}$.

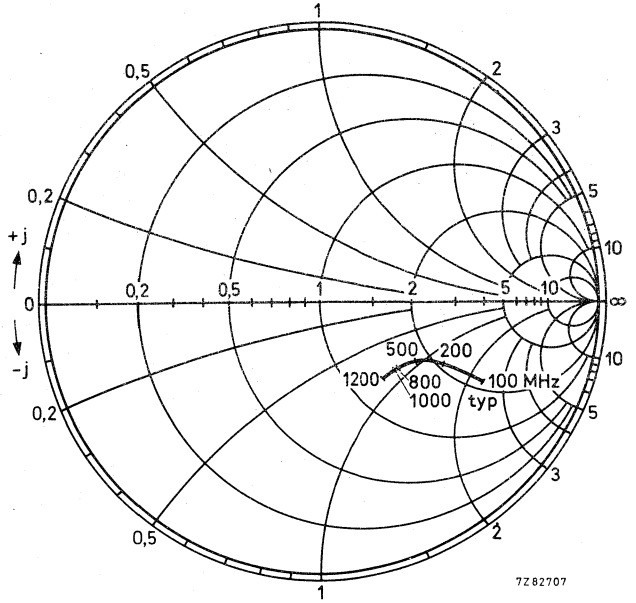


Fig. 6 Output impedance derived from output reflection coefficient s_{oe} co-ordinates in ohm $\times 50$.

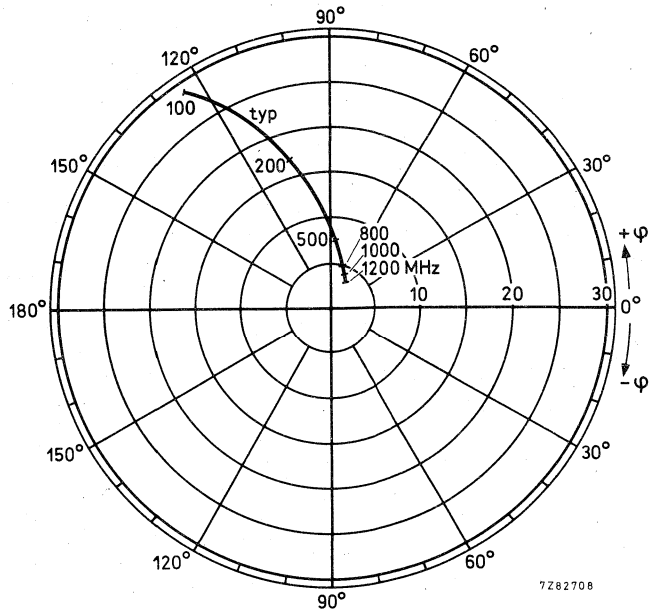


Fig. 7 Forward transmission coefficient s_{fe} .

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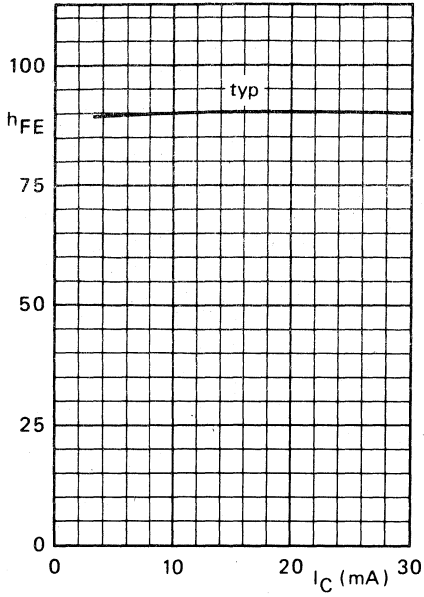


Fig. 8 $V_{CE} = 5\text{ V}$; $T_j = 25\text{ }^\circ\text{C}$.

7Z82702

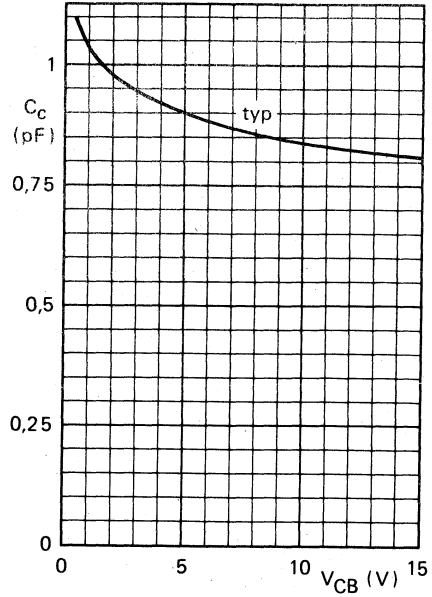


Fig. 9 $I_E = I_e = 0$; $f = 1\text{ MHz}$; $T_j = 25\text{ }^\circ\text{C}$.

7Z82701

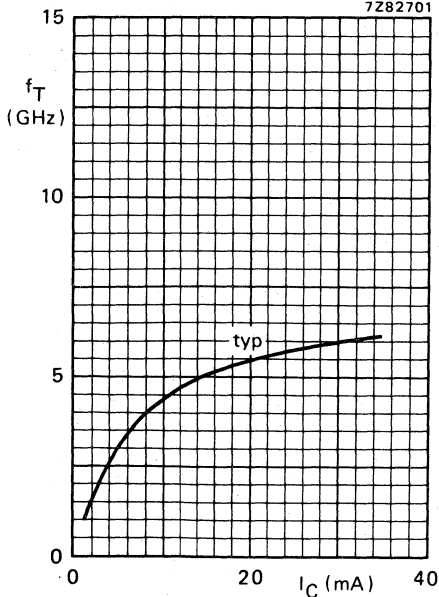


Fig. 10 $V_{CE} = 5\text{ V}$; $f = 500\text{ MHz}$; $T_j = 25\text{ }^\circ\text{C}$.

7Z82700

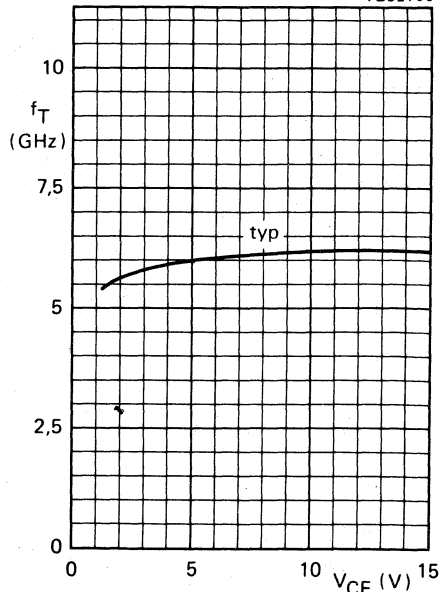


Fig. 11 $I_C = 30\text{ mA}$; $f = 500\text{ MHz}$; $T_j = 25\text{ }^\circ\text{C}$.



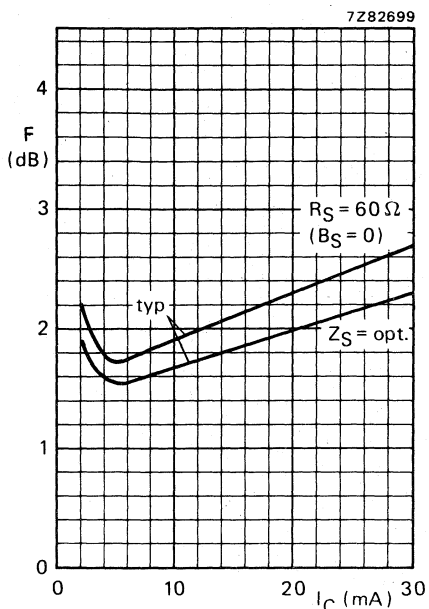


Fig. 12 $V_{CE} = 8 \text{ V}$; $f = 800 \text{ MHz}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$.

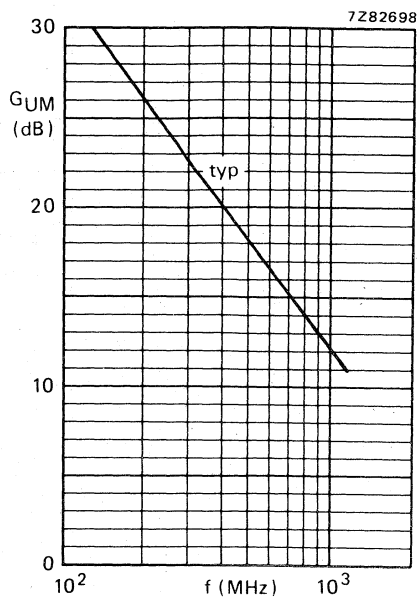


Fig. 13 $V_{CE} = 8 \text{ V}$; $I_C = 30 \text{ mA}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$.

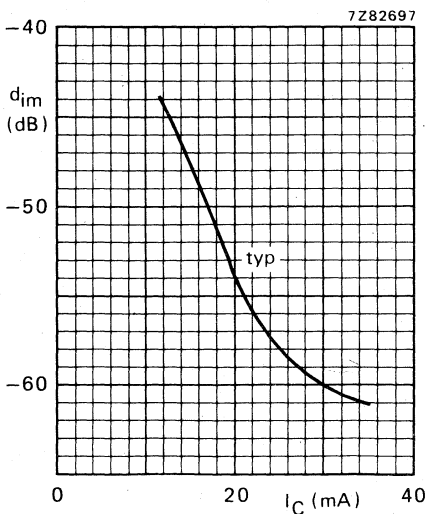


Fig. 14 $V_{CE} = 8 \text{ V}$; $V_o = 425 \text{ mV} = 52,6 \text{ dBmV}$;
 $f_{(p+q-r)} = 793,25 \text{ MHz}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$;
measured in MATV test circuit (see Fig. 3).

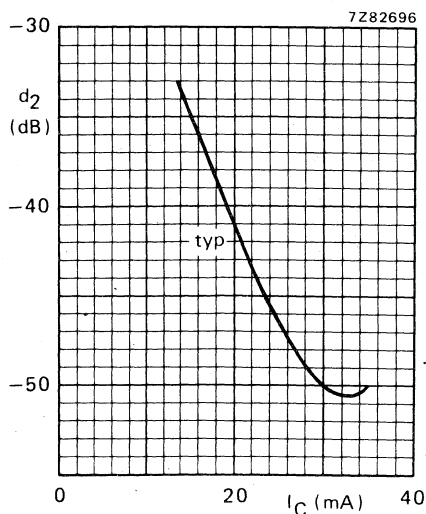


Fig. 15 $V_{CE} = 8 \text{ V}$; $V_o = 200 \text{ mV} = 46 \text{ dBmV}$;
 $f_{(p+q)} = 810 \text{ MHz}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$; measured in
MATV test circuit (see Fig. 3).

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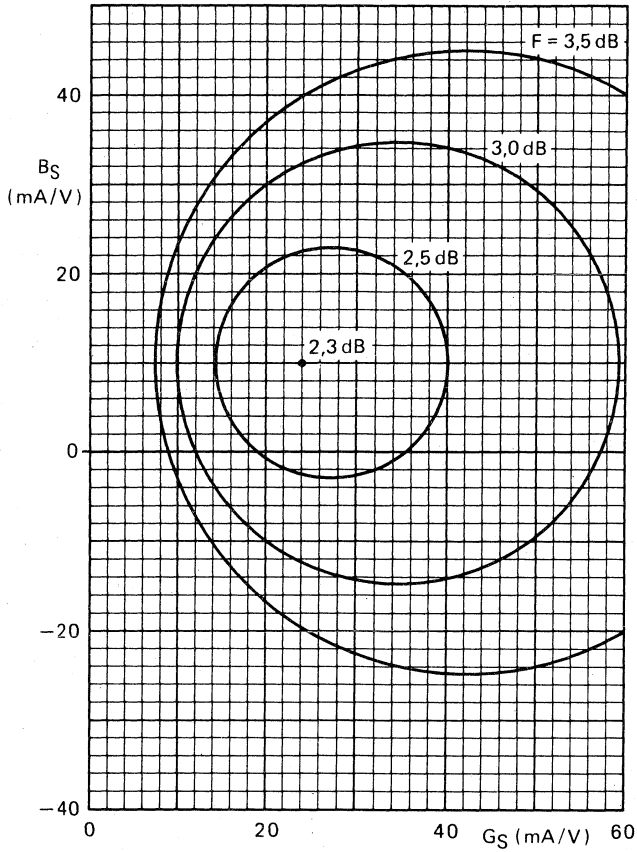


Fig. 16 Circles of constant noise figure.
 $V_{CE} = 8 \text{ V}$; $I_C = 30 \text{ mA}$; $f = 800 \text{ MHz}$;
 $T_{amb} = 25 \text{ }^\circ\text{C}$; typical values.

SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N resistance-stabilized transistor in a SOT-48 capstan envelope featuring extremely low cross modulation, intermodulation and second harmonic distortion. Thanks to its high transition frequency it has a high power gain in conjunction with good wideband properties and low noise up to high frequencies.

It is primarily intended for CATV and MATV applications.

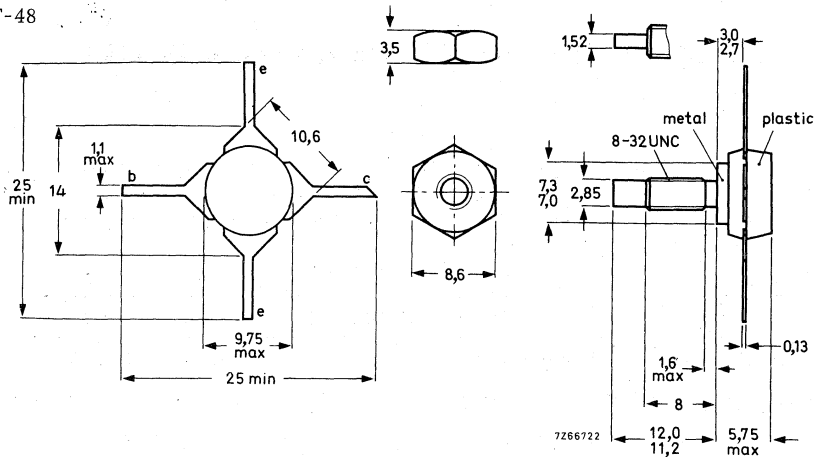
| QUICK REFERENCE DATA | | | |
|---|-----------|------|----------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 30 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 25 V |
| Collector current (d. c.) | I_C | max. | 150 mA |
| Total power dissipation up to $T_h = 145\text{ }^\circ\text{C}$; $f > 1\text{ MHz}$ | P_{tot} | max. | 3,5 W |
| Junction temperature | T_j | max. | 200 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 90\text{ mA}$; $V_{CE} = 20\text{ V}$ | f_T | typ. | 3,5 GHz |
| Cross modulation distortion (channel 13) $I_C = 90\text{ mA}$; $V_{CE} = 20\text{ V}$; $V_o = 48\text{ dBmV}$ | d_{cm} | typ. | -61 dB |
| | | < | -57 dB |
| $I_C = 90\text{ mA}$; $V_{CE} = 20\text{ V}$; $V_o = 32\text{ dBmV}$ | d_{cm} | typ. | -93 dB |
| | | < | -89 dB |
| Intermodulation distortion at $f_{(p+q-r)} = 194, 25\text{ MHz}$ $I_C = 90\text{ mA}$; $V_{CE} = 20\text{ V}$; $V_o = 60\text{ dBmV}$ | d_{im} | typ. | -63 dB |
| Broadband power gain $I_C = 90\text{ mA}$; $V_{CE} = 20\text{ V}$ | G_p | > | 10 dB |
| | | typ. | 11 dB |
| Noise figure at $f = 200\text{ MHz}$ $I_C = 90\text{ mA}$; $V_{CE} = 20\text{ V}$ | F | typ. | 8 dB |
| | | < | 10 dB |
| 2 nd harmonic distortion at $f_p + f_q = 210\text{ MHz}$ $I_C = 90\text{ mA}$; $V_{CE} = 20\text{ V}$; $V_o = 48\text{ dBmV}$ | d_2 | < | -56 dB |

MECHANICAL DATA (see page 2)

MECHANICAL DATA

SOT-48

Dimensions in mm



When locking is required an adhesive instead of a lock washer is preferred.

Torque on nut: min. 0,75 Nm
(7,5 kg cm)
max. 0,85 Nm
(8,5 kg cm)

Diameter of clearance hole in heatsink: max. 4,17 mm.
Mounting hole to have no burrs at either end.
De-burring must leave surface flat; do not chamfer or countersink either end of hole.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Voltages

| | | | | |
|--|-----------|------|----|---|
| Collector-base voltage (open emitter) | V_{CB0} | max. | 30 | V |
| Collector-emitter voltage ($R_{BE} = 10 \Omega$) | V_{CER} | max. | 35 | V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 25 | V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 3 | V |

Currents

| | | | | |
|---|----------|------|-----|----|
| Collector current (d.c.) | I_C | max. | 150 | mA |
| Collector current (peak value); $f > 1$ MHz | I_{CM} | max. | 300 | mA |

Power dissipation

| | | | | |
|--|-----------|------|-----|---|
| Total power dissipation (d.c.) up to $T_h = 160 \text{ }^\circ\text{C}$ | P_{tot} | max. | 2,5 | W |
| Total power dissipation up to $T_h = 145 \text{ }^\circ\text{C}$; $f > 1$ MHz | P_{tot} | max. | 3,5 | W |

Temperatures

| | | | |
|----------------------|-----------|-------------|----------------------|
| Storage temperature | T_{stg} | -65 to +200 | $^\circ\text{C}$ |
| Junction temperature | T_j | max. | 200 $^\circ\text{C}$ |

THERMAL RESISTANCE

| | | | | |
|--------------------------------|---------------|---|-----|--------------------|
| From junction to mounting base | $R_{th j-mb}$ | = | 15 | $^\circ\text{C/W}$ |
| From mounting base to heatsink | $R_{th mb-h}$ | = | 0,6 | $^\circ\text{C/W}$ |

CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified.

Collector cut-off current

$I_E = 0; V_{CB} = 20\text{ V}$ $I_{CBO} < 50\text{ }\mu\text{A}$

D.C. current gain

$I_C = 50\text{ mA}; V_{CE} = 20\text{ V}$ $h_{FE} > 30$ 1)

$I_C = 150\text{ mA}; V_{CE} = 20\text{ V}$ $h_{FE} > 30$ 1)

Transition frequency at $f = 500\text{ MHz}$

$I_C = 90\text{ mA}; V_{CE} = 20\text{ V}$ f_T typ. 3,5 GHz 1)

$I_C = 150\text{ mA}; V_{CE} = 20\text{ V}$ f_T typ. 3,5 GHz 1)

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 20\text{ V}$ C_C typ. 3,5 pF

Emitter capacitance at $f = 1\text{ MHz}$

$I_C = I_c = 0; V_{EB} = 0,5\text{ V}$ C_e typ. 12 pF

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 10\text{ mA}; V_{CE} = 20\text{ V}$ C_{re} typ. 1,3 pF

Collector-stud capacitance at $f = 1\text{ MHz}$

C_{cs} typ. 2 pF

Noise figure at optimum source impedance

$I_C = 90\text{ mA}; V_{CE} = 20\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ F typ. 5 dB 1)

Max. unilateral power gain (s_{re} assumed to be zero)

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$I_C = 90\text{ mA}; V_{CE} = 20\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ G_{UM} typ. 13,5 dB

1) Measured under pulse conditions.

CHARACTERISTICS (continued)

Intermodulation distortion at $T_{amb} = 25\text{ }^{\circ}\text{C}$

$$I_C = 90\text{ mA}; V_{CE} = 20\text{ V}; R_L = 75\ \Omega$$

$$V_p = V_o = 700\text{ mV at } f_p = 495,25\text{ MHz}$$

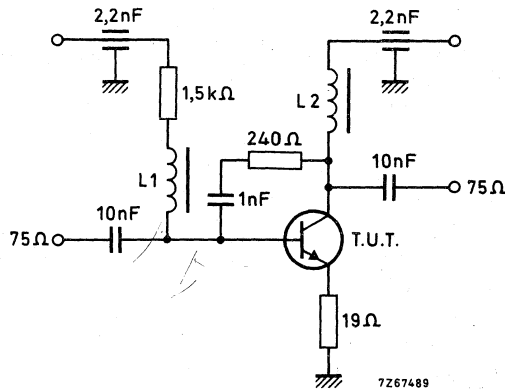
$$V_q = V_o -6\text{ dB at } f_q = 503,25\text{ MHz}$$

$$V_r = V_o -6\text{ dB at } f_r = 505,25\text{ MHz}$$

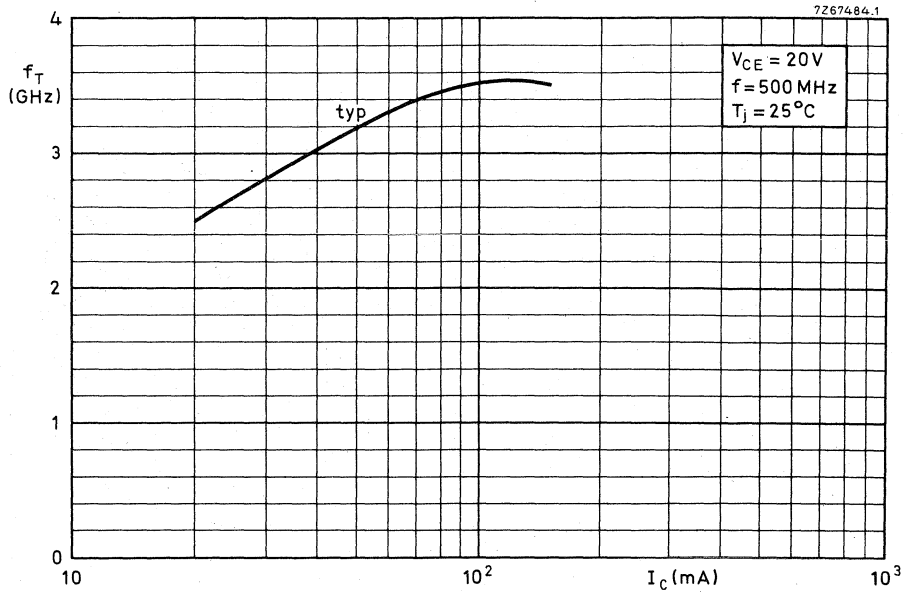
Measured at $f_{(p+q-r)} = 493,25\text{ MHz}$

d_{im} typ. -60 dB

MATV test circuit

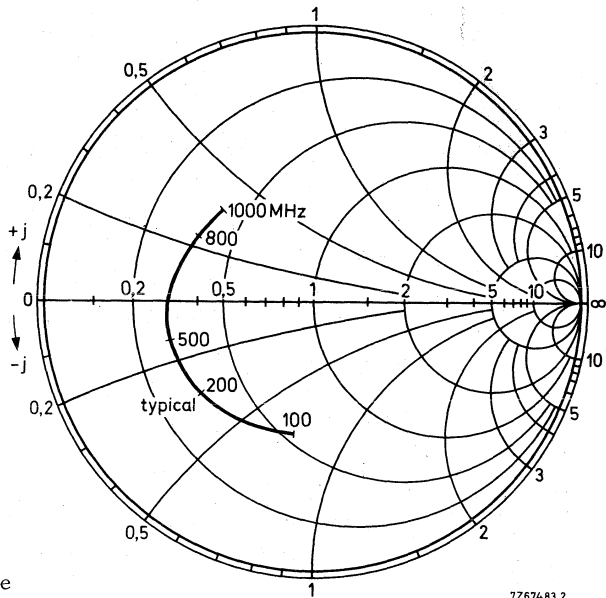


$L1 = L2 = 5\ \mu\text{H}$ ferroxcube coil (code number: 3122 108 20153)

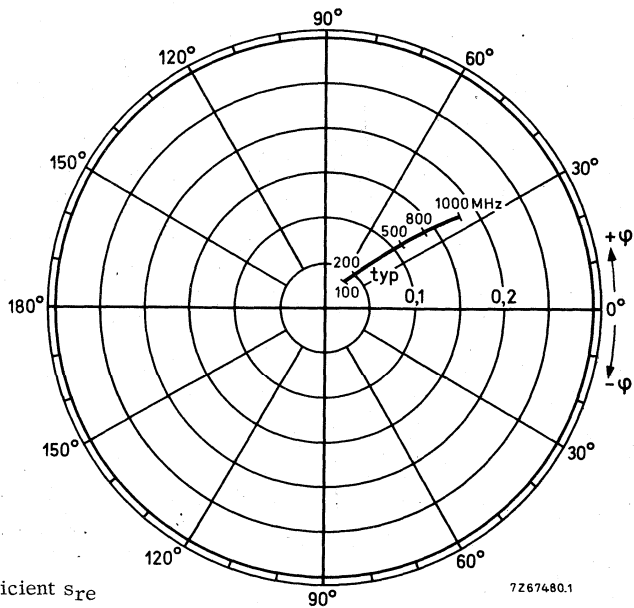


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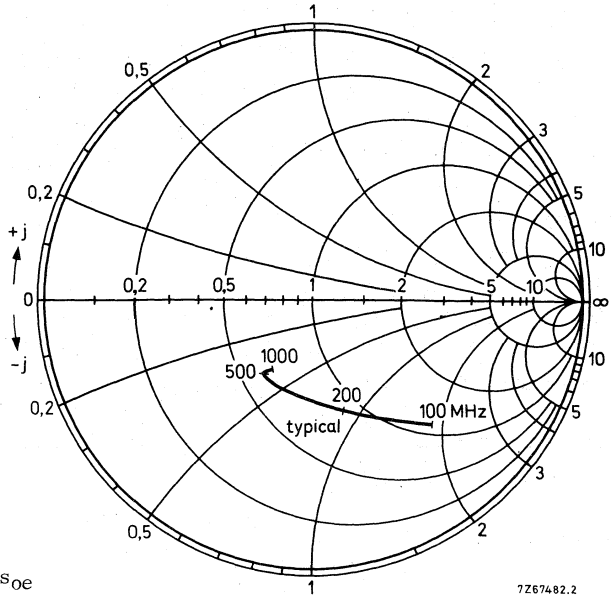
$V_{CE} = 20 \text{ V}$
 $I_C = 90 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$



$V_{CE} = 20 \text{ V}$
 $I_C = 90 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$



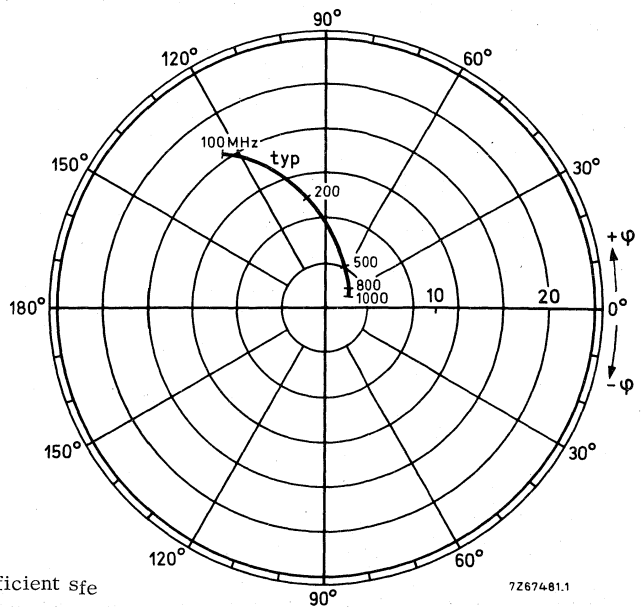
$V_{CE} = 20\text{ V}$
 $I_C = 90\text{ mA}$
 $T_{amb} = 25\text{ }^\circ\text{C}$



Output reflection coefficient s_{oe}

7Z67482.2

$V_{CE} = 20\text{ V}$
 $I_C = 90\text{ mA}$
 $T_{amb} = 25\text{ }^\circ\text{C}$



Forward transmission coefficient s_{fe}

7Z67481.1

APPLICATION INFORMATION (see page 9)

$T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified

Cross modulation distortion (channel 13) 1)

$I_C = 90\text{ mA}; V_{CE} = 20\text{ V}; V_O = 48\text{ dBmV}$

d_{cm} typ. -61 dB
< -57 dB

$I_C = 90\text{ mA}; V_{CE} = 20\text{ V}; V_O = 32\text{ dBmV}$

d_{cm} typ. -93 dB
< -89 dB

Intermodulation distortion

$I_C = 90\text{ mA}; V_{CE} = 20\text{ V}; R_L = 75\text{ }\Omega$

$V_p = V_o = 60\text{ dBmV}$ at $f_p = 196,25\text{ MHz}$

$V_q = V_o - 6\text{ dB}$ at $f_q = 203,25\text{ MHz}$

$V_r = V_o - 6\text{ dB}$ at $f_r = 205,25\text{ MHz}$

Measured at $f(p + q - r) = 194,25\text{ MHz}$

d_{im} typ. -63 dB

Broadband power gain

$I_C = 90\text{ mA}; V_{CE} = 20\text{ V}$

G_p > 10 dB
typ. 11 dB

Noise figure

$I_C = 90\text{ mA}; V_{CE} = 20\text{ V}; f = 200\text{ MHz}$

F typ. 8 dB
< 10 dB

2nd harmonic distortion

$I_C = 90\text{ mA}; V_{CE} = 20\text{ V}$

$f_p = 66\text{ MHz}; f_q = 144\text{ MHz}; f_p + f_q = 210\text{ MHz}; V_O = 48\text{ dBmV}$

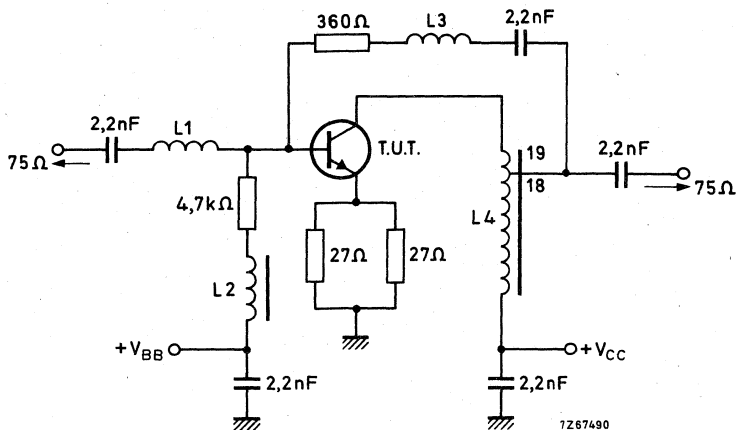
d_2 < -56 dB

1) In 12-channel measuring equipment; channel 13 unmodulated.

V_O = output level/signal, according to NCTA measuring standard.

APPLICATION INFORMATION (continued)

CATV test circuit



Frequency range 40 to 300 MHz (flatness gain $\pm 0, 2$ dB)

Return losses input and output < -16 dB

Power gain G_p typ. 11 dB

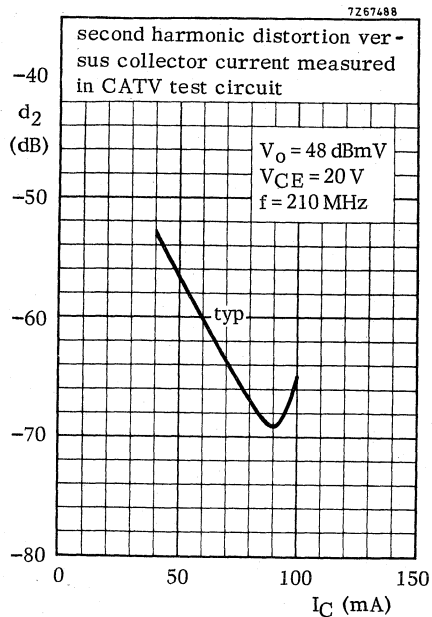
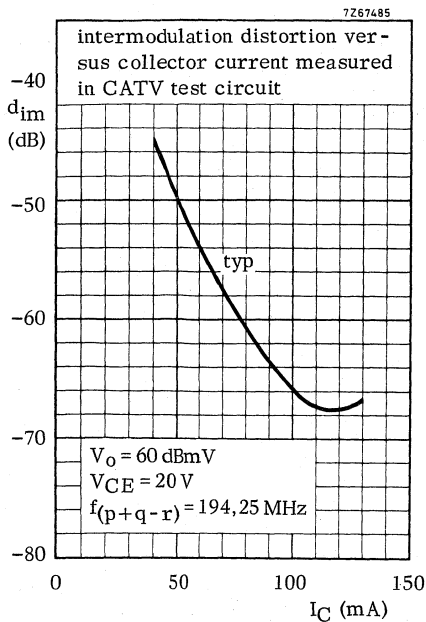
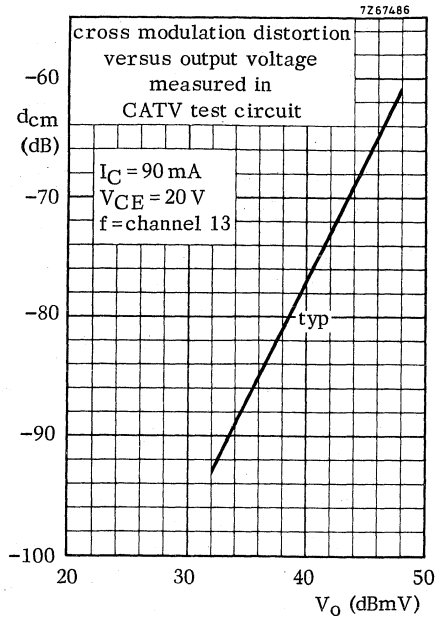
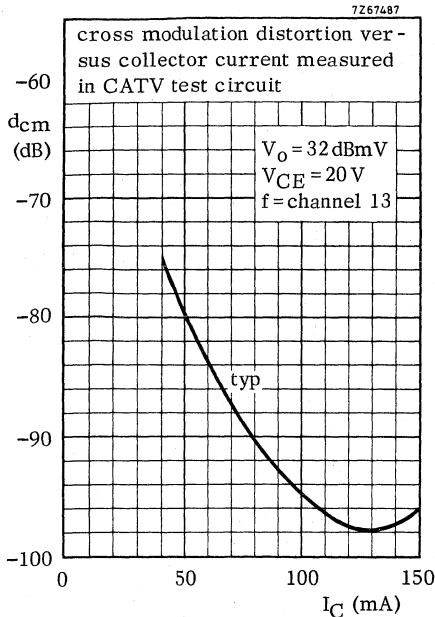
L1 = 2 turns closely wound enamelled Cu wire (0,7 mm); int. diam. 3 mm

L2 = 5 μ H ferroxcube coil (code number 3122 108 20153)

L3 = 5 turns closely wound enamelled Cu wire (0,7 mm); int. diam. 4,7 mm

L4 = 19 turns enamelled Cu wire (0,3 mm) on ferroxcube core (code no. 4322 020 91001)

APPLICATION INFORMATION (continued)



SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N resistance stabilized transistor in a TO-39 metal envelope.

Due to very linear characteristics the transistor features low cross modulation, intermodulation and second harmonic distortion. Thanks to its high transition frequency it has a high power gain combined with excellent wideband properties and low noise up to high frequencies.

The BFR95 is primarily intended for CATV and MATV applications.

QUICK REFERENCE DATA

| | | | |
|---|-----------|-----------|----------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 30 V |
| Collector-emitter voltage (open base) | V_{CE0} | max. | 25 V |
| Collector current (d.c.) | I_C | max. | 150 mA |
| Total power dissipation up to $T_{mb} = 125\text{ }^\circ\text{C}$ | P_{tot} | max. | 1,5 W |
| Junction temperature | T_j | max. | 200 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 80\text{ mA}; V_{CE} = 20\text{ V}$ | f_T | typ. | 3,5 GHz |
| Cross modulation distortion (channel 13) $I_C = 80\text{ mA}; V_{CE} = 18\text{ V}; V_o = 48\text{ dBmV}$ | d_{cm} | typ. < | -61 dB -57 dB |
| $I_C = 80\text{ mA}; V_{CE} = 18\text{ V}; V_o = 32\text{ dBmV}$ | d_{cm} | typ. < | -93 dB -89 dB |
| Intermodulation distortion at $f_{(p+q-r)} = 194,25\text{ MHz}$ $I_C = 80\text{ mA}; V_{CE} = 18\text{ V}; V_o = 60\text{ dBmV}$ | d_{im} | typ. | -64 dB |
| Broadband power gain $I_C = 80\text{ mA}; V_{CE} = 18\text{ V}$ | G_p | > typ. | 8 dB 9 dB |
| Noise figure at $f = 200\text{ MHz}$ $I_C = 80\text{ mA}; V_{CE} = 18\text{ V}$ | F | typ. < | 9 dB 10 dB |
| Second harmonic distortion at $f_{(p+q)} = 210\text{ MHz}$ $I_C = 80\text{ mA}; V_{CE} = 18\text{ V}; V_o = 48\text{ dBmV}$ | d_2 | typ. | -62 dB |

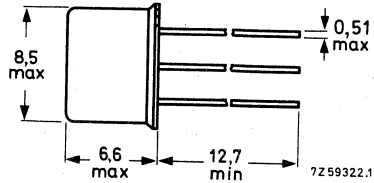
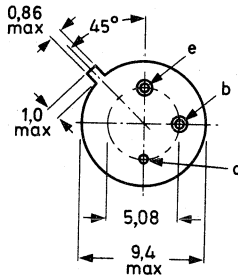
MECHANICAL DATA see page 2.

MECHANICAL DATA

Fig. 1 TO-39

Collector connected to case

Dimensions in mm



Maximum lead diameter guaranteed only for 12,7 mm.
Accessories: 56245 (distance disc).

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|---|-----------|------|-----------------|
| Collector-base voltage (open emitter) note 1 | V_{CBO} | max. | 30 V |
| Collector-emitter voltage ($R_{BE} = 10 \Omega$) note 2 | V_{CER} | max. | 35 V |
| Collector-emitter voltage (open base) note 2 | V_{CEO} | max. | 25 V |
| Emitter-base voltage (open collector) note 3 | V_{EBO} | max. | 3 V |
| Collector current (d.c.) | I_C | max. | 150 mA |
| Collector current (peak value); $f > 1$ MHz | I_{CM} | max. | 300 mA |
| Total power dissipation up to $T_{amb} = 25^\circ C$ | P_{tot} | max. | 0,7 W |
| up to $T_{mb} = 125^\circ C$ | P_{tot} | max. | 1,5 W |
| Storage temperature | T_{stg} | | -65 to + 200 °C |
| Junction temperature | T_j | max. | 200 °C |

THERMAL RESISTANCE (note 4)

| | | | |
|--------------------------------------|----------------|---|---------|
| From junction to ambient in free air | $R_{th\ j-a}$ | = | 250 K/W |
| From junction to mounting base | $R_{th\ j-mb}$ | = | 50 K/W |

Notes

1. At $I_C = 100 \mu A$.
2. At $I_C = 10 mA$.
3. At $I_E = 100 \mu A$.
4. K/W is SI unit for °C/W.

CHARACTERISTICS $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 20\text{ V}$

$I_{CBO} < 50\text{ }\mu\text{A}$

D.C. current gain (note 1)

$I_C = 50\text{ mA}; V_{CE} = 20\text{ V}$

$h_{FE} > 30$

$I_C = 150\text{ mA}; V_{CE} = 20\text{ V}$

$h_{FE} > 30$

Transition frequency at $f = 500\text{ MHz}$ (note 1)

$I_C = 80\text{ mA}; V_{CE} = 20\text{ V}$

f_T typ. 3,5 GHz

$I_C = 150\text{ mA}; V_{CE} = 20\text{ V}$

f_T typ. 3,5 GHz

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 20\text{ V}$

C_c typ. 3,5 pF

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 10\text{ mA}; V_{CE} = 20\text{ V}$

C_{re} typ. 1,6 pF

APPLICATION INFORMATION (see also test circuit on page 4)Measuring conditions: $I_C = 80\text{ mA}; V_{CE} = 18\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$

Cross modulation (channel 13) (note 2)

$V_o = 48\text{ dBmV}$

d_{cm} typ. -61 dB
< -57 dB

$V_o = 32\text{ dBmV}$

d_{cm} typ. -93 dB
< -89 dB

Intermodulation distortion

$V_p = V_o = 60\text{ dBmV}$ at $f_p = 196,25\text{ MHz}$

$V_q = V_o - 6\text{ dB}$ at $f_q = 203,25\text{ MHz}$

$V_r = V_o - 6\text{ dB}$ at $f_r = 205,25\text{ MHz}$

Measured at $f_{(p+q-r)} = 194,25\text{ MHz}$

d_{im} typ. -64 dB
> 8 dB

Broadband power gain

G_p typ. 9 dB

Noise figure at $f = 200\text{ MHz}$

F typ. 9 dB
< 10 dB

2nd harmonic distortion at $f_{(p+q)} = 210\text{ MHz}$

$f_p = 66\text{ MHz}; f_q = 144\text{ MHz}; V_o = 48\text{ dBmV}$

d_2 typ. -62 dB
< -56 dB

Notes

1. Measured under pulse conditions.

2. In 12-channel measuring equipment; channel 13 unmodulated.

 V_o = output level/signal, in accordance with NCTA measuring standard.

APPLICATION INFORMATION

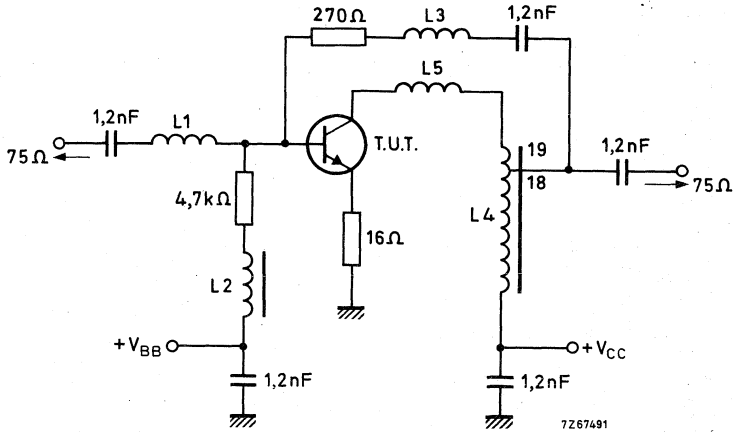


Fig. 2 CATV test circuit.

Frequency range 40 to 300 MHz

Power gain G_p typ. 9 dB

L1 = 2 turns closely wound enamelled Cu wire (0,7 mm); int. dia. 3 mm

L2 = 5 μ H Ferroxcube coil (cat. no. 3122 108 20153)

L3 = 3 turns closely wound enamelled Cu wire (0,7 mm); int. dia. 4,7 mm

L4 = 19 turns enamelled Cu wire (0,3 mm) on Ferroxcube core (cat. no. 4322 020 91001)

L5 = 2 turns closely wound enamelled Cu wire (0,7 mm); int. dia. 3 mm.

SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a subminiature plastic transfer-moulded T-package.

It is primarily intended for use in u. h. f. and microwave amplifiers such as in aerial amplifiers, radar systems, oscilloscopes, spectrum analysers, etc.

The transistor features very low intermodulation distortion and high power gain; thanks to its very high transition frequency, it also has excellent wideband properties and low noise up to high frequencies.

QUICK REFERENCE DATA

| | | | | |
|--|-----------|------|------|------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 20 | V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 | V |
| Collector current (d. c.) | I_C | max. | 75 | mA |
| Total power dissipation up to $T_{amb} = 60^\circ\text{C}$ | P_{tot} | max. | 500 | mW |
| Junction temperature | T_j | max. | 175 | $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ | f_T | typ. | 5 | GHz |
| $I_C = 50\text{ mA}; V_{CE} = 10\text{ V}$ | | | | |
| Feedback capacitance at $f = 1\text{ MHz}$ | C_{re} | < | 1,4 | pF |
| $I_C = 10\text{ mA}; V_{CE} = 10\text{ V}; T_{amb} = 25^\circ\text{C}$ | | | | |
| Noise figure at optimum source impedance | F | typ. | 3,3 | dB |
| $I_C = 50\text{ mA}; V_{CE} = 10\text{ V}; f = 500\text{ MHz}; T_{amb} = 25^\circ\text{C}$ | | | | |
| Max. unilateral power gain (see page 3) | G_{UM} | typ. | 15,2 | dB |
| $I_C = 50\text{ mA}; V_{CE} = 10\text{ V}; f = 500\text{ MHz}; T_{amb} = 25^\circ\text{C}$ | | | | |
| Intermodulation distortion at $T_{amb} = 25^\circ\text{C}$ | d_{im} | typ. | -60 | dB |
| $I_C = 50\text{ mA}; V_{CE} = 10\text{ V}; R_L = 75\ \Omega; V_o = 500\text{ mV}$ | | | | |
| $f(p + q - r) = 493,25\text{ MHz}$ (see page 4) | | | | |

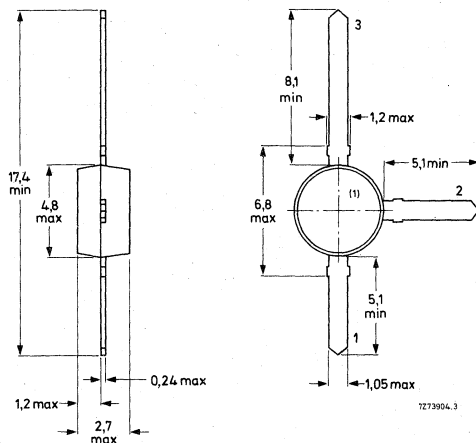
MECHANICAL DATA

Dimensions in mm

Fig. 1 SOT-37.

Connections

1. Base
2. Emitter
3. Collector



(1) = type number marking.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

| | | | | |
|---------------------------------------|-----------|------|-----|---|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 20 | V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 | V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 3,0 | V |

Currents

| | | | | |
|---|----------|------|-----|----|
| Collector current (d. c.) | I_C | max. | 75 | mA |
| Collector current (peak value); $f > 1$ MHz | I_{CM} | max. | 150 | mA |

Power dissipation

Total power dissipation up to $T_{amb} = 60$ °C
 mounted on a fibre-glass print
 of 40 mm x 35 mm x 1,5 mm

| | | | |
|-----------|------|-----|----|
| P_{tot} | max. | 500 | mW |
|-----------|------|-----|----|

Temperatures

| | | | |
|----------------------|-----------|-------------|--------|
| Storage temperature | T_{stg} | -65 to +175 | °C |
| Junction temperature | T_j | max. | 175 °C |

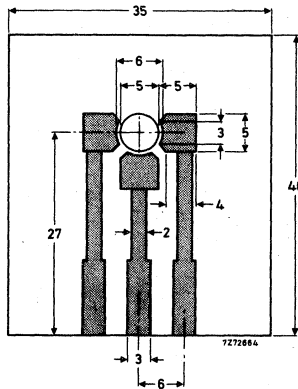
THERMAL RESISTANCE

From junction to ambient in free air
 mounted on a fibre-glass print
 of 40 mm x 35 mm x 1,5 mm

$R_{th\ j-a} = 0,23$ °C/mW

Requirements for fibre-glass print

Dimensions in mm



Single-sided 35 μ m Cu-clad epoxy fibre-glass print, thickness 1,5 mm.
 Tracks are fully tin-lead plated.

CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 10\text{ V}$

$I_{CBO} < 100\text{ nA}$

D.C. current gain ¹⁾

$I_C = 50\text{ mA}; V_{CE} = 10\text{ V}$

$h_{FE} > 25$
typ. 50

$I_C = 75\text{ mA}; V_{CE} = 10\text{ V}$

$h_{FE} > 25$
typ. 52

Transition frequency at $f = 500\text{ MHz}$ ¹⁾

$I_C = 50\text{ mA}; V_{CE} = 10\text{ V}$

$f_T > 4,0\text{ GHz}$
typ. 5,0 GHz

$I_C = 75\text{ mA}; V_{CE} = 10\text{ V}$

$f_T > 4,4\text{ GHz}$
typ. 5,5 GHz

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 10\text{ V}$

C_c typ. 1,3 pF

Emitter capacitance at $f = 1\text{ MHz}$

$I_C = I_c = 0; V_{EB} = 0,5\text{ V}$

C_e typ. 6,5 pF

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 10\text{ mA}; V_{CE} = 10\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$

C_{re} typ. 1,0 pF
< 1,4 pF

Noise figure at optimum source impedance

$I_C = 50\text{ mA}; V_{CE} = 10\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$

F typ. 3,3 dB

$I_C = 50\text{ mA}; V_{CE} = 10\text{ V}; f = 800\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$

F typ. 3,8 dB

Max. unilateral power gain (s_{re} assumed to be zero)

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$I_C = 50\text{ mA}; V_{CE} = 10\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$

G_{UM} typ. 15,2 dB

¹⁾ Measured under pulse conditions.

CHARACTERISTICS (continued)

Intermodulation distortion at $T_{amb} = 25\text{ }^{\circ}\text{C}$

$I_C = 50\text{ mA}$; $V_{CE} = 10\text{ V}$; $R_L = 75\text{ }\Omega$

$V_p = V_o = 500\text{ mV}$ at $f_p = 495,25\text{ MHz}$

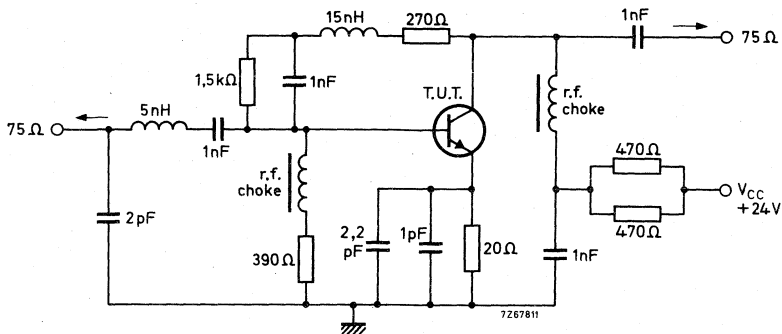
$V_q = V_o - 6\text{ dB}$ at $f_q = 503,25\text{ MHz}$

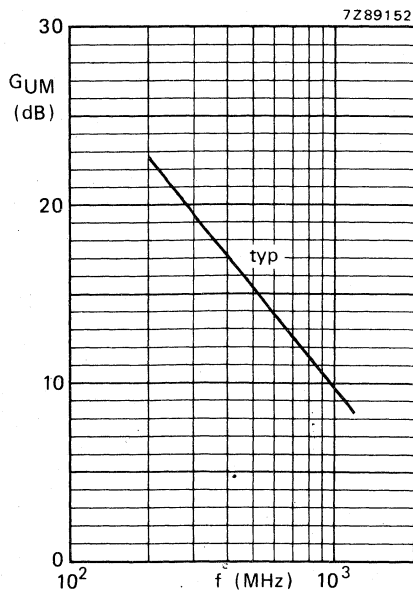
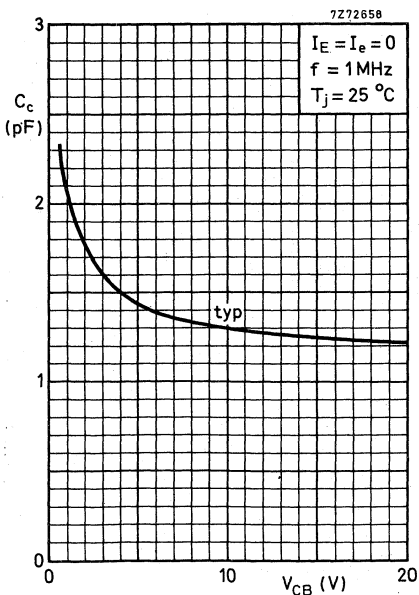
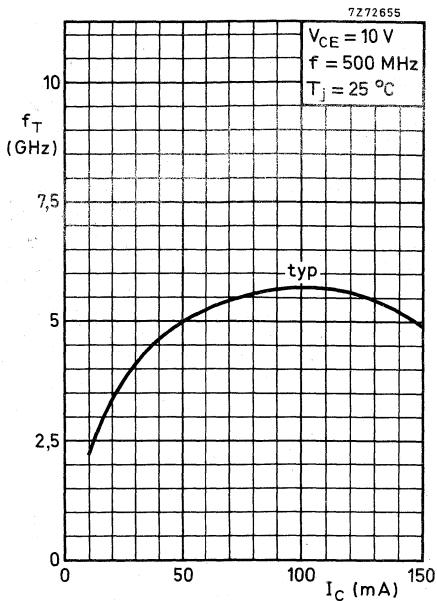
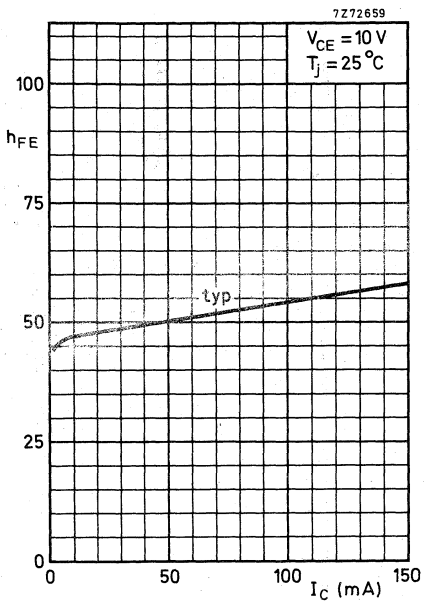
$V_r = V_o - 6\text{ dB}$ at $f_r = 505,25\text{ MHz}$

Measured at $f_{(p+q-r)} = 493,25\text{ MHz}$

d_{im} typ. -60 dB

Intermodulation test circuit:

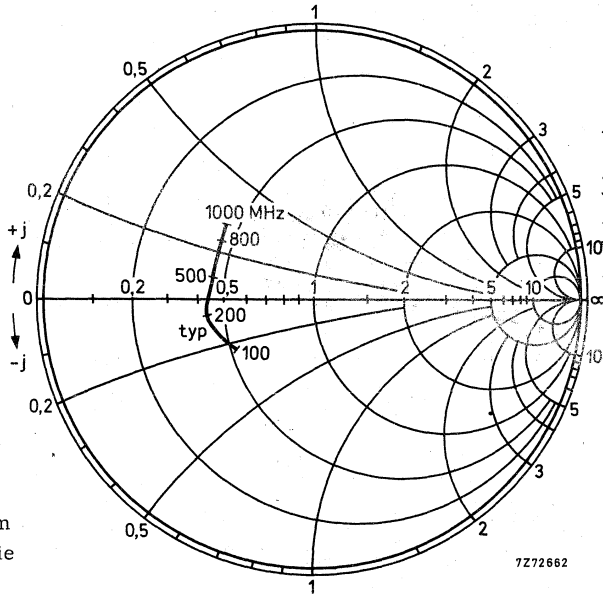




$V_{CE} = 10\text{ V}; I_C = 50\text{ mA}; T_{amb} = 25\text{ }^\circ\text{C}.$

BFR96

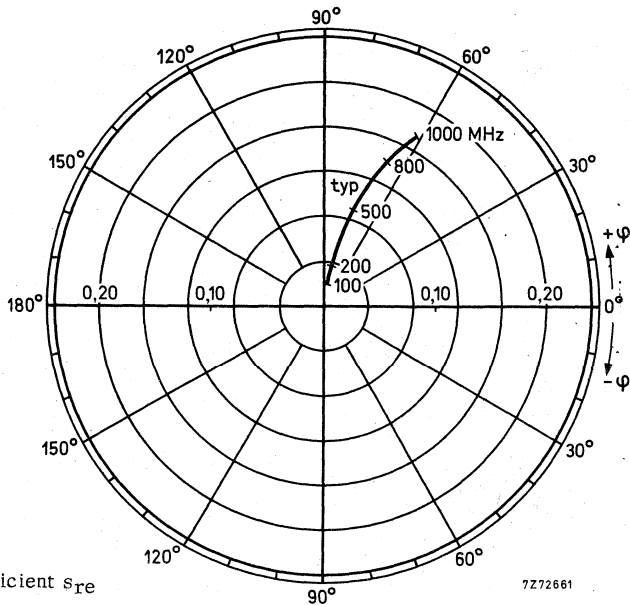
$V_{CE} = 10 \text{ V}$
 $I_C = 50 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$



Input impedance derived from
 input reflection coefficient s_{ie}
 co-ordinates in ohm $\times 50$

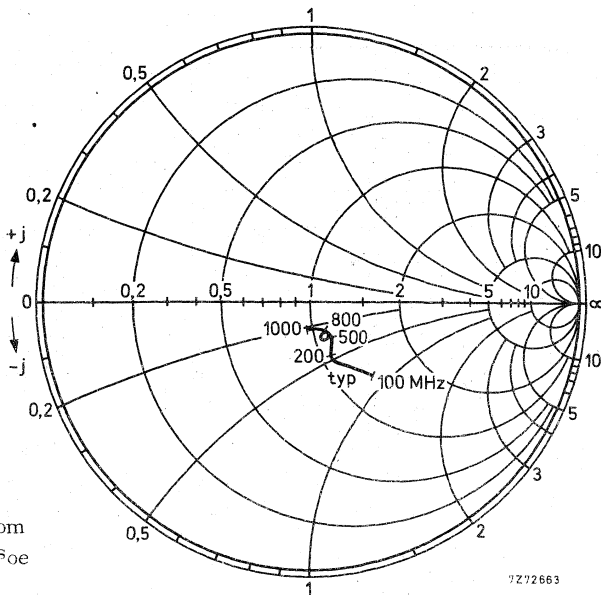


$V_{CE} = 10 \text{ V}$
 $I_C = 50 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$

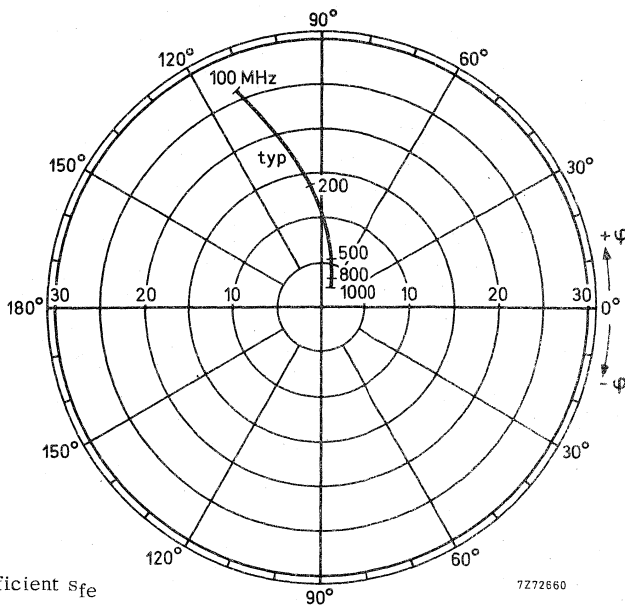


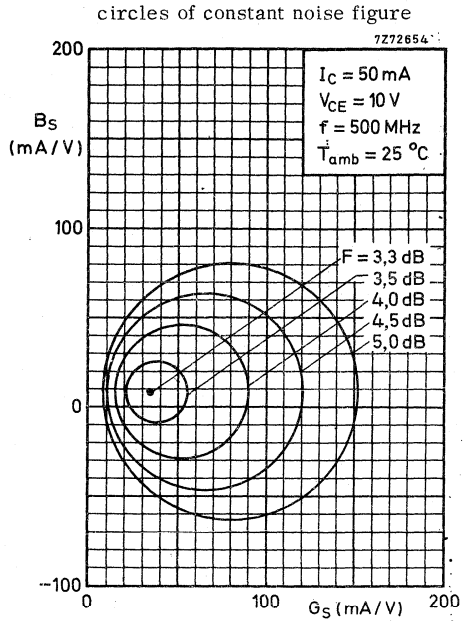
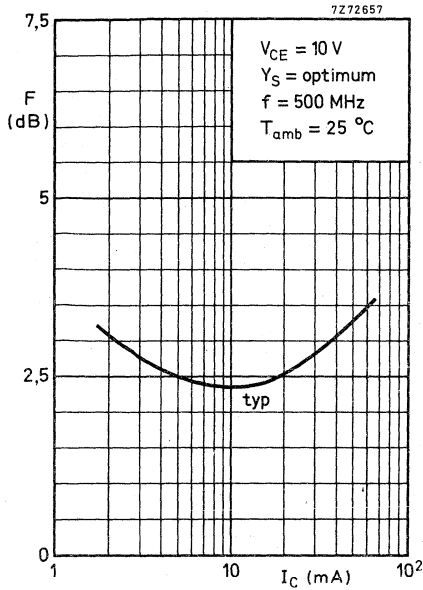
Reverse transmission coefficient s_{re}

$V_{CE} = 10 \text{ V}$
 $I_C = 50 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$



$V_{CE} = 10 \text{ V}$
 $I_C = 50 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$





SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a plastic T-package, primarily intended for MATV applications. The device features excellent output voltage capabilities.

QUICK REFERENCE DATA

| | | | |
|---|-----------|------|----------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 20 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 V |
| Collector current (d.c.) | I_C | max. | 100 mA |
| Total power dissipation up to $T_{amb} = 70\text{ }^\circ\text{C}$ | P_{tot} | max. | 700 mW |
| Junction temperature | T_j | max. | 175 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 70\text{ mA}$; $V_{CE} = 10\text{ V}$ | f_T | typ. | 5 GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $I_C = 0$; $V_{CE} = 10\text{ V}$ | C_{re} | typ. | 1 pF |
| Noise figure at optimum source impedance $I_C = 70\text{ mA}$; $V_{CE} = 10\text{ V}$; $f = 800\text{ MHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | F | typ. | 4,0 dB |
| Maximum unilateral power gain $I_C = 70\text{ mA}$; $V_{CE} = 10\text{ V}$; $f = 800\text{ MHz}$; $T_{amb} = 25\text{ }^\circ\text{C}$ | G_{UM} | typ. | 11,5 dB |
| Output voltage at $d_{im} = -60\text{ dB}$ (see Fig. 3) $I_C = 70\text{ mA}$; $V_{CE} = 10\text{ V}$; $R_L = 75\text{ }\Omega$; $T_{amb} = 25\text{ }^\circ\text{C}$ $f_{(p+q-r)} = 793,25\text{ MHz}$ | V_o | typ. | 700 mV |

MECHANICAL DATA

SOT-37 (see Fig. 1).

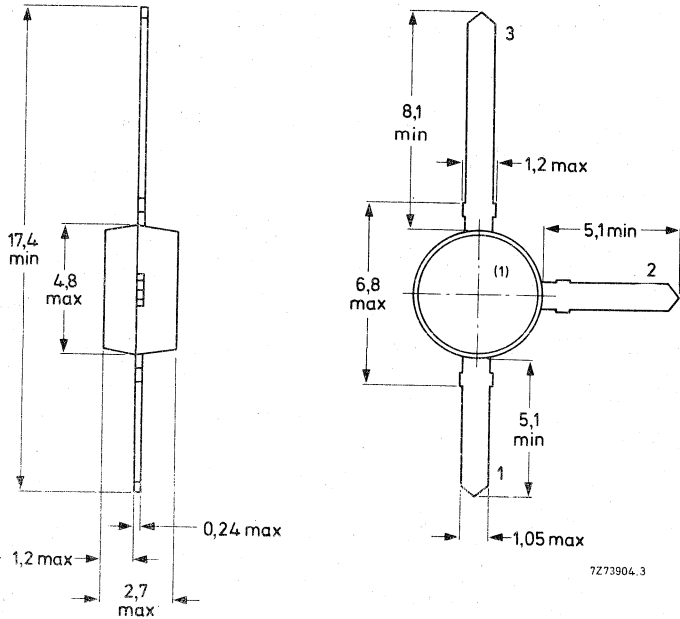
MECHANICAL DATA

Fig. 1 SOT-37.

Dimensions in mm

Connections

- 1. Base
- 2. Emitter
- 3. Collector



(1) = type number marking.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|--|-----------|------|-------------------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 20 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 3,0 V |
| Collector current (d.c.) | I_C | max. | 100 mA |
| Total power dissipation up to $T_{amb} = 70\text{ }^\circ\text{C}$ mounted on a fibre-glass print (see Fig. 2) of 50 mm x 50 mm x 1,5 mm | | | |
| Storage temperature | P_{tot} | max. | 700 mW |
| Junction temperature | T_{stg} | | -65 to + 175 $^\circ\text{C}$ |
| | T_j | max. | 175 $^\circ\text{C}$ |

THERMAL RESISTANCE

From junction to ambient in free air
mounted on a fibre-glass print (see Fig. 2)
of 50 mm x 50 mm x 1,5 mm

$R_{th\ j-a} = 150\text{ K/W}^*$

* K/W is SI unit for $^\circ\text{C/W}$.

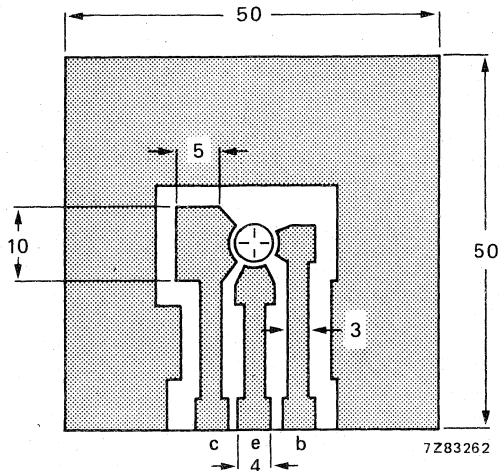


Fig. 2 Requirements for fibre-glass print. (Dimensions in mm.)
Single-sided 35 µm Cu-clad epoxy fibre-glass print, thickness
1,5 mm. Tracks are fully tin-lead plated. Shaded area is Cu.

CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$$I_E = 0; V_{CB} = 10\text{ V}$$

$$I_{CBO} < 100\text{ nA}$$

D.C. current gain*

$$I_C = 70\text{ mA}; V_{CE} = 10\text{ V}$$

$$h_{FE} > 25$$

Transition frequency at $f = 500\text{ MHz}$

$$I_C = 70\text{ mA}; V_{CE} = 10\text{ V}$$

$$f_T \text{ typ. } 5\text{ GHz}$$

Collector capacitance at $f = 1\text{ MHz}$

$$I_E = I_e = 0; V_{CB} = 10\text{ V}$$

$$C_c \text{ typ. } 1,5\text{ pF}$$

Emitter capacitance at $f = 1\text{ MHz}$

$$I_C = I_c = 0; V_{EB} = 0,5\text{ V}$$

$$C_e \text{ typ. } 6,5\text{ pF}$$

Feedback capacitance at $f = 1\text{ MHz}$

$$I_C = 0; V_{CE} = 10\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$$

$$C_{re} \text{ typ. } 1\text{ pF}$$

Noise figure at optimum source impedance

$$I_C = 70\text{ mA}; V_{CE} = 10\text{ V}; f = 800\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$$

$$F \text{ typ. } 4,0\text{ dB}$$

Maximum unilateral power gain (s_{re} assumed to be zero)

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$$I_C = 70\text{ mA}; V_{CE} = 10\text{ V}; f = 800\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$$

$$G_{UM} \text{ typ. } 11,5\text{ dB}$$

* Measured under pulse conditions.

s-parameters (common emitter) at $V_{CE} = 5\text{ V}$

| I_C mA | f MHz | S_{ie} | S_{re} | S_{fe} | S_{oe} |
|-------------|----------|---------------|---------------|---------------|---------------|
| 5 | 40 | 0,75/ -41,5° | 0,026/+ 69,1° | 15,1/+ 155,2° | 0,93/ -17,4° |
| | 200 | 0,62/ -128,1° | 0,064/+ 41,9° | 7,1/+ 106,9° | 0,53/ -43,3° |
| | 500 | 0,55/ -174,6° | 0,087/+ 47,0° | 3,2/+ 79,8° | 0,40/ -53,2° |
| | 800 | 0,56/+ 158,7° | 0,115/+ 56,5° | 2,1/ + 65,0° | 0,39/ -63,2° |
| | 1000 | 0,58/+ 146,7° | 0,135/+ 59,2° | 1,7/ + 56,6° | 0,39/ -72,5° |
| | 1200 | 0,61/+ 135,5° | 0,159/+ 61,7° | 1,4/ + 48,9° | 0,39/ -83,0° |
| 10 | 40 | 0,60/ -59,1° | 0,022/+ 64,1° | 24,3/+ 147,2° | 0,86/ -26,6° |
| | 200 | 0,54/ -146,1° | 0,050/+ 49,4° | 9,1/+ 100,7° | 0,38/ -54,7° |
| | 500 | 0,50/+ 175,8° | 0,087/+ 59,3° | 3,9/ + 78,6° | 0,27/ -62,8° |
| | 800 | 0,52/+ 152,4° | 0,129/+ 63,7° | 2,5/ + 65,8° | 0,27/ -72,2° |
| | 1000 | 0,53/+ 141,0° | 0,157/+ 63,9° | 2,1/ + 58,0° | 0,27/ -80,7° |
| | 1200 | 0,56/+ 130,7° | 0,186/+ 63,3° | 1,7/ + 51,2° | 0,27/ -90,9° |
| 30 | 40 | 0,39/ -105,6° | 0,015/+ 60,7° | 39,6/+ 133,3° | 0,69/ -44,1° |
| | 200 | 0,44/ -168,4° | 0,041/+ 65,9° | 11,1/ + 94,3° | 0,23/ -78,2° |
| | 500 | 0,46/+ 165,1° | 0,094/+ 70,3° | 4,7/ + 77,3° | 0,16/ -88,4° |
| | 800 | 0,48/+ 145,4° | 0,146/+ 69,2° | 3,0/ + 66,5° | 0,16/ -98,3° |
| | 1000 | 0,51/+ 135,6° | 0,175/+ 66,6° | 2,5/ + 60,1° | 0,16/ -109,3° |
| | 1200 | 0,53/+ 126,2° | 0,206/+ 64,2° | 2,1/ + 54,0° | 0,17/ -119,7° |
| 50 | 40 | 0,37/ -129,3° | 0,013/+ 63,4° | 44,6/+ 127,8° | 0,62/ -51,4° |
| | 200 | 0,43/ -174,7° | 0,040/+ 71,5° | 11,5/ + 92,5° | 0,19/ -89,2° |
| | 500 | 0,45/+ 162,4° | 0,095/+ 72,7° | 4,8/ + 76,8° | 0,14/ -101,5° |
| | 800 | 0,48/+ 143,4° | 0,151/+ 70,1° | 3,1/ + 66,5° | 0,14/ -111,5° |
| | 1000 | 0,50/+ 134,3° | 0,182/+ 67,4° | 2,5/ + 60,4° | 0,14/ -121,5° |
| | 1200 | 0,52/+ 124,9° | 0,215/+ 64,8° | 2,1/ + 54,6° | 0,15/ -130,7° |
| 70 | 40 | 0,38/ -141,7° | 0,011/+ 65,1° | 46,9/+ 124,9° | 0,57/ -55,8° |
| | 200 | 0,43/ -177,6° | 0,040/+ 73,7° | 11,6/ + 91,6° | 0,18/ -96,3° |
| | 500 | 0,46/+ 161,2° | 0,095/+ 73,9° | 4,9/ + 76,5° | 0,13/ -109,5° |
| | 800 | 0,49/+ 143,1° | 0,150/+ 70,6° | 3,1/ + 66,4° | 0,13/ -120,7° |
| | 1000 | 0,49/+ 133,5° | 0,186/+ 67,7° | 2,5/ + 60,2° | 0,14/ -126,2° |
| | 1200 | 0,52/+ 124,1° | 0,218/+ 65,0° | 2,1/ + 54,6° | 0,15/ -135,3° |

s-parameters (common emitter) at $V_{CE} = 10\text{ V}$

| I_C mA | f MHz | s_{ie} | s_{re} | s_{fe} | s_{oe} |
|-------------|----------|---------------|---------------|---------------|--------------|
| 5 | 40 | 0,77/ -38,9° | 0,023/+ 69,1° | 15,2/+ 156,2° | 0,93/ -15,4° |
| | 200 | 0,62/-124,0° | 0,059/+ 43,1° | 7,4/+ 108,3° | 0,57/ -38,0° |
| | 500 | 0,54/-172,5° | 0,081/+ 48,0° | 3,4/+ 80,8° | 0,45/ -46,8° |
| | 800 | 0,55/+ 159,9° | 0,106/+ 57,8° | 2,2/+ 65,9° | 0,43/ -57,1° |
| | 1000 | 0,56/+ 147,2° | 0,126/+ 61,5° | 1,8/+ 57,5° | 0,43/ -64,9° |
| | 1200 | 0,58/+ 135,9° | 0,150/+ 64,4° | 1,5/+ 50,1° | 0,42/ -74,7° |
| 10 | 40 | 0,62/ -54,5° | 0,020/+ 64,9° | 24,5/+ 148,7° | 0,87/ -23,5° |
| | 200 | 0,53/-142,3° | 0,046/+ 49,6° | 9,6/+ 102,0° | 0,42/ -47,8° |
| | 500 | 0,48/+ 177,6° | 0,080/+ 59,4° | 4,2/+ 79,4° | 0,31/ -54,2° |
| | 800 | 0,50/+ 153,2° | 0,118/+ 64,0° | 2,7/+ 66,4° | 0,31/ -63,5° |
| | 1000 | 0,52/+ 142,3° | 0,143/+ 64,1° | 2,2/+ 59,1° | 0,31/ -70,0° |
| | 1200 | 0,54/+ 131,8° | 0,168/+ 64,3° | 1,8/+ 52,4° | 0,30/ -79,5° |
| 30 | 40 | 0,41/ -94,4° | 0,014/+ 62,2° | 40,9/+ 135,0° | 0,72/ -39,2° |
| | 200 | 0,42/-164,6° | 0,039/+ 65,5° | 11,8/+ 95,1° | 0,25/ -64,5° |
| | 500 | 0,42/+ 167,0° | 0,087/+ 70,4° | 4,9/+ 77,9° | 0,19/ -71,1° |
| | 800 | 0,45/+ 146,6° | 0,136/+ 69,3° | 3,2/+ 67,1° | 0,18/ -79,1° |
| | 1000 | 0,47/+ 136,6° | 0,166/+ 67,2° | 2,6/+ 60,6° | 0,18/ -83,8° |
| | 1200 | 0,49/+ 126,3° | 0,196/+ 65,0° | 2,2/+ 54,6° | 0,17/ -95,1° |
| 50 | 40 | 0,36/-114,4° | 0,012/+ 62,7° | 46,5/+ 129,6° | 0,63/ -45,7° |
| | 200 | 0,40/-171,0° | 0,038/+ 70,4° | 12,3/+ 93,1° | 0,20/ -71,4° |
| | 500 | 0,41/+ 163,9° | 0,090/+ 72,4° | 5,1/+ 77,1° | 0,16/ -79,7° |
| | 800 | 0,44/+ 144,7° | 0,140/+ 70,1° | 3,3/+ 66,7° | 0,15/ -86,0° |
| | 1000 | 0,47/+ 135,3° | 0,168/+ 67,3° | 2,7/+ 60,8° | 0,14/ -95,3° |
| | 1200 | 0,49/+ 125,2° | 0,197/+ 65,0° | 2,3/+ 55,2° | 0,14/-106,6° |
| 70 | 40 | 0,35/-125,4° | 0,012/+ 63,6° | 49,1/+ 125,7° | 0,58/ -49,5° |
| | 200 | 0,40/-173,7° | 0,038/+ 72,7° | 12,4/+ 92,0° | 0,18/ -74,8° |
| | 500 | 0,41/+ 162,6° | 0,091/+ 73,2° | 5,2/+ 76,7° | 0,15/ -82,0° |
| | 800 | 0,44/+ 144,1° | 0,143/+ 70,2° | 3,3/+ 66,4° | 0,14/ -87,4° |
| | 1000 | 0,46/+ 134,6° | 0,175/+ 67,3° | 2,7/+ 60,2° | 0,13/ -95,3° |
| | 1200 | 0,48/+ 124,1° | 0,200/+ 64,8° | 2,3/+ 54,6° | 0,13/-109,5° |



Output voltage at $d_{im} = -60$ dB (see Figs 3 and 5)

(DIN45004B, par. 6.3: 3-tone)

$I_C = 70$ mA; $V_{CE} = 10$ V; $R_L = 75 \Omega$; $T_{amb} = 25$ °C

$V_p = V_o$ at $d_{im} = -60$ dB; $f_p = 795,25$ MHz

$V_q = V_o - 6$ dB; $f_q = 803,25$ MHz

$V_r = V_o - 6$ dB; $f_r = 805,25$ MHz

Measured at $f_{(p+q-r)} = 793,25$ MHz

V_o typ. 700 mV

Second harmonic distortion (see Figs 3 and 6)

$I_C = 70$ mA; $V_{CE} = 10$ V; $R_L = 75 \Omega$; $T_{amb} = 25$ °C

$V_p = V_o = 316$ mV = 50 dBmV; $f_p = 250$ MHz

$V_q = V_o = 316$ mV = 50 dBmV; $f_q = 560$ MHz

measured at $f_{(p+q)} = 810$ MHz

d_2 typ. -52 dB

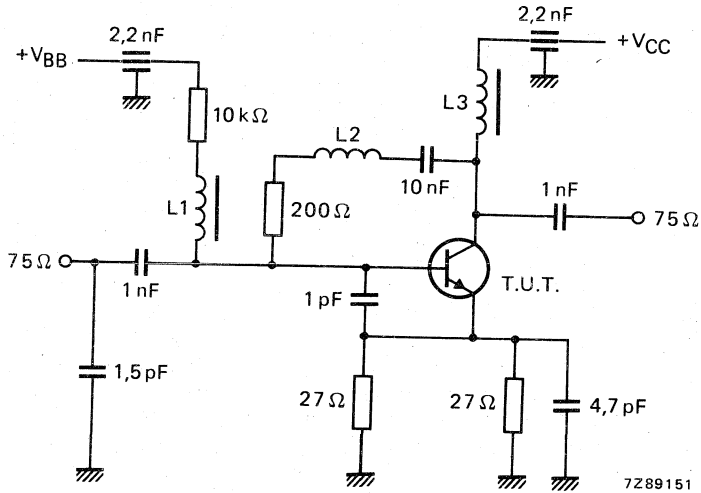


Fig. 3 Intermodulation distortion and second harmonic distortion MATV test circuit.

$L1 = L3 = 5 \mu$ H micro choke

$L2 = 1\frac{1}{2}$ turns Cu wire (0,4 mm); internal diameter 3,0 mm; winding pitch 1 mm

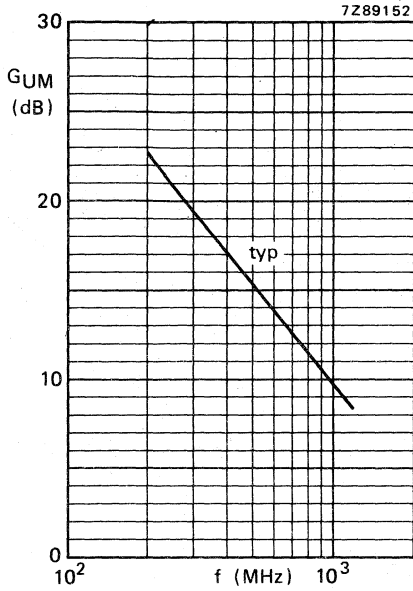


Fig. 4 $V_{CE} = 10 \text{ V}$; $I_C = 70 \text{ mA}$; $T_{amb} = 25 \text{ }^\circ\text{C}$.

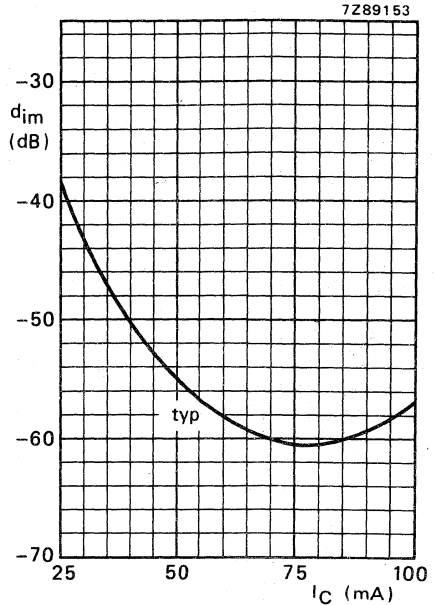


Fig. 5.

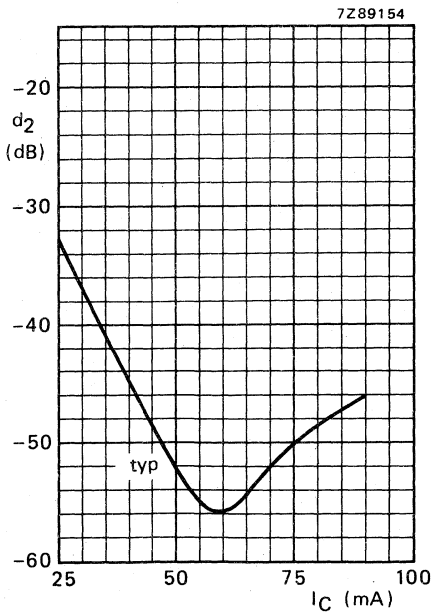


Fig. 6.

Intermodulation distortion (Fig. 5) and second harmonic distortion (Fig. 6) are measured in MATV circuit (see Fig. 3).

Fig. 5 $V_{CE} = 10 \text{ V}$; $V_o = 700 \text{ mV} = 56,9 \text{ dBmV}$;
 $f_{(p+q-r)} = 793,25 \text{ MHz}$; $T_{amb} = 25 \text{ }^\circ\text{C}$.

Fig. 6 $V_{CE} = 10 \text{ V}$; $V_o = 316 \text{ mV} = 50 \text{ dBmV}$;
 $f_{(p+q)} = 810 \text{ MHz}$; $T_{amb} = 25 \text{ }^\circ\text{C}$.

Conditions for Figs 7 and 8:

$V_{CE} = 10 \text{ V}; I_C = 70 \text{ mA};$

$T_{amb} = 25 \text{ }^\circ\text{C}.$

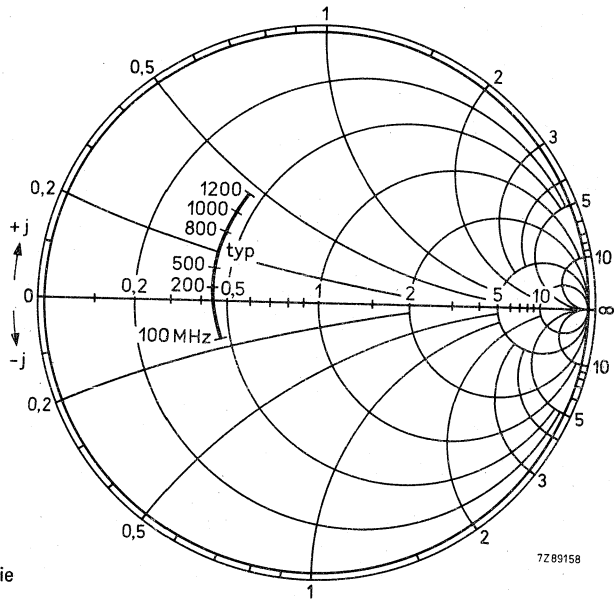


Fig. 7 Input impedance derived from input reflection coefficient s_{ie} co-ordinates in ohm x 50.

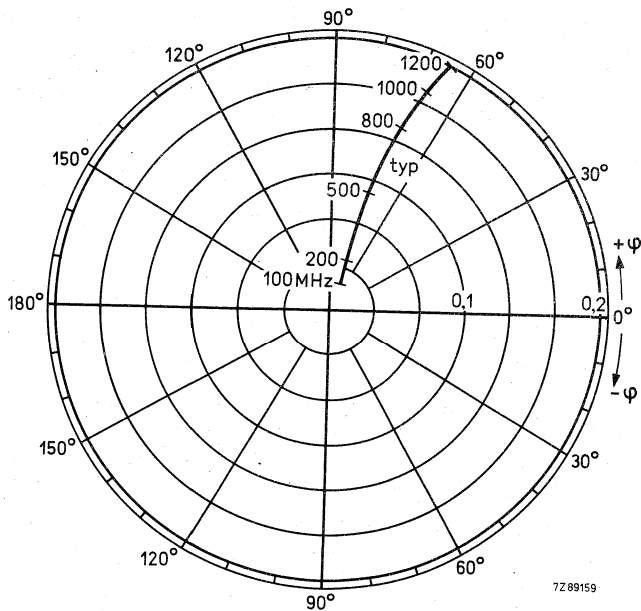


Fig. 8 Reverse transmission coefficient s_{re} .

Conditions for Figs 9 and 10:

$V_{CE} = 10 \text{ V}$; $I_C = 70 \text{ mA}$;

$T_{amb} = 25 \text{ }^\circ\text{C}$.

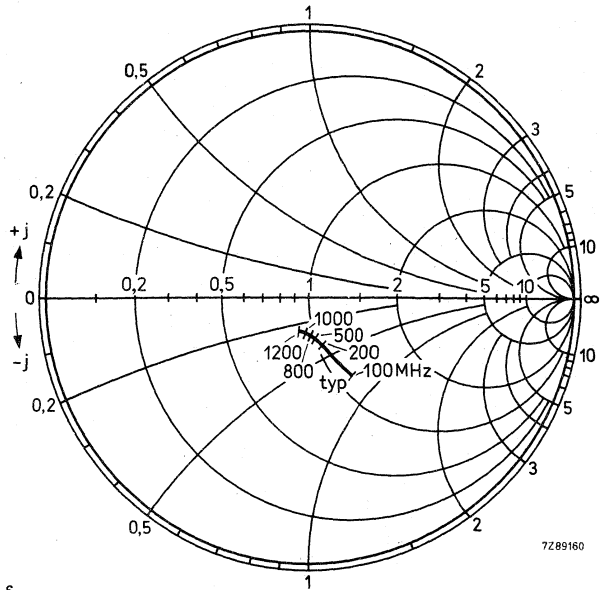


Fig. 9 Output impedance derived from output reflection coefficient s_{oe} co-ordinates in ohm x 50.

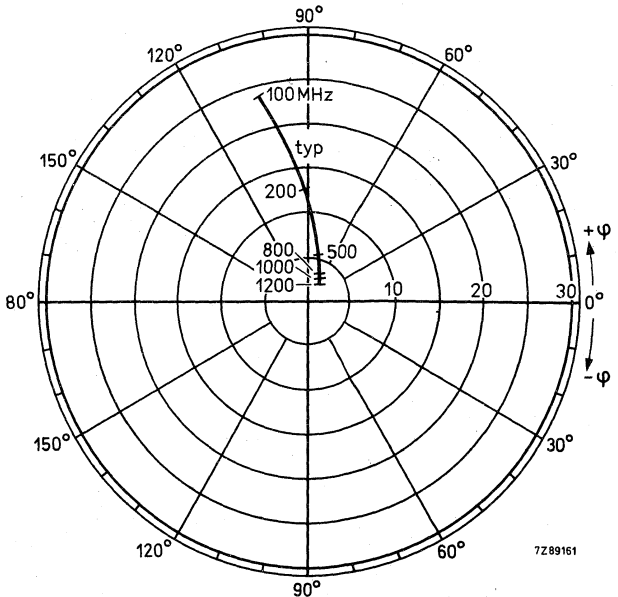


Fig. 10 Forward transmission coefficient s_{fe} .

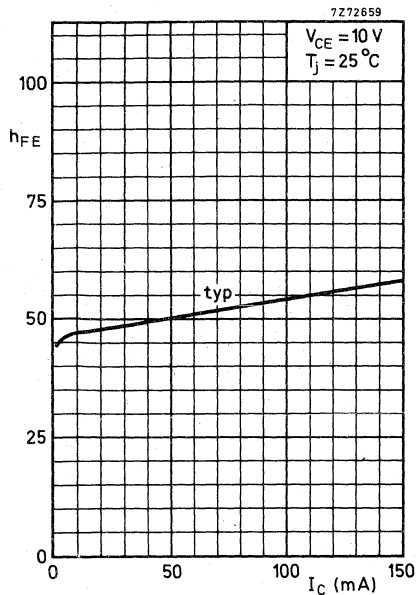


Fig. 11.

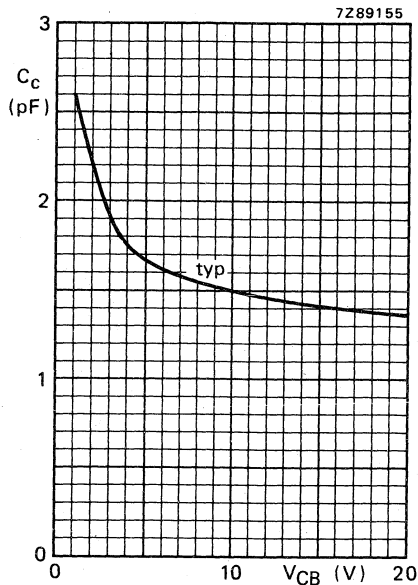


Fig. 12 $I_E = I_e = 0$; $f = 1\text{ MHz}$; $T_j = 25\text{ }^\circ\text{C}$.

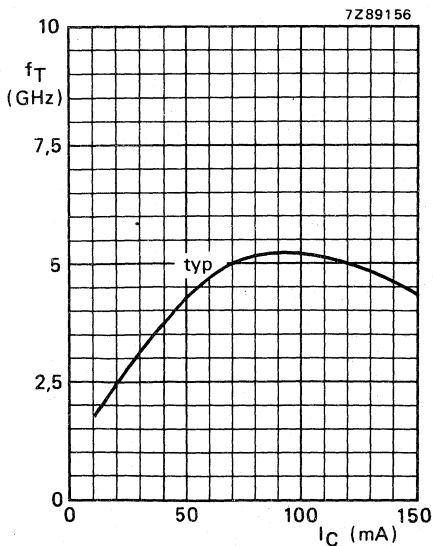


Fig. 13 $V_{CE} = 10\text{ V}$; $f = 500\text{ MHz}$; $T_j = 25\text{ }^\circ\text{C}$.

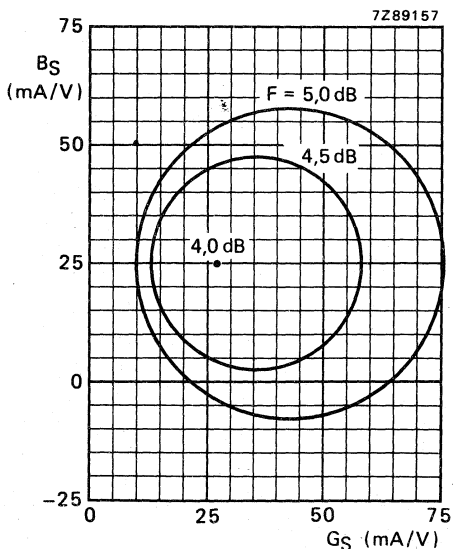


Fig. 14 Circles of constant noise figure.
 $V_{CE} = 10\text{ V}$; $I_C = 70\text{ mA}$; $f = 800\text{ MHz}$;
 $T_{amb} = 25\text{ }^\circ\text{C}$; typical values.

SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a subminiature plastic transfer-moulded T-package.

It is primarily intended for use in u. h. f. low power amplifiers such as in pocket phones, paging systems, etc.

The transistor features low current consumption (100 μ A - 1 mA); thanks to its high transition frequency, it also has excellent wideband properties and low noise up to high frequencies.

QUICK REFERENCE DATA

| | | | |
|--|-----------|------|----------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 8 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 5 V |
| Collector current (d. c.) | I_C | max. | 2.5 mA |
| Total power dissipation up to $T_{amb} = 135\text{ }^\circ\text{C}$ | P_{tot} | max. | 30 mW |
| Junction temperature | T_j | max. | 150 $^\circ\text{C}$ |
| Transition frequency at $f = 500\text{ MHz}$ $I_C = 1\text{ mA}; V_{CE} = 1\text{ V}$ | f_T | typ. | 2.3 GHz |
| Feedback capacitance at $f = 1\text{ MHz}$ $I_C = 1\text{ mA}; V_{CE} = 1\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$ | C_{re} | < | 0.4 pF |
| Noise figure at optimum source impedance $I_C = 1\text{ mA}; V_{CE} = 1\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | F | typ. | 3.8 dB |
| Max. unilateral power gain (see page 3) $I_C = 1\text{ mA}; V_{CE} = 1\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ | G_{UM} | typ. | 17 dB |

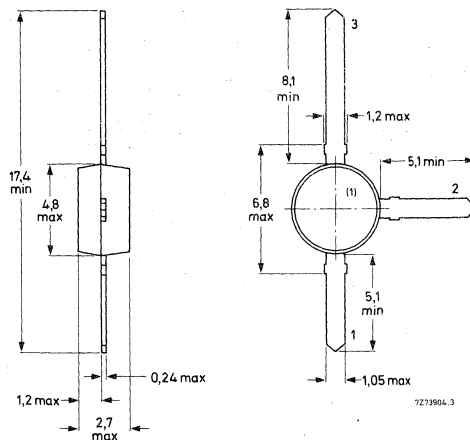
MECHANICAL DATA

Dimensions in mm

Fig. 1 SOT-37.

Connections

1. Base
2. Emitter
3. Collector



(1) = type number marking.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Voltages

| | | | | |
|---------------------------------------|-----------|------|---|---|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 8 | V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 5 | V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2 | V |

Current

| | | | | |
|---|----------|------|-----|----|
| Collector current (d. c.) | I_C | max. | 2,5 | mA |
| Collector current (peak value; $f > 1$ MHz) | I_{CM} | max. | 5,0 | mA |

Power dissipation

| | | | | |
|--|-----------|------|----|----|
| Total power dissipation up to $T_{amb} = 135$ °C | P_{tot} | max. | 30 | mW |
|--|-----------|------|----|----|

Temperatures

| | | | |
|----------------------|-----------|-------------|----|
| Storage temperature | T_{stg} | -65 to +150 | °C |
| Junction temperature | T_j | max. 150 | °C |

THERMAL RESISTANCE

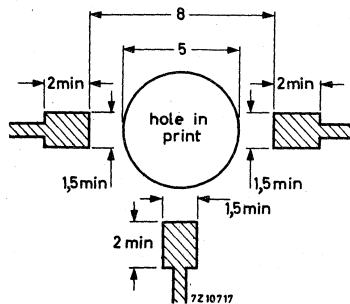
From junction to ambient in free air

mounted on a glass-fibre print *)
of 40 mm x 25 mm x 1 mm

$$R_{th\ j-a} = 0,5 \text{ °C/mW}$$

*) Requirements for glass-fibre print

(dimensions in mm)



CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 5\text{ V}$ $I_{CBO} < 50\text{ nA}$

D. C. current gain 1)

$I_C = 10\text{ }\mu\text{A}; V_{CE} = 1\text{ V}$ $h_{FE} > 20$
typ. 30

$I_C = 1\text{ mA}; V_{CE} = 1\text{ V}$ $h_{FE} > 20$
typ. 40

Saturation voltages

$I_C = 10\text{ }\mu\text{A}; I_B = 1\text{ }\mu\text{A}$ $V_{CEsat} < 200\text{ mV}$
 $V_{BEsat} < 750\text{ mV}$

$I_C = 1\text{ mA}; I_B = 0,1\text{ mA}$ $V_{CEsat} < 175\text{ mV}$
 $V_{BEsat} < 900\text{ mV}$

Transition frequency at $f = 500\text{ MHz}$ 1)

$I_C = 1\text{ mA}; V_{CE} = 1\text{ V}$ $f_T > 1,2\text{ GHz}$
typ. 2,3 GHz

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 0,5\text{ V}$ $C_c < 0,55\text{ pF}$

Emitter capacitance at $f = 1\text{ MHz}$

$I_C = I_c = 0; V_{EB} = 0$ $C_e < 0,45\text{ pF}$

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 1\text{ mA}; V_{CE} = 1\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$ $C_{re} < 0,4\text{ pF}$

Noise figure at optimum source impedance

$I_C = 0,1\text{ mA}; V_{CE} = 1\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ F typ. 5,5 dB

$I_C = 1\text{ mA}; V_{CE} = 1\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ F typ. 3,8 dB

Max. unilateral power gain (s_{re} assumed to be zero)

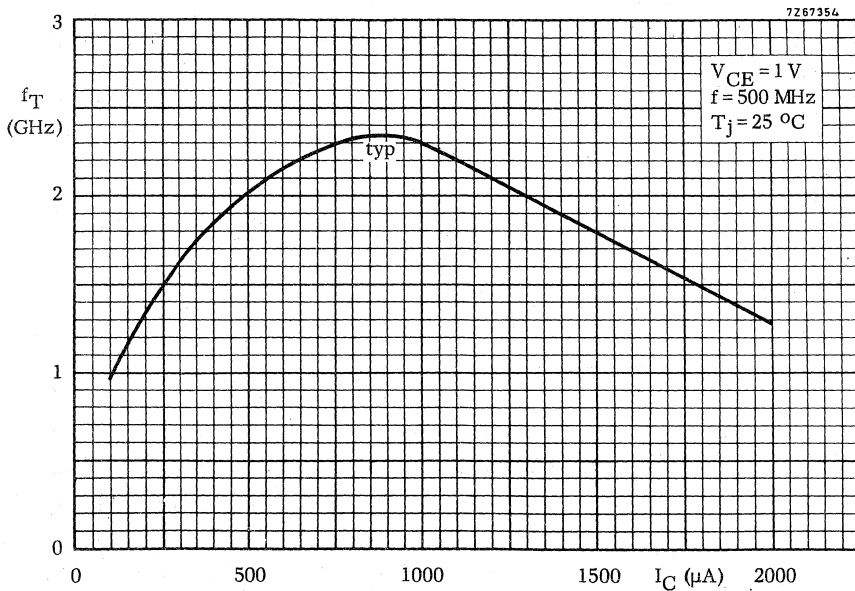
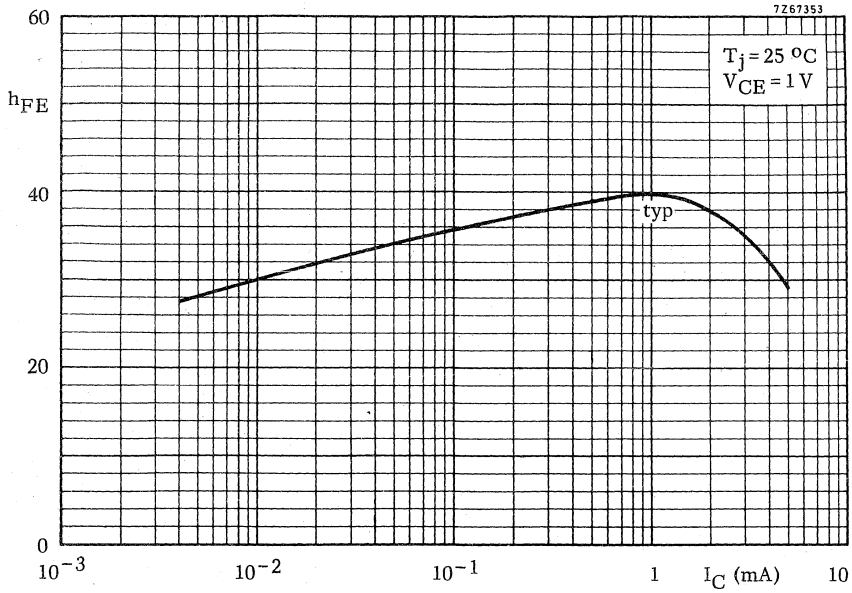
$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

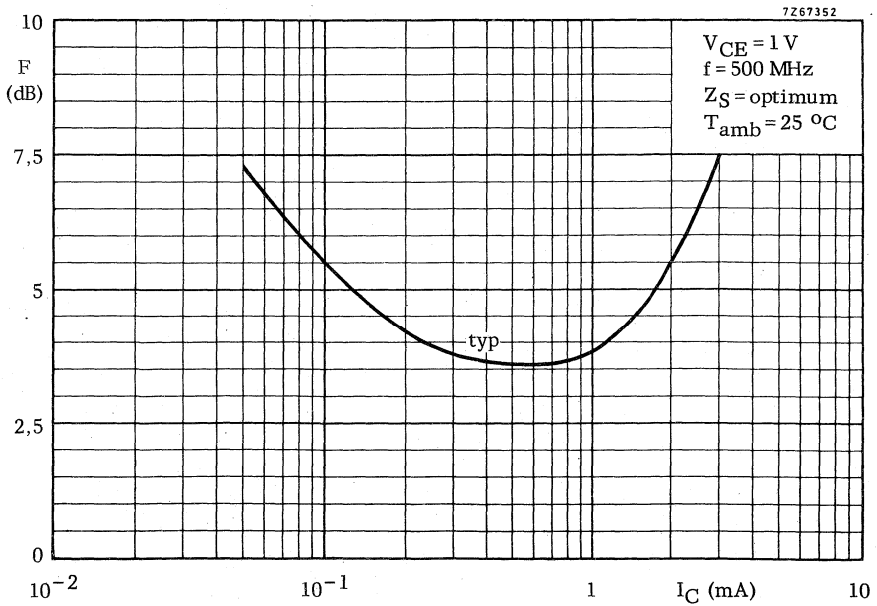
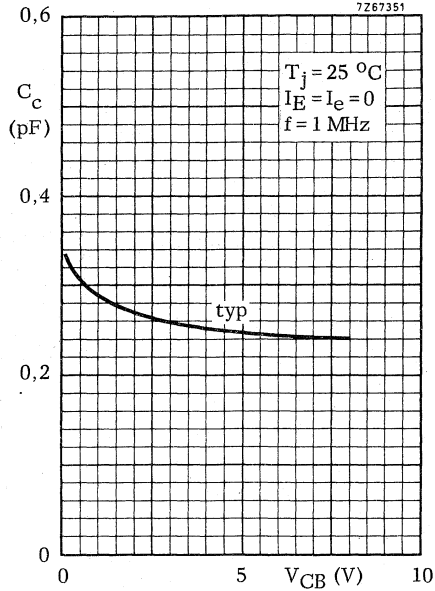
$I_C = 1\text{ mA}; V_{CE} = 1\text{ V}; f = 200\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ G_{UM} typ. 24 dB

$I_C = 1\text{ mA}; V_{CE} = 1\text{ V}; f = 500\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ G_{UM} typ. 17 dB

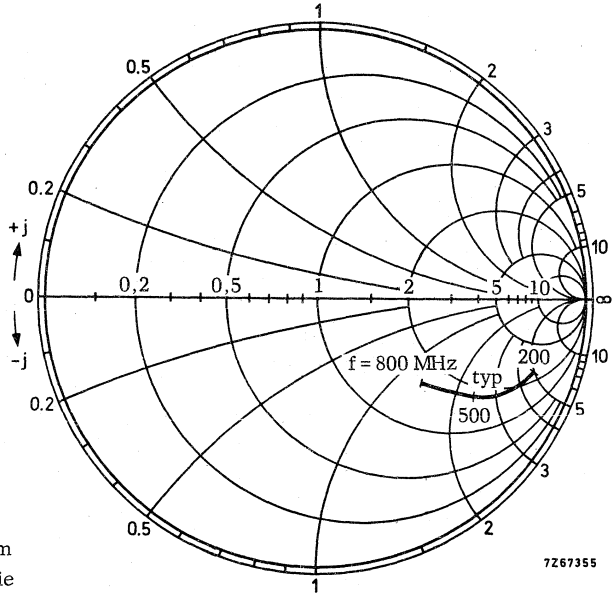
$I_C = 1\text{ mA}; V_{CE} = 1\text{ V}; f = 800\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ G_{UM} typ. 11 dB

1) Measured under pulse conditions.





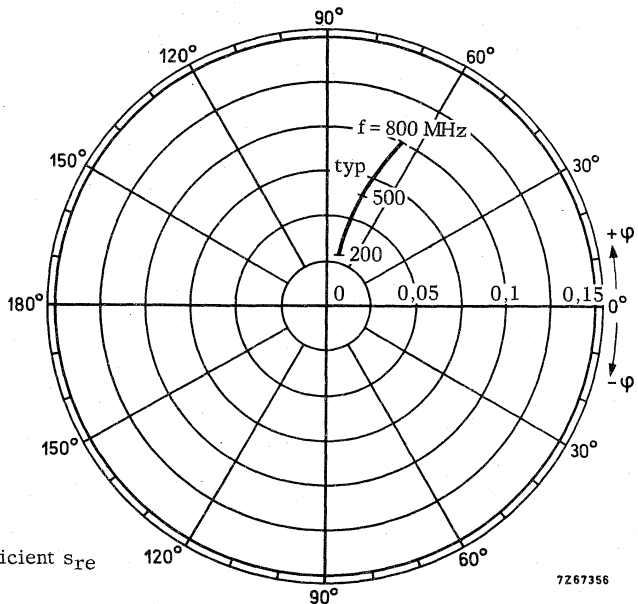
$V_{CE} = 1\text{ V}$
 $I_C = 1\text{ mA}$
 $T_{amb} = 25\text{ }^\circ\text{C}$



Input impedance derived from
input reflection coefficient s_{ie}
coordinates in ohm x 50

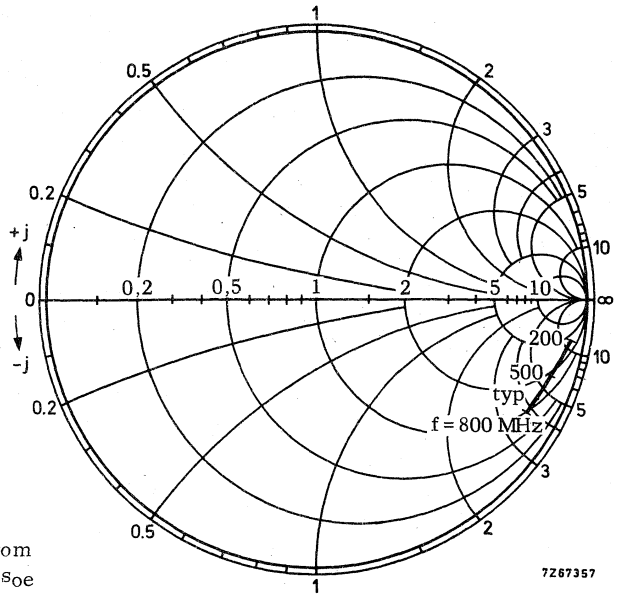


$V_{CE} = 1\text{ V}$
 $I_C = 1\text{ mA}$
 $T_{amb} = 25\text{ }^\circ\text{C}$



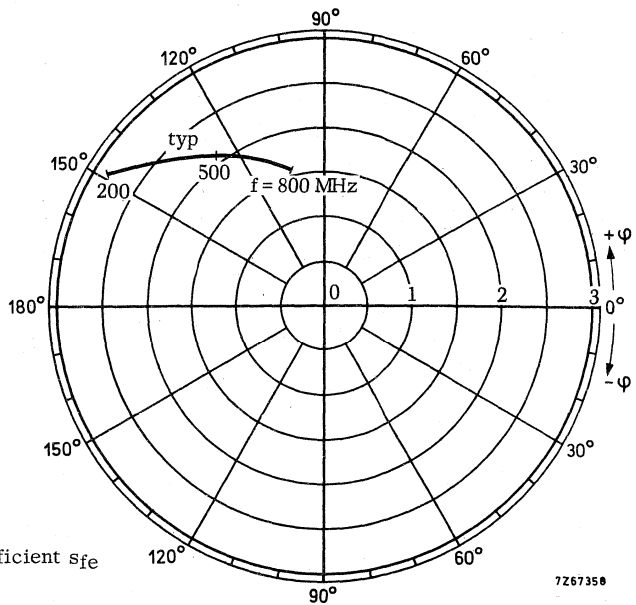
Reverse transmission coefficient s_{re}

$V_{CE} = 1\text{ V}$
 $I_C = 1\text{ mA}$
 $T_{amb} = 25\text{ }^\circ\text{C}$



Output impedance derived from output reflection coefficient s_{oe} coordinates in ohm x 50

$V_{CE} = 1\text{ V}$
 $I_C = 1\text{ mA}$
 $T_{amb} = 25\text{ }^\circ\text{C}$



Forward transmission coefficient s_{fe}

SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N multi-emitter transistor in a TO-39 metal envelope, with the collector connected to the case. The transistor has extremely good intermodulation properties and a high power gain. It is a ruggedized version of the BFW16, which it succeeds. It is primarily intended for:

- Final and driver stages of channel and band aerial amplifiers with high output power for bands I, II, III and IV/V (40–860 MHz).
- Final stage of the wideband vertical amplifier in high speed oscilloscopes.

QUICK REFERENCE DATA

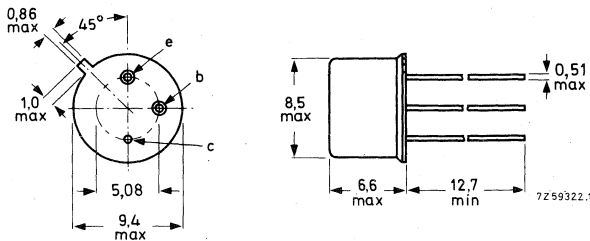
| | | | | |
|---|------------|------|-----|-----|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 40 | V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 25 | V |
| Collector current (peak value; $f > 1$ MHz) | I_{CM} | max. | 300 | mA |
| Total power dissipation up to $T_{mb} = 125$ °C | P_{tot} | max. | 1,5 | W |
| Junction temperature | T_j | max. | 200 | °C |
| Feedback capacitance at $f = 1$ MHz $I_C = 10$ mA; $V_{CE} = 15$ V | C_{re} | typ. | 1,7 | pF |
| Transition frequency $I_C = 150$ mA; $V_{CE} = 15$ V; $f = 500$ MHz | f_T | typ. | 1,2 | GHz |
| Power gain (not neutralized) $I_C = 70$ mA; $V_{CE} = 18$ V | G_p | typ. | 16 | 6,5 |
| Output power $d_{im} = -30$ dB; VSWR at output < 2 ; $I_C = 70$ mA; $V_{CE} = 18$ V | P_o | typ. | 150 | 90 |
| | | | | mW |

MECHANICAL DATA

Dimensions in mm

Collector connected to case

Fig. 1 TO-39.



Maximum lead diameter is guaranteed only for 12,7 mm.

Accessories: 56245 (distance disc).

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)Voltages

| | | | |
|--|------------|------|---------|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 40 V |
| Collector-emitter voltage ($R_{BE} \leq 50 \Omega$) peak value | V_{CERM} | max. | 40 V 1) |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 25 V 1) |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2 V |

Currents

| | | | |
|---|----------|------|--------|
| Collector current (d.c.) | I_C | max. | 150 mA |
| Collector current (peak value; $f > 1$ MHz) | I_{CM} | max. | 300 mA |

Power dissipation

| | | | |
|---|-----------|------|-------|
| Total power dissipation up to $T_{mb} = 125 \text{ }^\circ\text{C}$ | P_{tot} | max. | 1.5 W |
|---|-----------|------|-------|

Temperatures

| | | | |
|----------------------|-----------|-------------|----------------------|
| Storage temperature | T_{stg} | -65 to +200 | $^\circ\text{C}$ |
| Junction temperature | T_j | max. | 200 $^\circ\text{C}$ |

THERMAL RESISTANCE

| | | | |
|--|---------------|---|------------------------|
| From junction to ambient in free air | $R_{th j-a}$ | = | 250 $^\circ\text{C/W}$ |
| From junction to mounting base | $R_{th j-mb}$ | = | 50 $^\circ\text{C/W}$ |
| From mounting base to heatsink mounted with top clamping washer of 56218 and a boron nitride washer for electrical insulation | $R_{th mb-h}$ | = | 1.2 $^\circ\text{C/W}$ |

1) $I_C = 10 \text{ mA}$.

CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

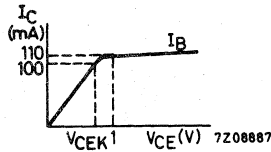
$I_E = 0; V_{CB} = 20\text{ V}; T_j = 150\text{ }^\circ\text{C}$

$I_{CBO} < 20\text{ }\mu\text{A}$

Knee voltage

$I_C = 100\text{ mA}; I_B = \text{value for which}$
 $I_C = 110\text{ mA at } V_{CE} = 1\text{ V}$

$V_{CEK} < 0.75\text{ V}$



D.C. current gain

$I_C = 50\text{ mA}; V_{CE} = 5\text{ V}$

$h_{FE} > 25$

$I_C = 150\text{ mA}; V_{CE} = 5\text{ V}$

$h_{FE} > 25$

Transition frequency

$I_C = 150\text{ mA}; V_{CE} = 15\text{ V}; f = 500\text{ MHz}$

$f_T \text{ typ. } 1.2\text{ GHz}$

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 15\text{ V}$

$C_c < 4\text{ pF}$

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 10\text{ mA}; V_{CE} = 15\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$

$C_{re} \text{ typ. } 1.7\text{ pF}$

Noise figure at $f = 200\text{ MHz}$

$I_C = 30\text{ mA}; V_{CE} = 15\text{ V}; R_S = 75\text{ }\Omega; T_{amb} = 25\text{ }^\circ\text{C}$

$F < 6\text{ dB}$

Power gain (not neutralized)

$I_C = 70\text{ mA}; V_{CE} = 18\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$

| | | | |
|-------|-----------|-------|--------------|
| | $f = 200$ | 800 | MHz |
| G_p | typ. 16 | 6.5 | dB |

CHARACTERISTICS (continued)

Intermodulation characteristics

1. Output power at $f = 200$ MHz; $T_{amb} = 25$ °C

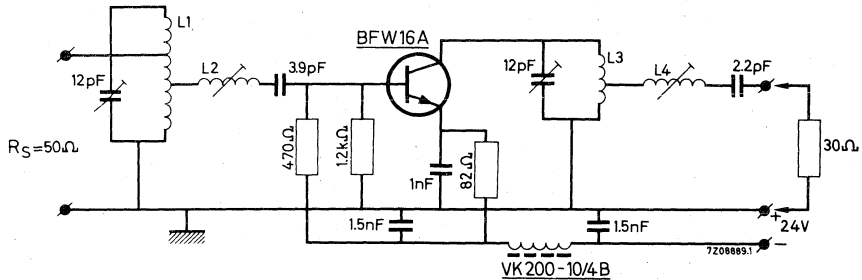
$I_C = 70$ mA; $V_{CE} = 18$ V; V.S.W.R. at output < 2

$f_p = 202$ MHz; $f_q = 205$ MHz; $d_{im} = -30$ dB

measured at $f(2q-p) = 208$ MHz (Channel 9)

$P_o > 130$ mW
typ. 150 mW

Test circuit:



Coil data:

L1 = 3 turns silver plated Cu wire (1.4 mm); winding pitch 2.7 mm;
int. diam. 8 mm; taps at 0.5 turn and 1.5 turns from earth.

L2 = 5.5 turns silver plated Cu wire (1.4 mm); winding pitch 2.2 mm;
int. diam. 8 mm.

L3 = 3 turns silver plated Cu wire (1.4 mm); winding pitch 3.3 mm;
int. diam. 8 mm.

L4 = 5.5 turns silver plated Cu wire (1.4 mm); winding pitch 2.2 mm;
int. diam. 11 mm.

CHARACTERISTICS (continued)

Basis of adjustment

The intermodulation at an intermodulation distortion of -30 dB is caused by h.f. output current - voltage clipping.

The maximum undistorted output power is realised, if

- a. Current and voltage clipping take place concurrently.
This occurs if

$$R_L = \frac{V_{CE} - V_{CEK}}{I_C},$$

in which V_{CEK} is the high frequency knee voltage.

- b. The h.f. collector current is as small as possible.

This is so if $-C_L = +C_{oe}$,

in which C_{oe} is the output capacitance of the transistor at short circuited input.

For maximum output power at an intermodulation distortion of -30 dB, the (experimentally found) values of R_L and C_L are:

$R_L = 220 \Omega$; $C_L = -5.6 \text{ pF}$.

C_{oe} is found by 4 pF of the transistor and 1.6 pF by the mounting system concerning of a borium nitride washer between the envelope of the transistor and the chassis. See also page 10, note 1.

Adjustment procedure

1. Remove the transistor and connect a dummy consisting of a 220.Ω resistor in parallel with a 5.6 pF capacitor between the collector and emitter connections of the output circuit.
2. Tune and match the output circuit for zero reflection at 205 MHz (V.S.W.R. = 1). After this adjustment, no further change may be made in the output circuit.
3. Replace the dummy by the transistor. Tune and match the input circuit for maximum power gain and good band pass curve.
The V.S.W.R. of the output will then, in most cases, be ≤ 2 over the whole channel.
Corrections can be made by tuning L2; this will not disturb the band pass curve.

CHARACTERISTICS (continued)

Intermodulation characteristics

2. Output power at $f = 800$ MHz; $T_{amb} = 25$ °C

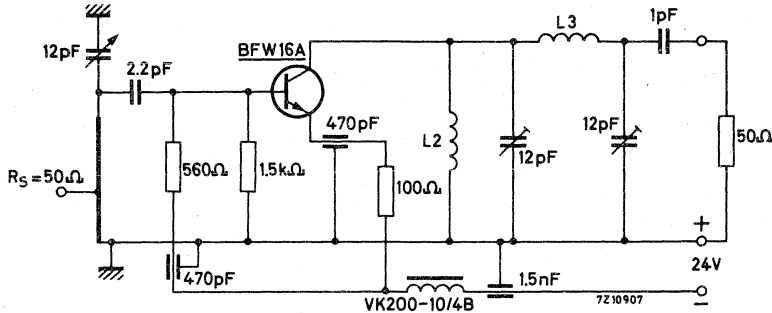
$I_C = 70$ mA; $V_{CE} = 18$ V; V.S.W.R. at output < 2

$f_p = 798$ MHz; $f_q = 802$ MHz; $dim = -30$ dB

measured at $f(2q-p) = 806$ MHz (Channel 62)

$P_o > 70$ mW
typ. 90 mW

Test circuit:



Coil data:

L1 = 25 mm x 7 mm x 0.85 mm silver plated Cu strip

Tap of the input at 5 mm from earth.

L2 = 13 turns enamelled Cu wire (0.6 mm); int. diam. 8 mm

L3 = 1.5 turns Cu wire (1.3 mm); int. diam. 8 mm

Basis of adjustment

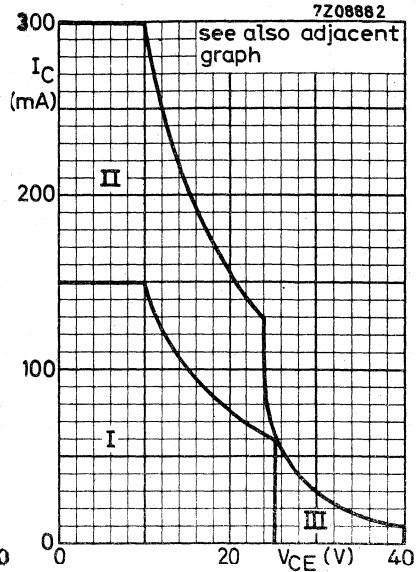
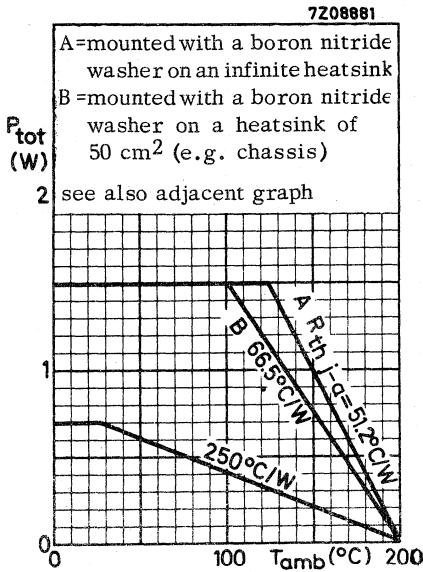
At 800 MHz no dummy can be used to adjust for optimum collector load because at these frequencies the impedance transformations of a dummy are too high. A small signal at the mid-channel frequency of 802 MHz is fed to the input and increased until clipping occurs; that is, until the output power no longer increases linearly with the input signal. This clipping can be eliminated by tuning the output circuit, thereby making the output power equal to

$$P_o = \frac{I_C(V_{CE} - V_{CEK})}{2} = 480 \text{ mW.}$$

The output circuit is adjusted for minimum intermodulation if the input signal is as small as possible at $P_o = 480$ mW.

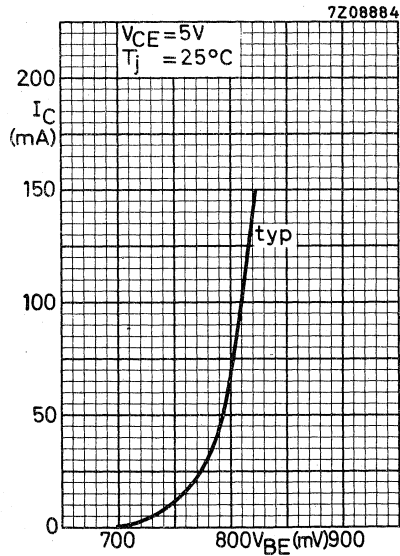
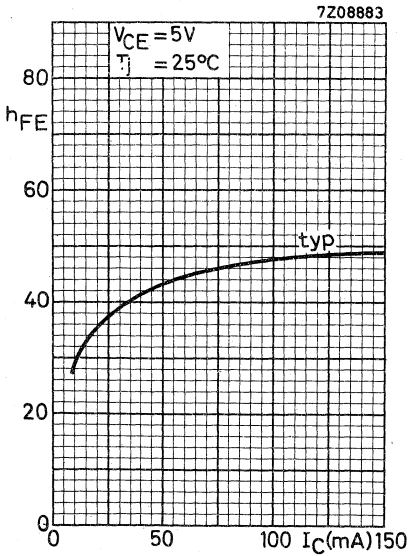
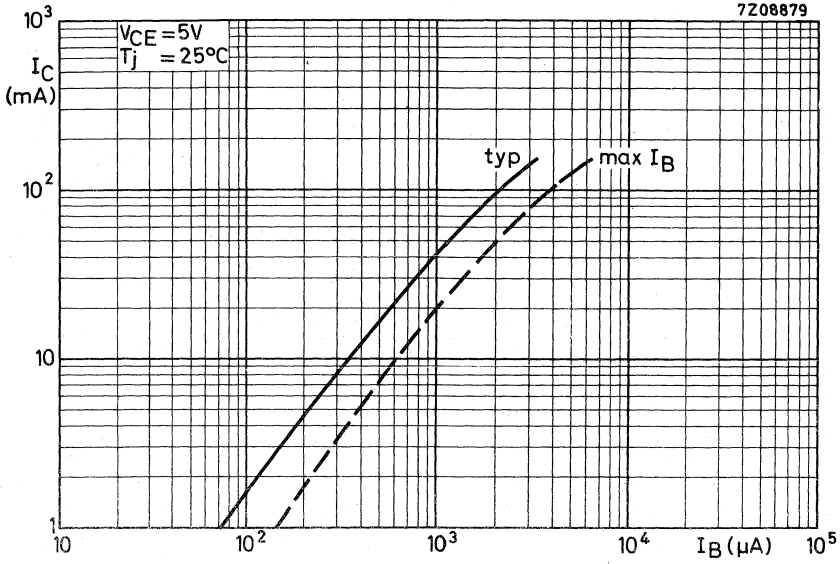
With this adjusting method care must be taken, that the transistor is not destructed by second breakdown (the voltage swing may not exceed the rated V_{CEK} value). Therefore as soon as clipping occurs, the increase of the input signal should be stopped until the clipping has been eliminated. After this adjustment has been made no further change may be made in the output circuit.

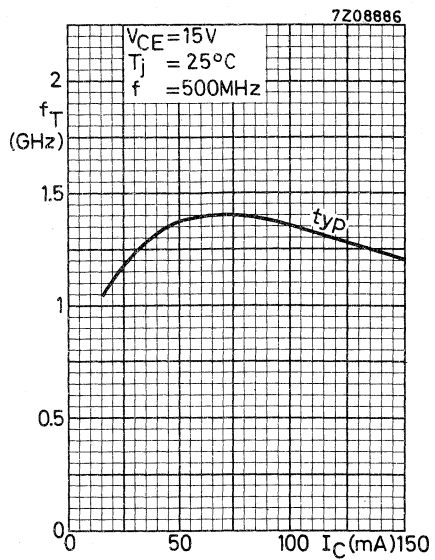
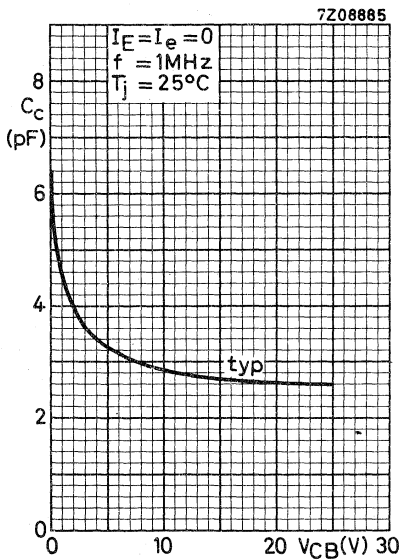
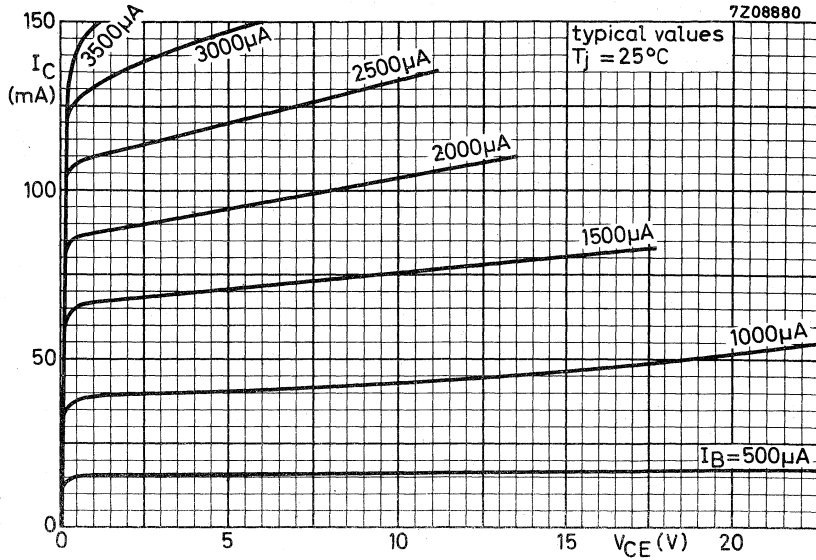
Adjust the input circuit for maximum power gain and good band pass curve. The V.S.W.R. of the output is then ≤ 2 over the whole channel.



- I = Region of permissible operation under all base-emitter conditions and at all frequencies, including d.c.
- II = Additional region of operation at $f \geq 1$ MHz.
- III = Operating under pulsed conditions is allowed, provided the transistor is cut-off with $R_{BE} \leq 50 \Omega$ and $f \geq 1$ MHz.







APPLICATION INFORMATION

Performance of channel- and band amplifiers ¹⁾

| Frequency range | channel 4 61-68 | channel 9 202-209 | channel 55 742-750 | band I 47-68 | band II 87.5-108 | band III 174-230 | MHz |
|--|-----------------------|-------------------------|--------------------------|--------------------|------------------------|------------------------|----------|
| Transistor used in final stage | BFW16A | BFW16A | BFW16A | BFW16A | BFW16A | BFW16A | |
| driver stage | | BFW16A | BFW16A | | | BFW16A | |
| second stage | | | BFY90 | | | | |
| first stage | BFY90 | BFY90 | BFY90 | BFY90 | BFY90 | BFY90 | |
| Output power at $d_{im} = -30$ dB | 150 ²⁾ | 150 ²⁾ | 100 | | | | mW |
| $d_{im} = -50$ dB | | | | 10 | 30 | 10 | mW |
| $d_{im} = -60$ dB | | | | | | | mW |
| Power gain | 50 | 44 | 26.5 | 51 | 43 | 39 | dB |
| Noise figure | 7 | 6 | 8 | 6.0-6.5 | 6.5 | 6.5 | dB |
| V.S.W.R. over the whole channel or band | | | | | | | |
| for the input | < 2 | < 2 | < 2 | < 2 | < 2 | < 2 | |
| for the output | < 2 | < 2 | < 2 | < 2 | < 2 | < 2 | |
| Load impedance | 30 | 30 | 50 | 30 | 30 | 30 | Ω |
| Source impedance | 60 | 60 | 50 | 60 | 60 | 60 | Ω |

¹⁾ Application information bulletins of all these amplifiers and a study of inter-modulation are available on request.

²⁾ $V_o = 2.2$ V over $R_L = 30 \Omega$ or
 $V_o = 3$ V over $R_L = 60 \Omega$.

SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N multi-emitter transistor in a TO-39 metal envelope, with the collector connected to the case. The transistor has extremely good intermodulation properties and a high power gain. It is a ruggedized version of the BFW17, which it succeeds. It is primarily intended for final and driver stages of channel and band aerial amplifiers with high output power for bands I, II and III (40–230 MHz).

QUICK REFERENCE DATA

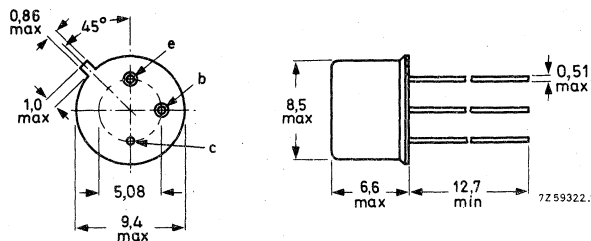
| | | | |
|---|------------|------|---------|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 40 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 25 V |
| Collector current (peak value; $f > 1$ MHz) | I_{CM} | max. | 300 mA |
| Total power dissipation up to $T_{mb} = 125$ °C | P_{tot} | max. | 1,5 W |
| Junction temperature | T_j | max. | 200 °C |
| Feedback capacitance at $f = 1$ MHz $I_C = 10$ mA; $V_{CE} = 15$ V | C_{re} | typ. | 1,7 pF |
| Transition frequency $I_C = 150$ mA; $V_{CE} = 15$ V; $f = 500$ MHz | f_T | typ. | 1,1 GHz |
| Power gain (not neutralized) $I_C = 70$ mA; $V_{CE} = 18$ V; $f = 200$ MHz | G_p | typ. | 16 dB |
| Output power $d_{im} = -30$ dB; VSWR at output < 2 ; $I_C = 70$ mA; $V_{CE} = 18$ V | P_o | typ. | 150 mW |

MECHANICAL DATA

Dimensions in mm

Collector connected to case

Fig. 1 TO-39.



Maximum lead diameter is guaranteed only for 12,7 mm.

Accessories: 56245 (distance disc).

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

| | | | |
|--|------------|------|--------------------|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 40 V |
| Collector-emitter voltage ($R_{BE} \leq 50 \Omega$) peak value | V_{CERM} | max. | 40 V ¹⁾ |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 25 V ¹⁾ |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2 V |

Currents

| | | | |
|---|----------|------|--------|
| Collector current (d.c.) | I_C | max. | 150 mA |
| Collector current (peak value; $f > 1$ MHz) | I_{CM} | max. | 300 mA |

Power dissipation

| | | | |
|--|-----------|------|-------|
| Total power dissipation up to $T_{mb} = 125^\circ C$ | P_{tot} | max. | 1.5 W |
|--|-----------|------|-------|

Temperatures

| | | | |
|----------------------|-----------|-------------|----------------|
| Storage temperature | T_{stg} | -65 to +200 | $^\circ C$ |
| Junction temperature | T_j | max. | 200 $^\circ C$ |

THERMAL RESISTANCE

| | | | |
|--|---------------|---|------------------|
| From junction to ambient in free air | $R_{th j-a}$ | = | 250 $^\circ C/W$ |
| From junction to mounting base | $R_{th j-mb}$ | = | 50 $^\circ C/W$ |
| From mounting base to heatsink mounted with top clamping washer of 56218 and a boron nitride washer for electrical insulation | $R_{th mb-h}$ | = | 1.2 $^\circ C/W$ |

¹⁾ $I_C = 10$ mA.

CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 20\text{ V}; T_j = 150\text{ }^\circ\text{C}$

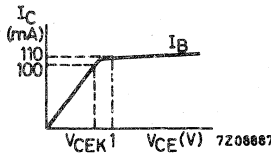
$I_{CBO} < 20\text{ }\mu\text{A}$

Knee voltage

$I_C = 100\text{ mA}; I_B = \text{value for which}$

$I_C = 110\text{ mA at } V_{CE} = 1\text{ V}$

$V_{CEK} < 0.75\text{ V}$



D.C. current gain

$I_C = 50\text{ mA}; V_{CE} = 5\text{ V}$

$h_{FE} > 25$

$I_C = 150\text{ mA}; V_{CE} = 5\text{ V}$

$h_{FE} > 25$

Transition frequency

$I_C = 150\text{ mA}; V_{CE} = 15\text{ V}; f = 500\text{ MHz}$

$f_T \text{ typ. } 1.1\text{ GHz}$

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 15\text{ V}$

$C_c < 4\text{ pF}$

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 10\text{ mA}; V_{CE} = 15\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$

$C_{re} \text{ typ. } 1.7\text{ pF}$

Power gain (not neutralized)

$I_C = 70\text{ mA}; V_{CE} = 18\text{ V}$
 $f = 200\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$

$G_p \text{ typ. } 16\text{ dB}$



CHARACTERISTICS (continued)

Intermodulation characteristics

1. Output power at $f = 200 \text{ MHz}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$

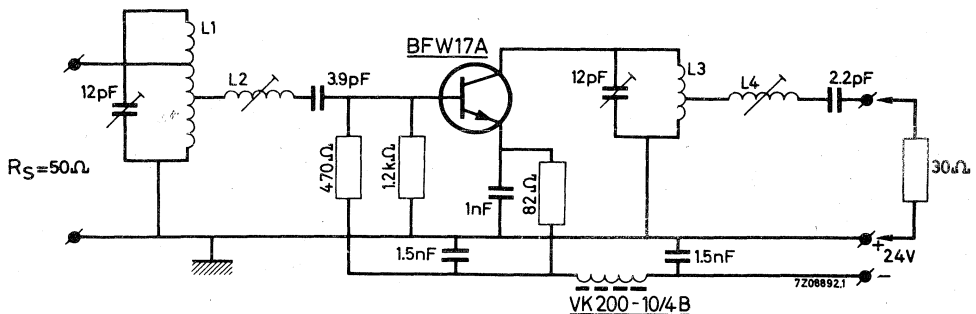
$I_C = 70 \text{ mA}$; $V_{CE} = 18 \text{ V}$; V.S.W.R. at output < 2

$f_p = 202 \text{ MHz}$; $f_q = 205 \text{ MHz}$; $d_{\text{im}} = -30 \text{ dB}$

measured at $f(2q-p) = 208 \text{ MHz}$ (Channel 9)

P_o typ. 150 mW

Test circuit:



Coil data:

- L1 = 3 turns silver plated Cu wire (1.4 mm); winding pitch 2.7 mm; int. diam. 8 mm; taps at 0.5 turn and 1.5 turns from earth.
- L2 = 5.5 turns silver plated Cu wire (1.4 mm); winding pitch 2.2 mm; int. diam. 8 mm.
- L3 = 3 turns silver plated Cu wire (1.4 mm); winding pitch 3.3 mm; int. diam. 8 mm.
- L4 = 5.5 turns silver plated Cu wire (1.4 mm); winding pitch 2.2 mm; int. diam. 11 mm.

CHARACTERISTICS (continued)

Basis of adjustment

The intermodulation at an intermodulation distortion of -30 dB is caused by h.f. output current - voltage clipping.

The maximum undistorted output power is realised, if

- a. Current and voltage clipping take place concurrently.

This occurs if

$$R_L = \frac{V_{CE} - V_{CEK}}{I_C}$$

in which V_{CEK} is the high frequency knee voltage.

- b. The h.f. collector current is as small as possible.

This is so if $-C_L = +C_{Oe}$,

in which C_{Oe} is the output capacitance of the transistor at short circuited input.

For maximum output power at an intermodulation distortion of -30 dB, the (experimentally found) values of R_L and C_L are:

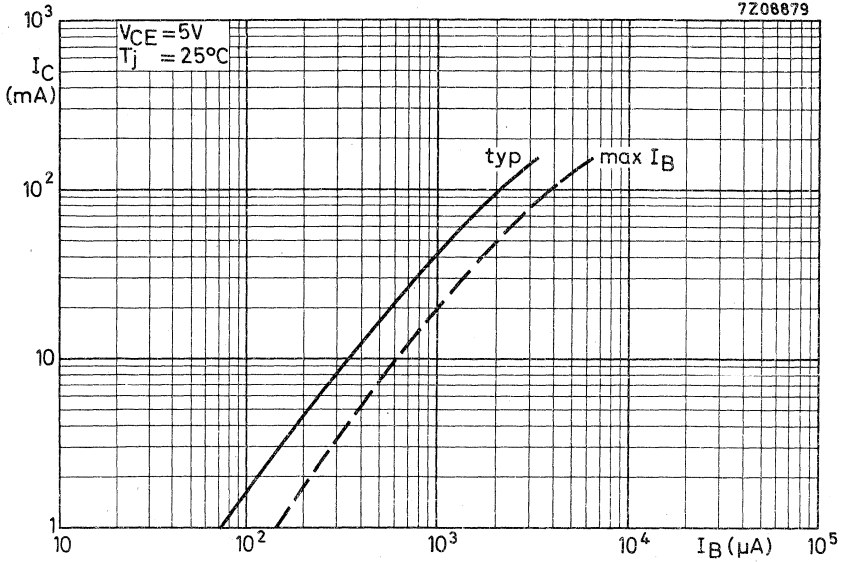
$R_L = 220 \Omega$; $C_L = -5.6 \text{ pF}$.

C_{Oe} is found by 4 pF of the transistor and 1.6 pF by the mounting system concerning of a borium nitride washer between the envelope of the transistor and the chassis.

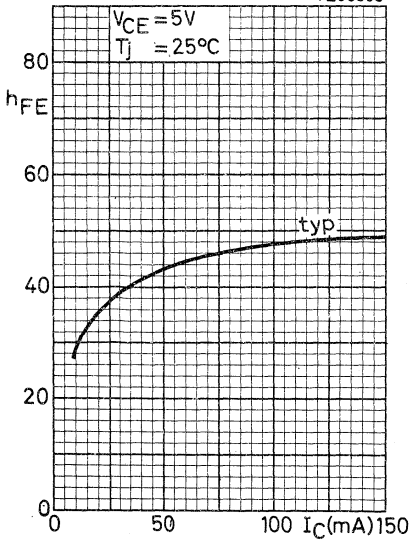
Adjustment procedure

1. Remove the transistor and connect a dummy consisting of a 220 Ω resistor in parallel with a 5.6 pF capacitor between the collector and emitter connections of the output circuit.
2. Tune and match the output circuit for zero reflection at 205 MHz (V.S.W.R. = 1). After this adjustment, no further change may be made in the output circuit.
3. Replace the dummy by the transistor. Tune and match the input circuit for maximum power gain and good band pass curve.
The V.S.W.R. of the output will then, in most cases, be ≤ 2 over the whole channel.
Corrections can be made by tuning L2; this will not disturb the band pass curve.

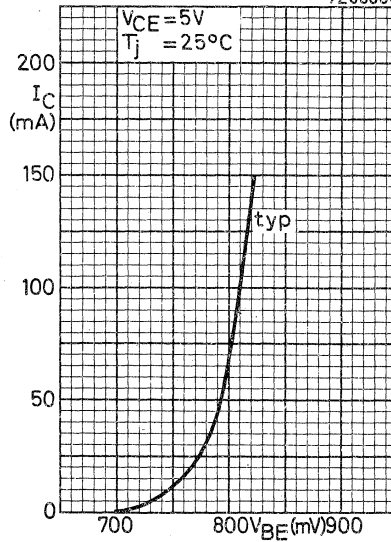
7208879

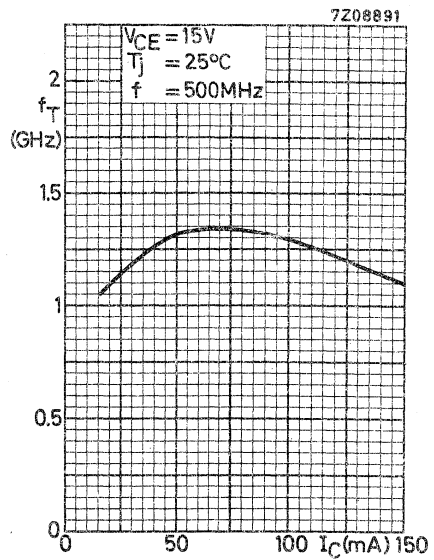
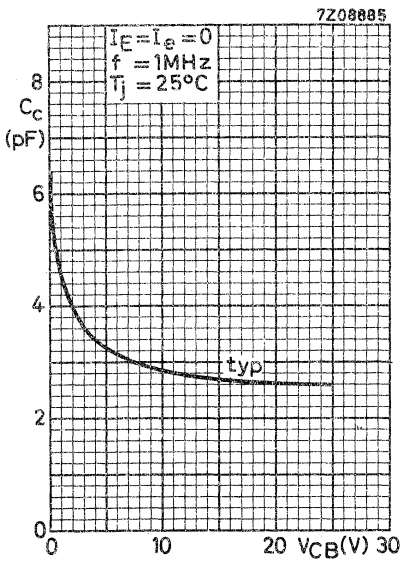
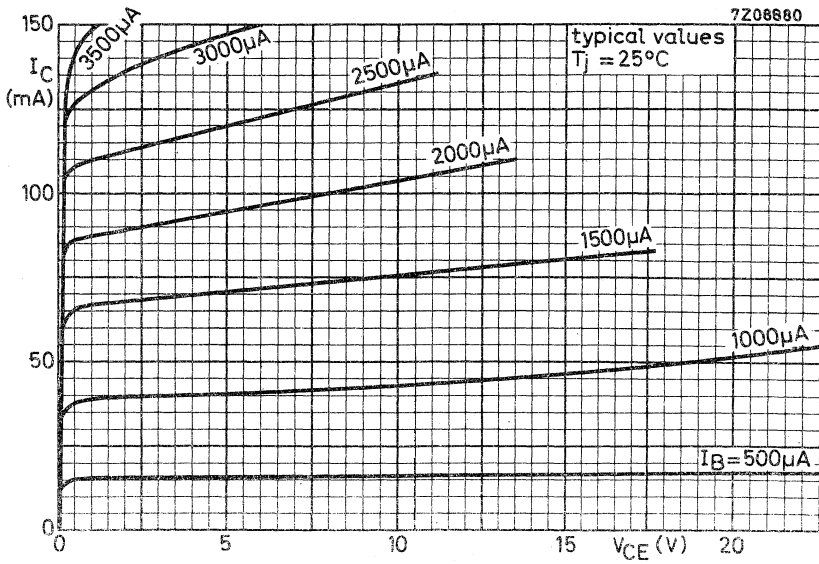


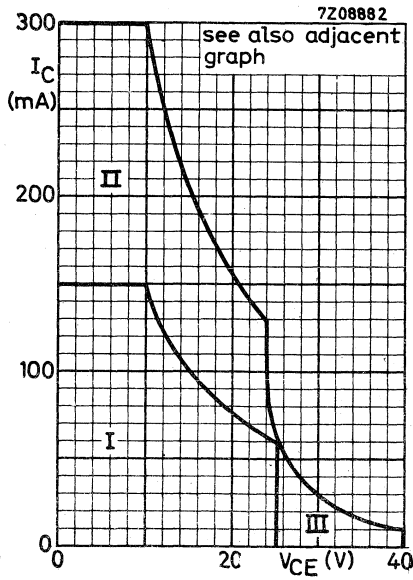
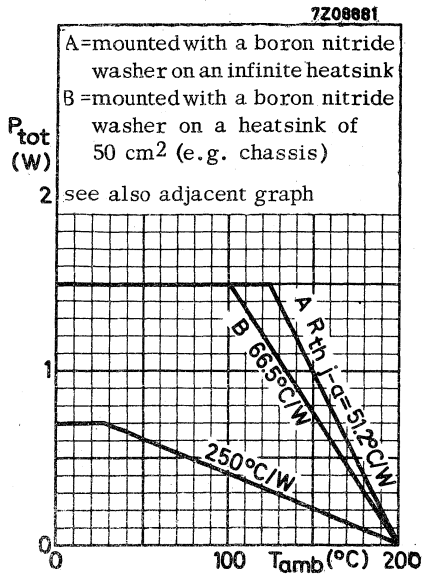
7208883



7208884







- I = Region of permissible operation under all base-emitter conditions and at all frequencies, including d.c.
- II = Additional region of operation at $f \geq 1$ MHz
- III = Operating under pulsed conditions is allowed, provided the transistor is cut-off with $R_{BE} \leq 50 \Omega$ and $f \geq 1$ MHz.

SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N multi-emitter transistor in a TO-72 metal envelope, with insulated electrodes and a shield lead connected to the case. The transistor has very low intermodulation distortion and very high power gain. It is primarily intended for:

- Wideband vertical amplifiers in high speed oscilloscopes.
- Wideband aerial amplifiers (40-860 MHz).
- Television distribution amplifiers.

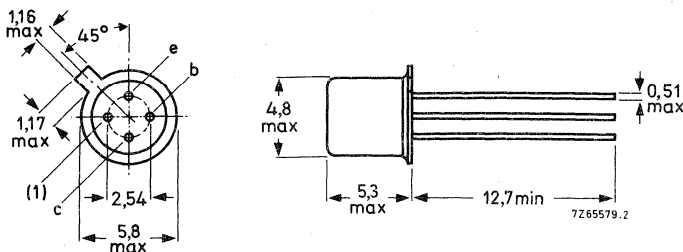
QUICK REFERENCE DATA

| | | | | |
|--|------------|------|----------|-----|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 20 | V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 10 | V |
| Collector current (peak value; $f > 1$ MHz) | I_{CM} | max. | 100 | mA |
| Total power dissipation up to $T_{amb} = 25$ °C | P_{tot} | max. | 250 | mW |
| Junction temperature | T_j | max. | 200 | °C |
| Feedback capacitance at $f = 1$ MHz $I_C = 2$ mA; $V_{CE} = 5$ V | C_{re} | typ. | 0,8 | pF |
| Transition frequency $I_C = 50$ mA; $V_{CE} = 5$ V; $f = 500$ MHz | f_T | typ. | 1,6 | GHz |
| Power gain (not neutralized) $I_C = 30$ mA; $V_{CE} = 5$ V | G_p | typ. | 21 7,5 | dB |
| Intermodulation distortion $I_C = 30$ mA; $V_{CE} = 6$ V; $R_L = 37,5$ Ω; $V_O = 100$ mV at $f_p = 183$ MHz; $V_O = 100$ mV at $f_q = 200$ MHz; measured at $f_{(2q-p)} = 217$ MHz | d_{im} | typ. | -60 | dB |

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-72.



(1) = shield lead (connected to case).

Accessories: 56246 (distance disc).

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

Collector-base voltage (open emitter; peak value) V_{CBOM} max. 20 V

Collector-emitter voltage (open base)

$I_C = 10$ mA

V_{CEO} max. 10 V

Emitter-base voltage (open collector)

V_{EBO} max. 2.5 V

Currents

Collector current (d. c.)

I_C max. 50 mA

Collector current (peak value; $f > 1$ MHz)

I_{CM} max. 100 mA

Power dissipation

Total power dissipation up to $T_{amb} = 25$ °C

P_{tot} max. 250 mW

Temperatures

Storage temperature

T_{stg} -65 to +200 °C

Junction temperature

T_j max. 200 °C

THERMAL RESISTANCE

From junction to ambient in free air

$R_{th\ j-a} = 0.7$ °C/mW

From junction to case

$R_{th\ j-c} = 0.5$ °C/mW

CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 10\text{ V}$

$I_{CBO} < 50\text{ nA}$

D.C. current gain

$I_C = 25\text{ mA}; V_{CE} = 5\text{ V}$

$h_{FE} > 25$

$I_C = 50\text{ mA}; V_{CE} = 5\text{ V}$

$h_{FE} > 25$

Transition frequency ¹⁾

$I_C = 50\text{ mA}; V_{CE} = 5\text{ V}; f = 500\text{ MHz}$

$f_T \text{ typ. } 1.6\text{ GHz}$

Collector capacitance at $f = 1\text{ MHz}$ ²⁾

$I_E = I_e = 0; V_{CB} = 5\text{ V}$

$C_c < 1.5\text{ pF}$

Feedback capacitance at $f = 1\text{ MHz}$ ¹⁾

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}$

$C_{re} \text{ typ. } 0.8\text{ pF}$

Noise figure ¹⁾

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}$

$f = 500\text{ MHz}; R_S = 50\text{ }\Omega$

$F < 5\text{ dB}$

Power gain (not neutralized) ¹⁾

$I_C = 30\text{ mA}; V_{CE} = 5\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$

| | | |
|-------|-------------------|------------------|
| | $f = 200$ | 800 MHz |
| G_p | > 19 | dB |
| | $\text{typ. } 21$ | 7.5 dB |

Intermodulation distortion ¹⁾

$I_C = 30\text{ mA}; V_{CE} = 6\text{ V}; R_L = 37.5\text{ }\Omega; T_{amb} = 25\text{ }^\circ\text{C}$

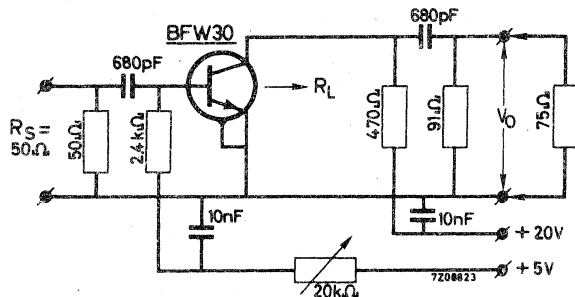
$V_o = 100\text{ mV}$ at $f_p = 183\text{ MHz}$

$V_o = 100\text{ mV}$ at $f_q = 200\text{ MHz}$

measured at $f(2q-p) = 217\text{ MHz}$

$\text{dim typ. } -60\text{ dB}$

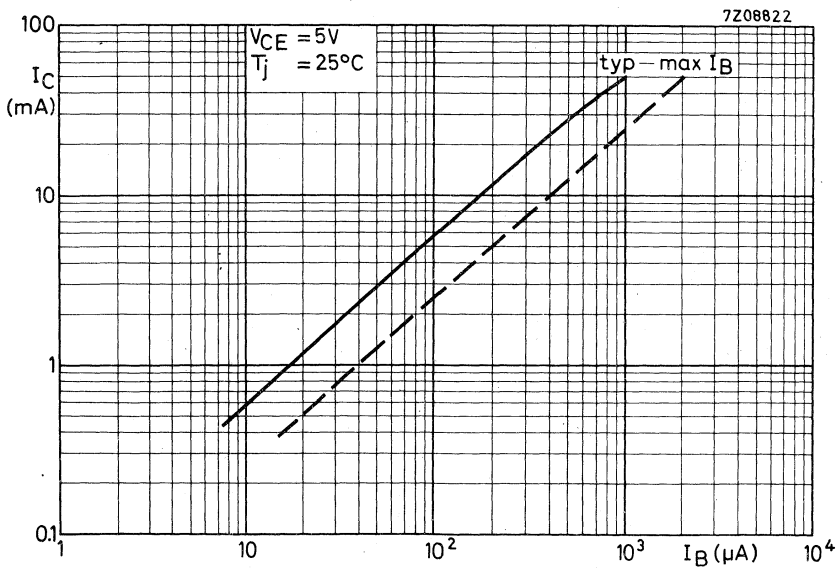
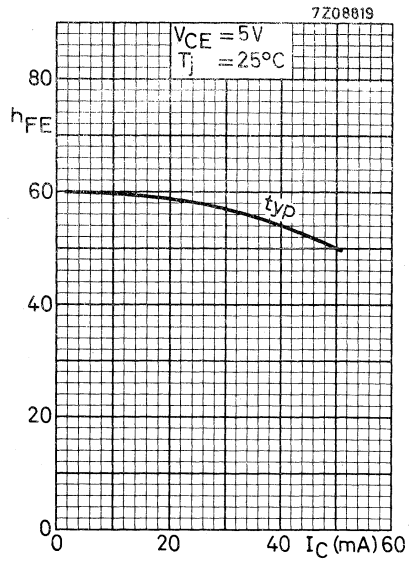
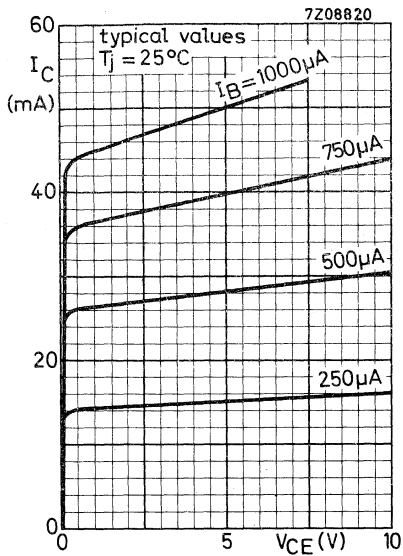
Test circuit

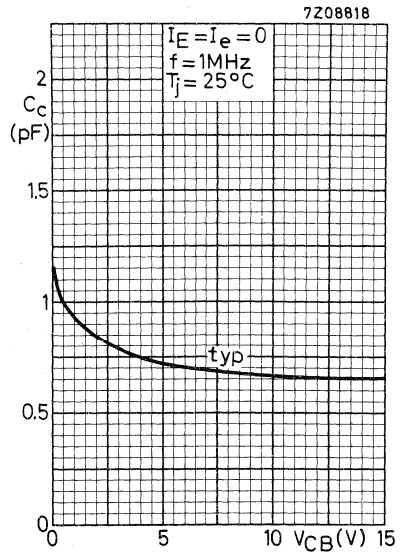
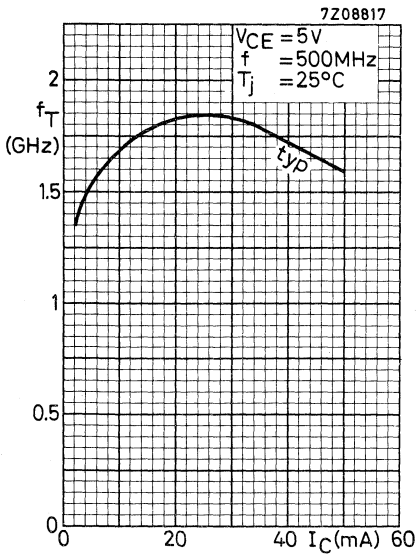
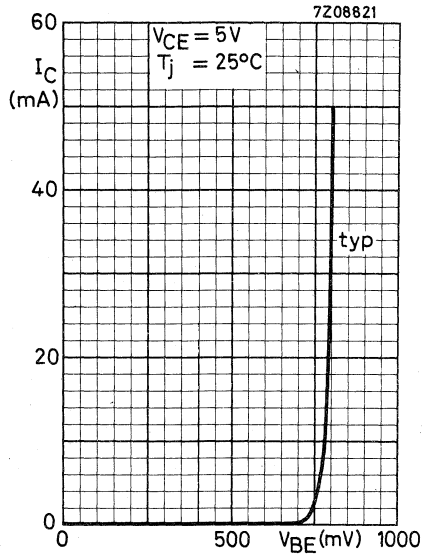


1) Shield lead grounded.

2) Shield lead not connected.

BFW30





SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a subminiature plastic T-package. It has a low noise over a wide current range, a very high power gain and good intermodulation properties.

It is primarily intended for:

- Wideband aerial amplifiers (40 - 860 MHz)
- Channel and band aerial amplifiers for band I, II, III and IV/V (40 - 860 MHz)
- Television distribution amplifiers
- Low noise wideband vertical amplifier in high speed oscilloscopes

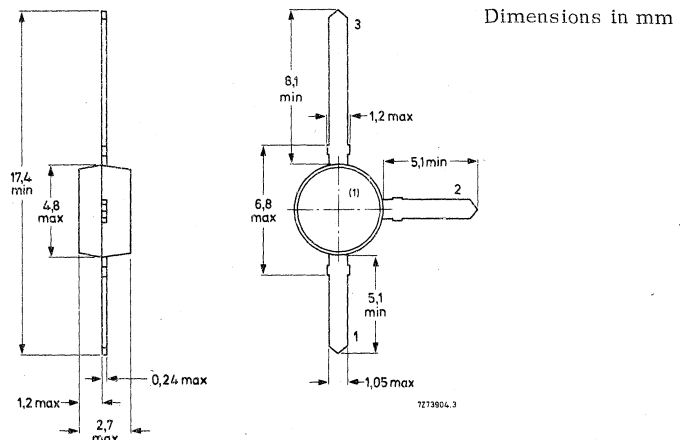
| QUICK REFERENCE DATA | | | |
|--|------------|------|---------------------|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 25 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 V |
| Collector current (peak value; $f > 1$ MHz) | I_{CM} | max. | 50 mA |
| Total power dissipation up to $T_{amb} = 73$ °C | P_{tot} | max. | 190 mW |
| Junction temperature | T_j | max. | 150 °C |
| Transition frequency at $f = 500$ MHz $I_C = 25$ mA; $V_{CE} = 5$ V | f_T | typ. | 1,6 GHz |
| Feedback capacitance at $f = 1$ MHz $I_C = 2$ mA; $V_{CE} = 5$ V | C_{re} | typ. | 0,6 pF |
| Noise figure at $f = 500$ MHz $I_C = 2$ mA; $V_{CE} = 5$ V | F | typ. | 4 dB |
| Power gain (not neutralized) $I_C = 10$ mA; $V_{CE} = 10$ V; $T_{amb} = 25$ °C | G_p | | $f = 200$ 800 MHz |
| | | typ. | 23 11 dB |
| Output power at $d_{im} = -30$ dB VSWR at output < 2 ; $I_C = 10$ mA; $V_{CE} = 10$ V | P_o | typ. | 8 8 mW |

MECHANICAL DATA

Fig. 1 SOT-37.

Connections

1. Base
2. Emitter
3. Collector



(1) = type number marking.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages

| | | | |
|---|------------|------|--------------------|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 25 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 V ¹⁾ |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2.5 V |

Currents

| | | | |
|---|----------|------|-------|
| Collector current (d.c.) | I_C | max. | 25 mA |
| Collector current (peak value; $f > 1$ MHz) | I_{CM} | max. | 50 mA |

Power dissipation

| | | | |
|---|-----------|------|--------|
| Total power dissipation up to $T_{amb} = 73$ °C | P_{tot} | max. | 190 mW |
|---|-----------|------|--------|

Temperatures

| | | |
|----------------------|-----------|----------------|
| Storage temperature | T_{stg} | -65 to +150 °C |
| Junction temperature | T_j | max. 150 °C |

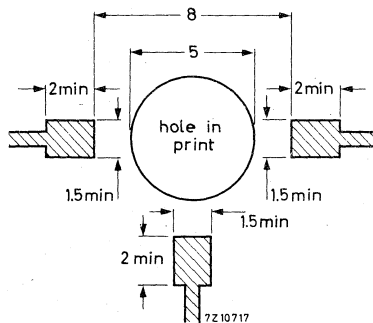
THERMAL RESISTANCE

From junction to ambient in free air
 mounted on a glass-fibre print *)
 of 40 mm x 25 mm x 1 mm

$$R_{th\ j-a} = 0.4 \text{ °C/mW}$$

*) Requirements for glass-fibre print

(dimensions in mm)



1) At $I_C = 10$ mA

CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 10\text{ V}$

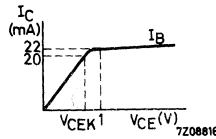
$I_{CBO} < 50\text{ nA}$

Knee voltage 1)

$I_C = 20\text{ mA}; I_B = \text{value for which}$

$I_C = 22\text{ mA at } V_{CE} = 1\text{ V}$

$V_{CEK} < 0.75\text{ V}$



D. C. current gain

$I_C = 2\text{ mA}; V_{CE} = 1\text{ V}$

$h_{FE} > 20$
 $h_{FE} < 150$

$I_C = 25\text{ mA}; V_{CE} = 1\text{ V}^1)$

$h_{FE} > 20$

Transition frequency at $f = 500\text{ MHz}$

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}$

$f_T \text{ typ. } 1.0\text{ GHz}$

$I_C = 25\text{ mA}; V_{CE} = 5\text{ V}^1)$

$f_T \text{ typ. } 1.6\text{ GHz}$

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 10\text{ V}$

$C_c \text{ typ. } 0.7\text{ pF}$

Emitter capacitance at $f = 1\text{ MHz}$

$I_C = I_c = 0; V_{EB} = 0.5\text{ V}$

$C_e \text{ typ. } 1.5\text{ pF}$

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$

$C_{re} \text{ typ. } 0.6\text{ pF}$

Noise figure at $f = 500\text{ MHz}$

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}; R_S = 50\text{ }^\Omega; T_{amb} = 25\text{ }^\circ\text{C}$

$F \text{ typ. } 4.0\text{ dB}$

Power gain (not neutralized)

$I_C = 10\text{ mA}; V_{CE} = 10\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$

| | | |
|--------------------|-----------|------------------|
| | $f = 200$ | 800 MHz |
| $G_p \text{ typ.}$ | 23 | .11 dB |

1) Measured under pulse conditions.

CHARACTERISTICS (continued)

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Intermodulation characteristics

1. Output power at $f = 200\text{ MHz}$; $T_{\text{amb}} = 25\text{ }^\circ\text{C}$

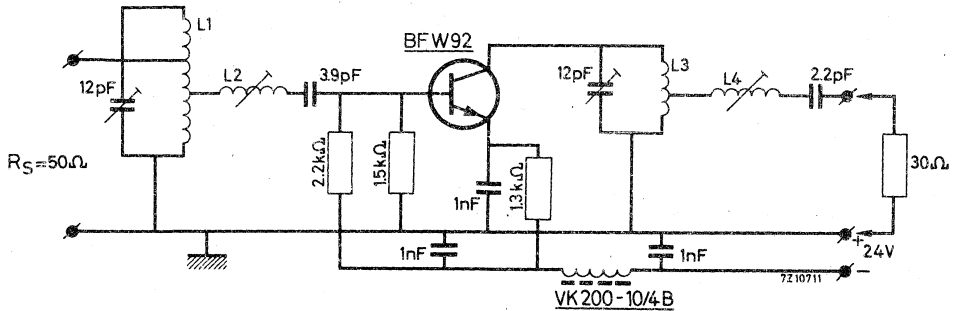
$I_C = 10\text{ mA}$; $V_{CE} = 10\text{ V}$; V.S.W.R. at output < 2

$f_p = 202\text{ MHz}$; $f_q = 205\text{ MHz}$; $d_{\text{im}} = -30\text{ dB}$

measured at $f_{(2q-p)} = 208\text{ MHz}$ (Channel 9)

P_o typ. 8 mW

Test circuit:



Coil data:

L1 = 3 turns silver plated Cu wire (1.4 mm); winding pitch 2.7 mm;
int. diam. 8 mm; taps at 0.5 turn and 1.5 turns from earth.

L2 = 5.5 turns silver plated Cu wire (1.4 mm); winding pitch 2.2 mm;
int. diam. 8 mm.

L3 = 3 turns silver plated Cu wire (1.4 mm); winding pitch 3.3 mm;
int. diam. 8 mm.

L4 = 5.5 turns silver plated Cu wire (1.4 mm); winding pitch 2.2 mm;
int. diam. 11 mm.

CHARACTERISTICS (continued)

Basis of adjustment

The intermodulation at an intermodulation distortion of -30 dB is caused by h.f. output current - voltage clipping.

The maximum undistorted output power is realised, if

- a. Current and voltage clipping take place concurrently.
This occurs if

$$R_L = \frac{V_{CE} - V_{CEK}}{I_C},$$

in which V_{CEK} is the high frequency knee voltage.

- b. The h.f. collector current is as small as possible.

This is so if $-C_L = +C_{Oe}$,

in which C_{Oe} is the output capacitance of the transistor at short circuited input.

For maximum output power at an intermodulation distortion of -30 dB, the (experimentally found) values of R_L and C_L are:

$$R_L = 820 \Omega; C_L = -1.0 \text{ pF}$$

Adjustment procedure

1. Remove the transistor and connect a dummy consisting of a 820 Ω resistor in parallel with a 1.0 pF capacitor between the collector and emitter connections of the output circuit.
2. Tune and match the output circuit for zero reflection at 205 MHz (V.S.W.R. = 1). After this adjustment, no further change may be made in the output circuit.
3. Replace the dummy by the transistor. Tune and match the input circuit for maximum power gain and good band pass curve.
The V.S.W.R. of the output will then, in most cases, be ≤ 2 over the whole channel.
Corrections can be made by tuning L2; this will not disturb the band pass curve.

CHARACTERISTICS (continued)

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Intermodulation characteristics

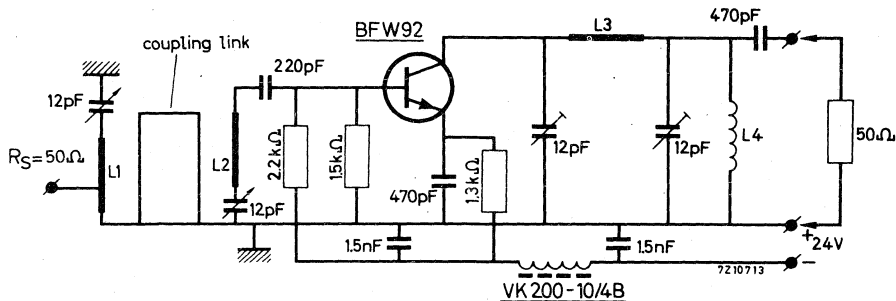
2. Output power at $f = 800\text{ MHz}$; $T_{\text{amb}} = 25\text{ }^\circ\text{C}$

$I_C = 10\text{ mA}$; $V_{CE} = 10\text{ V}$; V. S. W. R. at output < 2

$f_p = 798\text{ MHz}$; $f_q = 802\text{ MHz}$; $d_{\text{im}} = -30\text{ dB}$

measured at $f(2q-p) = 806\text{ MHz}$ (Channel 62)

P_o typ. 8 mW



Coil data:

L1 = 24 mm x 6 mm x 0.5 mm silver plated Cu strip.

Tap of the input at 5 mm from earth.

L2 = 15 mm x 6 mm x 0.5 mm silver plated Cu strip.

L3 = 20 mm x 8 mm x 0.5 mm silver plated Cu strip.

L4 = 4 turns enamelled Cu wire (0.5 mm); winding pitch 1.5 mm; int. diam. 4 mm

Coupling link: 42 mm silver plated Cu wire (1 mm).

Basis of adjustment.

At 800 MHz no dummy can be used to adjust for optimum collector load because at these frequencies the impedance transformations of a dummy are too high. A small signal at the mid-channel frequency of 802 MHz is fed to the input and increased until clipping occurs; that is, until the output power no longer increases linearly with the input signal. This clipping can be eliminated by tuning the output circuit, thereby making the output power equal to

$$P_o = \frac{I_C (V_{CE} - V_{CEK})}{2} = 40\text{ mW}$$

The output circuit is adjusted for minimum intermodulation if the input signal is as small as possible at $P_o = 40\text{ mW}$.

After this adjustment has been made no further change may be made in the output circuit.

Adjust the input circuit for maximum power gain and good band pass curve.

The V. S. W. R. of the output is then ≤ 2 over the whole channel.

CHARACTERISTICS (continued)

Intermodulation characteristics

3. Intermodulation distortion

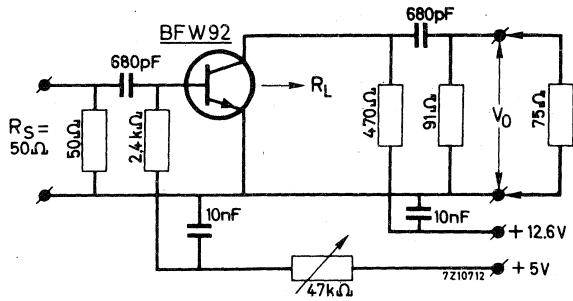
$I_C = 10 \text{ mA}$; $V_{CE} = 6 \text{ V}$; $R_L = 37.5 \Omega$; $T_{amb} = 25^\circ\text{C}$

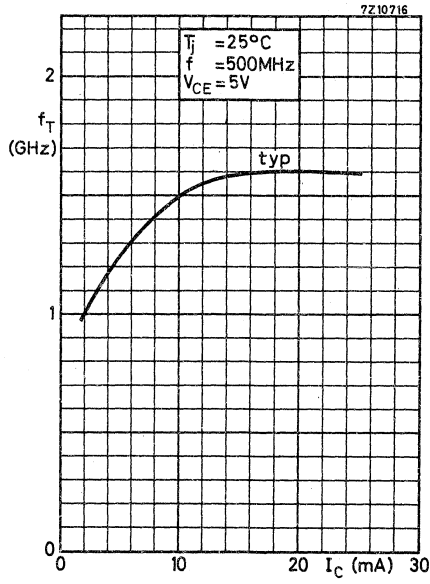
$V_0 = 100 \text{ mV}$ at $f_p = 183 \text{ MHz}$

$V_0 = 100 \text{ mV}$ at $f_q = 200 \text{ MHz}$
 measured at $f_{(2q-p)} = 217 \text{ MHz}$

d_{im} typ. -45 dB

Test circuit:





SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a subminiature plastic transfer-moulded T-package.

The device is intended for use in v. h. f. - u. h. f. applications, primarily wideband aerial amplifiers 40 - 800 MHz.

It is intended for mounting on miniature printed-circuit boards.

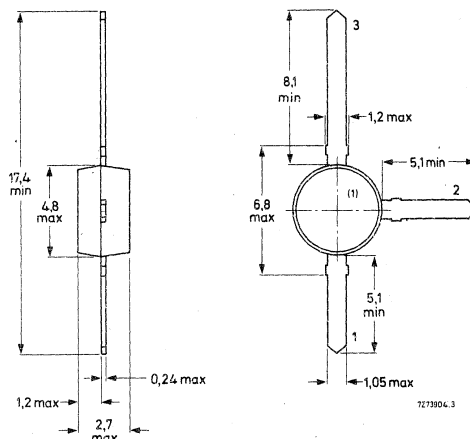
| QUICK REFERENCE DATA | | | | |
|--|-----------|------|------|-----|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 18 | V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 10 | V |
| Collector current (peak value; $f > 1$ MHz) | I_{CM} | max. | 100 | mA |
| Total power dissipation up to $T_{amb} = 73$ °C | P_{tot} | max. | 190 | mW |
| Junction temperature | T_j | max. | 150 | °C |
| Feedback capacitance at $f = 1$ MHz $I_C = 2$ mA; $V_{CE} = 5$ V; $T_{amb} = 25$ °C | C_{re} | typ. | 0,6 | pF |
| Transition frequency at $f = 500$ MHz $I_C = 50$ mA; $V_{CE} = 5$ V | f_T | typ. | 1,7 | GHz |
| Max. unilateral power gain (see page 3) $I_C = 30$ mA; $V_{CE} = 5$ V; $f = 200$ MHz; $T_{amb} = 25$ °C | GUM | typ. | 22 | dB |
| $I_C = 30$ mA; $V_{CE} = 5$ V; $f = 800$ MHz; $T_{amb} = 25$ °C | GUM | typ. | 10,5 | dB |
| Intermodulation distortion at $T_{amb} = 25$ °C $I_C = 30$ mA; $V_{CE} = 5$ V; $R_L = 37,5$ Ω | | | | |
| $V_O = 100$ mV at $f_p = 183$ MHz | | | | |
| $V_O = 100$ mV at $f_q = 200$ MHz measured at $f(2q-p) = 217$ MHz | d_{im} | typ. | -60 | dB |

MECHANICAL DATA

Fig. 1 SOT-37.

Connections

1. Base
2. Emitter
3. Collector



Dimensions in mm

(1) = type number marking.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Voltages

| | | | | |
|---------------------------------------|-----------|------|-----|---|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 18 | V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 10 | V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2.5 | V |

Currents

| | | | | |
|---|----------|------|-----|----|
| Collector current (d. c.) | I_C | max. | 50 | mA |
| Collector current (peak value; $f > 1$ MHz) | I_{CM} | max. | 100 | mA |

Power dissipation

| | | | | |
|---|-----------|------|-----|----|
| Total power dissipation up to $T_{amb} = 73$ °C | P_{tot} | max. | 190 | mW |
|---|-----------|------|-----|----|

Temperatures

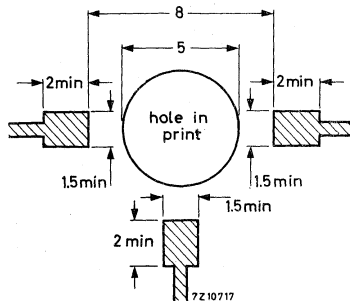
| | | | |
|----------------------|-----------|-------------|----|
| Storage temperature | T_{stg} | -65 to +150 | °C |
| Junction temperature | T_j | max. 150 | °C |

THERMAL RESISTANCE

From junction to ambient in free air
mounted on a glass-fibre print
of 40 mm x 25 mm x 1 mm

$$R_{th\ j-a} = 0.4 \text{ °C/mW}$$

Requirements for glass-fibre print
(dimensions in mm)



CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

$I_E = 0; V_{CB} = 10\text{ V}$ I_{CBO} < 50 nA

D.C. current gain ¹⁾

$I_C = 25\text{ mA}; V_{CE} = 5\text{ V}$ h_{FE} > 25

$I_C = 50\text{ mA}; V_{CE} = 5\text{ V}$ h_{FE} > 25

Transition frequency at $f = 500\text{ MHz}$ ¹⁾

$I_C = 50\text{ mA}; V_{CE} = 5\text{ V}$ f_T typ. 1.7 GHz

Collector capacitance at $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 5\text{ V}$ C_c typ. 0.7 pF

Emitter capacitance at $f = 1\text{ MHz}$

$I_C = I_c = 0; V_{EB} = 0.5\text{ V}$ C_e typ. 1.5 pF

Feedback capacitance at $f = 1\text{ MHz}$

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$ C_{re} typ. 0.6 pF

Noise figure at $f = 500\text{ MHz}$

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}; G_S = 20\text{ mA/V}$

B_S is tuned; $T_{amb} = 25\text{ }^\circ\text{C}$ F < 5 dB

Max. unilateral power gain (s_{re} assumed to be zero)

$$G_{UM} \text{ (in dB)} = 10 \log \frac{|s_{fe}|^2}{(1 - |s_{ie}|^2)(1 - |s_{oe}|^2)}$$

$I_C = 30\text{ mA}; V_{CE} = 5\text{ V}; f = 200\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ G_{UM} typ. 22 dB

$I_C = 30\text{ mA}; V_{CE} = 5\text{ V}; f = 800\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$ G_{UM} typ. 10.5 dB

¹⁾ Measured under pulse conditions.

CHARACTERISTICS (continued)

Intermodulation distortion at $T_{amb} = 25\text{ }^{\circ}\text{C}$

$$I_C = 30\text{ mA}; V_{CE} = 5\text{ V}; R_L = 37.5\ \Omega$$

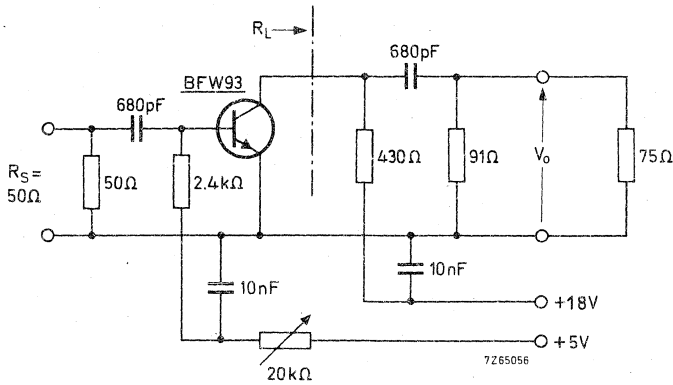
$$V_o = 100\text{ mV at } f_p = 183\text{ MHz}$$

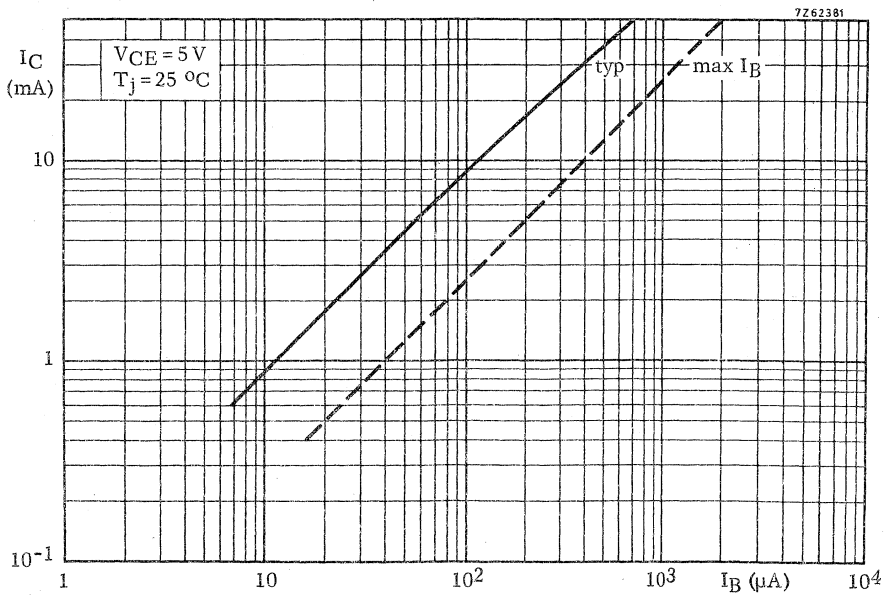
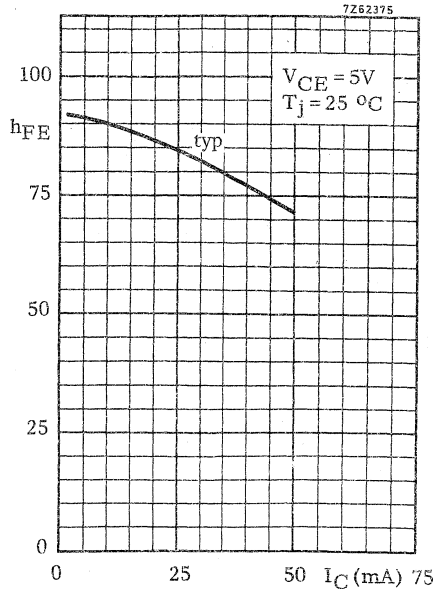
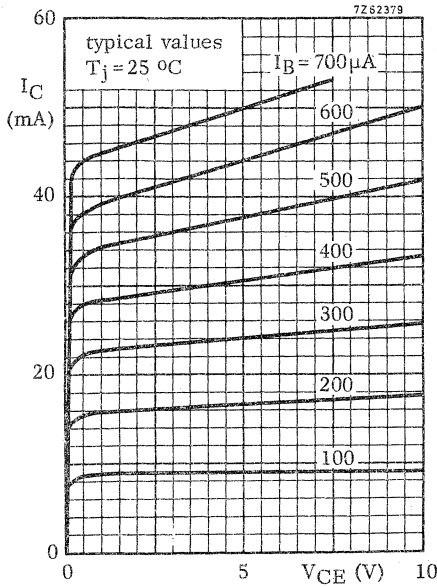
$$V_o = 100\text{ mV at } f_q = 200\text{ MHz}$$

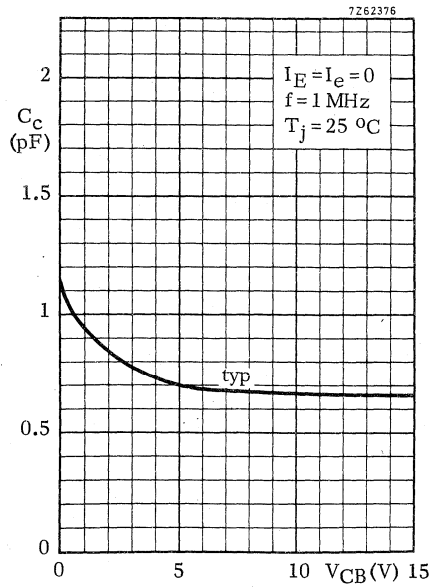
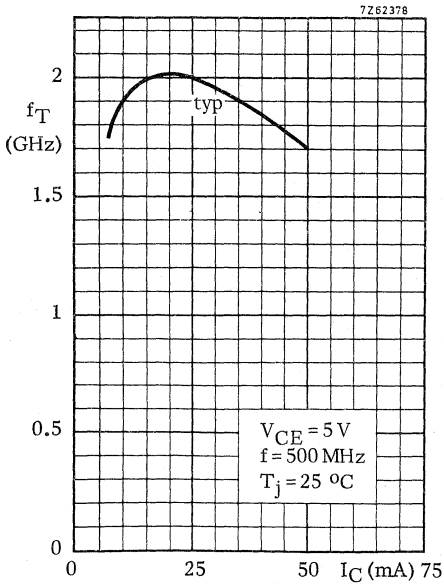
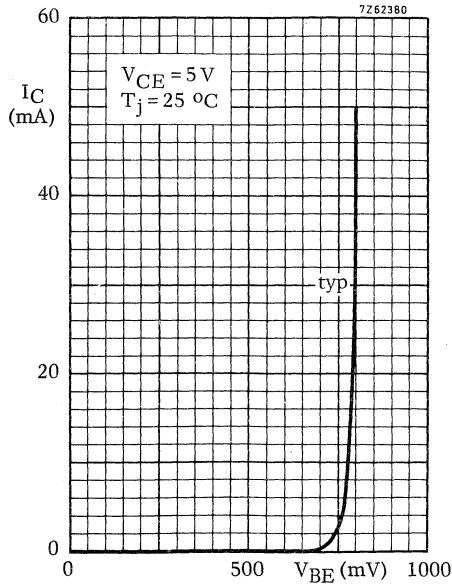
measured at $f(2q - p) = 217\text{ MHz}$

$$d_{im} \quad \text{typ.} \quad -60 \quad \text{dB}$$

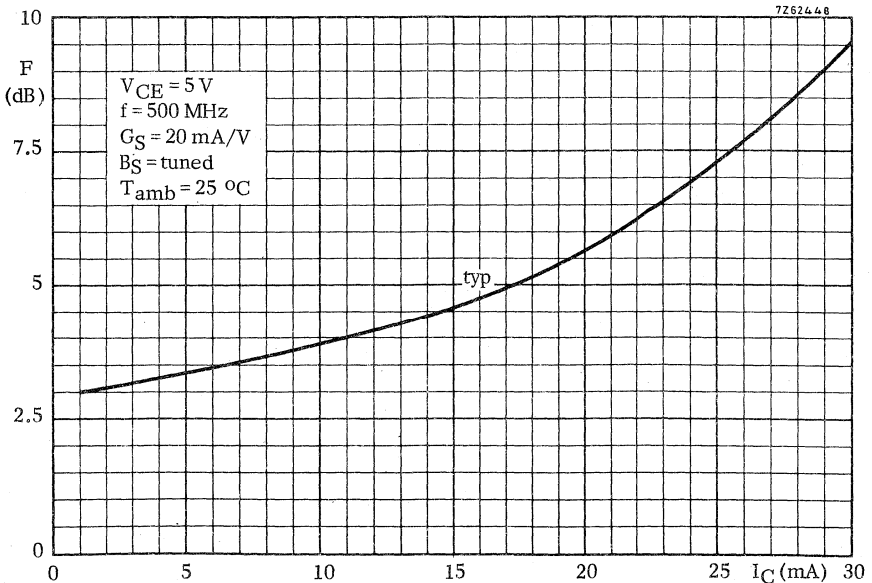
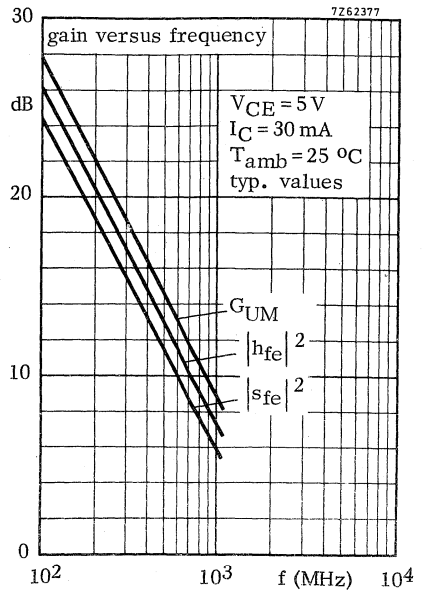
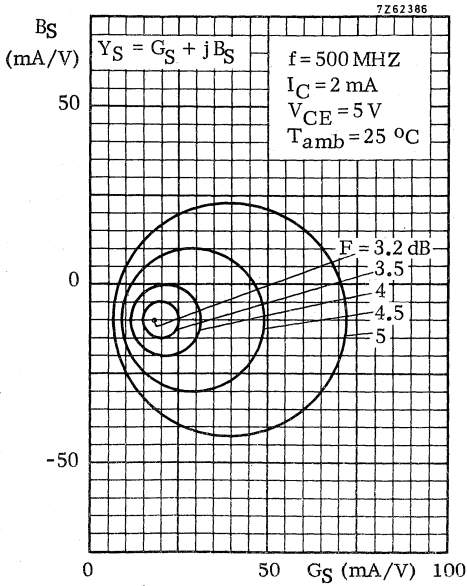
Test circuit :



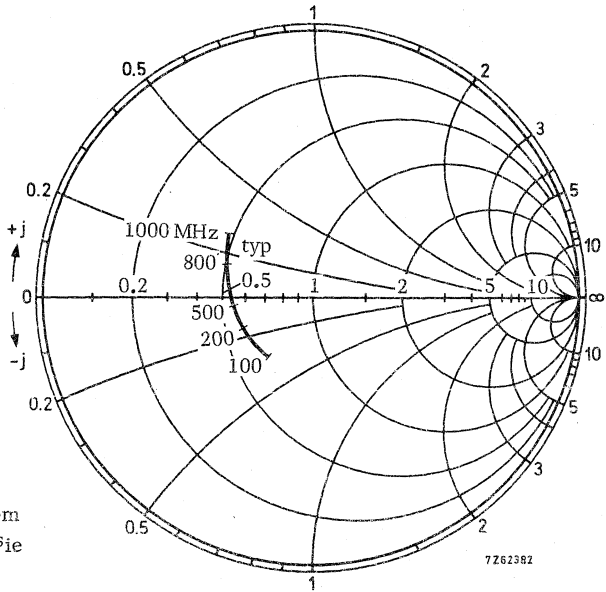




circles of constant noise figure



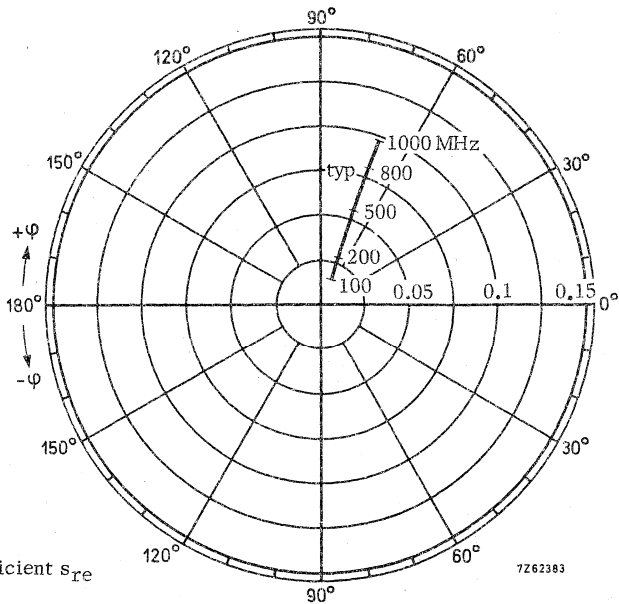
$V_{CE} = 5 \text{ V}$
 $I_C = 30 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$



Input impedance derived from
input reflection coefficient s_{ie}
coordinates in ohm x 50

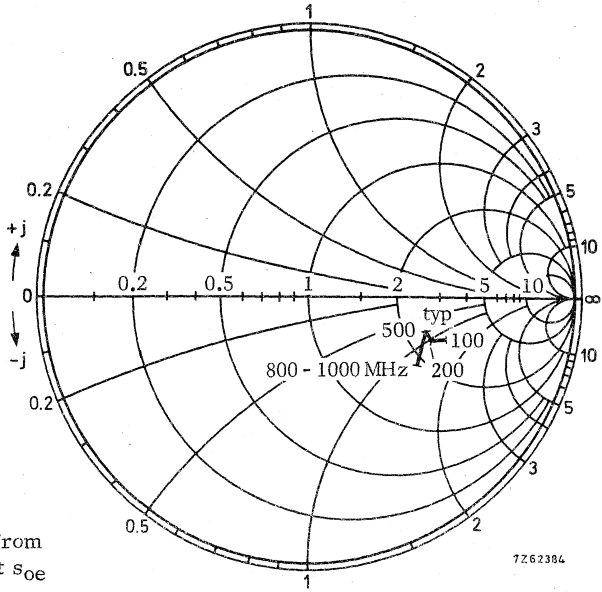


$V_{CE} = 5 \text{ V}$
 $I_C = 30 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$



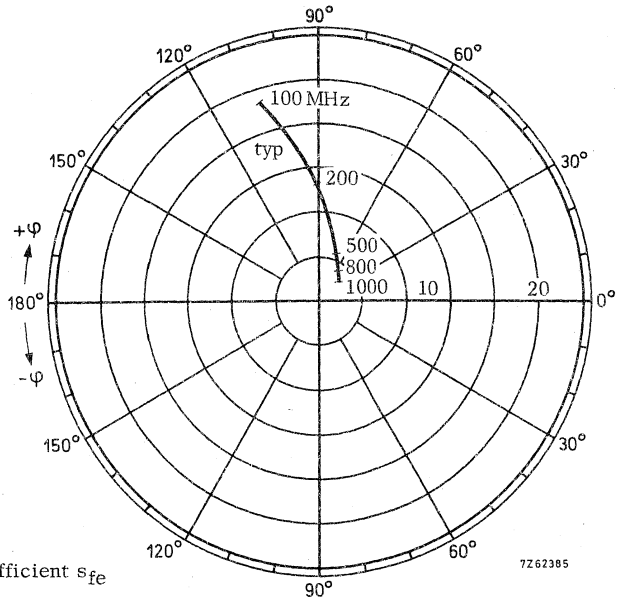
Reverse transmission coefficient s_{re}

$V_{CE} = 5 \text{ V}$
 $I_C = 30 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$



Output impedance derived from
 output reflection coefficient s_{oe}
 coordinates in ohm x 50

$V_{CE} = 5 \text{ V}$
 $I_C = 30 \text{ mA}$
 $T_{amb} = 25 \text{ }^\circ\text{C}$



Forward transmission coefficient s_{fe}



SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a TO-72 metal envelope, with insulated electrodes and a shield lead connected to the case. The transistor has a low noise, a very high power gain and good intermodulation properties. It is primarily intended for:

- Channel aerial amplifiers for bands I, II, III and IV/V (40-860 MHz).
- Wideband aerial amplifiers (40-860 MHz).

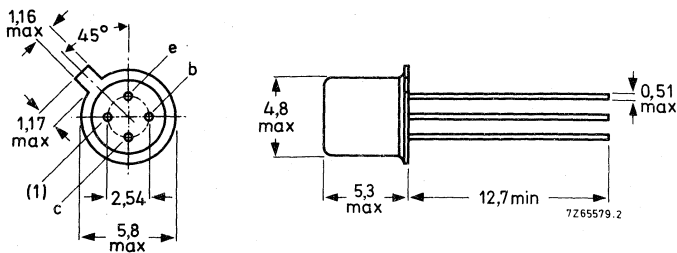
QUICK REFERENCE DATA

| | | | | | |
|--|------------|------|-----------------------|-----|----|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 30 | V | |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 | V | |
| Collector current (peak value; $f > 1$ MHz) | I_{CM} | max. | 50 | mA | |
| Total power dissipation up to $T_{amb} = 25$ °C | P_{tot} | max. | 200 | mW | |
| Junction temperature | T_j | max. | 200 | °C | |
| Transition frequency $I_C = 25$ mA; $V_{CE} = 5$ V; $f = 500$ MHz | f_T | typ. | 1,2 | GHz | |
| Feedback capacitance $I_C = 2$ mA; $V_{CE} = 5$ V; $f = 1$ MHz | C_{re} | typ. | 0,6 | pF | |
| Noise figure at optimum source impedance $I_C = 2$ mA; $V_{CE} = 5$ V | F | typ. | $f = 200$ 800 MHz | | |
| | | | 3,3 | 7 | dB |
| Power gain (not neutralized) $I_C = 8$ mA; $V_{CE} = 10$ V | G_p | typ. | 22 | 7 | dB |
| | | | $f = 200$ 800 MHz | | |
| Output power $d_{im} = -30$ dB; VSWR at output < 2 ; $I_C = 8$ mA; $V_{CE} = 10$ V | P_o | typ. | 6 | 6 | mW |
| | | | $f = 200$ 800 MHz | | |

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-72.



(1) = shield lead (connected to case).

Accessories: 56246 (distance disc).

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)Voltages

| | | | |
|--|------------|------|--------------------|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 30 V |
| Collector-emitter voltage (peak value) $R_{BE} \leq 50 \Omega$ | V_{CERM} | max. | 30 V ¹⁾ |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 V ¹⁾ |
| Emitter-base voltage (open collector) | V_{EBC} | max. | 2.5 V |

Currents

| | | | |
|---|----------|------|-------|
| Collector current (d.c.) | I_C | max. | 25 mA |
| Collector current (peak value; $f > 1$ MHz) | I_{CM} | max. | 50 mA |

Power dissipation

| | | | |
|---|-----------|------|--------|
| Total power dissipation up to $T_{amb} = 25 \text{ }^\circ\text{C}$ | P_{tot} | max. | 200 mW |
|---|-----------|------|--------|

Temperatures

| | | | |
|----------------------|-----------|-------------|----------------------|
| Storage temperature | T_{stg} | -65 to +200 | $^\circ\text{C}$ |
| Junction temperature | T_j | max. | 200 $^\circ\text{C}$ |

THERMAL RESISTANCE

| | | | |
|--------------------------------------|--------------|---|---------------------------------|
| From junction to ambient in free air | $R_{th j-a}$ | = | 0.88 $^\circ\text{C}/\text{mW}$ |
| From junction to case | $R_{th j-c}$ | = | 0.58 $^\circ\text{C}/\text{mW}$ |

¹⁾ $I_C = 10$ mA.

CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

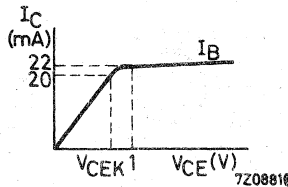
$I_E = 0; V_{CB} = 15\text{ V}$

$I_{CBO} < 10\text{ nA}$

Knee voltage

$I_C = 20\text{ mA}; I_B = \text{value for which}$
 $I_C = 22\text{ mA at } V_{CE} = 1\text{ V}$

$V_{CEK} < 0.75\text{ V}$



D.C. current gain

$I_C = 2\text{ mA}; V_{CE} = 1\text{ V}$

$h_{FE} 20\text{ to }150$

$I_C = 25\text{ mA}; V_{CE} = 1\text{ V}$

$h_{FE} 20\text{ to }125$

Transition frequency ¹⁾

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}; f = 500\text{ MHz}$

$f_T \text{ typ. } 1.0\text{ GHz}$

$I_C = 25\text{ mA}; V_{CE} = 5\text{ V}; f = 500\text{ MHz}$

$f_T \text{ typ. } 1.2\text{ GHz}$

Collector capacitance at $f = 1\text{ MHz}$ ²⁾

$I_E = I_e = 0; V_{CB} = 10\text{ V}$

$C_c < 1.7\text{ pF}$

Feedback capacitance at $f = 1\text{ MHz}$ ¹⁾

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}$

$C_{re} \text{ typ. } 0.6\text{ pF}$

Noise figure ¹⁾

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}$

$f = 200\text{ MHz}; \text{ optimum source impedance}$

$F < 4\text{ dB}$

$f = 500\text{ MHz}; R_S = 50\text{ }\Omega$

$F < 6.5\text{ dB}$

$f = 800\text{ MHz}; \text{ optimum source impedance}$

$F \text{ typ. } 7.0\text{ dB}$

Power gain (not neutralized) ¹⁾

$I_C = 8\text{ mA}; V_{CE} = 10\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$

| | | $f = 200$ | 800 | MHz |
|-------|------|-----------|-------|-----|
| G_p | $>$ | 19 | - | dB |
| | typ. | 22 | 7 | dB |

¹⁾ Shield lead grounded.

²⁾ Shield lead not connected.

CHARACTERISTICS (continued)

Intermodulation characteristics ¹⁾

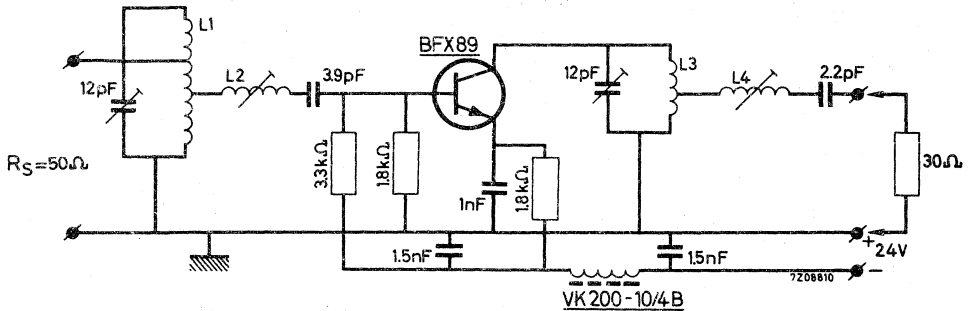
1. Output power at $f = 200$ MHz; $T_{amb} = 25$ °C

$I_C = 8$ mA; $V_{CE} = 10$ V; V.S.W.R. at output < 2

$f_p = 202$ MHz; $f_q = 205$ MHz; $d_{im} = -30$ dB
measured at $f(2q-p) = 208$ MHz (Channel 9)

P_o typ. 6 mW

Test circuit:



Coil data:

- L1 = 3 turns silver plated Cu wire (1.4 mm); winding pitch 2.7 mm;
int. diam. 8 mm; taps at 0.5 turn and 1.5 turns from earth.
- L2 = 5.5 turns silver plated Cu wire (1.4 mm); winding pitch 2.2 mm;
int. diam. 8 mm.
- L3 = 3 turns silver plated Cu wire (1.4 mm) winding pitch 3.3 mm;
int. diam. 8 mm.
- L4 = 5.5 turns silver plated Cu wire (1.4 mm) winding pitch 2.2 mm;
int. diam. 11 mm.

¹⁾ Shield lead grounded.

CHARACTERISTICS (continued)

Basis of adjustment

The intermodulation at an intermodulation distortion of -30 dB is caused by h.f. output current - voltage clipping.

The maximum undistorted output power is realised, if

- a. Current and voltage clipping take place concurrently.
This occurs if

$$R_L = \frac{V_{CE} - V_{CEK}}{I_C},$$

in which V_{CEK} is the high frequency knee voltage.

- b. The h.f. collector current is as small as possible.

This is so if $-C_L = +C_{Oe}$,

in which C_{Oe} is the output capacitance of the transistor at short circuited input.

For maximum output power at an intermodulation distortion of -30 dB, the (experimentally found) values of R_L and C_L are:

$$R_L = 1 \text{ k}\Omega; C_L = -1.8 \text{ pF}$$

Adjustment procedure

1. Remove the transistor and connect a dummy consisting of a 1 k Ω resistor in parallel with a 1.8 pF capacitor between the collector and emitter connections of the output circuit.
2. Tune and match the output circuit for zero reflection at 205 MHz (V.S.W.R. = 1). After this adjustment, no further change may be made in the output circuit.
3. Replace the dummy by the transistor. Tune and match the input circuit for maximum power gain and good band pass curve.
The V.S.W.R. of the output will then, in most cases, be ≤ 2 over the whole channel.
Corrections can be made by tuning L2; this will not disturb the band pass curve.



CHARACTERISTICS (continued)

Intermodulation characteristics ¹⁾

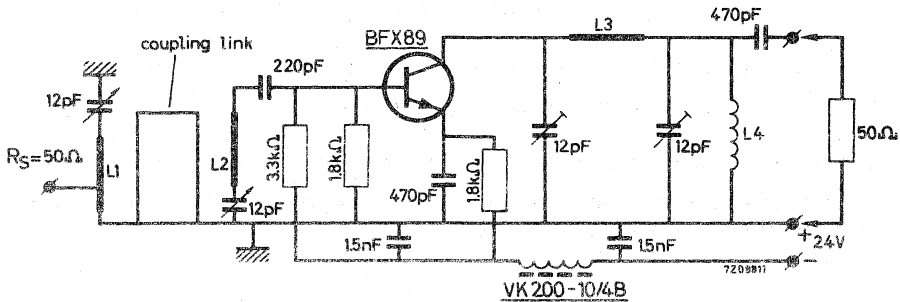
2. Output power at $f = 800 \text{ MHz}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$

$I_C = 8 \text{ mA}$; $V_{CE} = 10 \text{ V}$; V.S.W.R. at output < 2

$f_p = 798 \text{ MHz}$; $f_q = 802 \text{ MHz}$; $d_{\text{im}} = -30 \text{ dB}$
measured at $f(2q-p) = 806 \text{ MHz}$ (Channel 62)

P_o typ. 6 mW

Test circuit:



Coil data:

L1 = 24 mm x 6 mm x 0.5 mm silver plated Cu strip.

Tap of the input at 5 mm from earth.

L2 = 15 mm x 6 mm x 0.5 mm silver plated Cu strip.

L3 = 20 mm x 8 mm x 0.5 mm silver plated Cu strip.

L4 = 4 turns enamelled Cu wire (0.5 mm); winding pitch 1.5 mm;
int. diam. 4 mm.

Coupling link: 42 mm silver plated Cu wire (1 mm).

Basis of adjustment

At 800 MHz no dummy can be used to adjust for optimum collector load because at these frequencies the impedance transformations of a dummy are too high. A small signal at the mid-channel frequency of 802 MHz is fed to the input and increased until clipping occurs; that is, until the output power no longer increases linearly with the input signal. This clipping can be eliminated by tuning the output circuit, thereby making the output power equal to

$$P_o = \frac{I_C (V_{CE} - V_{CEK})}{2} = 35 \text{ mW}$$

The output circuit is adjusted for minimum intermodulation if the input signal is as small as possible at $P_o = 35 \text{ mW}$.

After this adjustment has been made no further change may be made in the output circuit.

Adjust the input circuit for maximum power gain and good band pass curve.

The V.S.W.R. of the output is then ≤ 2 over the whole channel.

¹⁾ Shield lead grounded

CHARACTERISTICS (continued)

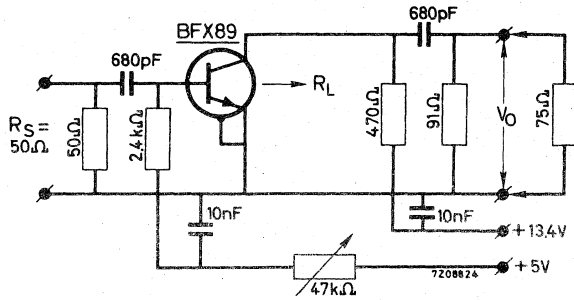
Intermodulation characteristics 1)

3. Intermodulation distortion

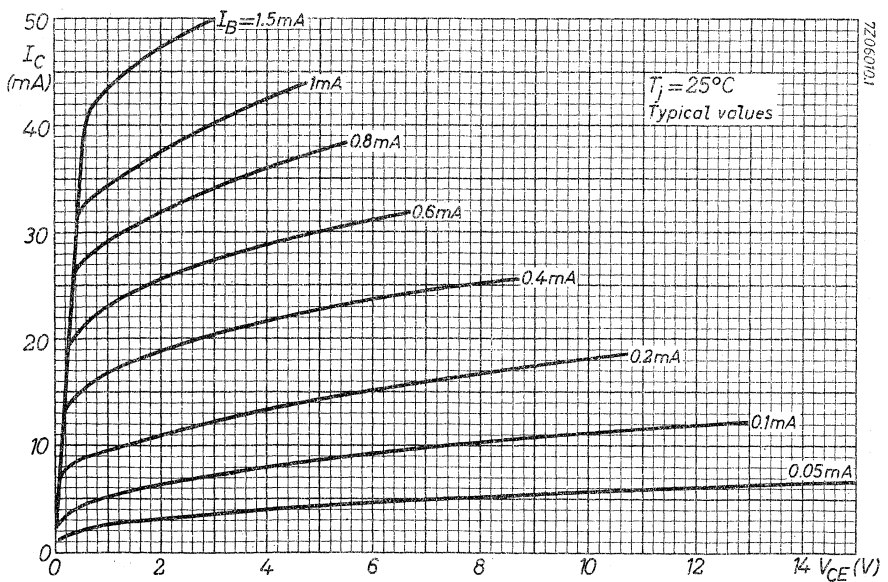
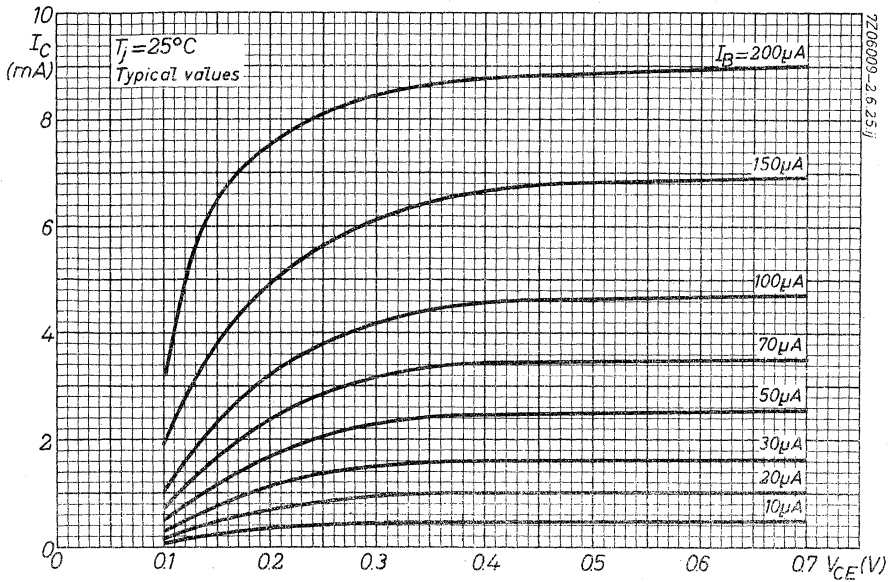
$I_C = 8 \text{ mA}$; $V_{CE} = 6 \text{ V}$; $R_L = 37.5 \Omega$; $T_{amb} = 25 \text{ }^\circ\text{C}$
 $V_o = 100 \text{ mV}$ at $f_p = 183 \text{ MHz}$
 $V_o = 100 \text{ mV}$ at $f_q = 200 \text{ MHz}$
 measured at $f(2q-p) = 217 \text{ MHz}$

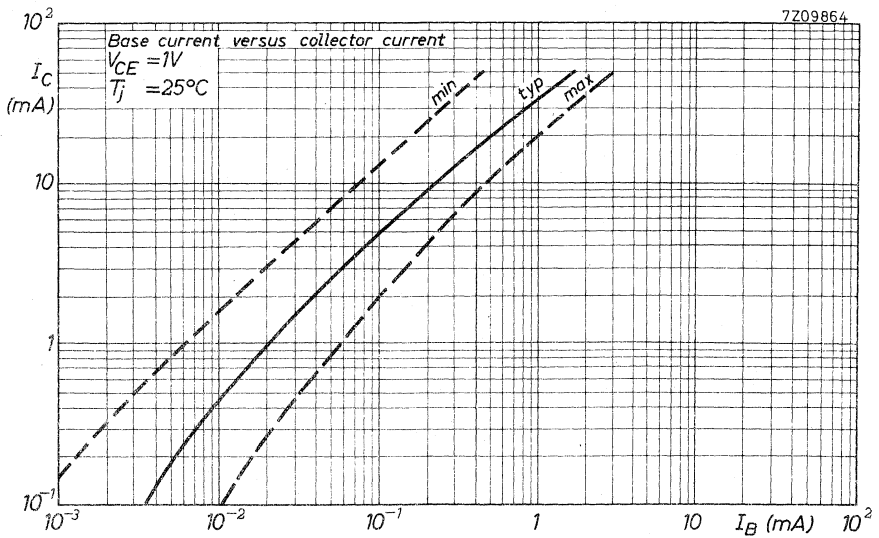
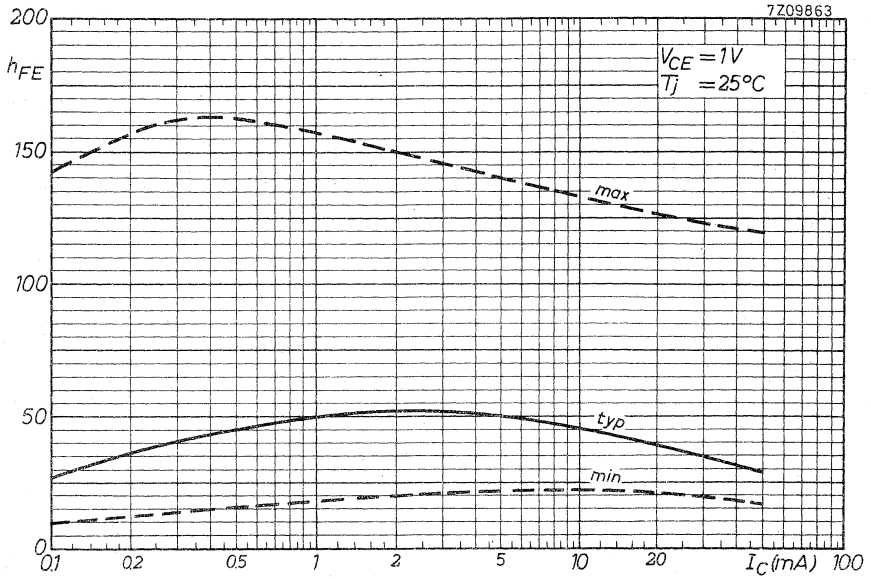
d_{im} typ. -40 dB

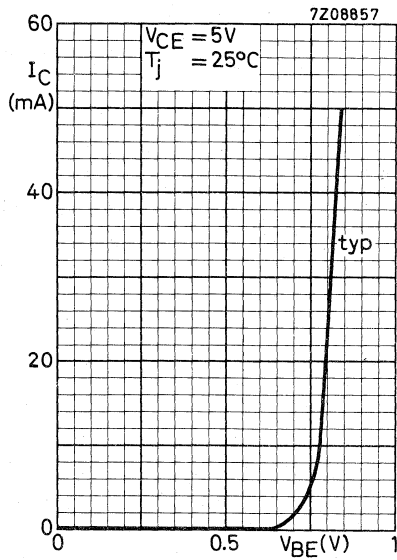
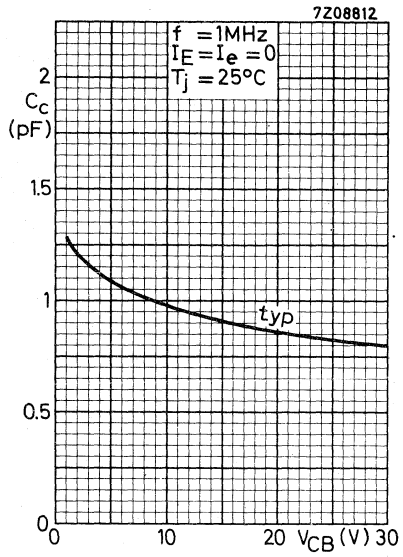
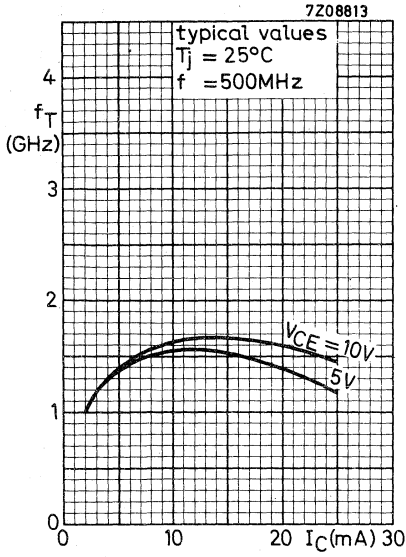
Test circuit:

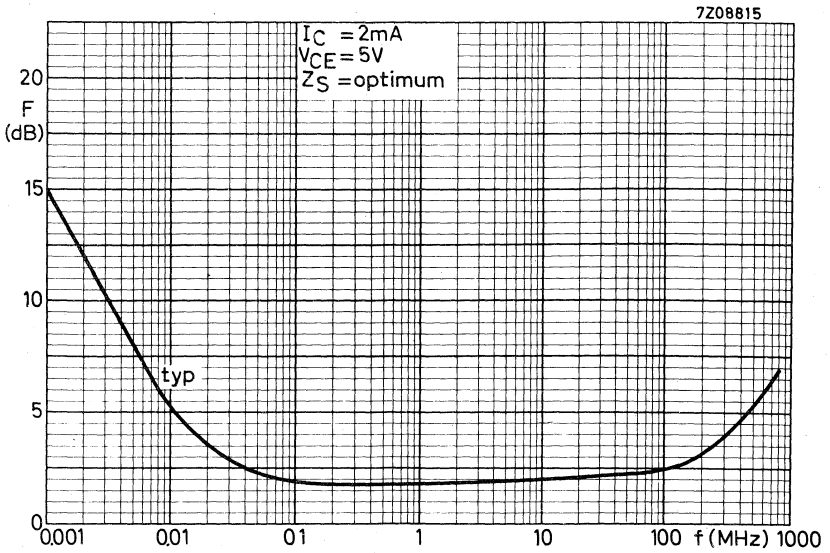
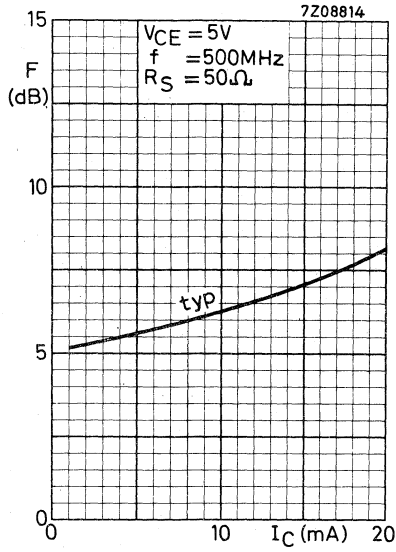


1) Shield lead grounded.









SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in a TO-72 metal envelope with insulated electrodes and a shield lead connected to the case.

The transistor has very low noise over a wide current range, a very high power gain and excellent intermodulation properties.

It is primarily intended for:

- Channel- and band aerial amplifiers for band I, II, III and IV/V (40-860 MHz)
 - Wide band aerial amplifiers (40-860 MHz)
 - Television distribution amplifiers
 - Low noise wide band vertical amplifier in high speed oscilloscopes
- It is also suitable for military- and industrial applications, such as:
- R.F. amplifiers and mixers for communication equipment
 - Microwave telephony link systems, wide band i.f. amplifiers
 - Large bandwidth radar i.f. amplifiers

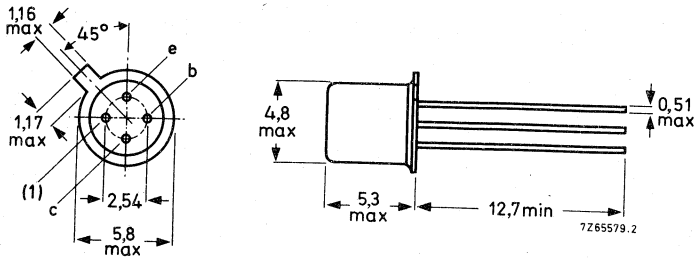
| QUICK REFERENCE DATA | | | |
|---|------------|-----------|---------|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 30 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 V |
| Collector current (peak value; $f > 1$ MHz) | I_{CM} | max. | 50 mA |
| Total power dissipation up to $T_{amb} = 25$ °C | P_{tot} | max. | 200 mW |
| Junction temperature | T_j | max. | 200 °C |
| Transition frequency $I_C = 25$ mA; $V_{CE} = 5$ V; $f = 500$ MHz | f_T | typ. | 1.4 GHz |
| Feedback capacitance at $f = 1$ MHz $I_C = 2$ mA; $V_{CE} = 5$ V | C_{re} | typ. | 0.6 pF |
| Noise figure at optimum source impedance $I_C = 2$ mA; $V_{CE} = 5$ V | F | $f = 200$ | 800 MHz |
| | | typ. 2.5 | 5.5 dB |
| Power gain (not neutralized) $I_C = 14$ mA; $V_{CE} = 10$ V | G_p | typ. | 23 |
| | | | 8 dB |
| Output power $d_{im} = -30$ dB; V.S.W.R. at output < 2 $I_C = 14$ mA; $V_{CE} = 10$ V | P_o | typ. | 12 |
| | | | 12 mW |

MECHANICAL DATA see page 2.

MECHANICAL DATA

Fig. 1 TO-72.

Dimensions in mm



(1) = shield lead (connected to case).

→ Accessories: 56246 (distance disc).

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|--|------------|------|------------------------------|
| Collector-base voltage (open emitter; peak value) | V_{CBOM} | max. | 30 V |
| Collector-emitter voltage (peak value) $R_{BE} \leq 50 \Omega$; $I_C = 10 \text{ mA}$ | V_{CERM} | max. | 30 V |
| Collector-emitter voltage (open base); $I_C = 10 \text{ mA}$ | V_{CEO} | max. | 15 V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 2,5 V |
| Collector current (d.c.) | I_C | max. | 25 mA |
| Collector current (peak value; $f > 1 \text{ MHz}$) | I_{CM} | max. | 50 mA |
| Total power dissipation up to $T_{amb} = 25 \text{ }^\circ\text{C}$ | P_{tot} | max. | 200 mW |
| Storage temperature | T_{stg} | | -65 to +200 $^\circ\text{C}$ |
| Junction temperature | T_j | max. | 200 $^\circ\text{C}$ |

THERMAL RESISTANCE

| | | | |
|--------------------------------------|----------------------|---|----------|
| From junction to ambient in free air | $R_{th \text{ j-a}}$ | = | 880 K/W* |
| From junction to case | $R_{th \text{ j-c}}$ | = | 580 K/W* |

* K/W is SI unit for $^\circ\text{C}/\text{W}$.

CHARACTERISTICS

$T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

Collector cut-off current

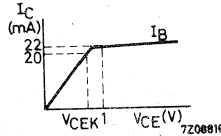
$I_E = 0; V_{CB} = 15\text{ V}$

$I_{CBO} < 10\text{ nA}$

Knee voltage

$I_C = 20\text{ mA}; I_B = \text{value for which}$
 $I_C = 22\text{ mA at } V_{CE} = 1\text{ V}$

$V_{CEK} < 0.75\text{ V}$



D.C. current gain

$I_C = 2\text{ mA}; V_{CE} = 1\text{ V}$

$h_{FE} \quad 25\text{ to }150$

$I_C = 25\text{ mA}; V_{CE} = 1\text{ V}$

$h_{FE} \quad 20\text{ to }125$

Transition frequency 1)

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}; f = 500\text{ MHz}$

$f_T > 1.0\text{ GHz}$
 typ. 1.1 GHz

$I_C = 25\text{ mA}; V_{CE} = 5\text{ V}; f = 500\text{ MHz}$

$f_T > 1.3\text{ GHz}$
 typ. 1.4 GHz

Collector capacitance at $f = 1\text{ MHz}$ 2)

$I_E = I_e = 0; V_{CB} = 10\text{ V}$

$C_c < 1.5\text{ pF}$

Feedback capacitance at $f = 1\text{ MHz}$ 1)

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}$

C_{re} typ. 0.6 pF
 $< 0.8\text{ pF}$

Noise figure 1)

$I_C = 2\text{ mA}; V_{CE} = 5\text{ V}$

$f = 100\text{ kHz}; \text{ optimum source resistance}$

$F < 4\text{ dB}$

$f = 200\text{ MHz}; \text{ optimum source impedance}$

$F < 3.5\text{ dB}$

$f = 500\text{ MHz}; R_S = 50\text{ }\Omega$

$F < 5\text{ dB}$

$f = 800\text{ MHz}; \text{ optimum source impedance}$

F typ. 5.5 dB

Power gain (not neutralized) 1)

$I_C = 14\text{ mA}; V_{CE} = 10\text{ V}; T_{amb} = 25\text{ }^\circ\text{C}$

| | | | |
|-------|-----------|------------------|-------------|
| G_p | > 21 | 800 MHz | dB |
| | typ. 23 | 8 | dB |

1) Shield lead grounded.

2) Shield lead not connected.

CHARACTERISTICS (continued)

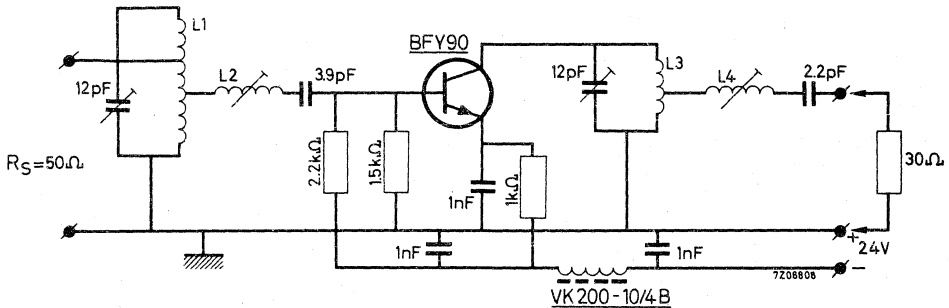
Intermodulation characteristics ¹⁾

1. Output power at $f = 200$ MHz; $T_{amb} = 25$ °C

$I_C = 14$ mA; $V_{CE} = 10$ V; V.S.W.R. at output < 2
 $f_p = 202$ MHz; $f_q = 205$ MHz; $d_{im} = -30$ dB
 measured at $f(2q-p) = 208$ MHz (Channel 9)

$P_o > 10$ mW
 typ. 12 mW

Test circuit:



Coil data:

- L1 = 3 turns silver plated Cu wire (1.4 mm); winding pitch 2.7 mm;
int. diam. 8 mm; taps at 0.5 turn and 1.5 turns from earth.
- L2 = 5.5 turns silver plated Cu wire (1.4 mm); winding pitch 2.2 mm;
int. diam. 8 mm.
- L3 = 3 turns silver plated Cu wire (1.4 mm); winding pitch 3.3 mm;
int. diam. 8 mm.
- L4 = 5.5 turns silver plated Cu wire (1.4 mm); winding pitch 2.2 mm;
int. diam. 11 mm.

¹⁾ Shield lead grounded

CHARACTERISTICS (continued)

Basis of adjustment

The intermodulation at an intermodulation distortion of -30 dB is caused by h.f. output current - voltage clipping.

The maximum undistorted output power is realised, if

- a. Current and voltage clipping take place concurrently.

This occurs if

$$R_L = \frac{V_{CE} - V_{CEK}}{I_C},$$

in which V_{CEK} is the high frequency knee voltage.

- b. The h.f. collector current is as small as possible.

This is so if $-C_L = +C_{Oe}$,

in which C_{Oe} is the output capacitance of the transistor at short circuited input.

For maximum output power at an intermodulation distortion of -30 dB, the (experimentally found) values of R_L and C_L are:

$$R_L = 560 \Omega; C_L = -1.8 \text{ pF}$$

Adjustment procedure

1. Remove the transistor and connect a dummy consisting of a 560Ω resistor in parallel with a 1.8 pF capacitor between the collector and emitter connections of the output circuit.
2. Tune and match the output circuit for zero reflection at 205 MHz (V.S.W.R. = 1). After this adjustment, no further change may be made in the output circuit.
3. Replace the dummy by the transistor. Tune and match the input circuit for maximum power gain and good band pass curve.
The V.S.W.R. of the output will then, in most cases, be ≤ 2 over the whole channel.
Corrections can be made by tuning L2; this will not disturb the band pass curve.

CHARACTERISTICS (continued)

Intermodulation characteristics ¹⁾

2. Output power at $f = 800$ MHz; $T_{amb} = 25$ °C

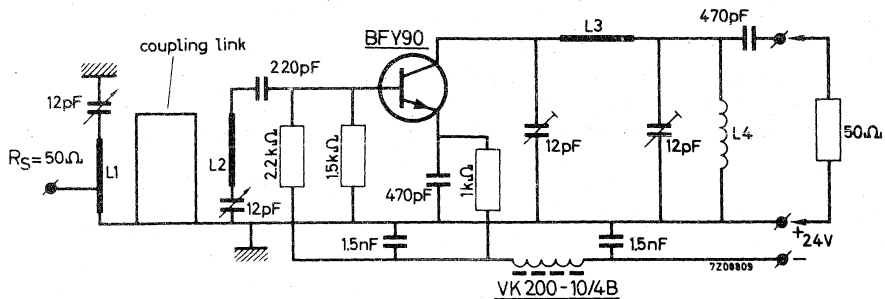
$I_C = 14$ mA; $V_{CE} = 10$ V; V.S.W.R. at output < 2

$f_p = 798$ MHz; $f_q = 802$ MHz; $d_{im} = -30$ dB

measured at $f(2q-p) = 806$ MHz (Channel 62)

P_o typ. 12 mW

Test circuit:



Coil data:

L1 = 24 mm x 6 mm x 0.5 mm silver plated Cu strip.

Tap of the input at 5 mm from earth.

L2 = 15 mm x 6 mm x 0.5 mm silver plated Cu strip.

L3 = 20 mm x 8 mm x 0.5 mm silver plated Cu strip.

L4 = 4 turns enamelled Cu wire (0.5 mm); winding pitch 1.5 mm; int. diam. 4 mm

Coupling link: 42 mm silver plated Cu wire (1 mm).

Basis of adjustment.

At 800 MHz no dummy can be used to adjust for optimum collector load because at these frequencies the impedance transformations of a dummy are too high. A small signal at the mid-channel frequency of 802 MHz is fed to the input and increased until clipping occurs; that is, until the output power no longer increases linearly with the input signal. This clipping can be eliminated by tuning the output circuit, thereby making the output power equal to

$$P_o = \frac{I_C (V_{CE} - V_{CEK})}{2} = 60 \text{ mW}$$

The output circuit is adjusted for minimum intermodulation if the input signal is as small as possible at $P_o = 60$ mW.

After this adjustment has been made no further change may be made in the output circuit.

Adjust the input circuit for maximum power gain and good band pass curve.

The V.S.W.R. of the output is then ≤ 2 over the whole channel.

¹⁾ Shield lead grounded

CHARACTERISTICS (continued)

Intermodulation characteristics 1)

3. Intermodulation distortion

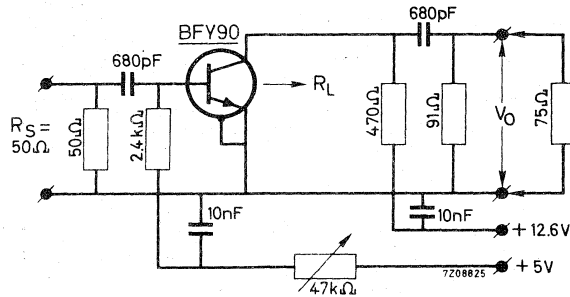
$I_C = 14 \text{ mA}$; $V_{CE} = 6 \text{ V}$; $R_L = 37.5 \text{ } \Omega$; $T_{\text{amb}} = 25 \text{ } ^\circ\text{C}$

$V_o = 100 \text{ mV}$ at $f_p = 183 \text{ MHz}$

$V_o = 100 \text{ mV}$ at $f_q = 200 \text{ MHz}$
measured at $f(2q-p) = 217 \text{ MHz}$

d_{im} typ. -50 dB

Test circuit:



y parameters at $f = 500 \text{ MHz}$ (common emitter) 1)

$I_C = 2 \text{ mA}$; $V_{CE} = 5 \text{ V}$

Input conductance

g_{ie} typ. $16 \text{ m}\Omega^{-1}$

Input capacitance

C_{ie} typ. 3.75 pF

Feedback admittance

$|y_{re}|$ typ. $1.55 \text{ m}\Omega^{-1}$

Phase angle of feedback admittance

φ_{re} typ. 258°

Transfer admittance

$|y_{fe}|$ typ. $45 \text{ m}\Omega^{-1}$

Phase angle of transfer admittance

φ_{fe} typ. 285°

Output conductance

g_{oe} typ. $0.19 \text{ m}\Omega^{-1}$

Output capacitance

C_{oe} typ. 1.9 pF

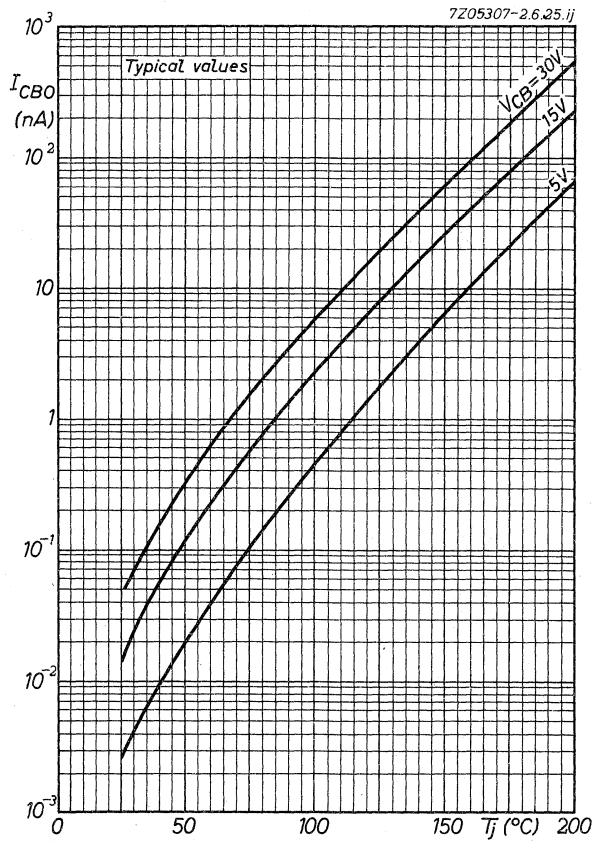
Maximum unilateralised power gain

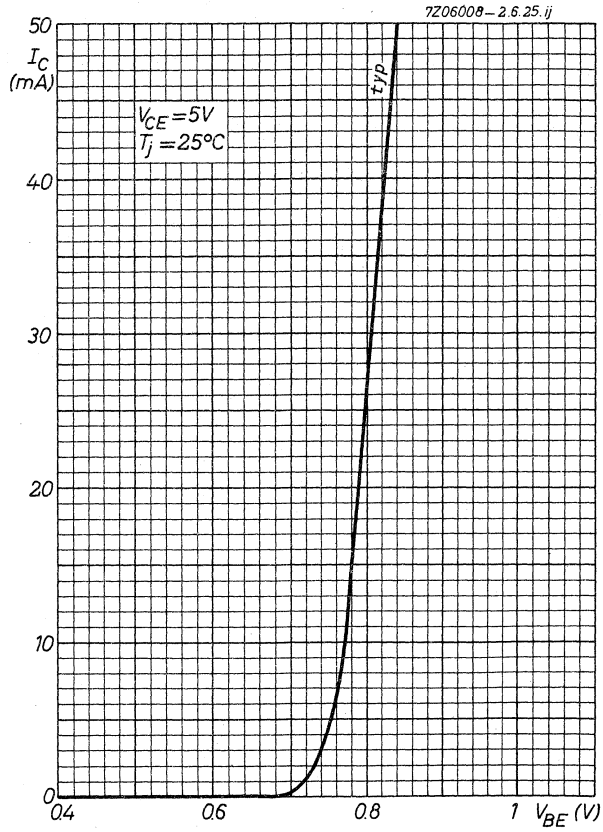
$$G_{UM} = \frac{|y_{fe}|^2}{4g_{ie}g_{oe}}$$

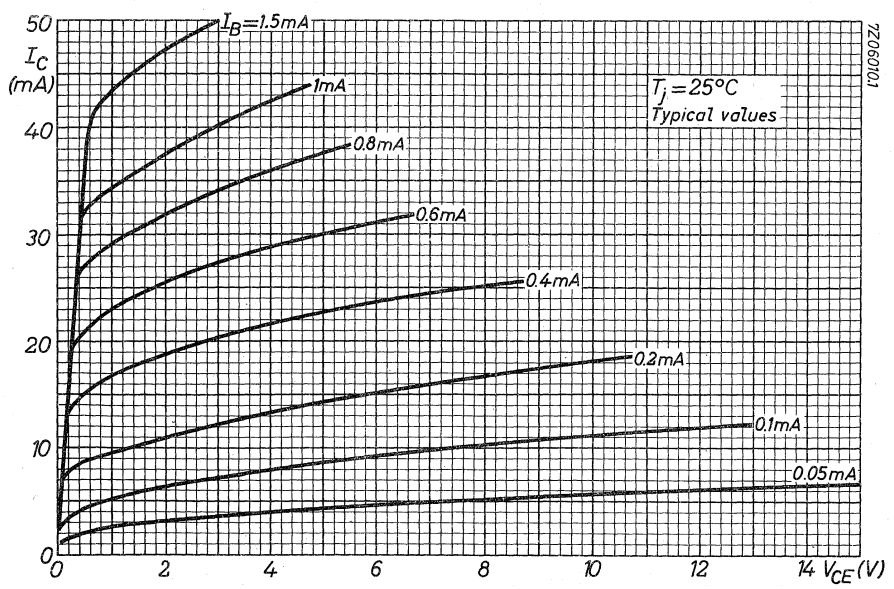
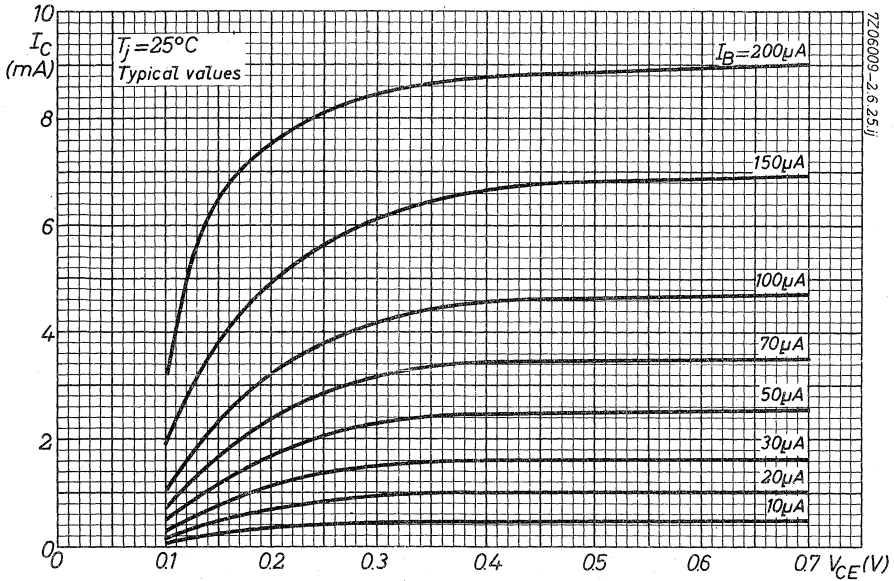
$I_C = 2 \text{ mA}$; $V_{CE} = 5 \text{ V}$; $f = 500 \text{ MHz}$

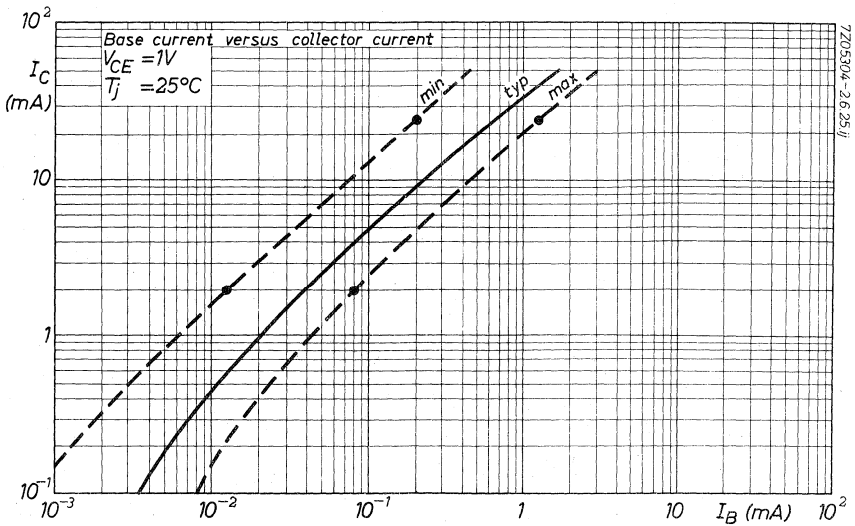
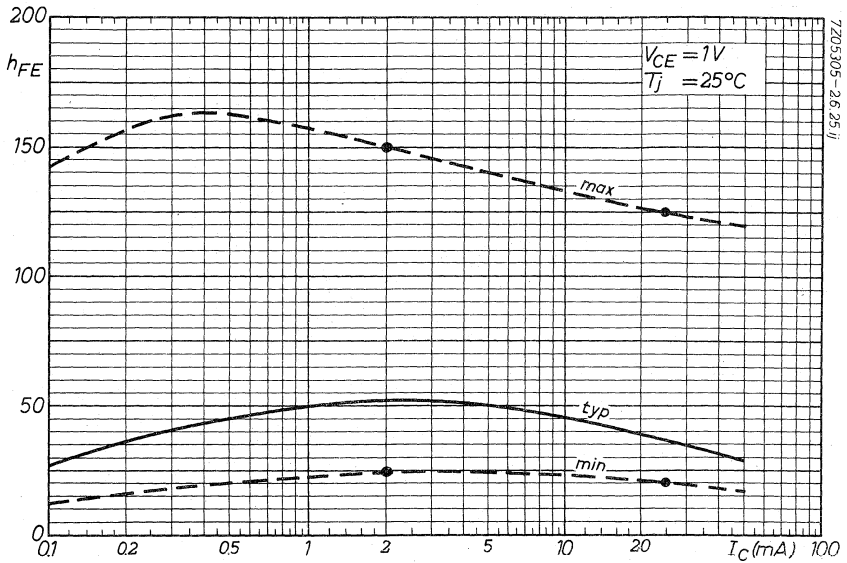
G_{UM} typ. 22 dB

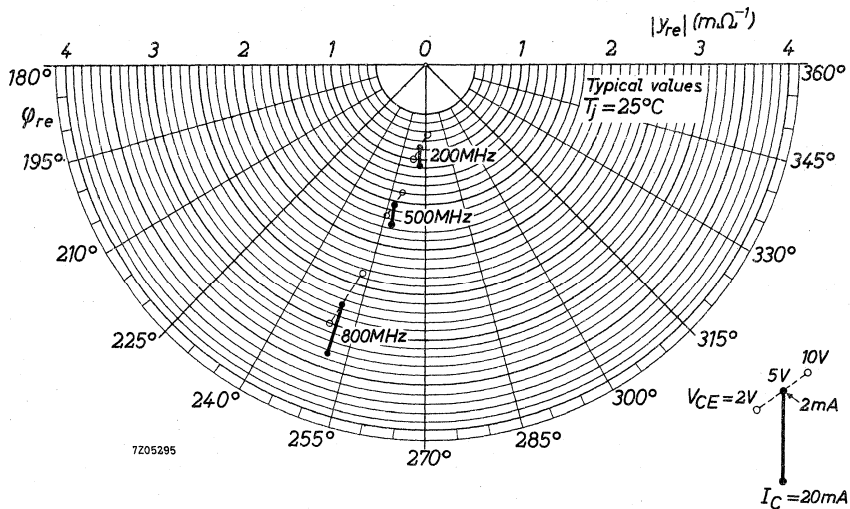
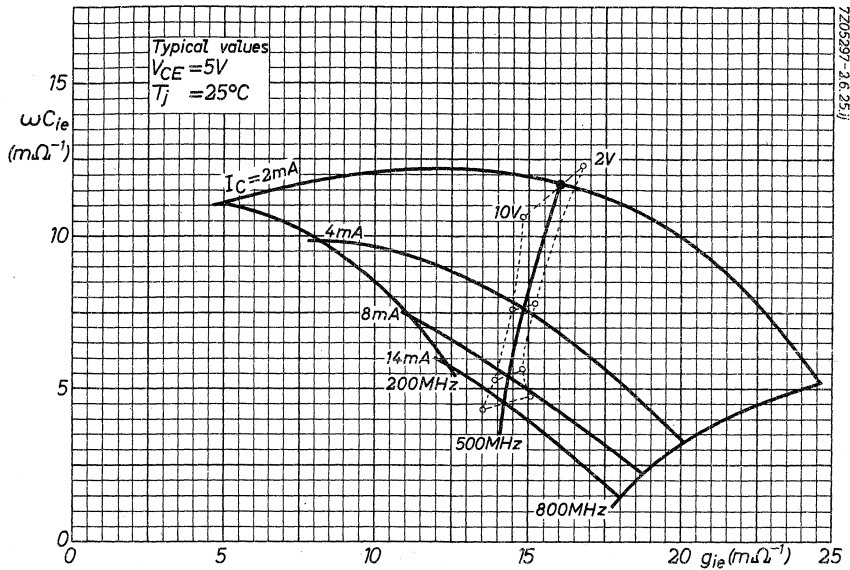
1) Shield lead grounded

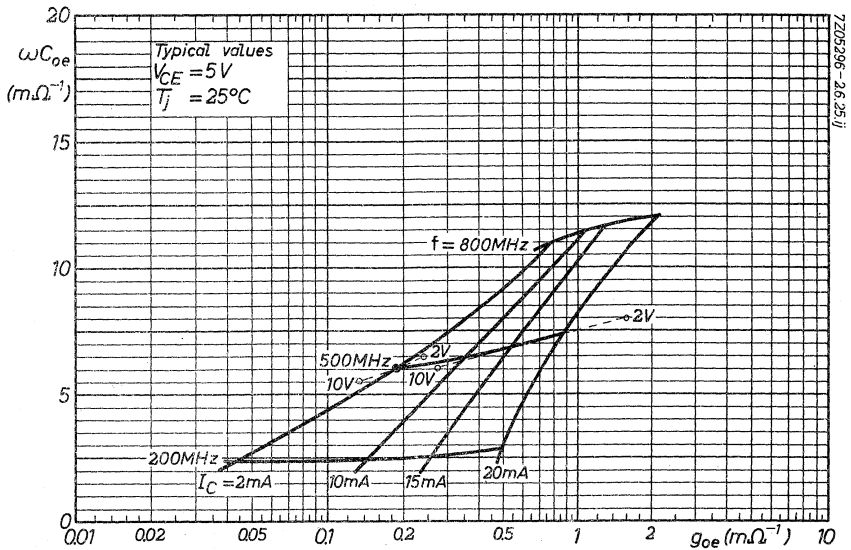
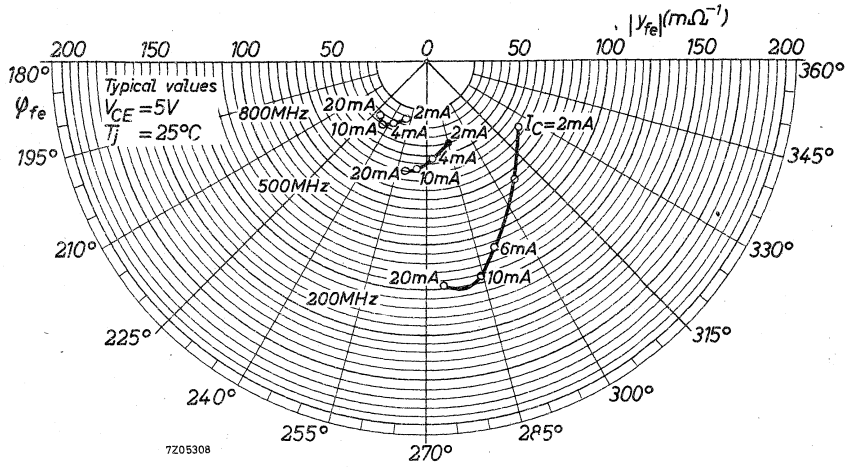




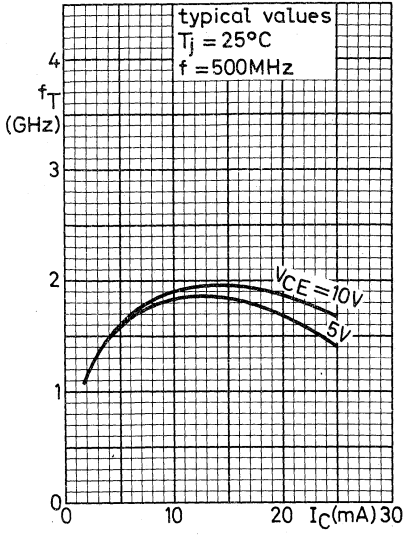




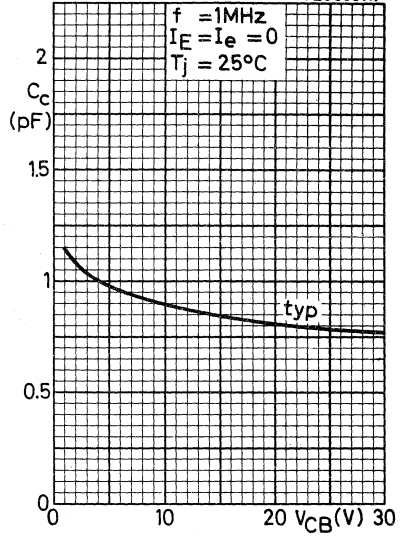




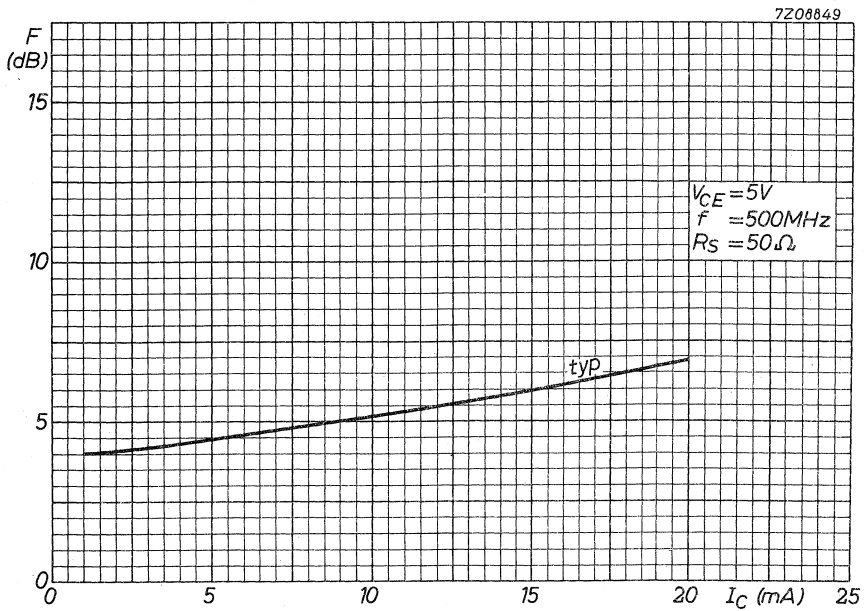
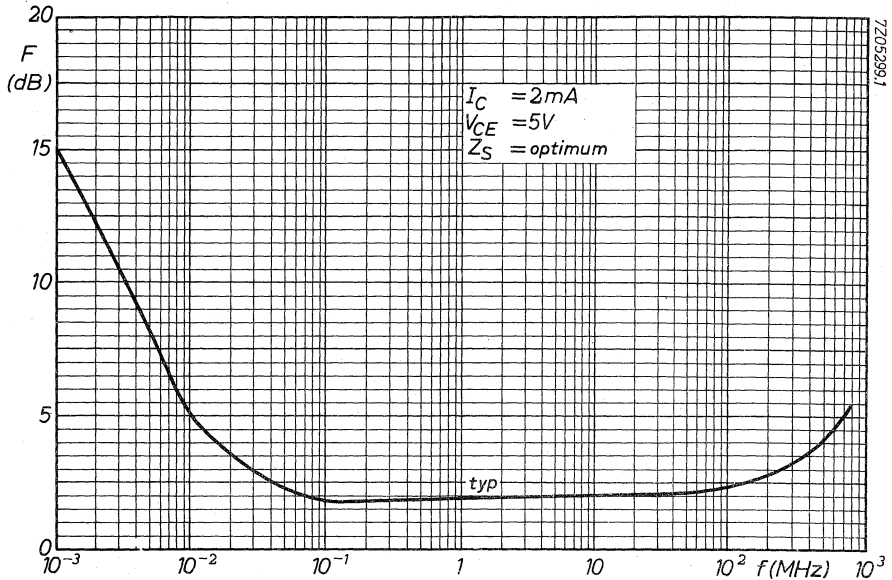
7Z08806.1



7Z08807.1



BFY90



SILICON PLANAR EPITAXIAL TRANSISTOR

N-P-N transistor in TO-72 metal envelope with insulated electrodes and a shield lead connected to the case. The 2N918 is primarily intended for low power amplifiers and oscillators in the v.h.f. and u.h.f. ranges for industrial service.

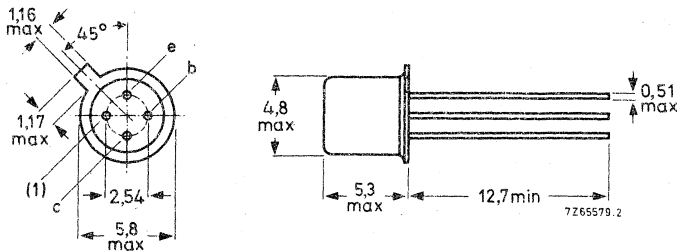
QUICK REFERENCE DATA

| | | | |
|--|-----------|------|----------------------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 30 V |
| Collector-emitter voltage (open base) | V_{CEO} | max. | 15 V |
| Collector current (d.c.) | I_C | max. | 50 mA |
| Total power dissipation up to $T_{amb} = 25\text{ }^\circ\text{C}$ | P_{tot} | max. | 200 mW |
| Junction temperature | T_j | max. | 200 $^\circ\text{C}$ |
| Transition frequency $I_C = 6\text{ mA}; V_{CE} = 10\text{ V}$ | f_T | > | 900 MHz |
| Maximum unilateralized power gain $I_C = 6\text{ mA}; V_{CE} = 12\text{ V}; f = 200\text{ MHz}$ | G_{UM} | typ. | 36 dB |
| Noise figure at $f = 60\text{ MHz}$ $I_C = 1\text{ mA}; V_{CE} = 6\text{ V}; R_S = 400\text{ }\Omega$ | F | < | 6 dB |

MECHANICAL DATA

Dimensions in mm

Fig. 1 TO-72.



(1) = shield lead (connected to case).

Accessories: 56246 (distance disc).

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

Voltages

| | | | |
|---|-----------|------|------|
| Collector-base voltage (open emitter) | V_{CBO} | max. | 30 V |
| Collector-emitter voltage (open base) $I_C = 3 \text{ mA}$ | V_{CEO} | max. | 15 V |
| Emitter-base voltage (open collector) | V_{EBO} | max. | 3 V |

Currents

| | | | |
|---------------------------|-------|------|-------|
| Collector current (d. c.) | I_C | max. | 50 mA |
|---------------------------|-------|------|-------|

Power dissipation

| | | | |
|---|-----------|------|--------|
| Total power dissipation up to $T_{amb} = 25 \text{ }^\circ\text{C}$ | P_{tot} | max. | 200 mW |
|---|-----------|------|--------|

Temperatures

| | | | |
|----------------------|-----------|-------------|----------------------|
| Storage temperature | T_{stg} | -65 to +200 | $^\circ\text{C}$ |
| Junction temperature | T_j | max. | 200 $^\circ\text{C}$ |

THERMAL RESISTANCE

| | | | |
|--------------------------------------|----------------------|---|--------------------------|
| From junction to ambient in free air | $R_{th \text{ j-a}}$ | = | 0.88 $^\circ\text{C/mW}$ |
| From junction to case | $R_{th \text{ j-c}}$ | = | 0.58 $^\circ\text{C/mW}$ |

CHARACTERISTICS $T_j = 25\text{ }^\circ\text{C}$ unless otherwise specified

All measurements taken with ungrounded shield lead

Collector cut-off current

$$I_E = 0; V_{CB} = 15\text{ V} \quad I_{CBO} < 10\text{ nA}$$

$$I_E = 0; V_{CB} = 15\text{ V}; T_j = 150\text{ }^\circ\text{C} \quad I_{CBO} < 1\text{ }\mu\text{A}$$

Saturation voltages

$$I_C = 10\text{ mA}; I_B = 1\text{ mA} \quad V_{CEsat} < 0.4\text{ V}$$

$$V_{BEsat} < 1\text{ V}$$

D. C. current gain

$$I_C = 3\text{ mA}; V_{CE} = 1\text{ V} \quad h_{FE} > 20$$

Collector capacitance at $f = 140\text{ kHz}$

$$I_E = I_e = 0; V_{CB} = 10\text{ V} \quad C_c < 1.7\text{ pF}$$

$$I_E = I_e = 0; V_{CB} = 0 \quad C_c < 3.0\text{ pF}$$

Emitter capacitance at $f = 140\text{ kHz}$

$$I_C = I_c = 0; V_{EB} = 0.5\text{ V} \quad C_e < 2.0\text{ pF}$$

Transition frequency

$$I_C = 6\text{ mA}; V_{CE} = 10\text{ V}^1) \quad f_T > 900\text{ MHz}$$

Noise figure at $f = 60\text{ MHz}$

$$I_C = 1\text{ mA}; V_{CE} = 6\text{ V}; R_S = 400\text{ }\Omega \quad F < 6\text{ dB}$$

Oscillator power output at $f = 500\text{ MHz}$

$$-I_E = 8\text{ mA}; V_{CB} = 15\text{ V} \quad P_O > 30\text{ mW}$$

Maximum unilateralised power gain

$$G_{UM} = \frac{|y_{fe}|^2}{4g_{ie}g_{oe}}$$

$$I_C = 6\text{ mA}; V_{CE} = 12\text{ V}; f = 200\text{ MHz} \quad G_{UM} \text{ typ. } 36\text{ dB}$$

¹⁾ JEDEC registration: $I_C = 4\text{ mA}; V_{CE} = 10\text{ V}, f_T > 600\text{ MHz}.$

CHARACTERISTICS (continued)

$T_j = 25^\circ\text{C}$

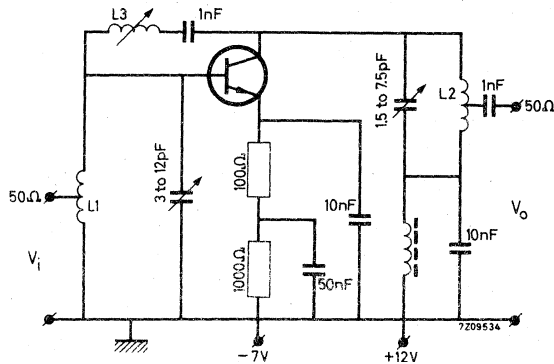
Available power gain at $f = 200\text{ MHz}$

$I_C = 6\text{ mA}$

$G_p > 15\text{ dB}$

Basic circuit for measuring the available neutralised power gain

Grounded shield lead



$L1 = 3.5\text{ turns tinned Cu wire, } 1.3\text{ mm}$
 $d = 8\text{ mm; length} = 11\text{ mm}$

Tap at $\approx 2\text{ turns from earth side}$

$L2 = 8\text{ turns tinned Cu wire, } 1.3\text{ mm}$
 $d = 3\text{ mm; length} = 22\text{ mm}$

Tap at $1\text{ turn from earth side}$

$L3 = 0.4\text{ to }0.65\ \mu\text{H}$

CATV AMPLIFIER MODULES (V.H.F.)

Selection guide



CATV AMPLIFIER MODULES

| type number | frequency range MHz | power gain (dB) at $f = 50$ MHz | application | V_o (dBmV) at $d_{im} = -60$ dB (DIN 45004B, par. 6.3: 3-tone) |
|-------------|---------------------|---------------------------------|-------------------------------------|--|
| BGY50 | 40 – 300 | $12,5 \pm 0,4$ | preamplifier | ≥ 61 |
| BGY51 | | | final amplifier | $\geq 63,5$ |
| BGY52 | 40 – 300 | $16,4 \pm 0,4$ | preamplifier | ≥ 61 |
| BGY53 | | | final amplifier | $\geq 63,5$ |
| BGY54 | 40 – 300 | $17,0 \pm 0,4$ | preamplifier | ≥ 61 |
| BGY55 | | | final amplifier | $\geq 63,5$ |
| BGY56 | 40 – 300 | $22,0 \pm 0,6$ | preamplifier | $\geq 61,5$ |
| BGY57 | | | final amplifier | ≥ 64 |
| BGY58 | 40 – 300 | $33,0 \pm 1,0$ | line extender | ≥ 64 |
| BGY59 | 40 – 300 | $38,5 \pm 1,0$ | line extender | ≥ 64 |
| BGY60 | 40 – 300 | $33,3 \pm 1,0$ | interstage amplifier (2 x 17 dB) | ≥ 64 |
| BGY74 | 40 – 440 | $17,0 \pm 0,4$ | preamplifier | $\geq 62,5$ |
| BGY75 | | | final amplifier | ≥ 65 |

All modules normally operate at $V_B = 24$ V, but are able to withstand supply transients up to 30 V.

The BGY53 is the replacement type for the BGY37.



HYBRID V.H.F. PUSH-PULL AMPLIFIER MODULES

Hybrid amplifier modules intended for CATV systems.

QUICK REFERENCE DATA

| | | BGY50 | BGY51 | |
|--|----------------|----------------|----------------|-------------|
| Frequency range | f | 40 to 300 | 40 to 300 | MHz |
| Source impedance and load impedance | $Z_S = Z_L =$ | 75 | 75 | Ω |
| Power gain at f = 50 MHz | G_p | $12,5 \pm 0,4$ | $12,5 \pm 0,4$ | dB |
| Slope cable equivalent f = 40 MHz to 300 MHz | | +0,2 to +0,8 | +0,2 to +0,8 | dB ← |
| Flatness of frequency response f = 40 MHz to 300 MHz | \leq | 0,2 | 0,2 | dB |
| Return losses at input and output f = 40 MHz to 300 MHz | \geq | 18 | 18 | dB |
| Output voltage at $d_{im} = -60$ dB (DIN 45004, par. 6.3: 3-tone) | $V_o \geq$ | 61 | 63,5 | dBmV |
| 2nd harmonic distortion at $V_o = 50$ dBmV | $d_2 \leq$ | -68 | -70 | dB |
| Noise figure f = 40 MHz to 300 MHz | $F \leq$ | 7 | 8 | dB |
| D.C. supply voltage | $+V_B =$ | 24 | 24 | V * |
| Total d.c. current consumption at $V_B = +24$ V | I_{tot} typ. | 160 | 200 | mA |
| Operating mounting base temperature | T_{mb} | -20 to +90 | -20 to +90 | $^{\circ}C$ |

MECHANICAL DATA

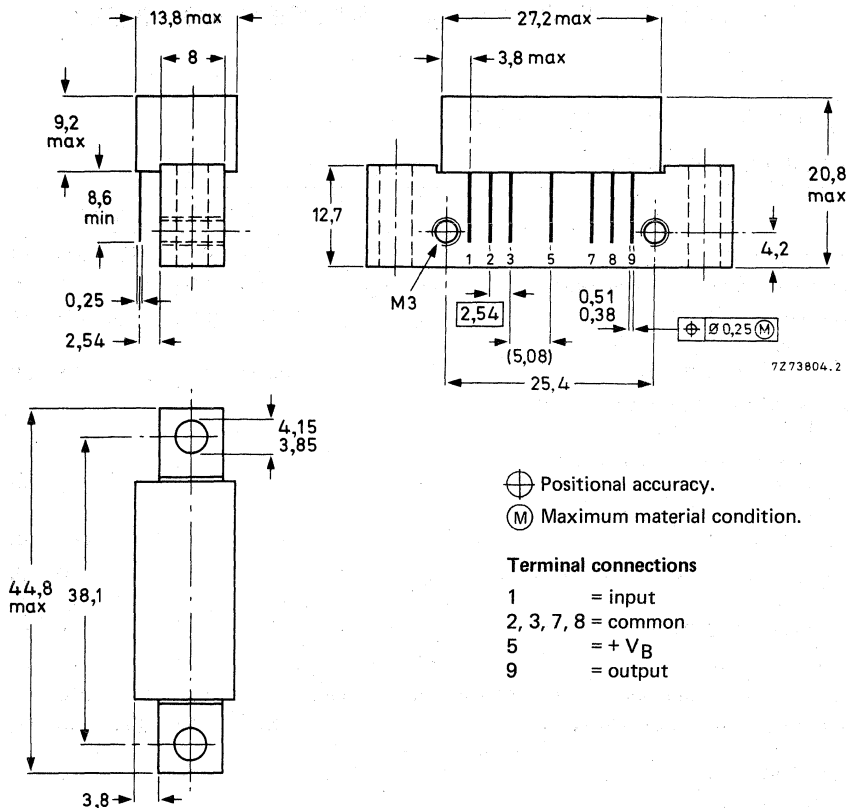
SOT-115 (see page 2).

* The modules are able to withstand incidental short peaks in the supply voltage up to a maximum of 30 V.

MECHANICAL DATA

Fig. 1 SOT-115.

Dimensions in mm



- ⊕ Positional accuracy.
- Ⓜ Maximum material condition.

Terminal connections

- 1 = input
- 2, 3, 7, 8 = common
- 5 = + V_B
- 9 = output

Soldering recommendations

The maximum permissible temperature of the soldering iron is 260 °C for a contact time of maximum 3 s, when the soldered joints are 3 mm or more from the module.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|-------------------------------------|------------------|----------------|---------|
| → R.F. input voltage | V _i | max. | 67 dBmV |
| Storage temperature | T _{stg} | -40 to +100 °C | |
| Operating mounting base temperature | T _{mb} | -20 to +90 °C* | |

* With a heatsink ≤ 4,7 K/W for the BGY51, and ≤ 5,8 K/W for the BGY50 a maximum ambient temperature of + 65 °C is permissible. (K/W is SI unit for °C/W.)

CHARACTERISTICS

Supply voltage $V_B = +24\text{ V}$; $T_{\text{amb}} = 25\text{ }^\circ\text{C}$

| | | BGY50 | BGY51 | |
|--|------------------|------------------------|------------------------|------|
| Power gain at $f = 50\text{ MHz}$ | G_p | $12,5 \pm 0,4$ | $12,5 \pm 0,4$ | dB |
| Slope cable equivalent $f = 40\text{ MHz to } 300\text{ MHz}$ | | $+0,2\text{ to } +0,8$ | $+0,2\text{ to } +0,8$ | dB ← |
| Flatness of frequency response $f = 40\text{ MHz to } 300\text{ MHz}$ | \leq | 0,2 | 0,2 | dB |
| Return losses at input and output $Z_S = Z_L = 75\ \Omega$; $f = 40\text{ MHz to } 300\text{ MHz}$ | \geq | 18 | 18 | dB |
| Output voltage at $d_{\text{im}} = -60\text{ dB}$ (DIN 45004, par. 6.3: 3-tone) | | | | |
| $V_p = V_o$; $f_p = 287,25\text{ MHz}$ | | | | |
| $V_q = V_o - 6\text{ dB}$; $f_q = 294,25\text{ MHz}$ | | | | |
| $V_r = V_o - 6\text{ dB}$; $f_r = 296,25\text{ MHz}$ | | | | |
| Measured at $f(p + q - r) = 285,25\text{ MHz}$ | $V_o \geq$ | 61 | 63,5 | dBmV |
| 2nd harmonic distortion | | | | |
| $V_p = V_o = 50\text{ dBmV}$; $f_p = 66\text{ MHz}$ | | | | |
| $V_q = V_o = 50\text{ dBmV}$; $f_q = 144\text{ MHz}$ | | | | |
| Measured at $f(p + q) = 210\text{ MHz}$ | $d_2 \leq$ | -68 | -70 | dB |
| Noise figure $f = 40\text{ MHz to } 300\text{ MHz}$ | $F \leq$ | 7 | 8 | dB |
| Total d.c. current consumption | I_{tot} | typ. 160 | 200 | mA |
| | \leq | 180 | 220 | mA |



HYBRID V.H.F. PUSH-PULL AMPLIFIER MODULES

Hybrid amplifier modules intended for CATV systems.

QUICK REFERENCE DATA

| | | BGY52 | BGY53 |
|--|----------------|----------------|-------------------------------|
| Frequency range | f | 40 to 300 | 40 to 300 MHz |
| Source impedance and load impedance | $Z_S = Z_L =$ | 75 | 75 Ω |
| Power gain at f = 50 MHz | G_p | $16,4 \pm 0,4$ | $16,4 \pm 0,4$ dB |
| Slope cable equivalent f = 40 MHz to 300 MHz | | 0 to +1,0 | 0 to +1,0 dB |
| Flatness of frequency response f = 40 MHz to 300 MHz | \leq | 0,1 | 0,1 dB |
| Return losses at input and output f = 40 MHz to 300 MHz | \geq | 18 | 18 dB |
| Output voltage at $d_{im} = -60$ dB (DIN 45004, par. 6.3: 3-tone) | $V_o \geq$ | 61 | 63,5 dBmV |
| 2nd harmonic distortion at $V_o = 50$ dBmV | $d_2 \leq$ | -68 | -70 dB |
| Noise figure f = 40 MHz to 300 MHz | F \leq | 6 | 7 dB |
| D.C. supply voltage | $+V_B =$ | 24 | 24 V * |
| Total d.c. current consumption at $V_B = +24$ V | I_{tot} typ. | 160 | 200 mA |
| Operating mounting base temperature | T_{mb} | -20 to +90 | -20 to +90 $^{\circ}\text{C}$ |

MECHANICAL DATA

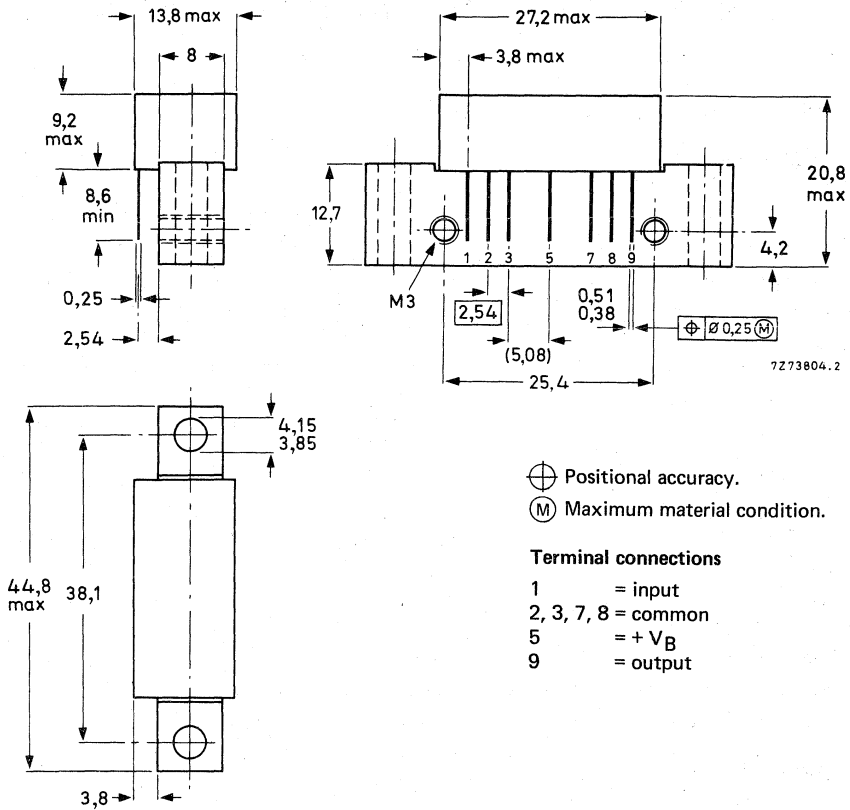
SOT-115 (see page 2).

* The modules are able to withstand incidental short peaks in the supply voltage up to a maximum of 30 V.

MECHANICAL DATA

Fig. 1 SOT-115.

Dimensions in mm



- ⊕ Positional accuracy.
- (M) Maximum material condition.

Terminal connections

- 1 = input
- 2, 3, 7, 8 = common
- 5 = +V_B
- 9 = output

Soldering recommendations

The maximum permissible temperature of the soldering iron is 260 °C for a contact time of maximum 3 s, when the soldered joints are 3 mm or more from the module.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|-------------------------------------|------------------|----------------|---------|
| → R.F. input voltage | V _i | max. | 65 dBmV |
| Storage temperature | T _{stg} | -40 to +100 °C | |
| Operating mounting base temperature | T _{mb} | -20 to +90 °C* | |

* With a heatsink ≤ 4,7 K/W for the BGY53, and ≤ 5,8 K/W for the BGY52 a maximum ambient temperature of +65 °C is permissible. (K/W is SI unit for °C/W.)

CHARACTERISTICS

Supply voltage $V_B = +24\text{ V}$; $T_{\text{amb}} = 25\text{ }^\circ\text{C}$ Power gain at $f = 50\text{ MHz}$ G_p

BGY52

 $16,4 \pm 0,4$

BGY53

 $16,4 \pm 0,4\text{ dB}$

Slope cable equivalent

 $f = 40\text{ MHz to }300\text{ MHz}$

0 to + 1,0

0 to + 1,0 dB

Flatness of frequency response

 $f = 40\text{ MHz to }300\text{ MHz}$ \leq

0,1

0,1 dB

Return losses at input and output

 $Z_S = Z_L = 75\ \Omega$; $f = 40\text{ MHz to }300\text{ MHz}$ \geq

18

18 dB

Output voltage at $d_{\text{im}} = -60\text{ dB}$

(DIN 45004, par. 6.3: 3-tone)

 $V_p = V_o$; $f_p = 287,25\text{ MHz}$ $V_q = V_o - 6\text{ dB}$; $f_q = 294,25\text{ MHz}$ $V_r = V_o - 6\text{ dB}$; $f_r = 296,25\text{ MHz}$ Measured at $f_{(p+q-r)} = 285,25\text{ MHz}$ V_o \geq

61

63,5 dBmV

2nd harmonic distortion

 $V_p = V_o = 50\text{ dBmV}$; $f_p = 66\text{ MHz}$ $V_q = V_o = 50\text{ dBmV}$; $f_q = 144\text{ MHz}$ Measured at $f_{(p+q)} = 210\text{ MHz}$ d_2 \leq

-68

-70 dB

Noise figure

 $f = 40\text{ MHz to }300\text{ MHz}$

F

 \leq

6

7 dB

Total d.c. current consumption

 I_{tot}

typ.

 \leq

160

200 mA

180

220 mA



HYBRID V.H.F. PUSH-PULL AMPLIFIER MODULES

Hybrid amplifier modules intended for CATV systems.

QUICK REFERENCE DATA

| | | BGY54 | BGY55 |
|--|----------------|----------------|------------------------|
| Frequency range | f | 40 to 300 | 40 to 300 MHz |
| Source impedance and load impedance | $Z_S = Z_L =$ | 75 | 75 Ω |
| Power gain at f = 50 MHz | G_p | $17,0 \pm 0,4$ | $17,0 \pm 0,4$ dB |
| Slope cable equivalent f = 40 MHz to 300 MHz | | 0 to +1,0 | 0 to +1,0 dB |
| Flatness of frequency response f = 40 MHz to 300 MHz | \leq | 0,1 | 0,1 dB |
| Return losses at input and output f = 40 MHz to 300 MHz | \geq | 18 | 18 dB |
| Output voltage at $d_{im} = -60$ dB (DIN 45004, par. 6.3: 3-tone) | $V_o \geq$ | 61 | 63,5 dBmV |
| 2nd harmonic distortion at $V_o = 50$ dBmV | $d_2 \leq$ | -68 | -70 dB |
| Noise figure f = 40 MHz to 300 MHz | F \leq | 6 | 7 dB |
| D.C. supply voltage | + $V_B =$ | 24 | 24 V * |
| Total d.c. current consumption at $V_B = +24$ V | I_{tot} typ. | 160 | 200 mA |
| Operating mounting base temperature | T_{mb} | -20 to +90 | -20 to +90 $^{\circ}C$ |

MECHANICAL DATA

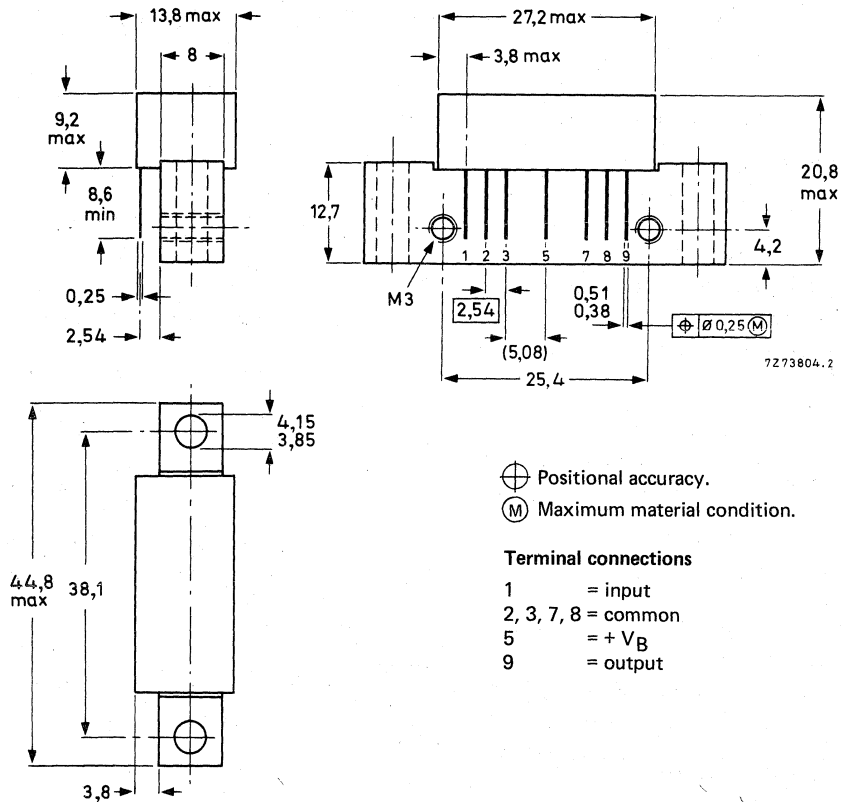
SOT-115 (see page 2).

* The modules are able to withstand incidental short peaks in the supply voltage up to a maximum of 30 V.

MECHANICAL DATA

Dimensions in mm

Fig. 1 SOT-115.



Soldering recommendations

The maximum permissible temperature of the soldering iron is 260 °C for a contact time of maximum 3 s, when the soldered joints are 3 mm or more from the module.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|-------------------------------------|------------------|----------------|---------|
| → R.F. input voltage | V _i | max. | 65 dBmV |
| Storage temperature | T _{stg} | -40 to +100 °C | |
| Operating mounting base temperature | T _{mb} | -20 to +90 °C* | |

* With a heatsink ≤ 4,7 K/W for the BGY55, and ≤ 5,8 K/W for the BGY54 a maximum ambient temperature of + 65 °C is permissible. (K/W is SI unit for °C/W.)

CHARACTERISTICS

Supply voltage $V_B = +24\text{ V}$; $T_{\text{amb}} = 25\text{ }^\circ\text{C}$ Power gain at $f = 50\text{ MHz}$ G_p

BGY54

 $17,0 \pm 0,4$

BGY55

 $17,0 \pm 0,4\text{ dB}$

Slope cable equivalent

 $f = 40\text{ MHz to }300\text{ MHz}$

0 to +1,0

0 to +1,0 dB

Flatness of frequency response

 $f = 40\text{ MHz to }300\text{ MHz}$ \leq

0,1

0,1 dB

Return losses at input and output

 $Z_S = Z_L = 75\text{ }\Omega$; $f = 40\text{ MHz to }300\text{ MHz}$ \geq

18

18 dB

Output voltage at $d_{\text{im}} = -60\text{ dB}$

(DIN 45004, par. 6.3: 3-tone)

 $V_p = V_o$; $f_p = 287,25\text{ MHz}$ $V_q = V_o - 6\text{ dB}$; $f_q = 294,25\text{ MHz}$ $V_r = V_o - 6\text{ dB}$; $f_r = 296,25\text{ MHz}$ Measured at $f_{(p+q-r)} = 285,25\text{ MHz}$ V_o \geq

61

63,5 dBmV

2nd harmonic distortion

 $V_p = V_o = 50\text{ dBmV}$; $f_p = 66\text{ MHz}$ $V_q = V_o = 50\text{ dBmV}$; $f_q = 144\text{ MHz}$ Measured at $f_{(p+q)} = 210\text{ MHz}$ d_2 \leq

-68

-70 dB

Noise figure

 $f = 40\text{ MHz to }300\text{ MHz}$

F

 \leq

6

7 dB

Total d.c. current consumption

 I_{tot}

typ.

 \leq

160

200 mA

180

220 mA

HYBRID V.H.F. PUSH-PULL AMPLIFIER MODULES

Hybrid amplifier modules intended for CATV systems.

QUICK REFERENCE DATA

| | | BGY56 | BGY57 | |
|--|----------------|------------|------------|-------------|
| Frequency range | f | 40 to 300 | 40 to 300 | MHz |
| Source impedance and load impedance | $Z_S = Z_L =$ | 75 | 75 | Ω |
| Power gain at f = 50 MHz | G_p | 22,0 ± 0,6 | 22,0 ± 0,6 | dB |
| Slope cable equivalent f = 40 MHz to 300 MHz | | 0 to +1,0 | 0 to +1,0 | dB |
| Flatness of frequency response f = 40 MHz to 300 MHz | \leq | ± 0,2 | ± 0,2 | dB |
| Return losses at input and output f = 40 MHz to 300 MHz | \geq | 20 | 20 | dB |
| Output voltage at $d_{im} = -60$ dB (DIN 45004, par. 6.3: 3-tone) | $V_o \geq$ | 61,5 | 64 | dBmV |
| 2nd harmonic distortion at $V_o = 50$ dBmV | $d_2 \leq$ | -64 | -66 | dB |
| Noise figure f = 40 MHz to 300 MHz | F \leq | 6 | 7 | dB |
| D.C. supply voltage | + $V_B =$ | 24 | 24 | V * |
| Total d.c. current consumption at $V_B = +24$ V | I_{tot} typ. | 160 | 200 | mA |
| Operating mounting base temperature | T_{mb} | -20 to +90 | -20 to +90 | $^{\circ}C$ |

MECHANICAL DATA

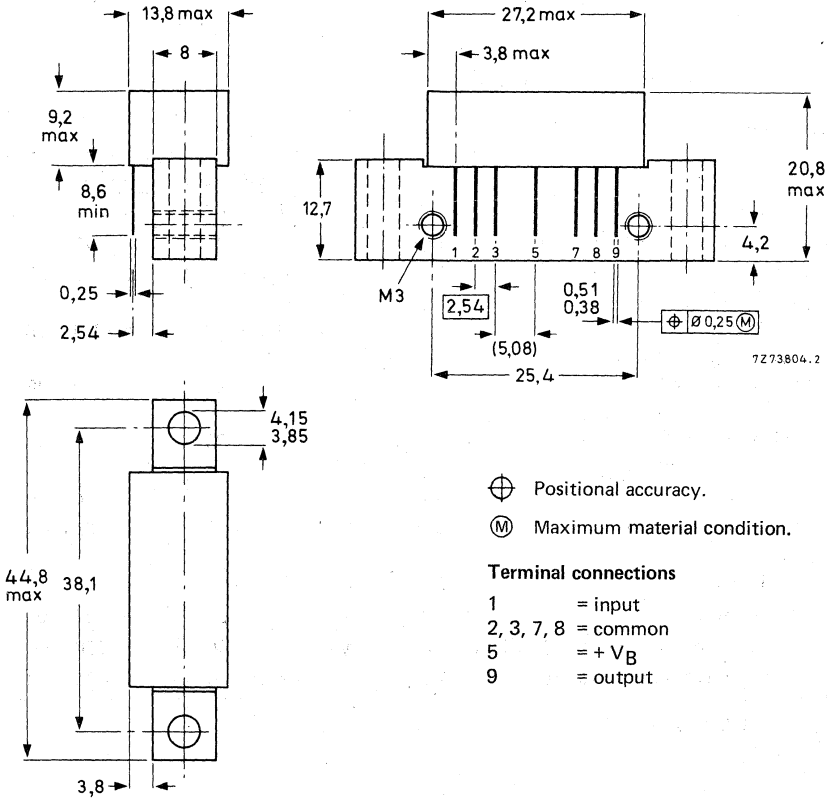
SOT-115 (see page 2).

* The modules are able to withstand incidental short peaks in the supply voltage up to a maximum of 30 V.

MECHANICAL DATA

Fig. 1 SOT-115.

Dimensions in mm



⊕ Positional accuracy.

Ⓜ Maximum material condition.

Terminal connections

- 1 = input
- 2, 3, 7, 8 = common
- 5 = +V_B
- 9 = output

Soldering recommendations

The maximum permissible temperature of the soldering iron is 260 °C for a contact time of maximum 3 s, when the soldered joints are 3 mm or more from the module.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | |
|-------------------------------------|---------------------|----------------|
| → R.F. input voltage | V _i max. | 63 dBmV |
| Storage temperature | T _{stg} | -40 to +100 °C |
| Operating mounting base temperature | T _{mb} | -20 to +90 °C* |

* With a heatsink ≤ 4,7 K/W for the BGY57, and ≤ 5,8 K/W for the BGY56 a maximum ambient temperature of + 65 °C is permissible. (K/W is SI unit for °C/W.)

CHARACTERISTICS

Supply voltage $V_B = +24 \text{ V}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$.Power gain at $f = 50 \text{ MHz}$

| | BGY56 | BGY57 | |
|-------|----------------|----------------|----|
| G_p | $22,0 \pm 0,6$ | $22,0 \pm 0,6$ | dB |

Slope cable equivalent

 $f = 40 \text{ MHz to } 300 \text{ MHz}$

| | | | |
|--|-----------|-----------|----|
| | 0 to +1,0 | 0 to +1,0 | dB |
|--|-----------|-----------|----|

Flatness of frequency response

 $f = 40 \text{ MHz to } 300 \text{ MHz}$

| | | | |
|--------|-----------|-----------|----|
| \leq | $\pm 0,2$ | $\pm 0,2$ | dB |
|--------|-----------|-----------|----|

Return losses at input and output

 $Z_S = Z_L = 75 \text{ } \Omega$; $f = 40 \text{ MHz to } 300 \text{ MHz}$

| | | | |
|--------|----|----|----|
| \geq | 20 | 20 | dB |
|--------|----|----|----|

Output voltage at $d_{\text{im}} = -60 \text{ dB}$

(DIN 45004 par. 6.3: 3-tone)

 $V_p = V_o$; $f_p = 287,25 \text{ MHz}$ $V_q = V_o - 6 \text{ dB}$; $f_q = 294,25 \text{ MHz}$ $V_r = V_o - 6 \text{ dB}$; $f_r = 296,25 \text{ MHz}$ Measured at $f_{(p+q-r)} = 285,25 \text{ MHz}$

| | | | | |
|-------|--------|------|----|------|
| V_o | \geq | 61,5 | 64 | dBmV |
|-------|--------|------|----|------|

2nd harmonic distortion

 $V_p = V_o = 50 \text{ dBmV}$; $f_p = 66 \text{ MHz}$ $V_q = V_o = 50 \text{ dBmV}$; $f_q = 144 \text{ MHz}$ Measured at $f_{(p+q)} = 210 \text{ MHz}$

| | | | | |
|-------|--------|-----|-----|----|
| d_2 | \leq | -64 | -66 | dB |
|-------|--------|-----|-----|----|

Noise figure

 $f = 40 \text{ MHz to } 300 \text{ MHz}$

| | | | | |
|---|--------|---|---|----|
| F | \leq | 6 | 7 | dB |
|---|--------|---|---|----|

Total d.c. current consumption

| | | | | |
|------------------|--------|-----|-----|----|
| I_{tot} | typ. | 160 | 200 | mA |
| | \leq | 180 | 220 | mA |

HYBRID V.H.F. PUSH-PULL AMPLIFIER MODULES

Hybrid amplifier module intended for CATV systems.

QUICK REFERENCE DATA

| | | |
|--|---------------|--------------------------|
| Frequency range | f | 40 to 300 MHz |
| Source impedance and load impedance | $Z_S = Z_L =$ | 75 Ω |
| Power gain at f = 50 MHz | G_p | $33,0 \pm 1,0$ dB |
| Slope cable equivalent f = 40 MHz to 300 MHz | | + 0,5 to + 1,5 dB |
| Flatness of frequency response f = 40 MHz to 300 MHz | \leq | $\pm 0,3$ dB |
| Return losses at input and output f = 40 MHz to 300 MHz | \geq | 20 dB |
| Output voltage at $d_{im} = -60$ dB (DIN 45004, par. 6.3: 3-tone) | V_o | \geq 64 dBmV |
| 2nd harmonic distortion at $V_o = 50$ dBmV | d_2 | \leq -68 dB |
| Noise figure f = 40 MHz to 300 MHz | F | \leq 6 dB |
| D.C. supply voltage | + V_B | = 24 V* |
| Total d.c. current consumption at $V_B = +24$ V | I_{tot} | typ. 320 mA |
| Operating mounting base temperature | T_{mb} | -20 to + 90 $^{\circ}$ C |

MECHANICAL DATA

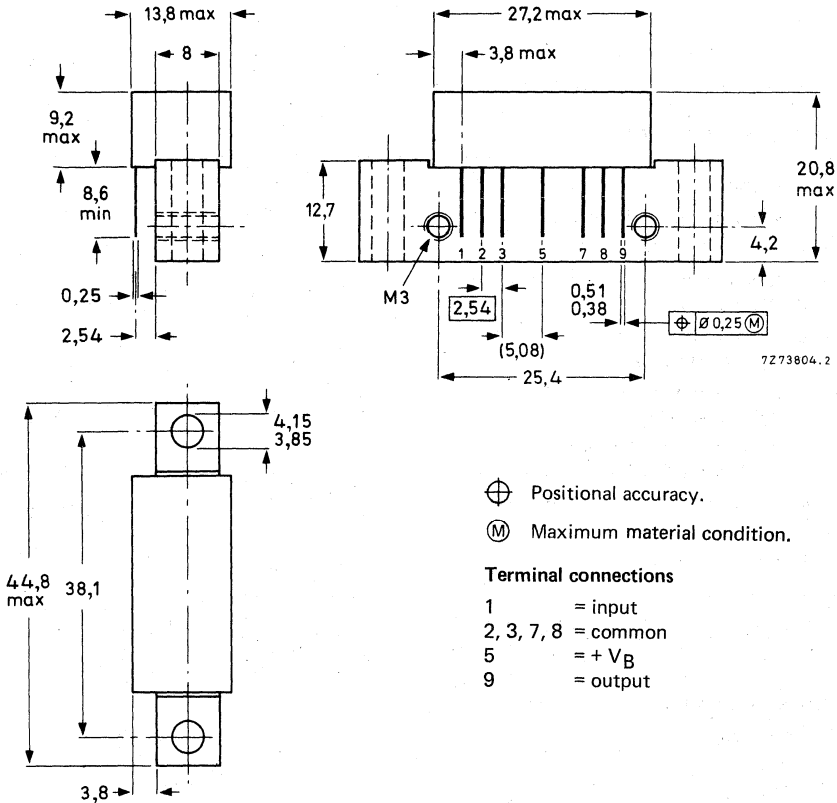
SOT-115 (see page 2).

* The module is able to withstand incidental short peaks in the supply voltage up to a maximum of 30 V.

MECHANICAL DATA

Fig. 1 SOT-115.

Dimensions in mm



- ⊕ Positional accuracy.
- Ⓜ Maximum material condition.

Terminal connections

- 1 = input
- 2, 3, 7, 8 = common
- 5 = + V_B
- 9 = output

Soldering recommendations

The maximum permissible temperature of the soldering iron is 260 °C for a contact time of maximum 3 s, when the soldered joints are 3 mm or more from the module.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|-------------------------------------|------------------|-----------------|---------|
| → R.F. input voltage | V _i | max. | 55 dBmV |
| Storage temperature | T _{stg} | -40 to +100 °C | |
| Operating mounting base temperature | T _{mb} | -20 to +90 °C * | |

* With a heatsink ≤ 3,2 K/W (K/W is SI unit for °C/W) a maximum ambient temperature of + 65 °C is permissible.

CHARACTERISTICS

Supply voltage $V_B = +24\text{ V}$; $T_{\text{amb}} = 25\text{ }^\circ\text{C}$ Power gain at $f = 50\text{ MHz}$ $G_p = 33,0 \pm 1,0\text{ dB}$

Slope cable equivalent

 $f = 40\text{ MHz to } 300\text{ MHz}$ $+0,5\text{ to } +1,5\text{ dB}$

Flatness of frequency response

 $f = 40\text{ MHz to } 300\text{ MHz}$ $\leq \pm 0,3\text{ dB}$

Return losses at input and output

 $Z_S = Z_L = 75\ \Omega$; $f = 40\text{ MHz to } 300\text{ MHz}$ $\geq 20\text{ dB}$ Output voltage at $d_{im} = -60\text{ dB}$

(DIN 45004, par. 6.3: 3-tone)

 $V_p = V_o$; $f_p = 287,25\text{ MHz}$ $V_q = V_o - 6\text{ dB}$; $f_q = 294,25\text{ MHz}$ $V_r = V_o - 6\text{ dB}$; $f_r = 296,25\text{ MHz}$ Measured at $f_{(p+q-r)} = 285,25\text{ MHz}$ $V_o \geq 64\text{ dBmV}$

2nd harmonic distortion

 $V_p = V_o = 50\text{ dBmV}$; $f_p = 66\text{ MHz}$ $V_q = V_o = 50\text{ dBmV}$; $f_q = 144\text{ MHz}$ Measured at $f_{(p+q)} = 210\text{ MHz}$ $d_2 \leq -68\text{ dB}$

Noise figure

 $f = 40\text{ MHz to } 300\text{ MHz}$ $F \leq 6\text{ dB}$

Total d.c. current consumption

 $I_{\text{tot}} \begin{matrix} \text{typ.} & 320\text{ mA} \\ \leq & 340\text{ mA} \end{matrix}$ 

DEVELOPMENT SAMPLE DATA

This information is derived from development samples made available for evaluation. It does not necessarily imply that the device will go into regular production.

BGY59

HYBRID V.H.F. PUSH-PULL AMPLIFIER MODULE

Hybrid amplifier module intended for CATV systems up to 300 MHz.

QUICK REFERENCE DATA

| | | |
|--|-------------|-------------------------|
| Frequency range | f | 40 to 300 MHz |
| Source impedance and load impedance | $Z_S = Z_L$ | = 75 Ω |
| Power gain at f = 50 MHz | G_p | 38,5 \pm 1,0 dB |
| Slope cable equivalent f = 40 MHz to 300 MHz | | 0 to +1,0 dB |
| Flatness of frequency response f = 40 MHz to 300 MHz | | \leq \pm 0,3 dB |
| Return losses at input and output f = 40 MHz to 300 MHz | | \geq 20 dB |
| Output voltage at $d_{im} = -60$ dB (DIN45004B, par. 6,3: 3-tone) | V_o | \geq 64 dBmV |
| 2nd harmonic distortion at $V_o = 50$ dBmV | d_2 | \leq -68 dB |
| Noise figure f = 40 MHz to 300 MHz | F | \leq 6 dB |
| D.C. supply voltage | + V_B | = 24 V* |
| Total d.c. current consumption at $V_B = +24$ V | I_{tot} | typ. 320 mA |
| Operating mounting base temperature | T_{mb} | -20 to +90 $^{\circ}$ C |

MECHANICAL DATA

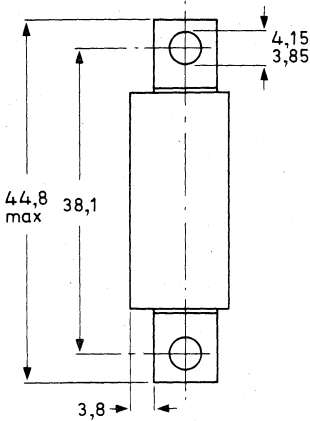
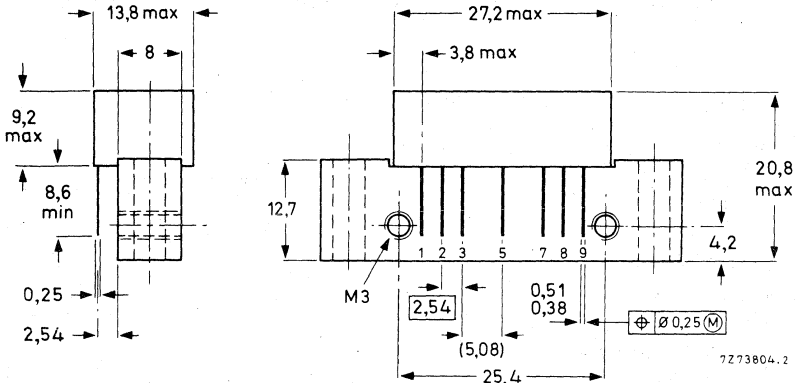
SOT-115 (see page 2).

* The module normally operates at $V_B = 24$ V, but is able to withstand supply transients up to 30 V.

MECHANICAL DATA

Dimensions in mm

Fig. 1 SOT-115.



- ⊕ Positional accuracy.
- Ⓜ Maximum Material Condition.

Terminal connections

- 1 = input
- 2, 3, 7, 8 = common
- 5 = +V_B
- 9 = output

Soldering recommendations

The maximum permissible temperature of the soldering iron is 260 °C for a contact time of maximum 3 s, when the soldered joints are 3 mm or more from the module.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|-------------------------------------|------------------|----------------|---------|
| R.F. input voltage | V _i | max. | 53 dBmV |
| Storage temperature | T _{stg} | -40 to +100 °C | |
| Operating mounting base temperature | T _{mb} | -20 to +90 °C* | |

* With a heatsink ≤3,2 K/W (K/W is SI unit for °C/W) a maximum ambient temperature of +65 °C is permissible.

CHARACTERISTICS

Supply voltage $V_B = +24\text{ V}$; $T_{amb} = 25\text{ }^\circ\text{C}$

Power gain at $f = 50\text{ MHz}$

$G_p \quad 38,5 \pm 1,0\text{ dB}$

Slope cable equivalent

$f = 40\text{ MHz to }300\text{ MHz}$

$0\text{ to }+1,0\text{ dB}$

Flatness of frequency response

$f = 40\text{ MHz to }300\text{ MHz}$

$\leq \pm 0,3\text{ dB}$

Return losses at input and output

$Z_S = Z_L = 75\ \Omega$; $f = 40\text{ MHz to }300\text{ MHz}$

$\geq 20\text{ dB}$

Output voltage at $d_{im} = -60\text{ dB}$

(DIN45004B, par. 6.3: 3-tone)

$V_p = V_o$; $f_p = 287,25\text{ MHz}$

$V_q = V_o - 6\text{ dB}$; $f_q = 294,25\text{ MHz}$

$V_r = V_o - 6\text{ dB}$; $f_r = 296,25\text{ MHz}$

Measured at $f_{(p+q-r)} = 285,25\text{ MHz}$

$V_o \quad \geq 64\text{ dBmV}$

2nd harmonic distortion

$V_p = V_o = 50\text{ dBmV}$; $f_p = 66\text{ MHz}$

$V_q = V_o = 50\text{ dBmV}$; $f_q = 144\text{ MHz}$

Measured at $f_{(p+q)} = 210\text{ MHz}$

$d_2 \quad \leq -68\text{ dB}$

Noise figure

$f = 40\text{ MHz to }300\text{ MHz}$

$F \quad \leq 6\text{ dB}$

Total d.c. current consumption

$I_{tot} \quad \begin{matrix} \text{typ. } 320\text{ mA} \\ \leq 340\text{ mA} \end{matrix}$

DEVELOPMENT SAMPLE DATA



DEVELOPMENT SAMPLE DATA

This information is derived from development samples made available for evaluation. It does not necessarily imply that the device will go into regular production.

BGY60

HYBRID V.H.F. PUSH-PULL AMPLIFIER MODULE

Interstage hybrid amplifier module intended for CATV systems up to 300 MHz. The inputs and outputs of the stages have been terminated separately.

QUICK REFERENCE DATA for total amplifier unless otherwise specified

| | | | | |
|--|-------------|----------------|--------------------|----|
| Frequency range | f | 40 to 300 | MHz | |
| Source impedance and load impedance | $Z_S = Z_L$ | = 75 | Ω | |
| Power gain at f = 50 MHz | G_p | $33,3 \pm 1,0$ | dB | |
| Slope cable equivalent f = 40 MHz to 300 MHz | | +0,5 to +1,5 | dB | |
| Flatness of frequency response f = 40 MHz to 300 MHz | | $\leq \pm 0,3$ | dB | |
| Return losses at input and output f = 40 MHz to 300 MHz | s_{11} | \geq 20 | 18 | dB |
| | | s_{22} | \geq 18 | 20 |
| Output voltage at $d_{im} = -60$ dB (DIN45004B, par. 6.3: 3-tone) | V_o | \geq 64 | dBmV | |
| 2nd harmonic distortion at $V_o = 50$ dBmV | d_2 | ≤ -66 | dB | |
| Noise figure f = 40 MHz to 300 MHz | F | \leq 6 | dB | |
| D.C. supply voltage | $+V_B$ | = 24 | V* | |
| Total d.c. current consumption at $V_B = +24$ V | I_{tot} | typ. 320 | mA | |
| Operating mounting base temperature | T_{mb} | -20 to +90 | $^{\circ}\text{C}$ | |

MECHANICAL DATA

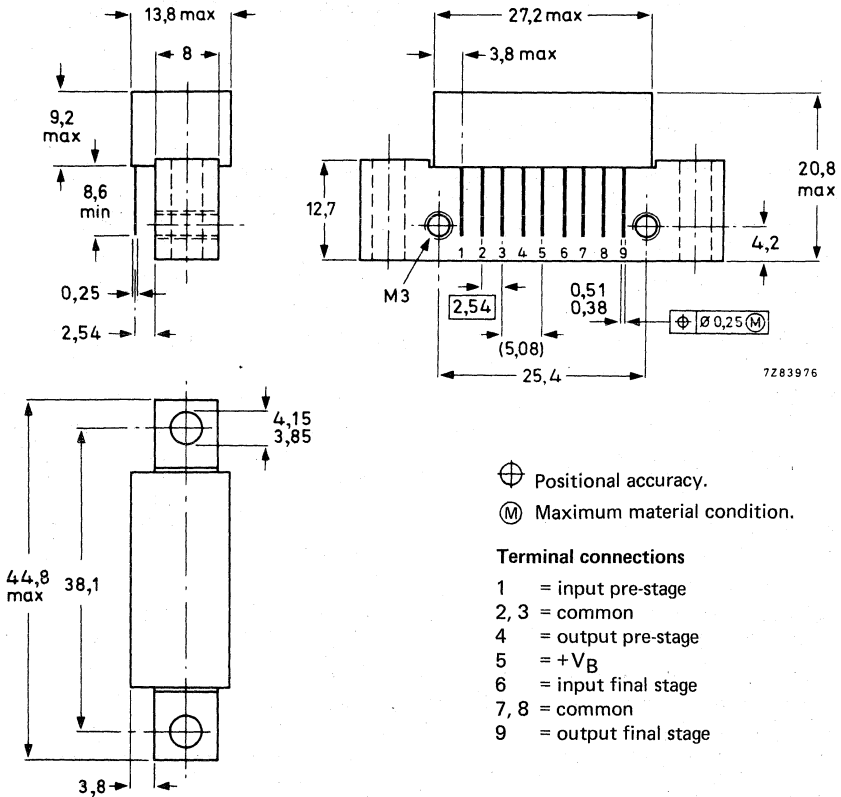
SOT-115 (see page 2).

* The module normally operates at $V_B = 24$ V, but is able to withstand supply transients up to 30 V.

MECHANICAL DATA

Fig. 1 SOT-115.

Dimensions in mm



Soldering recommendations

The maximum permissible temperature of the soldering iron is 260 °C for a contact time of maximum 3 s, when the soldered joints are 3 mm or more from the module.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|-------------------------------------|------------------|-----------------|----------|
| R.F. input voltage total amplifier | V _i | max. | 55 dB/mV |
| Storage temperature | T _{stg} | -40 to + 100 °C | |
| Operating mounting base temperature | T _{mb} | -20 to +90 °C* | |

* With a heatsink ≤ 3,2 K/W (K/W is SI unit for °C/W) a maximum ambient temperature of +65 °C is permissible.

CHARACTERISTICS for total amplifier unless otherwise specified.Supply voltage $V_B = +24\text{ V}$; $T_{\text{amb}} = 25\text{ }^\circ\text{C}$

| Power gain at $f = 50\text{ MHz}$ | G_p | $33,3 \pm 1,0$ | dB | | | | | | |
|---|----------------------|--|------------------|-------------|----|----|----|----|----|
| Slope cable equivalent $f = 40\text{ MHz to } 300\text{ MHz}$ | | $+0,5\text{ to } +1,5$ | dB | | | | | | |
| Flatness of frequency response $f = 40\text{ MHz to } 300\text{ MHz}$ | \ll | $\pm 0,3$ | dB | | | | | | |
| Return losses at input and output $Z_S = Z_L = 75\ \Omega$; $f = 40\text{ MHz to } 300\text{ MHz}$ | s_{11} s_{22} | <table border="1"> <thead> <tr> <th>pre-stage</th> <th>final-stage</th> </tr> </thead> <tbody> <tr> <td>20</td> <td>18</td> </tr> <tr> <td>18</td> <td>20</td> </tr> </tbody> </table> | pre-stage | final-stage | 20 | 18 | 18 | 20 | dB |
| pre-stage | final-stage | | | | | | | | |
| 20 | 18 | | | | | | | | |
| 18 | 20 | | | | | | | | |
| Output voltage at $d_{\text{im}} = -60\text{ dB}$ (DIN45004B, par. 6.3: 3-tone $V_p = V_o$; $f_p = 287,25\text{ MHz}$ $V_q = V_o - 6\text{ dB}$; $f_q = 294,25\text{ MHz}$ $V_r = V_o - 6\text{ dB}$; $f_r = 296,25\text{ MHz}$ Measured at $f_{(p+q-r)} = 285,25\text{ MHz}$ | V_o | \gg | 64 dBmV | | | | | | |
| 2nd harmonic distortion $V_p = V_o = 50\text{ dBmV}$; $f_p = 66\text{ MHz}$ $V_q = V_o = 50\text{ dBmV}$; $f_q = 144\text{ MHz}$ Measured at $f_{(p+q)} = 210\text{ MHz}$ | d_2 | \ll | -66 dB | | | | | | |
| Noise figure $f = 40\text{ MHz to } 300\text{ MHz}$ | F | \ll | 6 dB | | | | | | |
| Total d.c. current consumption | I_{tot} | typ. \ll | 320 mA 340 mA | | | | | | |

DEVELOPMENT SAMPLE DATA

|||||

DEVELOPMENT SAMPLE DATA

This information is derived from development samples made available for evaluation. It does not necessarily imply that the device will go into regular production.

BGY74
BGY75

HYBRID V.H.F. PUSH-PULL AMPLIFIER MODULES

Hybrid amplifier modules intended for CATV systems up to 440 MHz.

QUICK REFERENCE DATA

| | | BGY74 | BGY75 |
|--|---------------|----------------|-------------------------|
| Frequency range | f | 40 to 440 | 40 to 440 MHz |
| Source impedance and load impedance | $Z_S = Z_L =$ | 75 | 75 Ω |
| Power gain at f = 50 MHz | G_p | 17,0 \pm 0,4 | 17,0 \pm 0,4 dB |
| Slope cable equivalent f = 40 MHz to 440 MHz | | 0,5 to + 1,5 | 0,5 to + 1,5 dB |
| Flatness of frequency response f = 40 MHz to 440 MHz | \leq | \pm 0,1 | \pm 0,1 dB |
| Return losses at input and output f = 40 MHz to 440 MHz | \geq | 18 | 18 dB |
| Output voltage at $d_{im} = -60$ dB (DIN45004B, par. 6.3: 3-tone) | V_o | \geq 62,5 | 65 dBmV |
| 2nd harmonic distortion at $V_o = 50$ dBmV | d_2 | \leq -68 | -70 dB |
| Noise figure f = 40 MHz to 440 MHz | F | \leq 6 | 7 dB |
| D.C. supply voltage | $+V_B$ | = 24 | 24 V* |
| Total d.c. current consumption at $V_B = +24$ V | I_{tot} | typ. 160 | 200 mA |
| Operating mounting base temperature | T_{mb} | -20 to +90 | -20 to +90 $^{\circ}$ C |

MECHANICAL DATA

SOT-115 (see page 2).

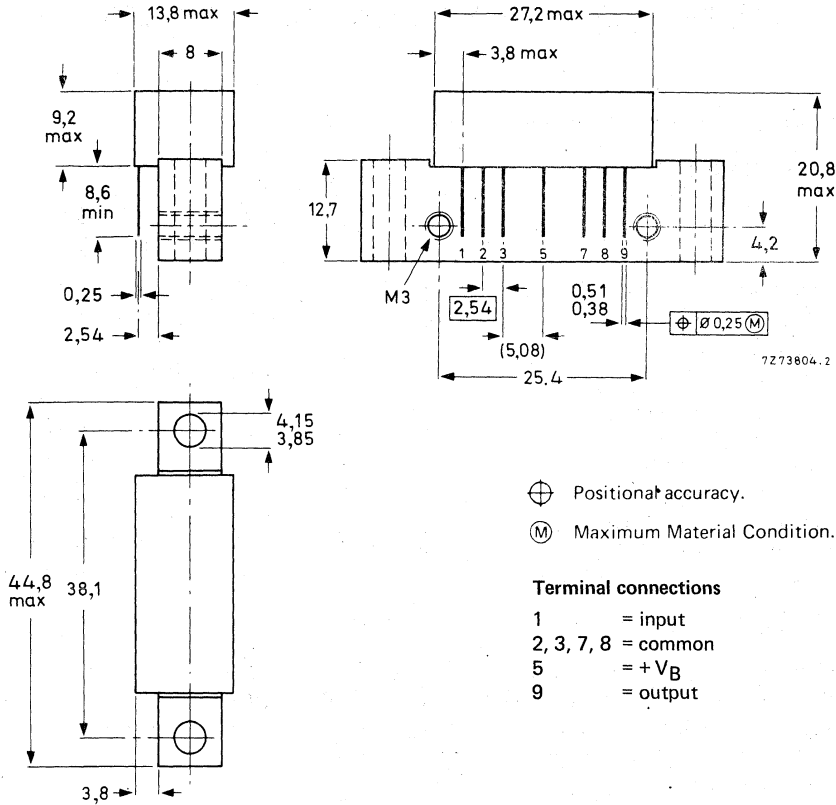
* The modules normally operate at $V_B = 24$ V, but are able to withstand supply transients up to 30 V.

BGY74
BGY75

MECHANICAL DATA

Fig. 1 SOT-115.

Dimensions in mm



Soldering recommendations

The maximum permissible temperature of the soldering iron is 260 °C for a contact time of maximum 3 s, when the soldered joints are 3 mm or more from the module.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|-------------------------------------|------------------|----------------|---------|
| R.F. input voltage | V _i | max. | 65 dBmV |
| Storage temperature | T _{stg} | -40 to +100 °C | |
| Operating mounting base temperature | T _{mb} | -20 to +90 °C | |

* With a heatsink ≤ 4,7 K/W for the BGY75, and ≤ 5,8 K/W for the BGY74 a maximum ambient temperature of +65 °C is permissible. (K/W is SI unit for °C/W.)

CHARACTERISTICS

Supply voltage $V_B = +24 \text{ V}$; $T_{\text{amb}} = 25 \text{ }^\circ\text{C}$ Power gain at $f = 50 \text{ MHz}$

| | BGY74 | BGY75 |
|-------|----------------|---------------------------|
| G_p | $17,0 \pm 0,4$ | $17,0 \pm 0,4 \text{ dB}$ |

Slope cable equivalent

 $f = 40 \text{ MHz to } 440 \text{ MHz}$

| | | |
|--|------------------------|-----------------------------------|
| | $0,5 \text{ to } +1,5$ | $0,5 \text{ to } +1,5 \text{ dB}$ |
|--|------------------------|-----------------------------------|

Flatness of frequency response

 $f = 40 \text{ MHz to } 440 \text{ MHz}$

| | | |
|--------|-----------|----------------------|
| \leq | $\pm 0,1$ | $\pm 0,1 \text{ dB}$ |
|--------|-----------|----------------------|

Return losses at input and output

 $Z_S = Z_L = 75 \text{ } \Omega$; $f = 40 \text{ MHz to } 440 \text{ MHz}$

| | | |
|--------|----|-------|
| \geq | 18 | 18 dB |
|--------|----|-------|

Output voltage at $d_{\text{im}} = -60 \text{ dB}$

(DIN45004B, par. 6.3: 3-tone)

 $V_p = V_o$; $f_p = 287,25 \text{ MHz}$ $V_q = V_o - 6 \text{ dB}$; $f_q = 294,25 \text{ MHz}$ $V_r = V_o - 6 \text{ dB}$; $f_r = 296,25 \text{ MHz}$ Measured at $f_{(p+q-r)} = 285,25 \text{ MHz}$

| | | | |
|-------|--------|------|---------|
| V_o | \geq | 62,5 | 65 dBmV |
|-------|--------|------|---------|

2nd harmonic distortion

 $V_p = V_o = 50 \text{ dBmV}$; $f_p = 55,25 \text{ MHz}$ $V_q = V_o = 50 \text{ dBmV}$; $f_q = 211,25 \text{ MHz}$ Measured at $f_{(p+q)} = 266,50 \text{ MHz}$

| | | | |
|-------|--------|-----|--------|
| d_2 | \leq | -68 | -70 dB |
|-------|--------|-----|--------|

Noise figure

 $f = 40 \text{ MHz to } 440 \text{ MHz}$

| | | | |
|---|--------|---|------|
| F | \leq | 6 | 7 dB |
|---|--------|---|------|

Total d.c. current consumption

| | | | |
|------------------|--------|-----|--------|
| I_{tot} | typ. | 160 | 200 mA |
| | \leq | 180 | 220 mA |

DEVELOPMENT SAMPLE DATA

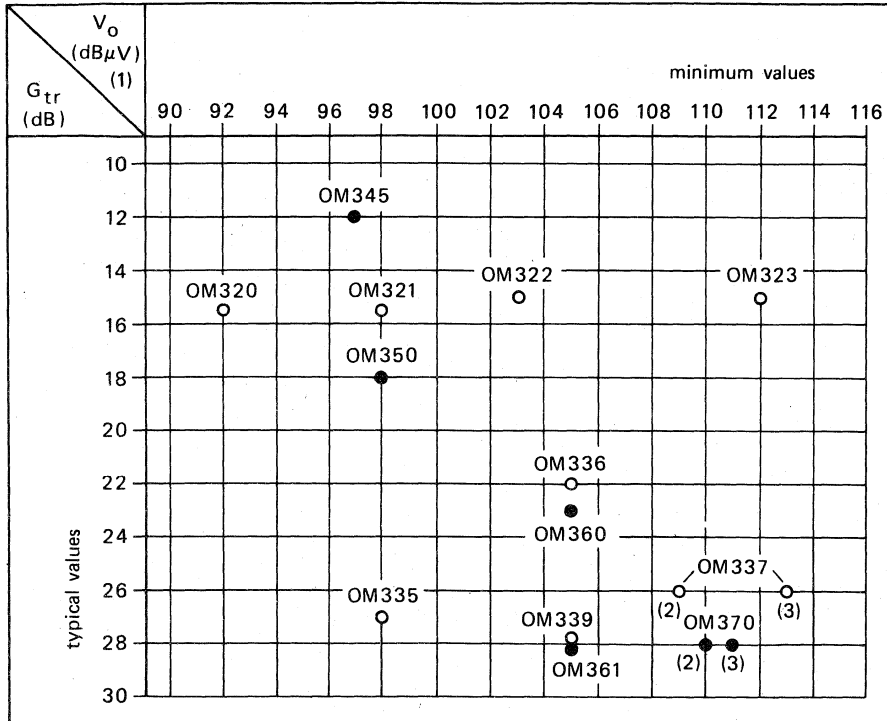


WIDEBAND AMPLIFIERS (V.H.F. & U.H.F.)

Selection guide



HYBRID ICs FOR WIDE-BAND AMPLIFIERS



7283427

● 12 V types

○ 24 V types

(1) At -60 dB intermodulation distortion (DIN 45004, par. 6.3: 3-tone).

(2) UHF.

(3) VHF.

Fig. 1 Type/performance in matrix survey.

The matrix survey (Fig. 1) and the tables next page show both the 12 V and 24 V ranges.

Note that the modules are available in the combination of high gain- high output voltage.

Tables of VHF/UHF hybrid ICs for wide-band amplifiers
12 V supply voltage

| | type | stages | gain (dB) | $V_{O(rms)}$ (dB μ V) -60 dB IMD (note 1) min. values | noise figure (dB) | max. VSWR typ. values (note 2) | | supply current (mA) |
|------------------|-------|--------|--------------|--|-------------------------|--------------------------------------|--------|---------------------------|
| | | | | | | input | output | |
| low | OM345 | 1 | 12 | 97 | 5,5 | 2,0 | 1,4 | 11,5 |
| medium | OM350 | 2 | 18 | 98 | 6,0 | 1,5 | 1,9 | 18 |
| medium output | OM360 | 3 | 23 | 105 | 7,0 | 1,3 | 1,5 | 55 |
| | OM361 | 3 | 28 | 105 | 6,0 | 1,5 | 1,7 | 50 |
| high output | OM370 | 3 | 28 | 111 | 7,0 | 2,3 | 1,9 | 105 |

24 V supply voltage

| | type | stages | gain (dB) | $V_{O(rms)}$ (dB μ V) -60 dB IMD (note 1) min. values | noise figure (dB) | max. VSWR typ. values (note 2) | | supply current (mA) |
|------------------|--------|--------|--------------|--|-------------------------|--------------------------------------|--------|---------------------------|
| | | | | | | input | output | |
| low output | OM320 | 2 | 15,5 | 92 | 5,5 | 2,2 | 2,5 | 23 |
| | OM321 | 2 | 15,5 | 98 | 6,0 | 2,5 | 2,0 | 33 |
| | OM335 | 3 | 27 | 98 | 5,5 | 1,9 | 3,2 | 35 |
| medium output | OM322 | 2 | 15 | 103 | 7,0 | 1,7 | 1,7 | 60 |
| | OM336 | 3 | 22 | 105 | 7,0 | 1,4 | 1,6 | 65 |
| | OM339 | 3 | 28 | 105 | 6,0 | 1,5 | 1,5 | 66 |
| high output | OM323* | 2 | 15 | 112 | 9,0 | 1,9 | 2,3 | 100 |
| | OM337* | 3 | 26 | 113 | 9,8 | 2,3 | 1,8 | 115 |

* Also available in A-version for external coil and output capacitor.

Notes

1. Measured at -60 dB intermodulation distortion to DIN 45004, par. 6.3: 3-tone, $f = 470$ MHz.
2. The typical maximum VSWR occurring in the frequency range 40-860 MHz, for a sample connected to a 75 Ω line.

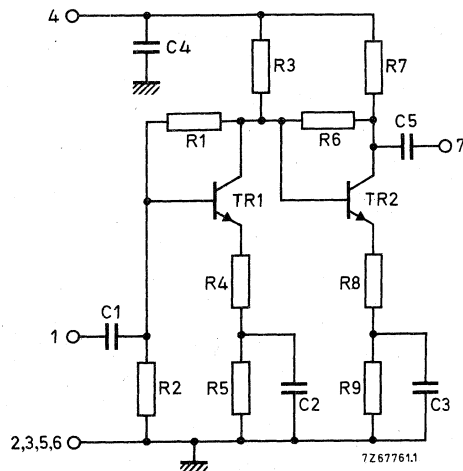
HYBRID VHF/UHF WIDE-BAND AMPLIFIER

Two-stage wide-band amplifier in the hybrid technique, designed for use in mast-head booster amplifiers, as pre-amplifier in MATV systems, and as general-purpose amplifier for v. h. f. and u. h. f. applications

| QUICK REFERENCE DATA | | | |
|--|----------------------|------------|--------------|
| Frequency range | f | 40 to 860 | MHz |
| Source and load (characteristic) impedance | $R_S = R_L = Z_0$ | = 75 | Ω |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. 15,5 | dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 1 | dB |
| Output voltage at -60 dB intermodulation distortion (DIN45004, 3-tone) | $V_{O(rms)}$ | > 92 | dB μ V |
| Noise figure | F | typ. 5,5 | dB |
| D. C. supply voltage | V_B | = 24 | V \pm 10% |
| Operating ambient temperature | T_{amb} | -20 to +70 | $^{\circ}$ C |

ENCAPSULATION 7-pin, in-line, resin-coated body, see MECHANICAL DATA

CIRCUIT DIAGRAM



RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|--------------------------------------|--------------------|-------------|----|
| Operating ambient temperature | T_{amb} | -20 to +70 | °C |
| Storage temperature | T_{stg} | -40 to +125 | °C |
| D.C. supply voltage | V_B | max. 28 | V |
| Peak voltages on pins 1 and 7 | V_{1M}, V_{7M} | max. 28 | V |
| | $-V_{1M}, V_{7M}$ | max. 10 | V |
| Peak incident powers on pins 1 and 7 | P_{I1M}, P_{I7M} | max. 100 | mW |

CHARACTERISTICS

Measuring conditions

| | | | |
|---|--------------------------------|-----------|----------|
| V. H. F. -U. H. F. test socket | catalogue no. 3504 110 01840 * | | |
| Ambient temperature | T_{amb} | = 25 | °C |
| D.C. supply voltage | V_B | = 24 | V |
| Source impedance and load impedance | R_S, R_L | = 75 | Ω |
| Characteristic impedance of h. f. connections | Z_0 | = 75 | Ω |
| Frequency range | f | 40 to 860 | MHz |

Performance

| | | | | |
|--|----------------------|---------------------|---------------------|------------|
| Supply current | I_B | typ. 23 | mA | |
| Transducer gain | $G_{tr} = s_f ^2$ | 13 to 18 | dB | |
| | | typ. 15,5 | dB | |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 1 | dB | |
| Individual maximum v. s. w. r. | input | VSWR _(i) | typ. 2,2 | ** |
| | | output | VSWR _(o) | typ. 2,5 |
| Back attenuation | $ s_r ^2$ | f = 100 MHz | typ. 30 | dB |
| | | f = 860 MHz | typ. 24 | dB |
| Output voltage at -60 dB intermodulation distortion (DIN45004, par. 6.3: 3-tone) | $V_{o(rms)}$ | > | 92 | dB μ V |
| | | typ. | 94 | dB μ V |
| Noise figure | F | typ. 5,5 | dB | |

| |
|---|
| s-parameters $s_f = s_{21}$ $s_i = s_{11}$ $s_r = s_{12}$ $s_o = s_{22}$ |
|---|

* This socket can be made available for customer reference purposes.

** Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

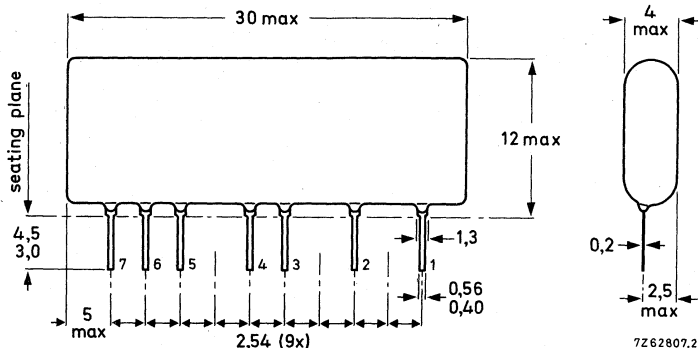
| | | | |
|-------------------------------------|------------|---|----------------|
| Ambient temperature range | T_{amb} | = | -20 to +70 °C |
| D.C. supply voltage | V_B | = | 24 V \pm 10% |
| Frequency range | f | = | 40 to 860 MHz |
| Source impedance and load impedance | R_S, R_L | = | 75 Ω |

MECHANICAL DATA

Dimensions in mm

Encapsulation

The device is resin coated.



Terminal connections

- 1 = Input
- 2; 3, 5, 6 = Common
- 4 = Supply (+)
- 7 = Output

Soldering recommendations

Hand soldering

Maximum contact time for a soldering-iron temperature of 260 °C; up to seating plane:

5 s



Dip or wave soldering

260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

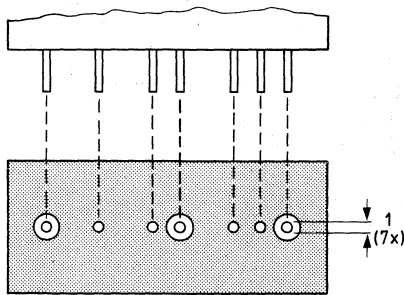
The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

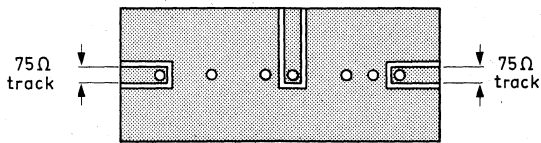
The module should preferably be mounted on double-sided printed-circuit board, see the example shown below.

Input and output should be connected to 75 Ω tracks.

The connections to the "common" pins should be as close to the seating plane as possible.

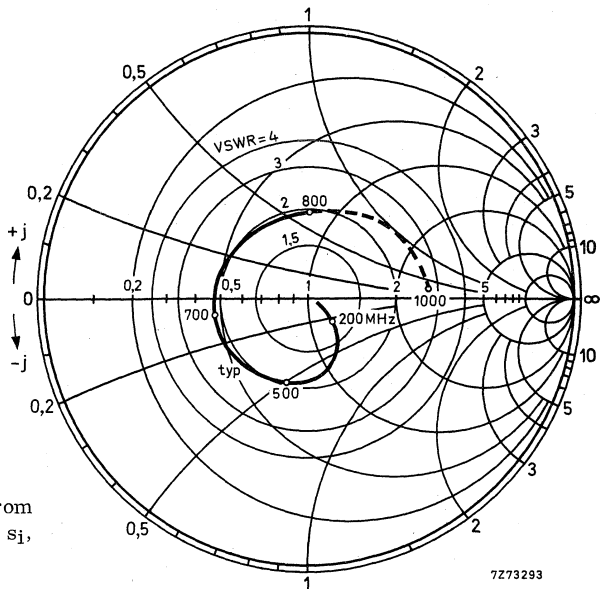
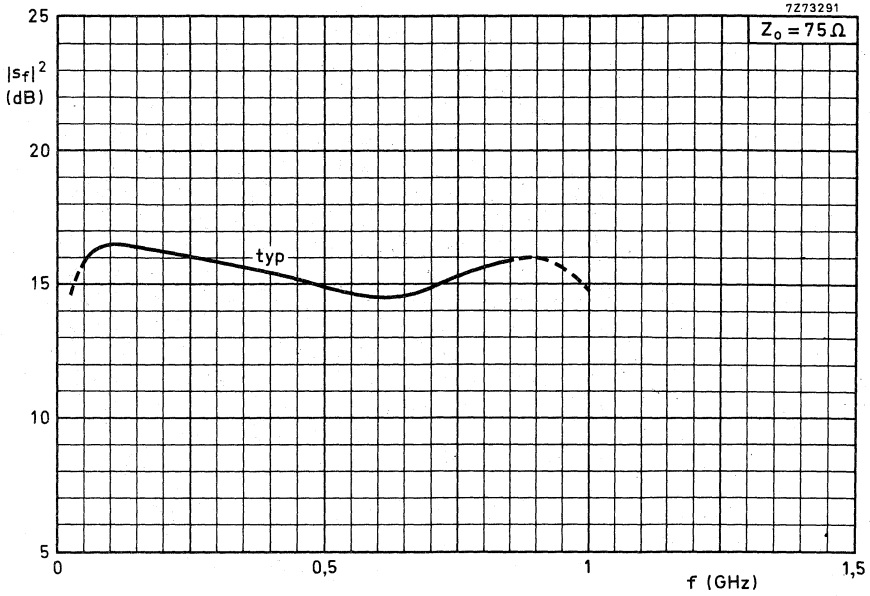


top view

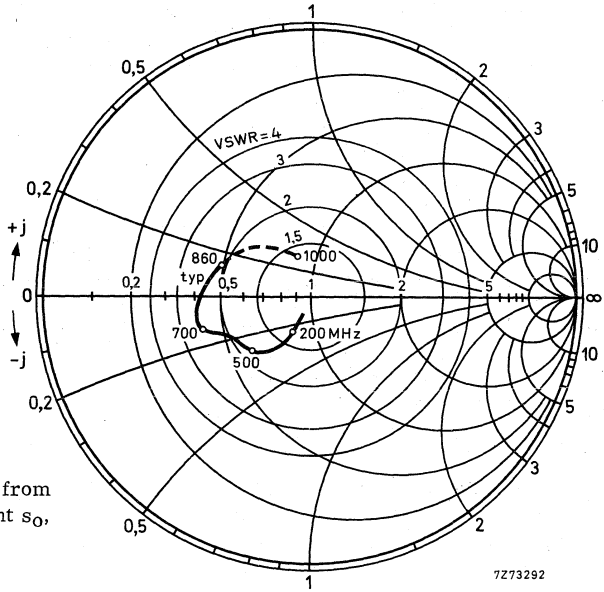


bottom view

7265910



Input impedance derived from input reflection coefficient s_1 , co-ordinates in ohm x 75.



Output impedance derived from output reflection coefficient s_o , co-ordinates in ohm x 75.



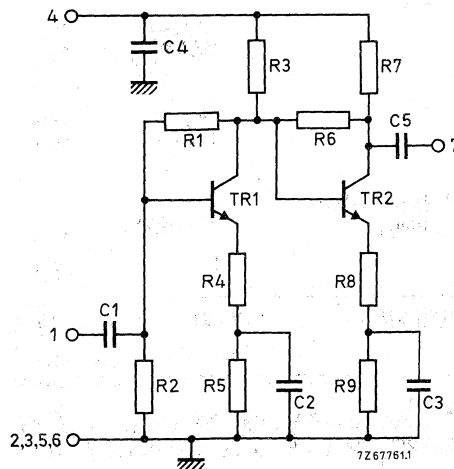
HYBRID VHF/UHF WIDE BAND AMPLIFIER

Two-stage wide-band amplifier in the hybrid technique, designed for use in mast-head booster-amplifiers, as pre-amplifier in MATV systems, and as general-purpose amplifier for v. h. f. and u. h. f. applications.

| QUICK REFERENCE DATA | | | |
|--|----------------------|------------|--------------|
| Frequency range | f | 40 to 860 | MHz |
| Source and load (characteristic) impedance | $R_S = R_L = Z_0 =$ | 75 | Ω |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. 15,5 | dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 1 | dB |
| Output voltage at -60 dB intermodulation distortion (DIN45004, 3-tone) | $V_{o(rms)}$ | > 98 | dB μ V |
| Noise figure | F | typ. 6 | dB |
| D.C. supply voltage | V_B | = 24 | V $\pm 10\%$ |
| Operating ambient temperature | T_{amb} | -20 to +70 | $^{\circ}C$ |

ENCAPSULATION 7-pin, in-line, resin-coated body, see MECHANICAL DATA

CIRCUIT DIAGRAM



RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|--------------------------------------|--------------------|-------------|----|
| Operating ambient temperature | T_{amb} | -20 to +70 | °C |
| Storage temperature | T_{stg} | -40 to +125 | °C |
| D. C. supply voltage | V_B | max. 28 | V |
| Peak voltages on pins 1 and 7 | V_{1M}, V_{7M} | max. 28 | V |
| | $-V_{1M}, -V_{7M}$ | max. 10 | V |
| Peak incident powers on pins 1 and 7 | P_{11M}, P_{17M} | max. 100 | mW |

CHARACTERISTICS

Measuring conditions

| | | |
|---|---------------|------------------|
| V.H.F. -U.H.F. test socket | catalogue no. | 3504 110 01840 * |
| Ambient temperature | T_{amb} | = 25 °C |
| D. C. supply voltage | V_B | = 24 V |
| Source impedance and load impedance | R_s, R_l | = 75 Ω |
| Characteristic impedance of h. f. connections | Z_o | = 75 Ω |
| Frequency range | f | = 40 to 860 MHz |

Performance

| | | | |
|--|----------------------|-----------|------|
| Supply current | I_B | typ. 33 | mA |
| Transducer gain | $G_{tr} = s_f ^2$ | 13 to 18 | dB |
| | | typ. 15,5 | dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 1 | dB |
| Individual maximum v. s. w. r. | VSWR | typ. 2,5 | ** |
| | | typ. 2,0 | ** |
| Back attenuation | $ s_r ^2$ | typ. 30 | dB |
| | | typ. 26 | dB |
| Output voltage at -60 dB intermodulation distortion (DIN45004, par. 6.3: 3-tone) | $V_o(rms)$ | > 98 | dBμV |
| | | typ. 100 | dBμV |
| Noise figure | F | typ. 6 | dB |

| | | |
|---------------|----------------|----------------|
| s-parameters: | $s_f = s_{21}$ | $s_i = s_{11}$ |
| | $s_r = s_{12}$ | $s_o = s_{22}$ |

* This socket can be made available for customer reference purposes.
 ** Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

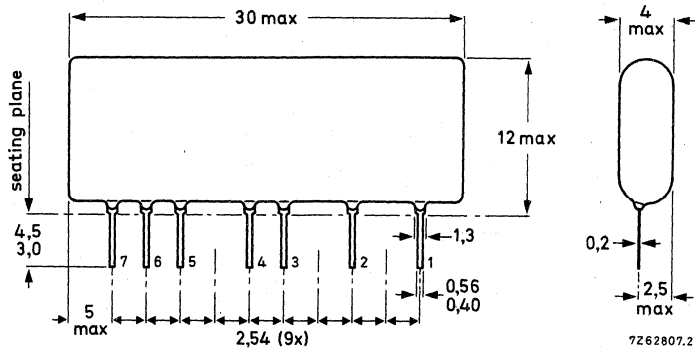
| | | | |
|-------------------------------------|------------|---|-----------------|
| Ambient temperature range | T_{amb} | = | -20 to +70 °C |
| D. C. supply voltage | V_B | = | 24 V $\pm 10\%$ |
| Frequency range | f | = | 40 to 860 MHz |
| Source impedance and load impedance | R_S, R_l | = | 75 Ω |

MECHANICAL DATA

Dimensions in mm

Encapsulation

The device is resin coated.



Terminal connections

- 1 = Input
- 2, 3, 5, 6 = Common
- 4 = Supply (+)
- 7 = Output

Soldering recommendations

Hand soldering

Maximum contact time for a soldering-iron temperature of 260 °C; up to seating plane:

5 s



Dip or wave soldering

260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

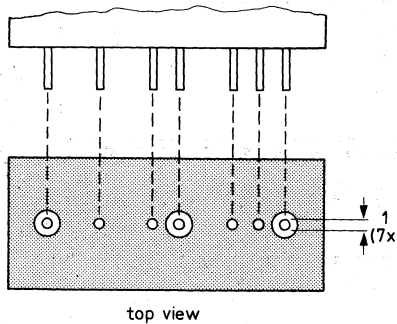
The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

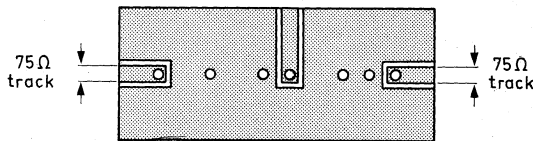
The module should preferably be mounted on double-sided printed-circuit board, see the example shown below.

Input and output should be connected to 75 Ω tracks.

The connections to the "common" pins should be as close to the seating plane as possible.

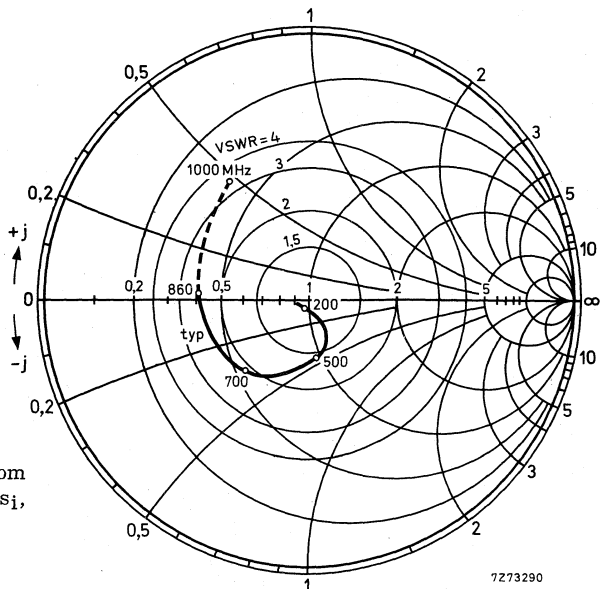
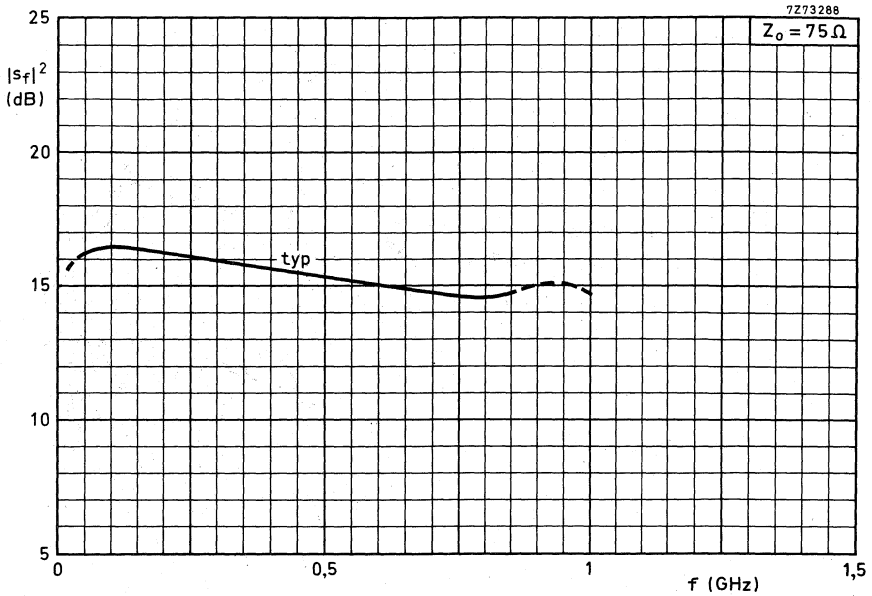


top view

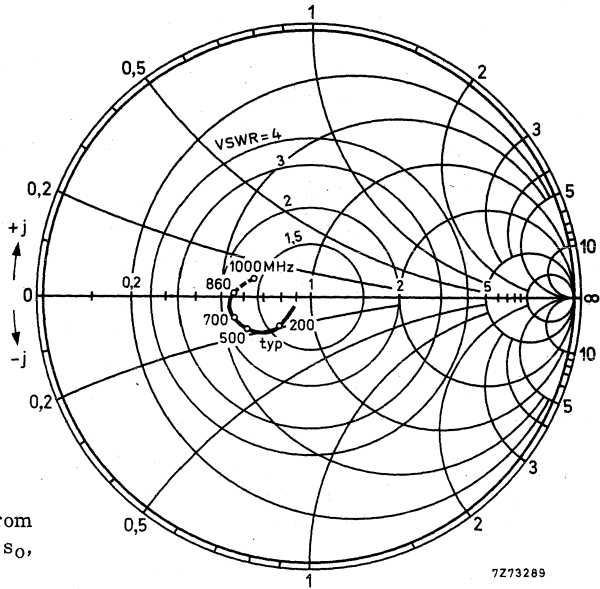


bottom view

7265910



Input impedance derived from input reflection coefficient s_i , co-ordinates in ohm x 75.



Output impedance derived from output reflection coefficient s_o , co-ordinates in ohm x 75.

7Z73289



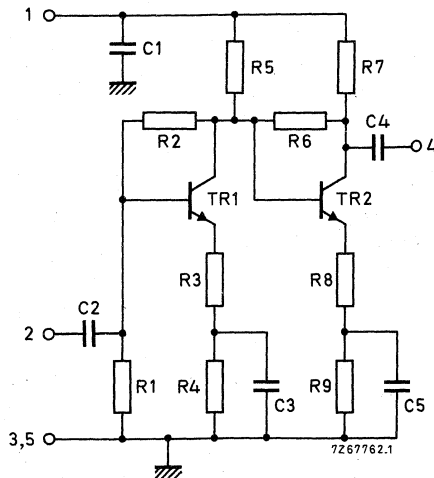
HYBRID VHF/UHF WIDE-BAND AMPLIFIER

Two-stage wide-band amplifier in the hybrid technique, designed for use as distribution amplifier in MATV and CATV systems and as general-purpose amplifier for v. h. f. and u. h. f. applications. Except for the encapsulation coating, the OM322 and OM175 have the same specification. OM322 will replace OM175.

| QUICK REFERENCE DATA | | | |
|--|----------------------|------------|--------------|
| Frequency range | f | 40 to 860 | MHz |
| Source and load (characteristic) impedance | $R_S = R_L = Z_O$ | 75 | Ω |
| Transducer gain | $G_{TR} = s_f ^2$ | typ. 15 | dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 0,3 | dB |
| Output voltage at -60 dB intermodulation distortion (DIN45004, 3-tone) | $V_{O(rms)}$ | > 103 | dB μ V |
| Noise figure | F | typ. 7 | dB |
| D. C. supply voltage | V_B | = 24 | V $\pm 10\%$ |
| Operating ambient temperature | T_{amb} | -20 to +70 | $^{\circ}$ C |

ENCAPSULATION 5-lead, resin coated body on metal base, see MECHANICAL DATA

CIRCUIT DIAGRAM



RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

| | | | |
|--------------------------------------|--------------------|-------------|----|
| Operating ambient temperature | T_{amb} | -20 to +70 | °C |
| Operating mounting-base temperature | T_{mb} | max. 100 | °C |
| Storage temperature | T_{stg} | -40 to +125 | °C |
| D.C. supply voltage | V_B | max. 28 | V |
| Peak voltages on pins 2 and 4 | V_{2M}, V_{4M} | max. 28 | V |
| | $-V_{2M}, -V_{4M}$ | max. 10 | V |
| Peak incident powers on pins 2 and 4 | P_{I2M}, P_{I4M} | max. 100 | mW |

CHARACTERISTICS

Measuring conditions

| | | | | |
|--|------------|---|-----------|-----|
| Ambient temperature | T_{amb} | = | 25 | °C |
| D.C. supply voltage | V_B | = | 24 | V |
| Source impedance and load impedance | R_s, R_l | = | 75 | Ω |
| Characteristic impedance of h.f. connections | Z_o | = | 75 | Ω |
| Frequency range | f | = | 40 to 860 | MHz |

Performance

| | | | | |
|--|-------------------------------|-------------|---------------------|-------------|
| Supply current | I_B | typ. | 60 | mA |
| Transducer gain | $G_{tr} = s_f ^2$ | | 14 to 16 | dB |
| | | typ. | 15 | dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. | 0,3 | dB |
| | | < | 0,5 | dB |
| Individual maximum v. s. w. r. input | VSWR _(i) | typ. | 1,7 | 1) |
| | | output | VSWR _(o) | typ. 1,7 1) |
| Back attenuation | s _r ² | typ. | 31 | dB |
| | | f = 100 MHz | | |
| | s _r ² | typ. | 25 | dB |
| Output voltage at -60 dB intermodulation distortion (DIN45004, par. 6.3: 3-tone) | $V_{o(rms)}$ | > | 103 | dBμV |
| | | typ. | 105 | dBμV |
| Noise figure | F | typ. | 7 | dB |

| | | |
|---------------|----------------|----------------|
| s-parameters: | $s_f = s_{21}$ | $s_i = s_{11}$ |
| | $s_r = s_{12}$ | $s_o = s_{22}$ |

1) Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

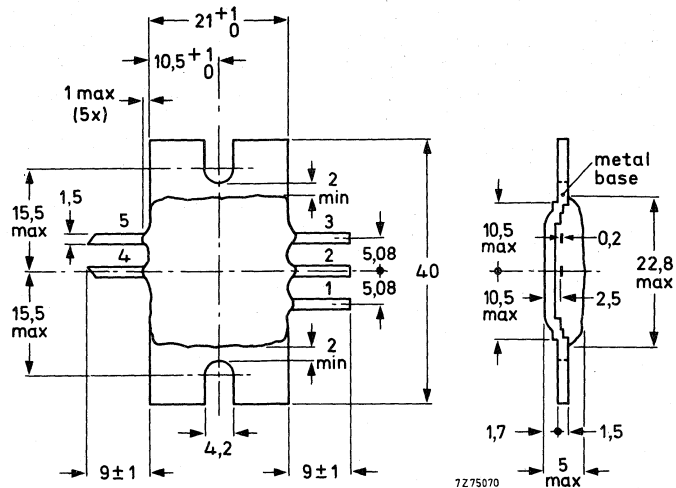
| | | | |
|-------------------------------------|------------|---|----------------|
| Ambient temperature range | T_{amb} | = | -20 to +70 °C |
| D.C. supply voltage | V_B | = | 24 V \pm 10% |
| Frequency range | f | = | 40 to 860 MHz |
| Source impedance and load impedance | R_S, R_L | = | 75 Ω |

MECHANICAL DATA

Dimensions in mm

Encapsulation

The device is resin coated and mounted on a metal mounting base.



Terminal connections

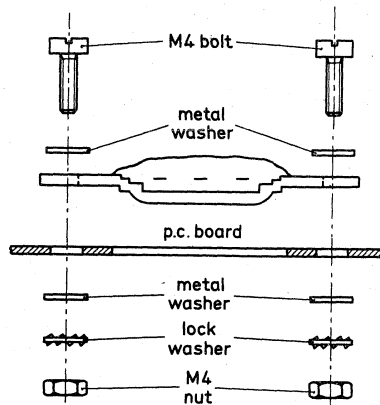
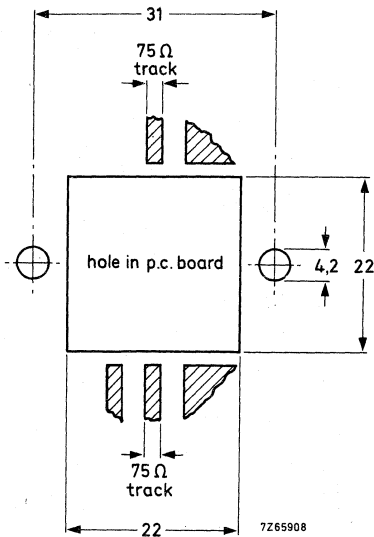
- 1 = Supply (+)
- 2 = Input
- 3 and 5 = Common (internally connected to metal base)
- 4 = Output

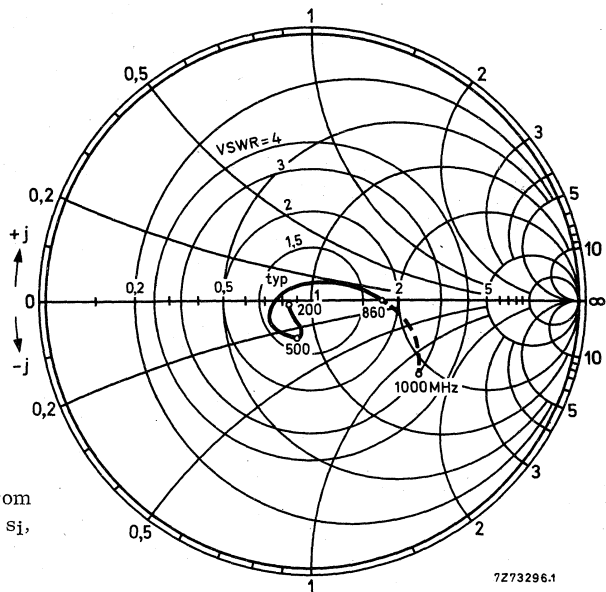
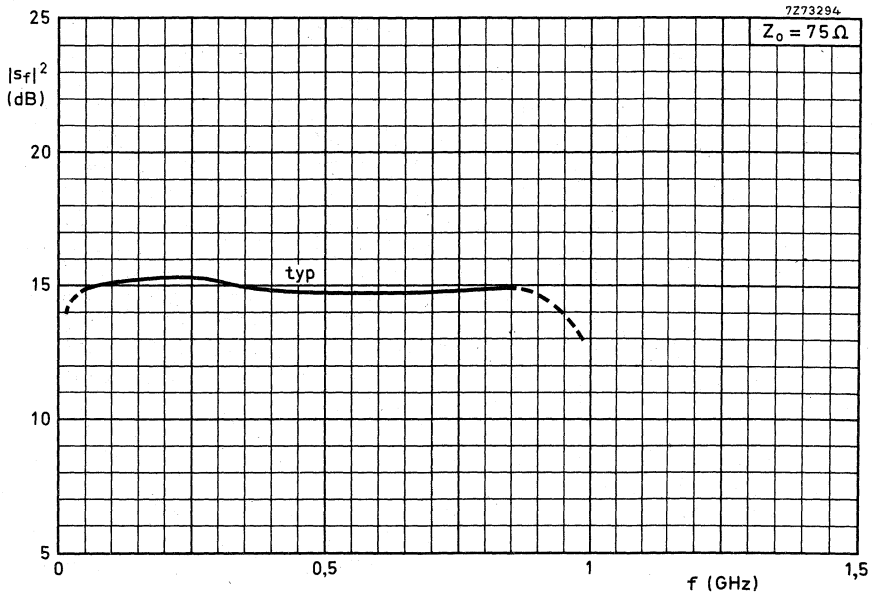
Soldering recommendations

Maximum contact time for a soldering-iron temperature of 260 °C 5 s

Mounting recommendations

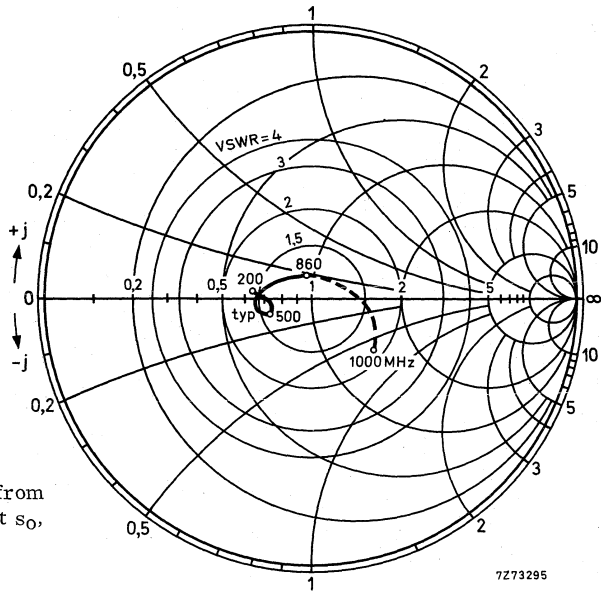
The module should preferably be mounted on a double-sided printed-circuit board, see the examples shown below. Input and output should be connected to 75 Ω tracks.





Input impedance derived from
input reflection coefficient s_f ,
co-ordinates in ohm $\times 75$

7273296.1



Output impedance derived from
output reflection coefficient s_o ,
co-ordinates in ohm x 75



HYBRID V.H.F./U.H.F. WIDE-BAND AMPLIFIER

Two-stage wide-band amplifier in the hybrid technique, designed for use in MATV systems, and as general purpose amplifier for v.h.f. and u.h.f. applications requiring a high output level. The OM323A needs an external collector-coil and blocking capacitor, whereas, the OM323 has these components built-in.

QUICK REFERENCE DATA

| | | |
|---|----------------------|--------------------------|
| Frequency range | f | 40 to 860 MHz |
| Source and load (characteristic) impedance | $R_s = R_l = Z_0 =$ | 75 Ω |
| Transducer gain | $G_{tr} = s_f ^2$ | typ 15 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ 0,5 dB |
| Output voltage at -60 dB intermodulation distortion (DIN45004, 3-tone); $f = 470$ MHz | $V_{o(rms)}$ | typ 113 dB μ V |
| Noise figure | F | typ 9 dB |
| D.C. supply voltage | V_B | = 24 V \pm 10% |
| Operating mounting-base temperature | T_{mb} | -30 to +100 $^{\circ}$ C |

ENCAPSULATION 9-pin, in-line, resin-coated body on a right-angled metal mounting tab, see
MECHANICAL DATA

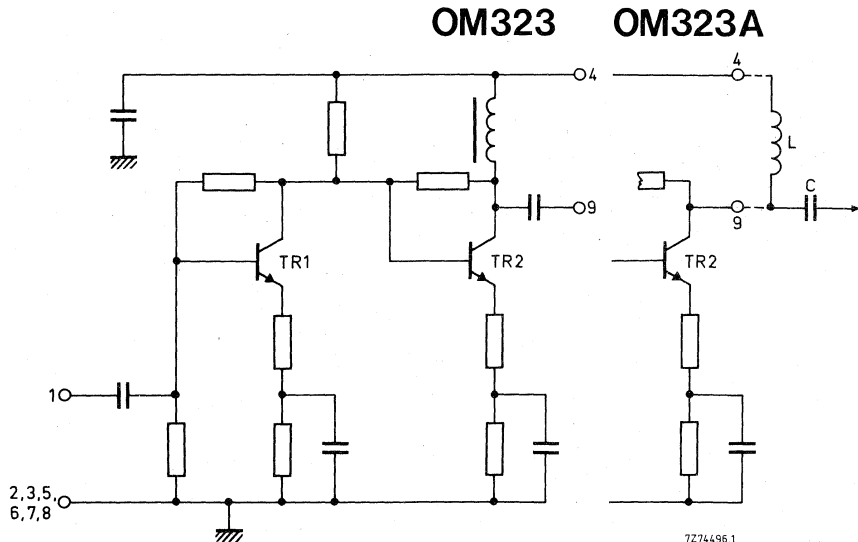


Fig. 1 Circuit diagram.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

| | | |
|--------------------------------------|-------------------|----------------|
| Operating mounting-base temperature | T_{mb} | -30 to +100 °C |
| Storage temperature | T_{stg} | -40 to +125 °C |
| D.C. supply voltage | V_B | max 28 V |
| Peak voltages on pin 1 | V_{1M} | max 28 V |
| | $-V_{1M}$ | max 24 V |
| Peak voltages on pin 9 | V_{9M} | max 28 V |
| | $-V_{9M}$ | max 4 V |
| Peak incident powers on pins 1 and 9 | P_{11M}, P_{9M} | max 100 mW |

CHARACTERISTICS

Measuring conditions

V.H.F.—U.H.F. test socket

Mounting base temperature

D.C. supply voltage

Source impedance and load impedance

Characteristic impedance of h.f. connections

Frequency range

catalogue no. 3504 110 01830 *

| | | |
|------------|---|---------------|
| T_{mb} | = | 25 °C |
| V_B | = | 24 V |
| R_s, R_l | = | 75 Ω |
| Z_o | = | 75 Ω |
| f | = | 40 to 860 MHz |

Performance

Supply current

Transducer gain

Flatness of frequency response

Individual maximum v.s.w.r.

input

output

Back attenuation

f = 100 MHz

f = 650 MHz

f = 860 MHz

| | | |
|----------------------|-----|--------------|
| I_B | | 95 to 105 mA |
| | | typ 100 mA |
| $G_{tr} = s_f ^2$ | | 14 to 17 dB |
| | | typ 15 dB |
| $\pm \Delta s_f ^2$ | | typ 0,5 dB |
| $VSWR_{(i)}$ | typ | 1,9 ** |
| $VSWR_{(o)}$ | typ | 2,3 ** |
| $ s_r ^2$ | typ | 29 dB |
| $ s_r ^2$ | typ | 25,5 dB |
| $ s_r ^2$ | typ | 24 dB |

* This socket can be made available for customer reference purposes.

** Highest value, for a sample, occurring in the frequency range.

Output voltage

at -60 dB intermodulation distortion

(DIN45004, par. 6.3: 3-tone)

f = 40-230 MHz

f = 470 MHz

f = 860 MHz

| | | |
|--------------|-----|----------------|
| $V_{o(rms)}$ | > | 112 dB μ V |
| | typ | 114 dB μ V |
| $V_{o(rms)}$ | typ | 113 dB μ V |
| $V_{o(rms)}$ | typ | 112 dB μ V |

Noise figure

channel 2

channel 65

| | | |
|---|-----|------|
| F | typ | 8 dB |
| F | typ | 9 dB |

| | | |
|---------------|----------------|----------------|
| s-parameters: | $s_f = s_{21}$ | $s_i = s_{11}$ |
| | $s_r = s_{12}$ | $s_o = s_{22}$ |

OPERATING CONDITIONS

Mounting-base temperature range

 T_{amb} -30 to +100 °C

D.C. supply voltage

 V_B = 24 V \pm 10%

Frequency range

f 40 to 860 MHz

Source impedance and load impedance

 R_s, R_l = 75 Ω

THERMAL DATA

- The maximum permissible temperature at the mounting base is 100 °C.
- When the mounting tab is screwed to a double-sided printed-circuit board with dimensions 37 mm x 51 mm, its temperature will be 57 °C above the temperature of the surrounding free air.
- When a heatsink is fixed to the mounting tab and the pins are soldered into a double-sided printed-circuit board with dimensions 37 mm x 51 mm, the tab will reach the temperatures stated in the following table.

Notes

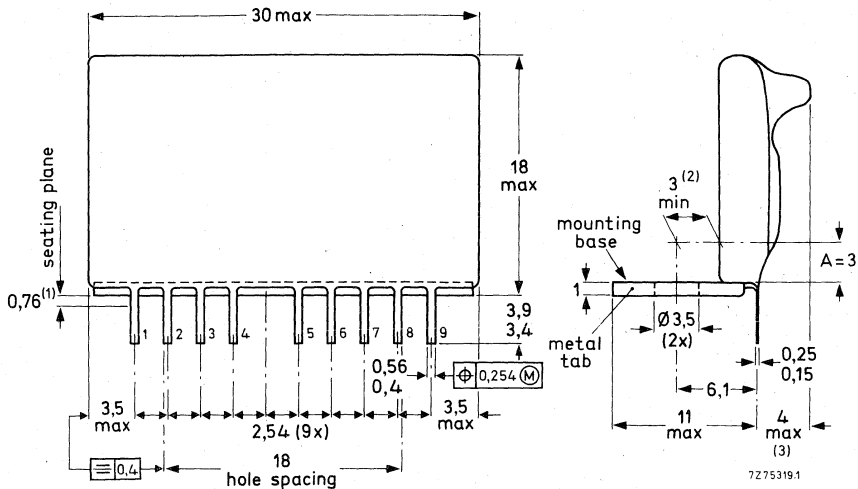
- When the device is fixed only to a heatsink, not to a printed-circuit board, the values of the second column of the table should be increased by 2 °C and those of the third column decreased by 2 °C.
- The user is free to realize proper cooling by using differently shaped sinks, or, preferably, by fixing the tab to any convenient part of the equipment (e.g. a wall of the metal cabinet).

| heatsink data thickness 1 mm | $T_{mb} - T_{amb}$ °C | T_{amb} max °C |
|--|--------------------------|---------------------|
| Bright aluminium heatsink L-shaped bar, length 100 mm, height 165 mm | 24 | 76 |
| Blackened aluminium heatsink L-shaped bar; length 50 mm, height 70 mm | 23 | 77 |

MECHANICAL DATA

Dimensions in mm

The amplifier is resin coated and has a metal mounting tab at a right angle to the encapsulation part.



- (1) Tolerance applies within this zone.
- (2) Distance applies within zone A.
- (3) For the OM323A: 3 mm maximum.

Fig. 2 Encapsulation.

Terminal connections

- 1 = Input
- 2, 3, 5, 6, 7, 8 = Common, connected to mounting tab
- 4 = Supply (+)
- 9 = Output

Soldering recommendations

Hand soldering

Maximum contact time for a soldering-iron temperature of 260 °C up to the seating plane is 5 s.

Dip or wave soldering

260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds. The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

The module should preferably be mounted on a double-sided printed-circuit board, see the following example. An example is also given of heatsink mounting.

Input and output should be connected to 75 Ω tracks.

The connections to the common pins should be as close to the seating plane as possible.

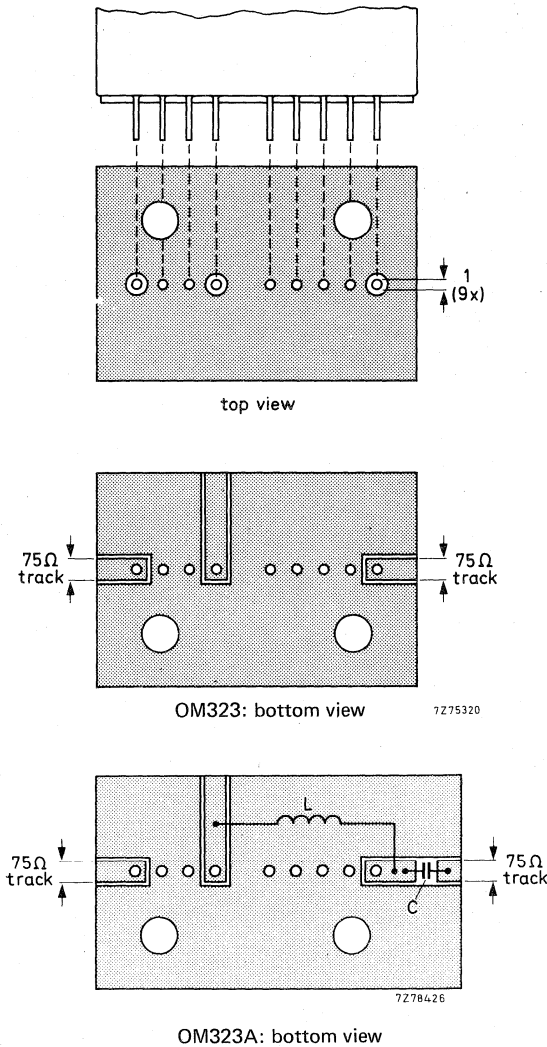


Fig. 3 Printed-circuit board holes and tracks for the OM323 and OM323A.

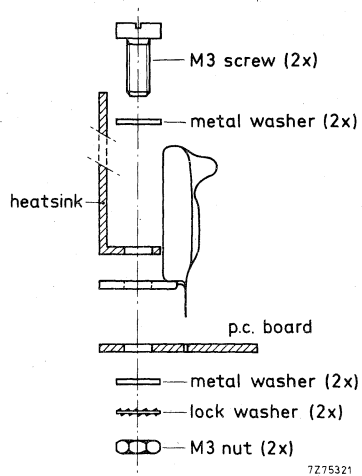


Fig. 4 Example of heatsink mounting.

$L > 5 \mu\text{H}$; e.g. catalogue no. 3122 108 20150 or 27 turns enamelled Cu wire (0,3 mm) wound on a ferrite core with a diameter of 1,6 mm.
 $C > 220 \text{ pF}$ ceramic capacitor.

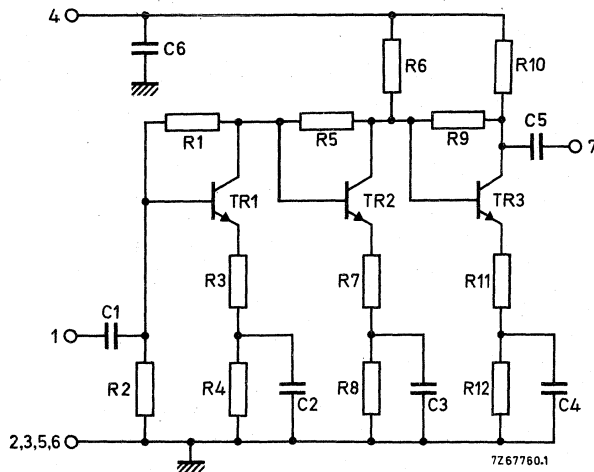
HYBRID VHF/UHF WIDE-BAND AMPLIFIER

Three-stage wide-band amplifier in the hybrid technique, designed for use in mast-head booster-amplifiers, as pre-amplifier in MATV systems, and as general-purpose amplifier for v. h. f. and u. h. f. applications.

| QUICK REFERENCE DATA | | | |
|--|----------------------|------------|-----------------|
| Frequency range | f | 40 to 860 | MHz |
| Source and load (characteristic) impedance | $R_S = R_L = Z_0 =$ | = | 75 Ω |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. | 27 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. | 1,6 dB |
| Output voltage at -60 dB intermodulation distortion (DIN45004, 3-tone) | $V_{o(rms)}$ | > | 98 dB μ V |
| Noise figure | F | typ. | 5,5 dB |
| D.C. supply voltage | V_B | = | 24 V $\pm 10\%$ |
| Operating ambient temperature | T_{amb} | -20 to +70 | $^{\circ}C$ |

ENCAPSULATION 7-pin, in-line, resin-coated body, see MECHANICAL DATA

CIRCUIT DIAGRAM



RATINGS Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|--------------------------------------|--------------------|-------------|----|
| Operating ambient temperature | T_{amb} | -20 to +70 | °C |
| Storage temperature | T_{stg} | -40 to +125 | °C |
| D.C. supply voltage | V_B | max. 28 | V |
| Peak voltages on pins 1 and 7 | V_{1M}, V_{7M} | max. 28 | V |
| | $-V_{1M}, -V_{7M}$ | max. 10 | V |
| Peak incident powers on pins 1 and 7 | P_{11M}, P_{17M} | max. 100 | mW |

CHARACTERISTICS

Measuring conditions

| | | | |
|---|--------------------------------|-------------|-----|
| V. H. F. -U. H. F. test socket | catalogue no. 3504 110 01840 * | | |
| Ambient temperature | T_{amb} | = 25 | °C |
| D.C. supply voltage | V_B | = 24 | V |
| Source impedance and load impedance | R_S, R_L | = 75 | Ω |
| Characteristic impedance of h. f. connections | Z_0 | = 75 | Ω |
| Frequency range | f | = 40 to 860 | MHz |

Performance

| | | | |
|--|----------------------|---------------------|---------------------|
| Supply current | I_B | typ. 35 | mA |
| Transducer gain | $G_{tr} = s_f ^2$ | 23 to 31 | dB |
| | | typ. 27 | dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 1,6 | dB |
| Individual maximum v. s. w. r. | input | VSWR _(i) | typ. 1,9 ** |
| | | output | VSWR _(o) |
| Back attenuation | $ s_r ^2$ | f = 100 MHz | typ. 46 dB |
| | | f = 860 MHz | typ. 40 dB |
| Output voltage at -60 dB intermodulation distortion (DIN45004, par. 6.3: 3-tone) | $V_{o(rms)}$ | > 98 | dB μ V |
| | | typ. 101 | dB μ V |
| Noise figure | F | typ. 5,5 | dB |

| | | |
|---------------|----------------|----------------|
| s-parameters: | $s_f = s_{21}$ | $s_i = s_{11}$ |
| | $s_r = s_{12}$ | $s_o = s_{22}$ |

* This socket can be made available for customer reference purposes.
 ** Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

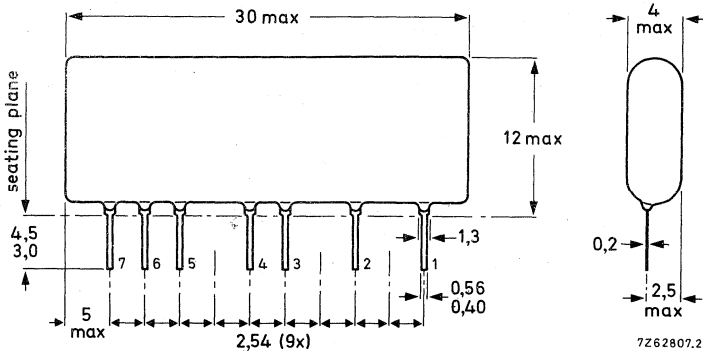
| | | | |
|-------------------------------------|------------|---|-----------------|
| Ambient temperature range | T_{amb} | = | -20 to +70 °C |
| D.C. supply voltage | V_B | = | 24 V $\pm 10\%$ |
| Frequency range | f | = | 40 to 860 MHz |
| Source impedance and load impedance | R_S, R_l | = | 75 Ω |

MECHANICAL DATA

Dimensions in mm

Encapsulation

The device is resin coated.



Terminal connections

- 1 = Input
- 2, 3, 5, 6 = Common
- 4 = Supply (+)
- 7 = Output

Soldering recommendations

Hand soldering

Maximum contact time for a soldering-iron temperature of 260 °C; up to seating plane:

5 s



Dip or wave soldering

260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds.

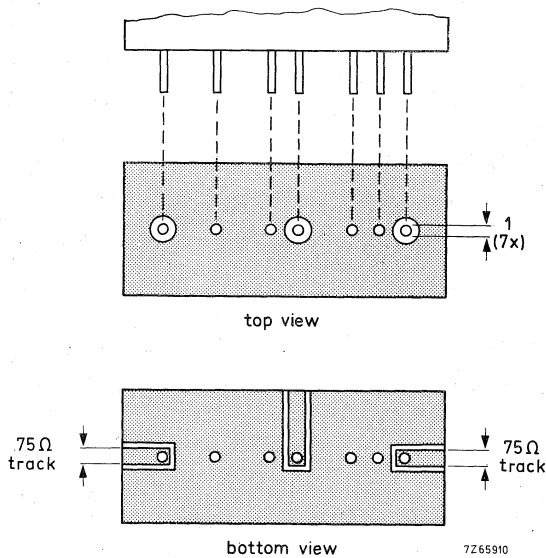
The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

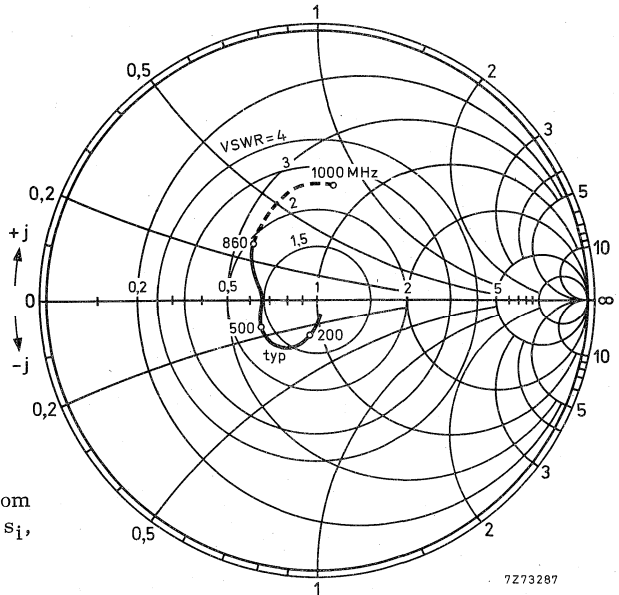
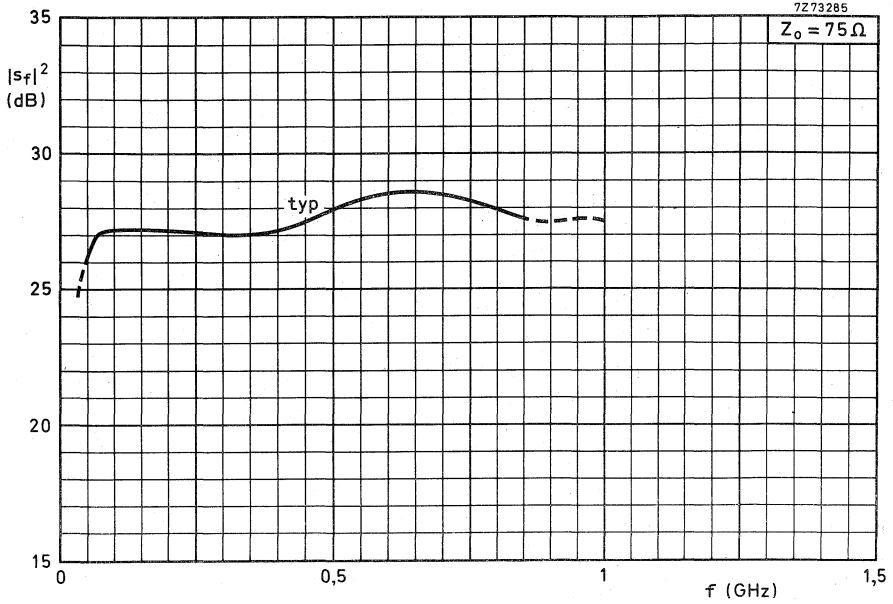
Mounting recommendations

The module should preferably be mounted on double-sided printed-circuit board, see the example shown below.

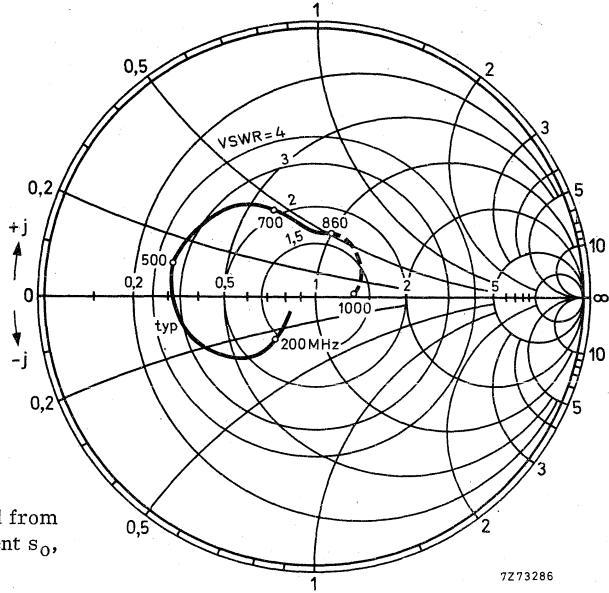
Input and output should be connected to 75 Ω tracks.

The connections to the "common" pins should be as close to the seating plane as possible.





Input impedance derived from input reflection coefficient s_i , co-ordinates in ohm x 75.



Output impedance derived from output reflection coefficient s_o , co-ordinates in ohm x 75.



HYBRID VHF/UHF WIDE-BAND AMPLIFIER

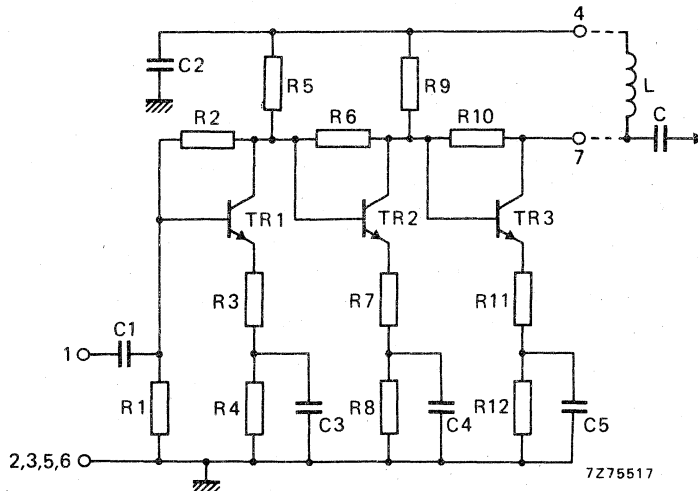
Three-stage wide-band amplifier in the hybrid technique, designed for use in mast-head booster-amplifiers, as preamplifier in MATV systems, and as general-purpose amplifier for v.h.f. and u.h.f. applications.

QUICK REFERENCE DATA

| | | |
|---|----------------------|-------------------------|
| Frequency range | f | 40 to 860 MHz |
| Source and load (characteristic) impedance | $R_s = R_l = Z_0$ | = 75 Ω |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. 22 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 1,0 dB |
| Output voltage at -60 dB intermodulation distortion (DIN 45004, 3-tone) | $V_{o(rms)}$ | > 105 dB μ V |
| Noise figure | F | typ. 7 dB |
| D.C. supply voltage | V_B | = 24 V \pm 10% |
| Operating ambient temperature | T_{amb} | -20 to +70 $^{\circ}$ C |

ENCAPSULATION 7-pin, in-line, resin-coated body, see MECHANICAL DATA

CIRCUIT DIAGRAM



RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | |
|--------------------------------------|--------------------|----------------|
| Operating ambient temperature | T_{amb} | -20 to +70 °C |
| Storage temperature | T_{stg} | -40 to +125 °C |
| D.C. supply voltage | V_B | max. 28 V |
| Peak voltages on pins 1 and 7 | V_{1M}, V_{7M} | max. 28 V |
| | $-V_{1M}, -V_{7M}$ | max. 10 V |
| Peak incident powers on pins 1 and 7 | P_{I1M}, P_{I7M} | max. 100 mW |

CHARACTERISTICS

Measuring conditions

V.H.F.-U.H.F. test socket

catalogue no. 3504 110 01840 *

| | | |
|--|------------|-----------------|
| Ambient temperature | T_{amb} | = 25 °C |
| D.C. supply voltage | V_B | = 24 V |
| Source impedance and load impedance | R_s, R_l | = 75 Ω |
| Characteristic impedance of h.f. connections | Z_0 | = 75 Ω |
| Frequency range | f | = 40 to 860 MHz |

Performance

| | | |
|--------------------------------------|----------------------|---|
| Supply current | I_B | typ. 65 mA |
| Transducer gain | $G_{tr} = s_f ^2$ | 20 to 24 dB typ. 22 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 1,0 dB |
| Individual maximum v.s.w.r. | | |
| input | VSWR _(i) | typ. 1,4 ** |
| output | VSWR _(o) | typ. 1,6 ** |
| Back attenuation | | |
| f = 100 MHz | $ s_r ^2$ | typ. 42 dB |
| f = 860 MHz | $ s_r ^2$ | typ. 40 dB |
| Output voltage | | |
| at -60 dB intermodulation distortion | | |
| (DIN 45004, par. 6.3: 3-tone) | $V_{o(rms)}$ | > 105 dB μ V typ. 107 dB μ V |
| Noise figure | F | typ. 7 dB |

| | | |
|---------------|----------------|----------------|
| s-parameters: | $s_f = s_{21}$ | $s_i = s_{11}$ |
| | $s_r = s_{12}$ | $s_o = s_{22}$ |

* This socket can be made available for customer reference purposes.

** Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

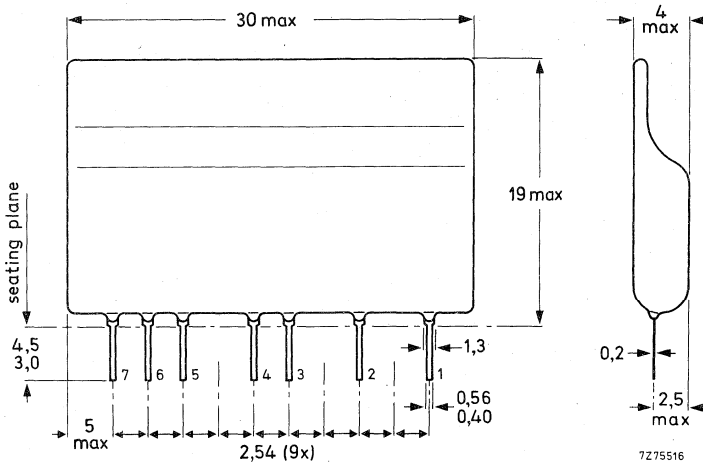
| | | |
|-------------------------------------|------------|------------------|
| Ambient temperature range | T_{amb} | -20 to +70 °C |
| D.C. supply voltage | V_B | = 24 V \pm 10% |
| Frequency range | f | 40 to 860 MHz |
| Source impedance and load impedance | R_S, R_L | = 75 Ω |

MECHANICAL DATA

Dimensions in mm

Encapsulation

The device is resin coated.

**Terminal connections**

- 1 = Input
- 2, 3, 5, 6 = Common
- 4 = Supply (+)
- 7 = Output.

Soldering recommendations**Hand soldering**

Maximum contact time for a soldering-iron temperature of 260 °C up to the seating plane is 5 s.

Dip or wave soldering

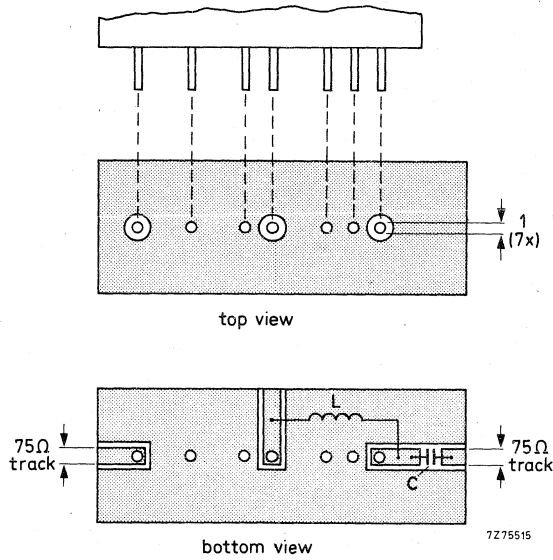
260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds. The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

The module should preferably be mounted on double-sided printed-circuit board, see the example shown below.

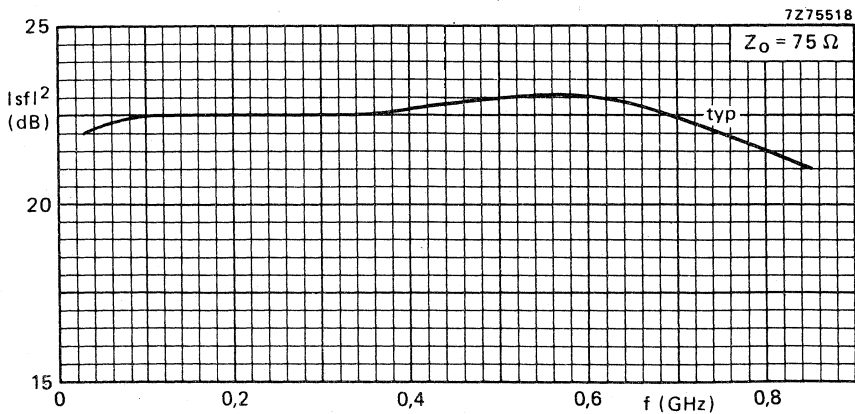
Input and output should be connected to 75 Ω tracks.

The connections to the 'common' pins should be as close to the seating plane as possible.



$L > 5 \mu\text{H}$; e.g. catalogue no. 3122 108 20150 or 27 turns enamelled Cu wire (0,3 mm) wound on a ferrite core with a diameter of 1,6 mm.

$C > 220 \text{ pF}$ ceramic capacitor.



HYBRID V.H.F./U.H.F. WIDE-BAND AMPLIFIER

Three-stage wide-band amplifier in the hybrid technique, designed for use in MATV systems, and as general purpose amplifier for v.h.f. and u.h.f. applications requiring a high output level. The OM337A needs an external collector-coil and blocking capacitor, whereas, the OM337 has these components built-in.

QUICK REFERENCE DATA

| | | |
|--|----------------------|--------------------------|
| Frequency range | f | 40 to 860 MHz |
| Source and load (characteristic) impedance | $R_s = R_l = Z_o =$ | 75 Ω |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. 26 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 1 dB |
| Output voltage at -60 dB intermodulation distortion (DIN45004, 3-tone); $f = 470$ MHz | $V_o(rms)$ | typ. 112 dB μ V |
| Noise figure | F | typ. 9,8 dB |
| D.C. supply voltage | V_B | = 24 V \pm 10% |
| Operating mounting-base temperature | T_{mb} | -30 to +100 $^{\circ}$ C |

ENCAPSULATION 9-pin, in-line, resin-coated body on a right-angled metal mounting tab, see
MECHANICAL DATA

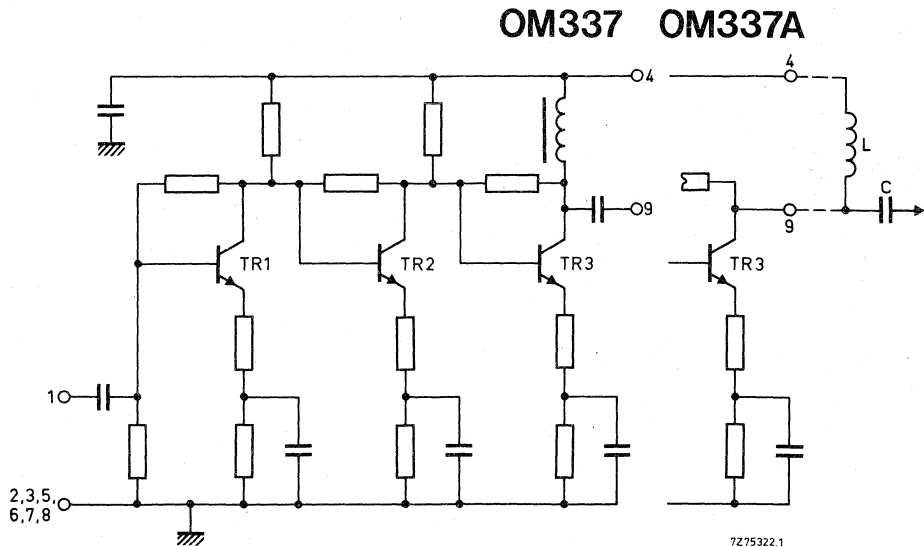


Fig. 1 Circuit diagram.

RATINGS Limiting values in accordance with the Absolute Maximum System (IEC134)

| | | |
|--------------------------------------|--------------------|----------------|
| Operating mounting-base temperature | T_{mb} | -30 to +100 °C |
| Storage temperature | T_{stg} | -40 to +125 °C |
| D.C. supply voltage | V_B | max. 28 V |
| Peak voltages on pin 1 | V_{1M} | max. 28 V |
| | $-V_{1M}$ | max. 24 V |
| Peak voltages on pin 9 | V_{9M} | max. 28 V |
| | $-V_{9M}$ | max. 4 V |
| Peak incident powers on pins 1 and 9 | P_{11M}, P_{19M} | max. 100 mW |

CHARACTERISTICS

Measuring conditions

| | |
|--|-------------------------------|
| V.H.F.—U.H.F. test socket | catalogue no. 3504 110 01830* |
| Mounting base temperature | T_{mb} = 25 °C |
| D.C. supply voltage | V_B = 24 V |
| Source impedance and load impedance | R_s, R_l = 75 Ω |
| Characteristic impedance of h.f. connections | Z_o = 75 Ω |
| Frequency range | f = 40 to 860 MHz |

Performance

| | | |
|--------------------------------------|----------------------|------------------------------|
| Supply current | I_B | 110 to 120 mA typ. 115 mA |
| Transducer gain | $G_{tr} = s_f ^2$ | 23 to 29 dB typ. 26 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 1 dB |
| Individual maximum v.s.w.r. input | $VSWR_{(i)}$ | typ. 2,3 ** |
| | $VSWR_{(o)}$ | typ. 1,8 ** |
| Back attenuation | $ s_r ^2$ | typ. 44 dB |
| | $ s_r ^2$ | typ. 41 dB |
| | $ s_r ^2$ | typ. 43 dB |

* This socket can be made available for customer reference purposes.
** Highest value, for a sample, occurring in the frequency range.

Output voltage

at -60 dB intermodulation distortion
(DIN45004, par. 6.3: 3-tone)
f = 40-230 MHz

| | | |
|-------------------|------|----------------|
| $V_o(\text{rms})$ | > | 113 dB μ V |
| | typ. | 114 dB μ V |
| $V_o(\text{rms})$ | typ. | 112 dB μ V |
| $V_o(\text{rms})$ | typ. | 110 dB μ V |

f = 470 MHz

f = 860 MHz

Noise figure

channel 2

channel 65

| | | |
|---|------|--------|
| F | typ. | 7 dB |
| F | typ. | 9,8 dB |

| | | |
|---------------|----------------|----------------|
| s-parameters: | $s_f = s_{21}$ | $s_i = s_{11}$ |
| | $s_r = s_{12}$ | $s_o = s_{22}$ |

OPERATING CONDITIONS

Mounting-base temperature range

 T_{mb} -30 to +100 °C

D.C. supply voltage

 V_B = 24 V \pm 10%

Frequency range

f 40 to 860 MHz

Source impedance and load impedance

 R_s, R_l = 75 Ω

THERMAL DATA

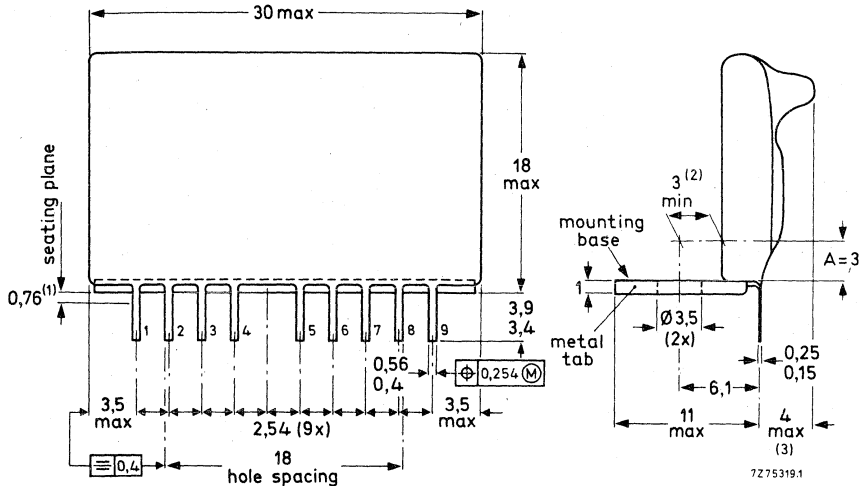
- The maximum permissible temperature at the mounting base is 100 °C.
- When the mounting tab is screwed to a double-sided printed-circuit board with dimensions 37 mm x 51 mm, its temperature will be 57 °C above the temperature of the surrounding free air.
- When a heatsink is fixed to the mounting tab and the pins are soldered into a double-sided printed-circuit board with dimensions 37 mm x 51 mm, the tab will reach the temperatures stated in the following table.

Notes:

- When the device is fixed only to a heatsink, not to a printed-circuit board, the values of the second column of the table should be increased by 2 °C and those of the third column decreased by 2 °C.
- The user is free to realize proper cooling by using differently shaped sinks, or, preferably, by fixing the tab to any convenient part of the equipment (e.g. a wall of the metal cabinet).

| heatsink data thickness 1 mm | $T_{mb} - T_{amb}$ °C | T_{amb} max °C |
|--|--------------------------|---------------------|
| Bright aluminium heatsink L-shaped bar; length 100 mm, height 65 mm | 27,5 | 72,5 |
| Blackened aluminium heatsink L-shaped bar; length 50 mm, height 70 mm | 26,5 | 73,5 |

The amplifier is resin coated and has a metal mounting tab at a right angle to the encapsulated part.



- (1) Tolerance applies within this zone.
- (2) Distance applies within zone A.
- (3) For the OM337A: 3 mm maximum.

Fig. 2 Encapsulation.

Terminal connections



- 1 = Input
- 2, 3, 5, 6, 7, 8 = Common, connected to mounting tab
- 4 = Supply (+)
- 9 = Output

Soldering recommendations

Hand soldering

Maximum contact time for a soldering-iron temperature of 260 °C up to the seating plane is 5 s.

Dip or wave soldering

260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds. The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

The module should preferably be mounted on a double-sided printed-circuit board, see the following example. An example is also given of heatsink mounting.

Input and output should be connected to $75\ \Omega$ tracks.

The connections to the common pins should be as close to the seating plane as possible.

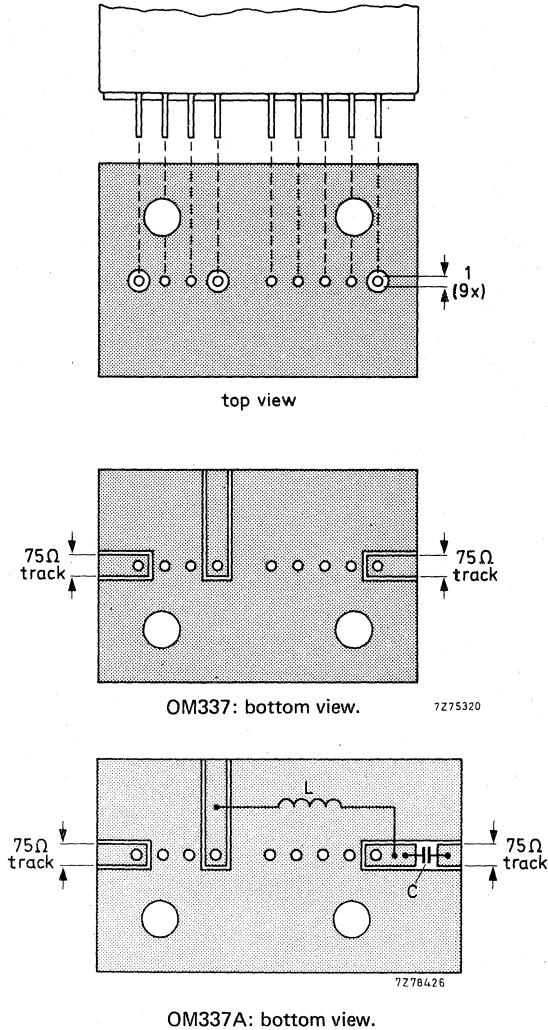


Fig. 3 Printed-circuit board holes and tracks for the OM337 and OM337A.

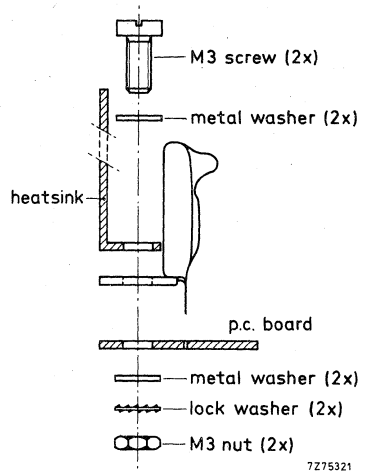


Fig. 4 Example of heatsink mounting.

$L > 5\ \mu\text{H}$; e.g. catalogue no. 3122 108 20150 or 27 turns enamelled Cu wire (0,3 mm) wound on a ferrite core with a diameter of 1,6 mm.
 $C > 220\ \text{pF}$ ceramic capacitor.

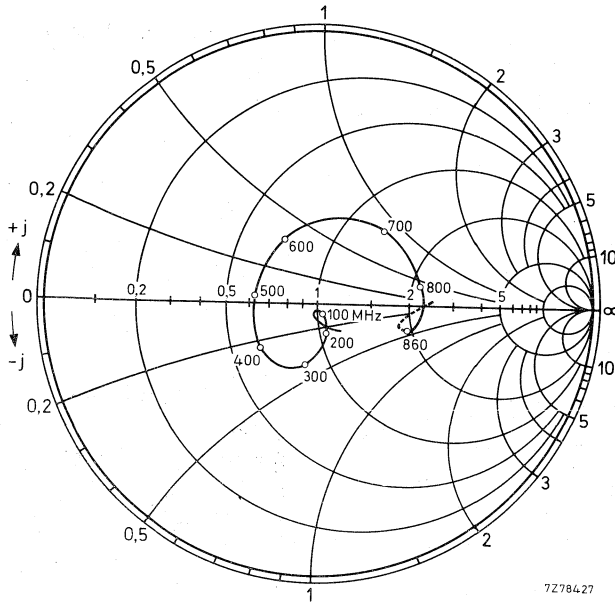


Fig. 5 Input impedance derived from input reflection coefficient s_i , co-ordinates in ohm x 75; typical values.

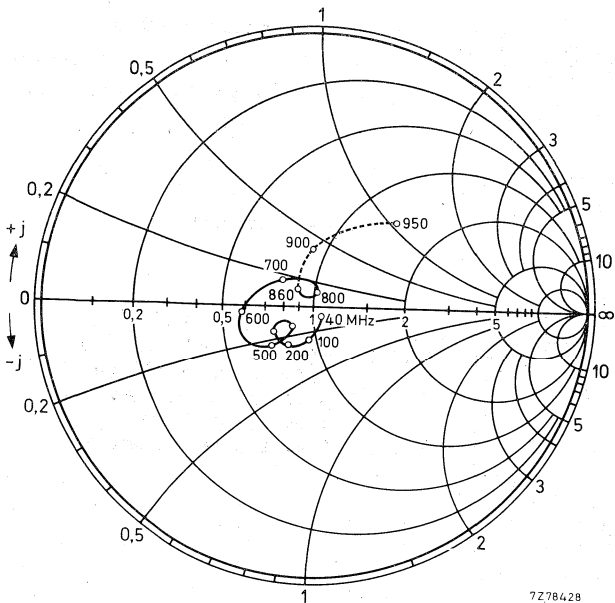


Fig. 6 Output impedance derived from output reflection coefficient s_o , co-ordinates in ohm x 75; typical values.

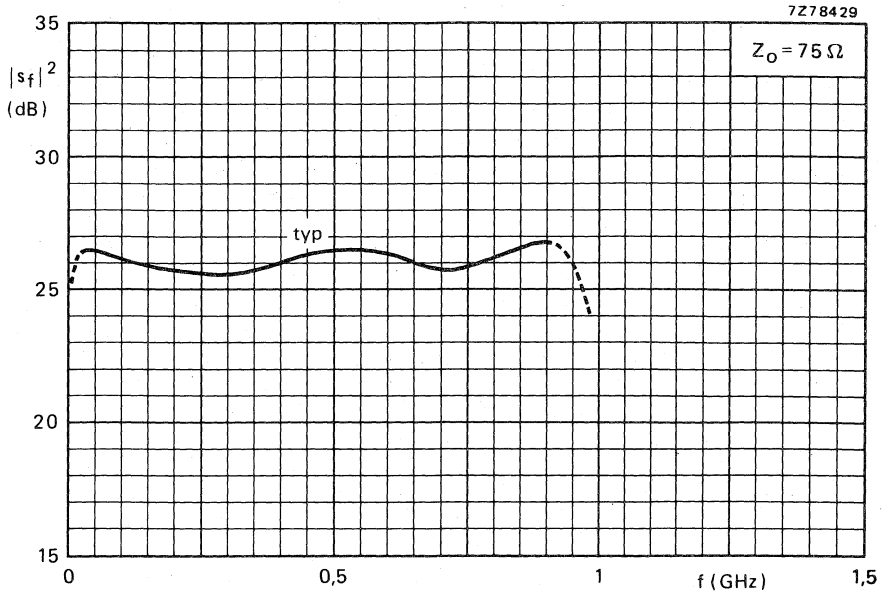


Fig. 7 Transducer gain as a function of frequency.

HYBRID INTEGRATED CIRCUIT VHF/UHF WIDE-BAND AMPLIFIER

Three-stage wide-band amplifier in the hybrid integrated circuit technique, designed for use in mast-head booster-amplifiers, as amplifier in MATV systems, and as general-purpose amplifier for v.h.f. and u.h.f. applications.

QUICK REFERENCE DATA

| | | |
|---|----------------------|-------------------------|
| Frequency range | f | 40 to 860 MHz |
| Source and load (characteristic) impedance | $R_s = R_l = Z_0$ | = 75 Ω |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. 28 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 1,5 dB |
| Output voltage at -60 dB intermodulation distortion (DIN 45004, 3-tone) | $V_{O(rms)}$ | > 105 dB μ V |
| Noise figure | F | typ. 6 dB |
| D.C. supply voltage | V_B | = 24 V \pm 10% |
| Operating ambient temperature | T_{amb} | -20 to +70 $^{\circ}$ C |

ENCAPSULATION 7-pin, in-line, resin-coated body, see MECHANICAL DATA (Fig. 2)

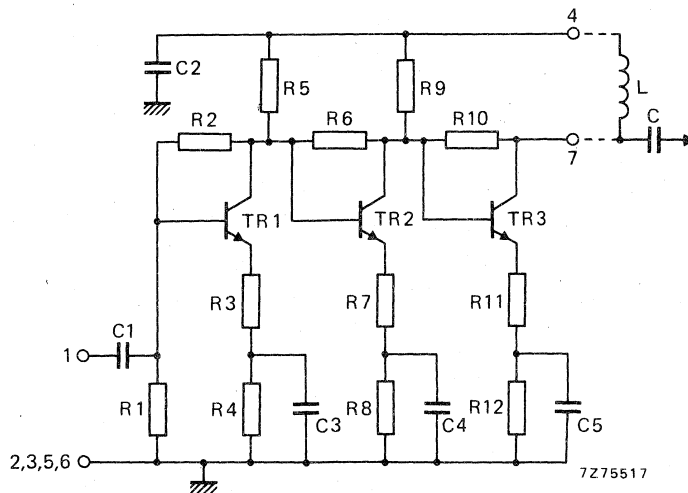


Fig. 1 Circuit diagram.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | |
|--------------------------------------|--------------------|----------------|
| Operating ambient temperature | T_{amb} | -20 to +70 °C |
| Storage temperature | T_{stg} | -40 to +125 °C |
| D.C. supply voltage | V_B | max. 28 V |
| Peak voltages on pins 1 and 7 | V_{1M}, V_{7M} | max. 28 V |
| | $-V_{1M}, -V_{7M}$ | max. 10 V |
| Peak incident powers on pins 1 and 7 | P_{11M}, P_{17M} | max. 100 mW |

CHARACTERISTICS

Measuring conditions

| | | |
|--|--------------------------------|-----------------|
| V.H.F.-U.H.F. test socket | catalogue no. 3504 110 01840 * | |
| Ambient temperature | T_{amb} | = 25 °C |
| D.C. supply voltage | V_B | = 24 V |
| Source impedance and load impedance | R_s, R_l | = 75 Ω |
| Characteristic impedance of h.f. connections | Z_0 | = 75 Ω |
| Frequency range | f | = 40 to 860 MHz |

Performance

| | | |
|--------------------------------------|----------------------|---|
| Supply current | I_B | typ. 67 mA |
| Transducer gain | $G_{tr} = s_f ^2$ | 25 to 30 dB typ. 28 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 1,5 dB |
| Individual maximum v.s.w.r. | | |
| input | VSWR _(i) | typ. 1,5 ** |
| output | VSWR _(o) | typ. 1,5 ** |
| Back attenuation | | |
| f = 100 MHz | $ s_r ^2$ | typ. 46 dB |
| f = 860 MHz | $ s_l ^2$ | typ. 31 dB |
| Output voltage | | |
| at -60 dB intermodulation distortion | | |
| (DIN 45004, par. 6.3: 3-tone) | $V_o(rms)$ | > 105 dB μ V typ. 107 dB μ V |
| Noise figure | F | typ. 6 dB |

| | | |
|---------------|----------------|----------------|
| s-parameters: | $s_f = s_{21}$ | $s_l = s_{11}$ |
| | $s_r = s_{12}$ | $s_o = s_{22}$ |

* This socket can be made available for customer reference purposes.

** Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

| | | |
|-------------------------------------|------------|---------------|
| Ambient temperature range | T_{amb} | -20 to +70 °C |
| D.C. supply voltage | V_B | = 24 V ±10% |
| Frequency range | f | 40 to 860 MHz |
| Source impedance and load impedance | R_S, R_L | = 75 Ω |

MECHANICAL DATA

The device is resin coated.

Dimensions in mm

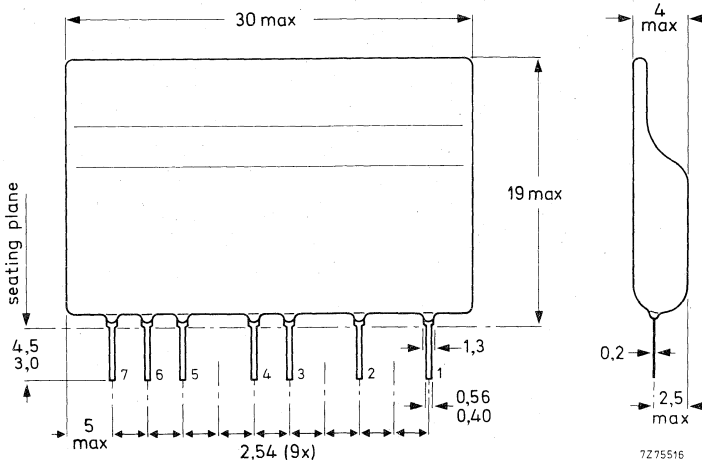


Fig. 2 Encapsulation.

Terminal connections

- 1 = input
- 2, 3, 5, 6 = common
- 4 = supply (+)
- 7 = output

Soldering recommendations

Hand soldering

Maximum contact time for a soldering-iron temperature of 260 °C up to the seating plane is 5 s.

Dip or wave soldering

260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds. The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

The module should preferably be mounted on double-sided printed-circuit board, see the example shown below.

Input and output should be connected to 75 Ω tracks.

The connections to the 'common' pins should be as close to the seating plane as possible.

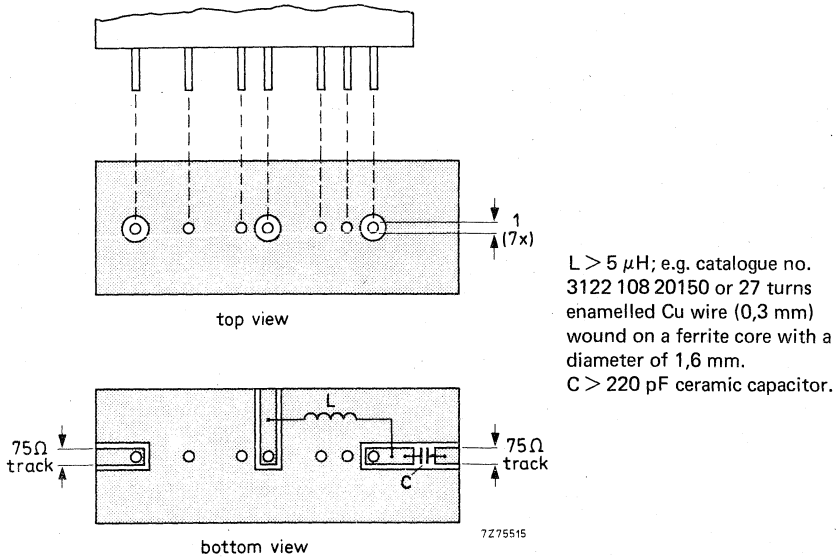


Fig. 3 Printed-circuit board holes and tracks.

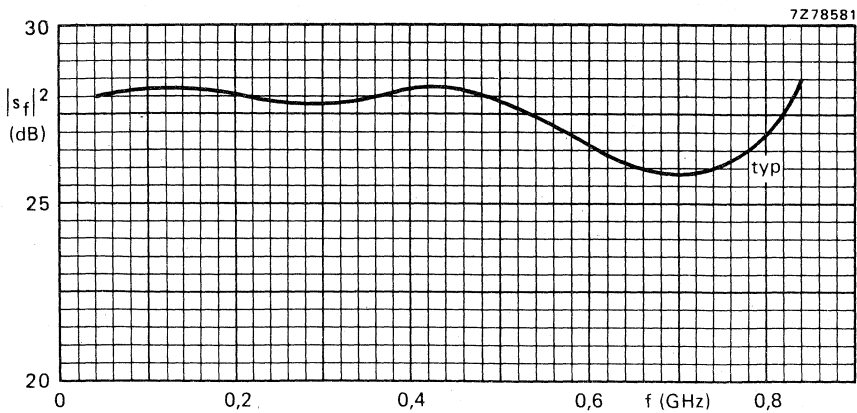


Fig. 4 Transducer gain as a function of frequency; $Z_O = 75 \Omega$.

HYBRID INTEGRATED CIRCUIT VHF/UHF WIDE-BAND AMPLIFIER

One-stage wide-band amplifier in hybrid integrated circuit technique on a thin-film substrate, intended for aerial amplifiers in car radios, caravans or RATV and MATV applications.

QUICK REFERENCE DATA

| | | | |
|---|----------------------|------|-------------------------|
| D.C. supply voltage | V_B | = | 12 V \pm 10% |
| Frequency range | f | | 40 to 860 MHz |
| Source and load (characteristic) impedance | $R_S = R_L = Z_O$ | = | 75 Ω |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. | 12 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. | 1 dB |
| Output voltage at -60 dB intermodulation distortion (DIN 45004, 3-tone) | $V_{O(rms)}$ | typ. | 99 dB μ V |
| Noise figure | F | typ. | 5,5 dB |
| Operating ambient temperature | T_{amb} | | -20 to +70 $^{\circ}$ C |

ENCAPSULATION 5-pin, in-line, resin-coated body, see MECHANICAL DATA (Fig. 2)

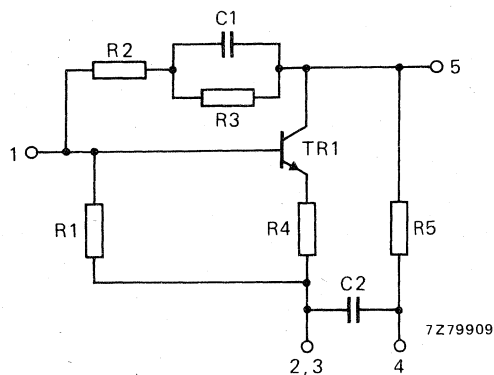


Fig. 1 Circuit diagram.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | |
|--------------------------------------|--------------------|----------------|
| Operating ambient temperature | T_{amb} | -20 to +70 °C |
| Storage temperature | T_{stg} | -40 to +125 °C |
| D.C. supply voltage | V_B | max. 15 V |
| Peak incident powers on pins 1 and 5 | P_{I1M}, P_{I5M} | max. 100 mW |

CHARACTERISTICS**Measuring conditions**

| | | | |
|--|------------|---|---------------|
| Ambient temperature | T_{amb} | = | 25 °C |
| D.C. supply voltage | V_B | = | 12 V |
| Source impedance and load impedance | R_s, R_l | = | 75 Ω |
| Characteristic impedance of h.f. connections | Z_o | = | 75 Ω |
| Frequency range | f | = | 40 to 860 MHz |

Performance

| | | | |
|---|----------------------|------|---------------|
| Supply current | I_B | typ. | 11,5 mA |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. | 12 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. | 1 dB |
| Individual maximum v.s.w.r. | | | |
| input | $VSWR_{(i)}$ | typ. | 2,0 * |
| output | $VSWR_{(o)}$ | typ. | 1,4 * |
| Back attenuation | | | |
| f = 100 MHz | $ s_r ^2$ | typ. | 22 dB |
| f = 860 MHz | $ s_r ^2$ | typ. | 19 dB |
| Output voltage | | | |
| at -60 dB intermodulation distortion (DIN 45004, par. 6.3: 3-tone) | $V_{O(rms)}$ | typ. | 99 dB μ V |
| Noise figure | F | typ. | 5,5 dB |

| |
|--|
| s-parameters: $s_f = s_{21}$ $s_i = s_{11}$ $s_r = s_{12}$ $s_o = s_{22}$ |
|--|

* Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

Ambient temperature range
 D.C. supply voltage
 Frequency range
 Source impedance and load impedance

T_{amb} = -20 to + 70 °C
 V_B = 12 V \pm 10%
 f = 40 to 860 MHz
 R_s, R_l = 75 Ω

MECHANICAL DATA

The device is resin coated.

Dimensions in mm

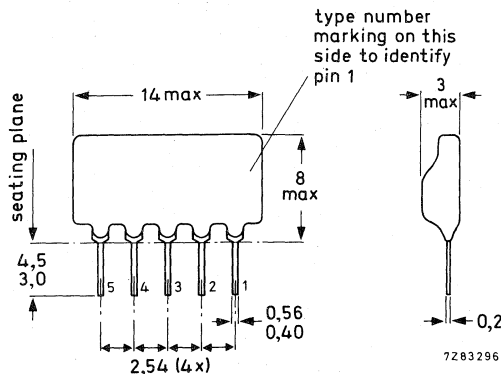


Fig. 2 Encapsulation.

Terminal connections

- 1 = input
- 2,3 = common
- 4 = supply (+)
- 5 = output

Soldering recommendations*Hand soldering*

Maximum contact time for a soldering-iron temperature of 260 °C up to the seating plane is 5 s.

Dip or wave soldering

260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds. The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

The module should preferably be mounted on double-sided printed-circuit board, see the example shown below.

Input and output should be connected to 75 Ω tracks.

The connections to the 'common' pins should be as close to the seating plane as possible.

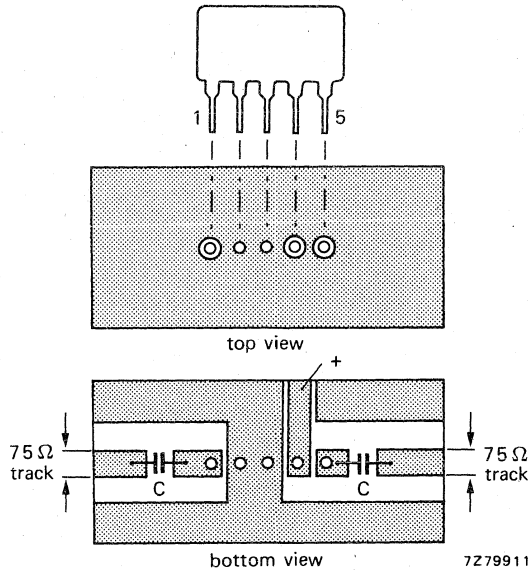


Fig. 3 Printed-circuit board holes and tracks.
C > 220 pF ceramic capacitor.

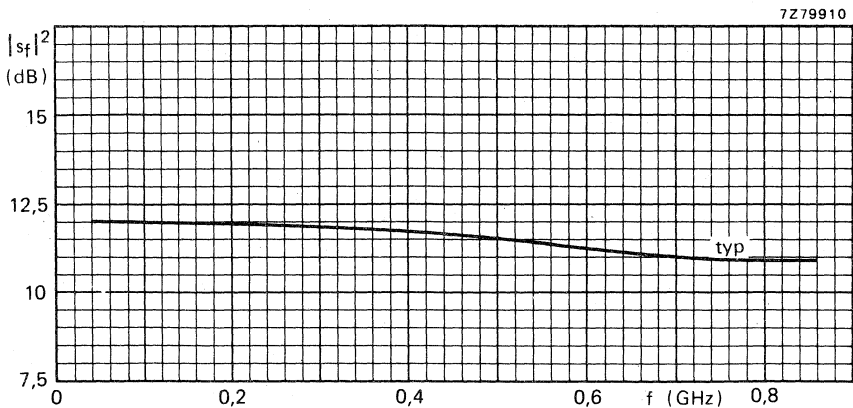


Fig. 4 Transducer gain as a function of frequency; $Z_0 = 75 \Omega$.

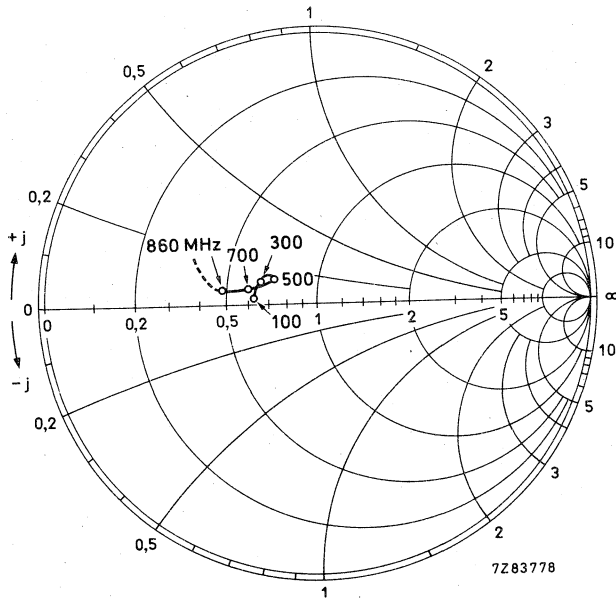


Fig. 5 Input impedance derived from input reflection coefficient s_i , co-ordinates in ohm $\times 75$; typical values.

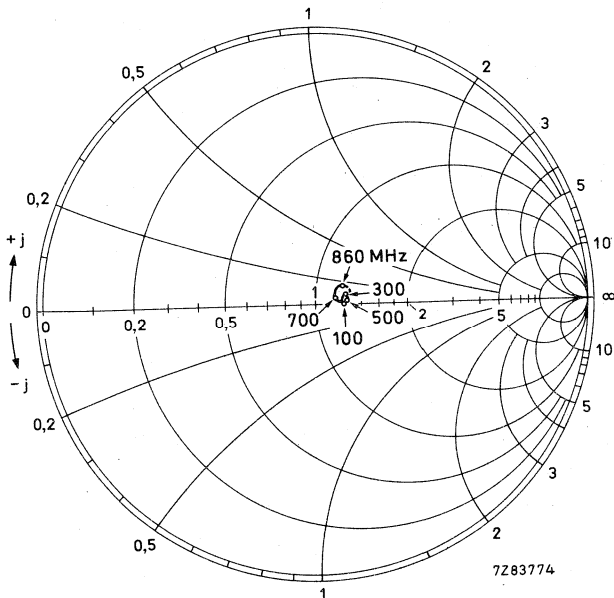


Fig. 6 Output impedance derived from output reflection coefficient s_o , co-ordinates in ohm $\times 75$; typical values.

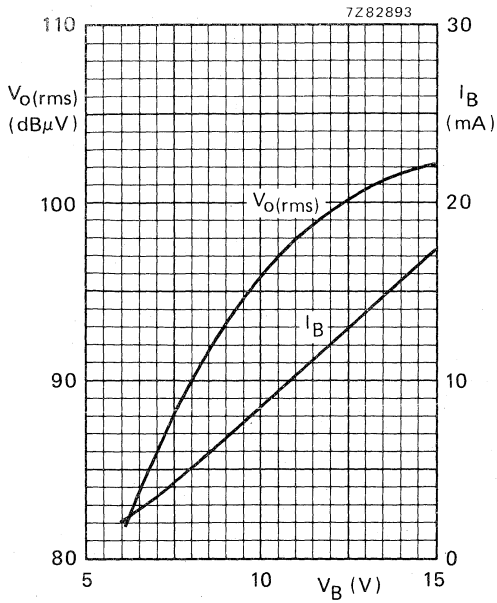


Fig. 7 Output voltage and supply current as a function of the supply voltage; typical values.

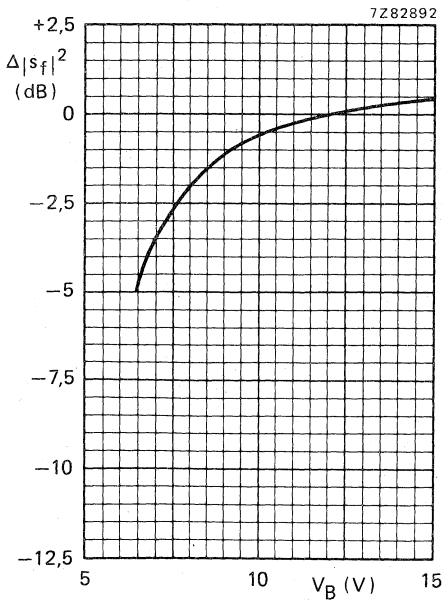


Fig. 8 Variation of transducer gain with supply voltage; reference 0 dB at 12 V; $f = 100$ to 860 MHz; typical values.

HYBRID INTEGRATED CIRCUIT VHF/UHF WIDE-BAND AMPLIFIER

Two-stage wide-band amplifier in hybrid integrated circuit technique on a thin-film substrate, intended for RATV and MATV applications.

QUICK REFERENCE DATA

| | | | |
|---|----------------------|------|-------------------------|
| D.C. supply voltage | V_B | = | 12 V \pm 10% |
| Frequency range | f | | 40 to 860 MHz |
| Source and load (characteristic) impedance | $R_s = R_l = Z_0$ | = | 75 Ω |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. | 18 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. | 1 dB |
| Output voltage at -60 dB intermodulation distortion (DIN 45004, 3-tone) | $V_{O(rms)}$ | typ. | 100 dB μ V |
| Noise figure | F | typ. | 6 dB |
| Operating ambient temperature | T_{amb} | | -20 to +70 $^{\circ}$ C |

ENCAPSULATION 5-pin, in-line, resin-coated body, see MECHANICAL DATA (Fig. 2)

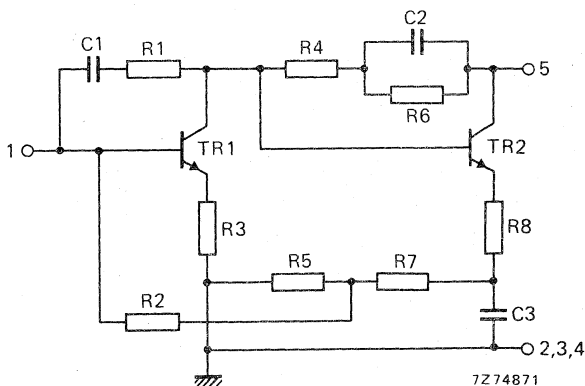


Fig. 1 Circuit diagram.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | |
|--------------------------------------|--------------------|----------------|
| Operating ambient temperature | T_{amb} | -20 to +70 °C |
| Storage temperature | T_{stg} | -40 to +125 °C |
| D.C. supply voltage | V_B | max. 15 V |
| Peak incident powers on pins 1 and 5 | P_{I1M}, P_{I5M} | max. 100 mW |

CHARACTERISTICS

Measuring conditions

| | | | |
|--|------------|---|---------------|
| Ambient temperature | T_{amb} | = | 25 °C |
| D.C. supply voltage | V_B | = | 12 V |
| Source impedance and load impedance | R_s, R_l | = | 75 Ω |
| Characteristic impedance of h.f. connections | Z_o | = | 75 Ω |
| Frequency range | f | = | 40 to 860 MHz |

Performance

| | | | |
|---|----------------------|--------------|----------------|
| Supply current | I_B | typ. | 18 mA |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. | 18 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. | 1 dB |
| Individual maximum v.s.w.r. | $VSWR_{(i)}$ | typ. | 1,5 * |
| | | $VSWR_{(o)}$ | typ. |
| Back attenuation | $ s_r ^2$ | typ. | 29 dB |
| | | $ s_r ^2$ | typ. |
| Output voltage | $V_o(rms)$ | typ. | 100 dB μ V |
| at -60 dB intermodulation distortion (DIN 45004, par. 6.3: 3-tone) | F | typ. | 6 dB |
| Noise figure | | | |

s-parameters: $s_f = s_{21}$ $s_i = s_{11}$
 $s_r = s_{12}$ $s_o = s_{22}$

* Highest value, for a sample, occuring in the frequency range.

OPERATING CONDITIONS

Ambient temperature range

 T_{amb} = -20 to +70 °C

D.C. supply voltage

 V_B = 12 V \pm 10%

Frequency range

f = 40 to 860 MHz

Source impedance and load impedance

 R_s, R_l = 75 Ω **MECHANICAL DATA**

The device is resin coated.

Dimensions in mm

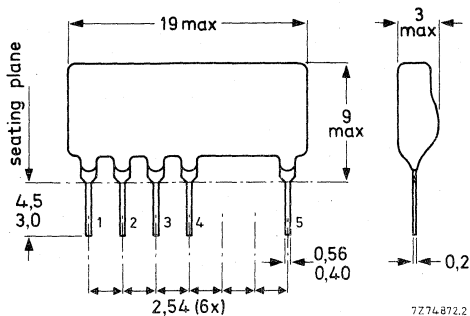


Fig. 2 Encapsulation.

Terminal connections

1 = input

2,3,4 = common

5 = output/supply(+)

Soldering recommendations*Hand soldering*

Maximum contact time for a soldering-iron temperature of 260 °C up to the seating plane is 5 s.

Dip or wave soldering

260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds. The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

The module should preferably be mounted on double-sided printed-circuit board, see the example shown below.

Input and output should be connected to 75 Ω tracks.

The connections to the 'common' pins should be as close to the seating plane as possible.

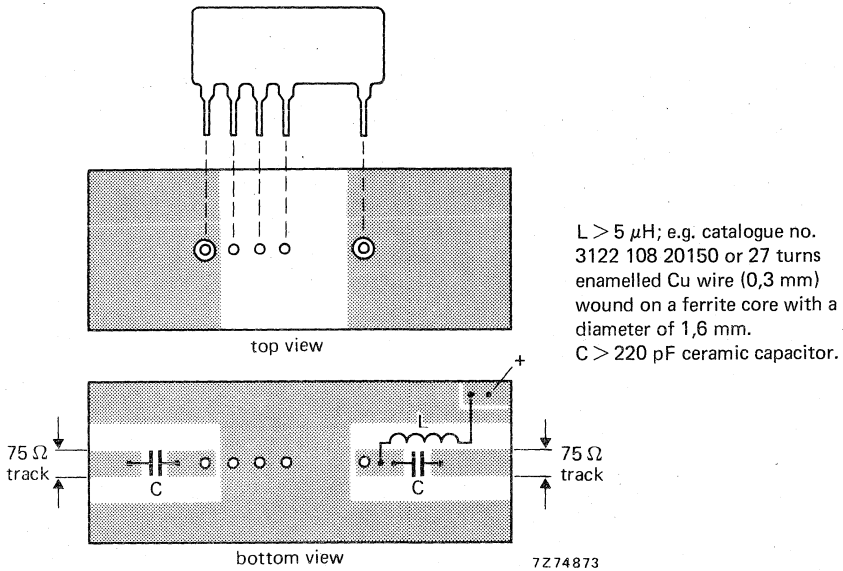


Fig. 3 Printed-circuit board holes and tracks.

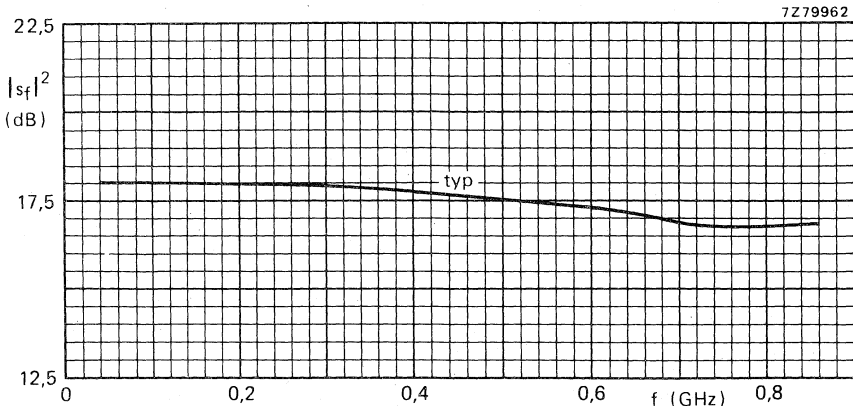


Fig. 4 Transducer gain as a function of frequency; $Z_0 = 75 \Omega$.

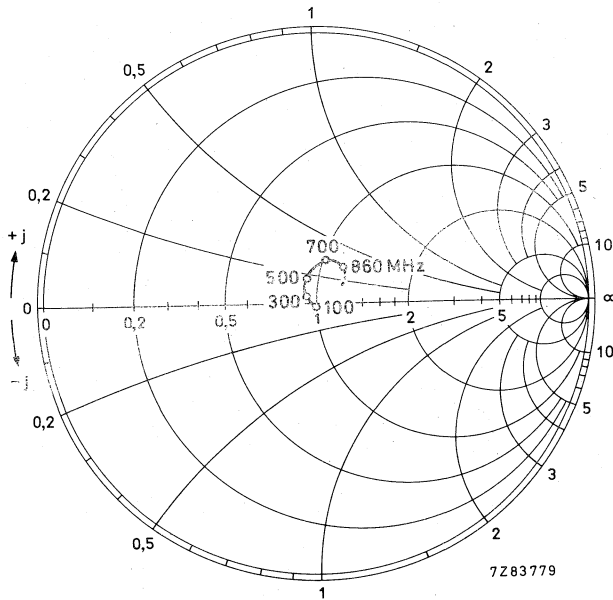


Fig. 5 Input impedance derived from input reflection coefficient s_i , co-ordinates in ohm x 75; typical values.

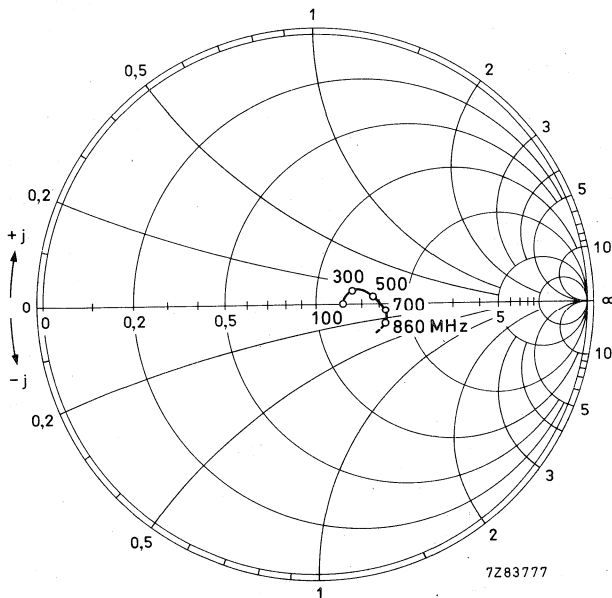


Fig. 6 Output impedance derived from output reflection coefficient s_o , co-ordinates in ohm x 75; typical values.

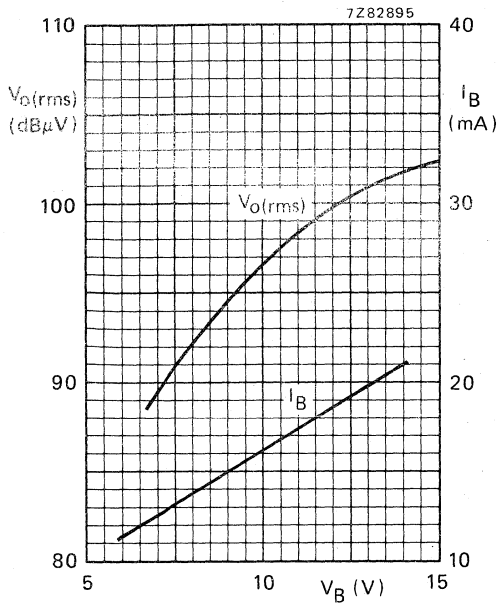


Fig. 7 Output voltage and supply current as a function of the supply voltage; typical values.

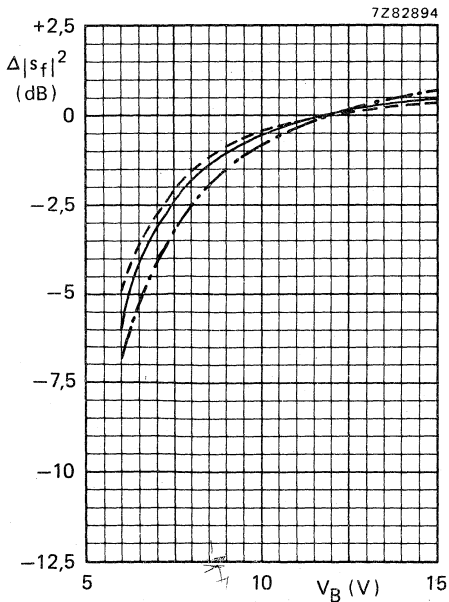


Fig. 8 Variation of transducer gain with supply voltage; reference 0 dB at 12 V:
 — $f = 500$ MHz;
 - - - $f = 100$ MHz;
 - · - $f = 860$ MHz;
 typical values.

HYBRID INTEGRATED CIRCUIT VHF/UHF WIDE-BAND AMPLIFIER

Three-stage wide-band amplifier in hybrid integrated circuit technique on a thin-film substrate, intended for use in mast-head booster-amplifiers, as preamplifier in MATV systems, and as general-purpose amplifier for v.h.f. and u.h.f. applications.

QUICK REFERENCE DATA

| | | |
|---|----------------------|-------------------------|
| Frequency range | f | 40 to 860 MHz |
| Source and load (characteristic) impedance | $R_s = R_l = Z_0 =$ | 75 Ω |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. 23 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 0,5 dB |
| Output voltage at -60 dB intermodulation distortion (DIN 45004, 3-tone) | $V_o(\text{rms})$ | > 105 dB μ V |
| Noise figure | F | typ. 7 dB |
| D.C. supply voltage | V_B | = 12 V \pm 10% |
| Operating ambient temperature | T_{amb} | -20 to +70 $^{\circ}$ C |

ENCAPSULATION 8-pin, in-line, resin-coated body, see MECHANICAL DATA (Fig. 2)

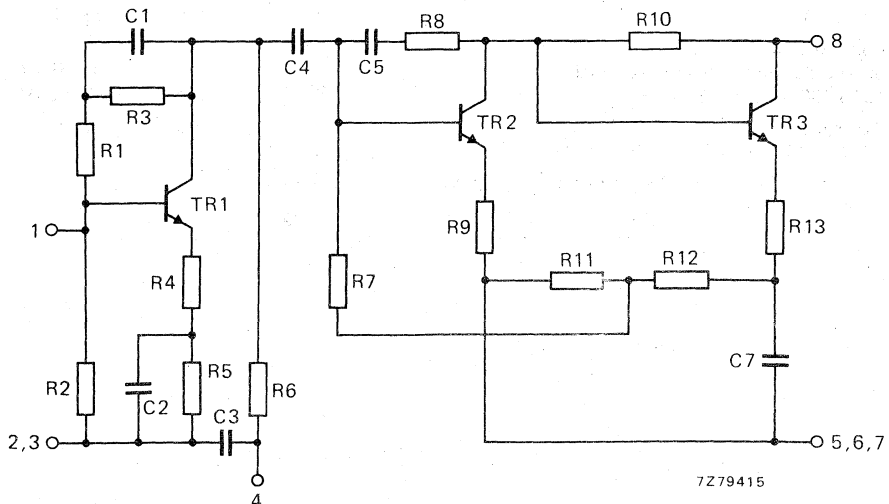


Fig. 1 Circuit diagram.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | |
|--------------------------------------|--------------------|----------------|
| Operating ambient temperature | T_{amb} | -20 to +70 °C |
| Storage temperature | T_{stg} | -40 to +125 °C |
| D.C. supply voltage | V_B | max. 15 V |
| Peak incident powers on pins 1 and 7 | P_{11M}, P_{17M} | max. 100 mW |

CHARACTERISTICS

Measuring conditions

| | | | |
|--|------------|---|---------------|
| Ambient temperature | T_{amb} | = | 25 °C |
| D.C. supply voltage | V_B | = | 12 V |
| Source impedance and load impedance | R_s, R_l | = | 75 Ω |
| Characteristic impedance of h.f. connections | Z_o | = | 75 Ω |
| Frequency range | f | = | 40 to 860 MHz |

Performance

| | | | |
|---|----------------------|------|---------------------------------------|
| Supply current | I_B | typ. | 55 mA |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. | 23 dB 21 to 25 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. | 0,5 dB |
| Individual maximum v.s.w.r. | | | |
| input | $VSWR_{(i)}$ | typ. | 1,3 * |
| output | $VSWR_{(o)}$ | typ. | 1,5 * |
| Back attenuation | | | |
| $f = 100$ MHz | $ s_r ^2$ | typ. | 42 dB |
| $f = 860$ MHz | $ s_r ^2$ | typ. | 33 dB |
| Output voltage | | | |
| at -60 dB intermodulation distortion (DIN 45004, par. 6.3: 3-tone) | $V_{o(rms)}$ | > | 105 dB μ V typ. 107 dB μ V |
| Noise figure | F | typ. | 7 dB |

| | | |
|---------------|----------------|----------------|
| s-parameters: | $s_f = s_{21}$ | $s_i = s_{11}$ |
| | $s_r = s_{12}$ | $s_o = s_{22}$ |

* Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

Ambient temperature range

D.C. supply voltage

Frequency range

Source impedance and load impedance

 T_{amb} V_B f R_S, R_L

-20 to +70 °C

= 12 V \pm 10%

40 to 860 MHz

= 75 Ω **MECHANICAL DATA**

The device is resin coated.

Dimensions in mm

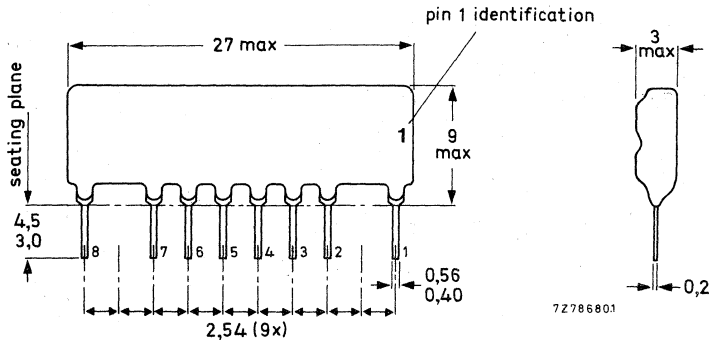


Fig. 2 Encapsulation.

Terminal connections

- 1 = input
- 2, 3, 5, 6, 7 = common
- 4 = supply (+)
- 8 = output/supply (+)

Soldering recommendations*Hand soldering*

Maximum contact time for a soldering-iron temperature of 260 °C up to the seating plane is 5 s.

Dip or wave soldering

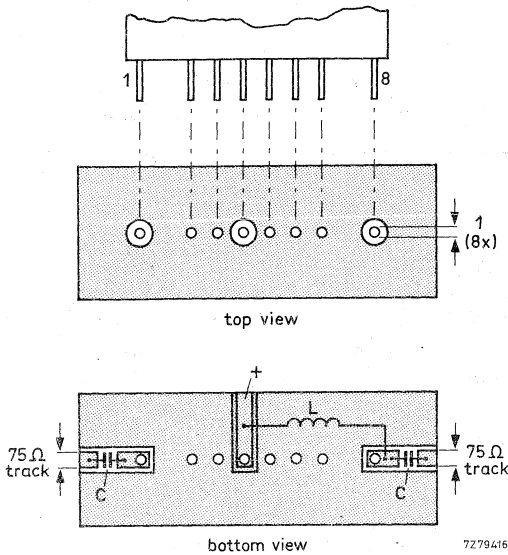
260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds. The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

The module should preferably be mounted on double-sided printed-circuit board, see the example shown below.

Input and output should be connected to 75 Ω tracks.

The connections to the 'common' pins should be as close to the seating plane as possible.



$L > 5 \mu\text{H}$; e.g. catalogue no. 3122 108 20150 or 27 turns enamelled Cu wire (0,3 mm) wound on a ferrite core with a diameter of 1,6 mm.
 $C > 220 \text{ pF}$ ceramic capacitor.

Fig. 3 Printed-circuit board holes and tracks.

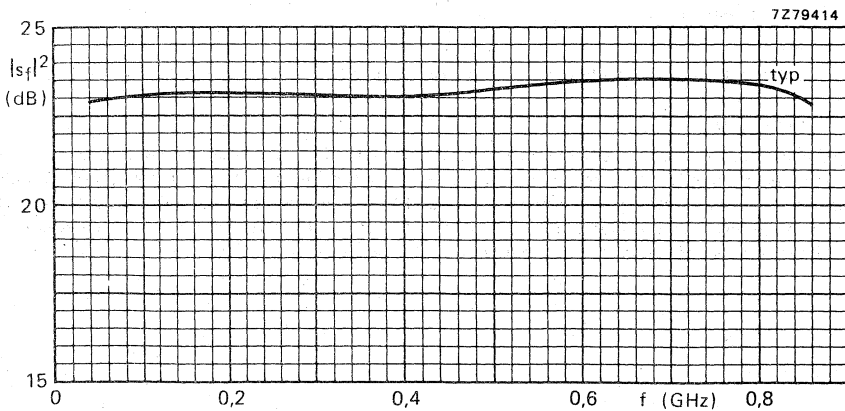


Fig. 4 Transducer gain as a function of frequency; $Z_0 = 75 \Omega$.

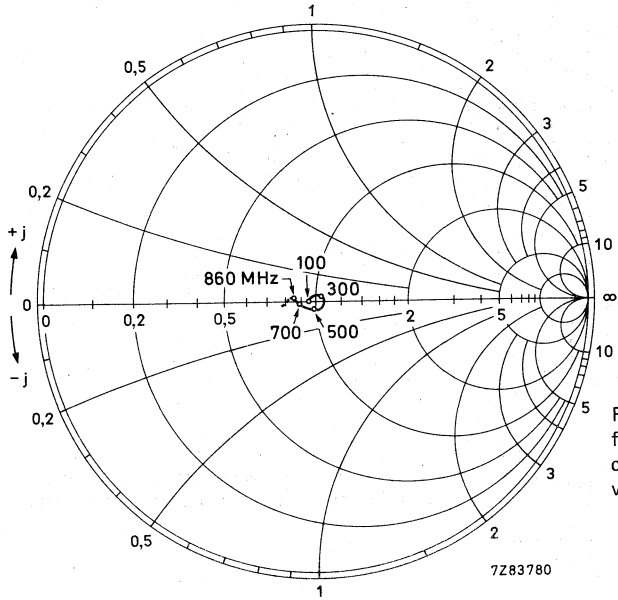


Fig. 5 Input impedance derived from input reflection coefficient s_i , co-ordinates in ohm x 75; typical values.

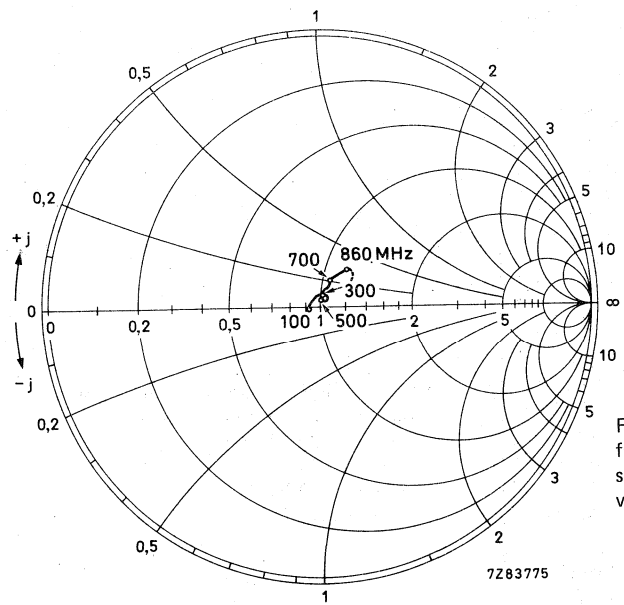


Fig. 6 Output impedance derived from output reflection coefficient s_o , co-ordinates in ohm x 75; typical values.

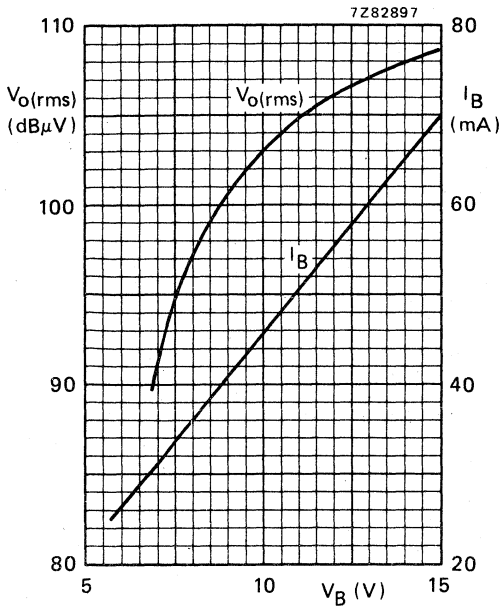


Fig. 7 Output voltage and supply current as a function of the supply voltage; typical values.

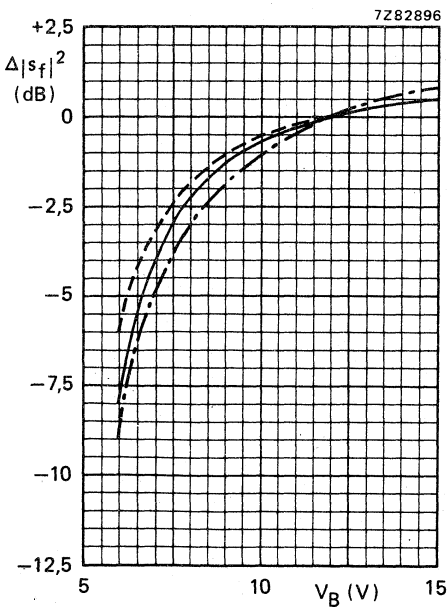


Fig. 8 Variation of transducer gain with supply voltage; reference 0 dB at 12 V;
 — $f = 500$ MHz;
 - - - $f = 100$ MHz;
 - · - $f = 860$ MHz;
 typical values.

HYBRID INTEGRATED CIRCUIT VHF/UHF WIDE-BAND AMPLIFIER

Three-stage wide-band amplifier in hybrid integrated circuit technique on a thin-film substrate, intended for use in mast-head booster-amplifiers, as an amplifier in MATV systems, and as general-purpose amplifier for v.h.f. and u.h.f. applications.

QUICK REFERENCE DATA

| | | |
|---|----------------------|-------------------------|
| Frequency range | f | 40 to 860 MHz |
| Source and load (characteristic) impedance | $R_s = R_l = Z_o =$ | 75 Ω |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. 28 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. 1 dB |
| Output voltage at -60 dB intermodulation distortion (DIN 45004, 3-tone) | $V_o(rms)$ | > 105 dB μ V |
| Noise figure | F | typ. 6 dB |
| D.C. supply voltage | V_B | = 12 V \pm 10% |
| Operating ambient temperature | T_{amb} | -20 to +70 $^{\circ}$ C |

ENCAPSULATION 8-pin, in-line, resin-coated body, see MECHANICAL DATA (Fig. 2)

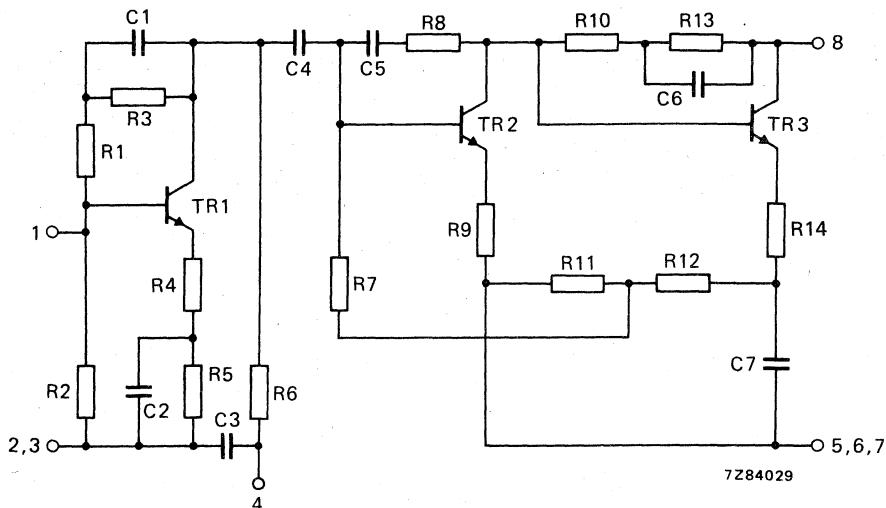


Fig. 1 Circuit diagram.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|--------------------------------------|--------------------|------|----------------|
| Operating ambient temperature | T_{amb} | | -20 to +70 °C |
| Storage temperature | T_{stg} | | -40 to +125 °C |
| D.C. supply voltage | V_B | max. | 15 V |
| Peak incident powers on pins 1 and 8 | P_{11M}, P_{18M} | max. | 100 mW |

CHARACTERISTICS

Measuring conditions

| | | | |
|--|------------|---|---------------|
| Ambient temperature | T_{amb} | = | 25 °C |
| D.C. supply voltage | V_B | = | 12 V |
| Source impedance and load impedance | R_s, R_l | = | 75 Ω |
| Characteristic impedance of h.f. connections | Z_0 | = | 75 Ω |
| Frequency range | f | = | 40 to 860 MHz |

Performance

| | | | |
|---|----------------------|-----------|----------------------------------|
| Supply current | I_B | typ. | 50 mA |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. | 28 dB 26 to 31 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. | 1 dB |
| Individual maximum v.s.w.r. | | | |
| input | $VSWR_{(i)}$ | typ. | 1,5 * |
| output | $VSWR_{(o)}$ | typ. | 1,7 * |
| Back attenuation | | | |
| f = 100 MHz | $ s_r ^2$ | typ. | 45 dB |
| f = 860 MHz | $ s_r ^2$ | typ. | 35 dB |
| Output voltage | | | |
| at -60 dB intermodulation distortion (DIN 45004, par. 6,3; 3-tone) | $V_{o(rms)}$ | > typ. | 105 dB μ V 107 dB μ V |
| Noise figure | F | typ. | 6 dB |

| | | |
|---------------|----------------|----------------|
| s-parameters: | $s_f = s_{21}$ | $s_i = s_{11}$ |
| | $s_r = s_{12}$ | $s_o = s_{22}$ |

* Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

Ambient temperature range
 D.C. supply voltage
 Frequency range
 Source impedance and load impedance

T_{amb} = -20 to +70 °C
 V_B = 12 V \pm 10%
 f = 40 to 860 MHz
 R_s, R_l = 75 Ω

MECHANICAL DATA

The device is resin coated.

Dimensions in mm

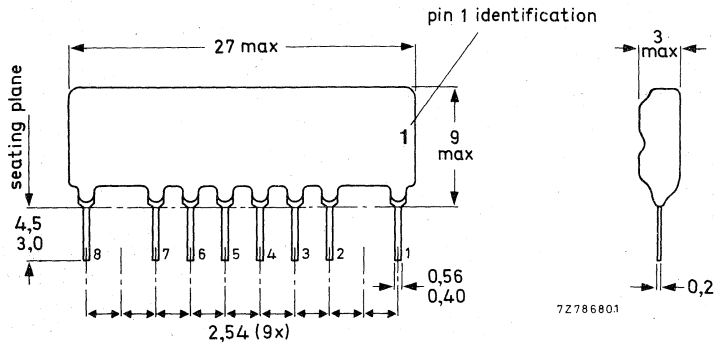


Fig. 2 Encapsulation.

Terminal connections

1 = input
 2, 3, 5, 6, 7 = common
 4 = supply (+)
 8 = output/supply (+)

Soldering recommendations*Hand soldering*

Maximum contact time for a soldering-iron temperature of 260 °C up to the seating plane is 5 s.

Dip or wave soldering

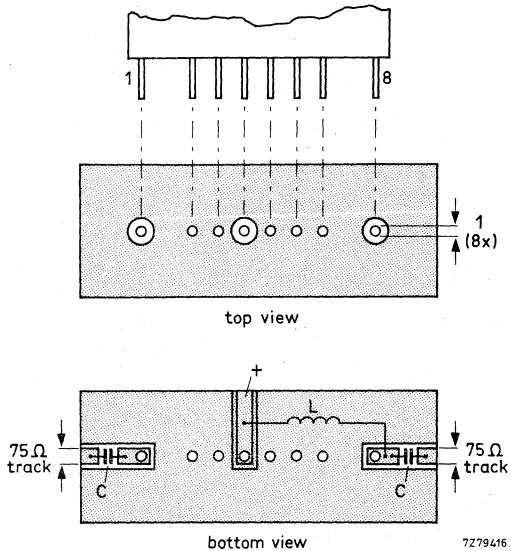
260 °C is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds. The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed 125 °C. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

The module should preferably be mounted on double-sided printed-circuit board, see the example shown below.

Input and output should be connected to 75 Ω tracks.

The connections to the 'common' pins should be as close to the seating plane as possible.



$L > 5 \mu\text{H}$; e.g. catalogue no. 3122 108 20150 or 27 turns enamelled Cu wire (0,3 mm) wound on a ferrite core (material 4B1; catalogue number 3122 104 91110) with a diameter of 1,6 mm.
 $C > 220 \text{ pF}$ ceramic capacitor.

Fig. 3 Printed-circuit board holes and tracks.

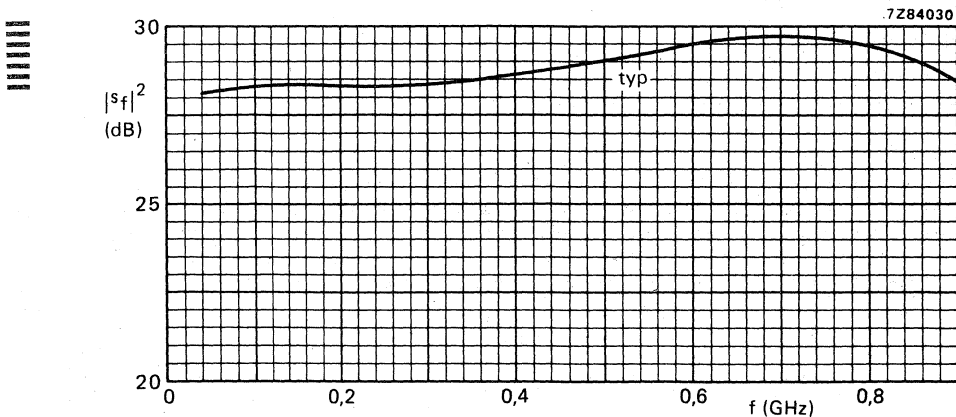


Fig. 4 Transducer gain as a function of frequency; $Z_0 = 75 \Omega$.

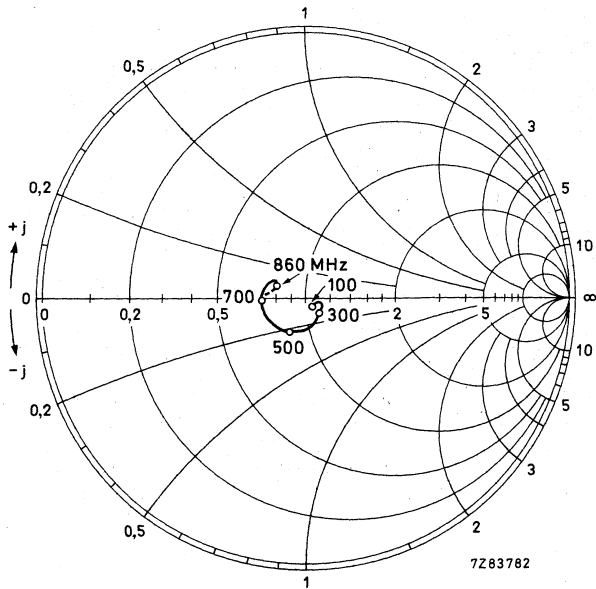


Fig. 5 Input impedance derived from input reflection coefficient s_i , co-ordinates in ohm x 75; typical values.

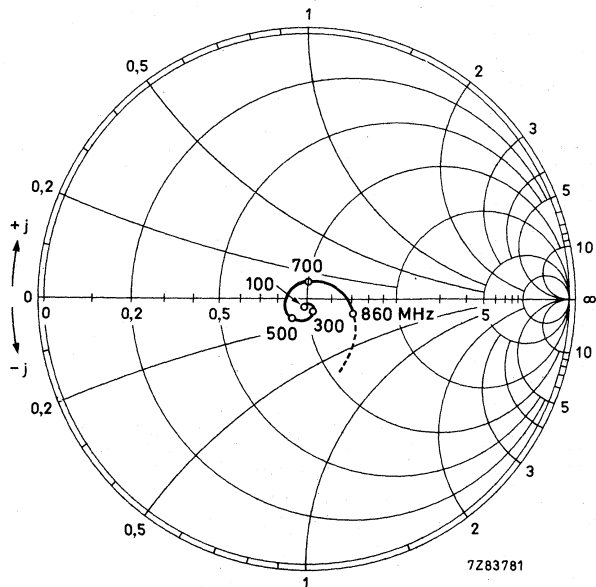


Fig. 6 Output impedance derived from output reflection coefficient s_o , co-ordinates in ohm x 75; typical values.

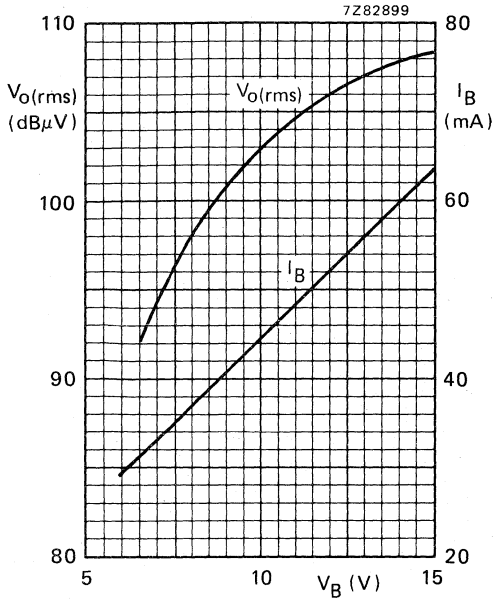


Fig. 7 Output voltage and supply current as a function of the supply voltage; typical values.

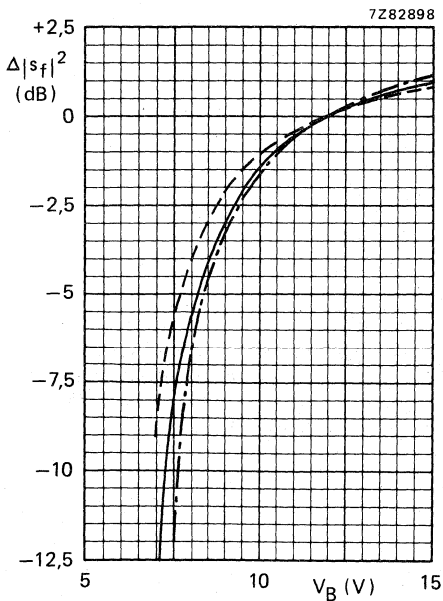


Fig. 8 Variation of transducer gain with supply voltage; reference 0 dB at 12 V;
 — $f = 500$ MHz;
 - - - $f = 100$ MHz;
 - · - $f = 860$ MHz;
 typical values.

HYBRID INTEGRATED CIRCUIT VHF/UHF WIDE-BAND AMPLIFIER

Three-stage wide-band amplifier in hybrid integrated circuit technique on a thin-film substrate, intended for use in mast-head booster-amplifiers, as an amplifier in MATV and CATV systems, and as general-purpose amplifier for v.h.f. and u.h.f. applications.

QUICK REFERENCE DATA

| | | | |
|---|-------------------------|------|-------------------------|
| Frequency range | f | | 40 to 860 MHz |
| Source and load (characteristic) impedance | $R_s = R_l = Z_0 =$ | | 75 Ω |
| Transducer gain | $G_{tr} = s_{f1} ^2$ | typ. | 28 dB |
| Flatness of frequency response | $\pm \Delta s_{f1} ^2$ | typ. | 1 dB |
| Output voltage at -60 dB intermodulation distortion (DIN 45004, 3-tone) | | | |
| VHF | $V_{o(rms)}$ | typ. | 113 dB μ V |
| UHF | $V_{o(rms)}$ | typ. | 112 dB μ V |
| Noise figure | F | typ. | 7 dB |
| D.C. supply voltage | V_B | = | 12 V \pm 10% |
| Operating ambient temperature | T_{amb} | | -20 to +70 $^{\circ}$ C |

ENCAPSULATION 9-pin, in-line, resin-coated body, see MECHANICAL DATA (Fig.2)

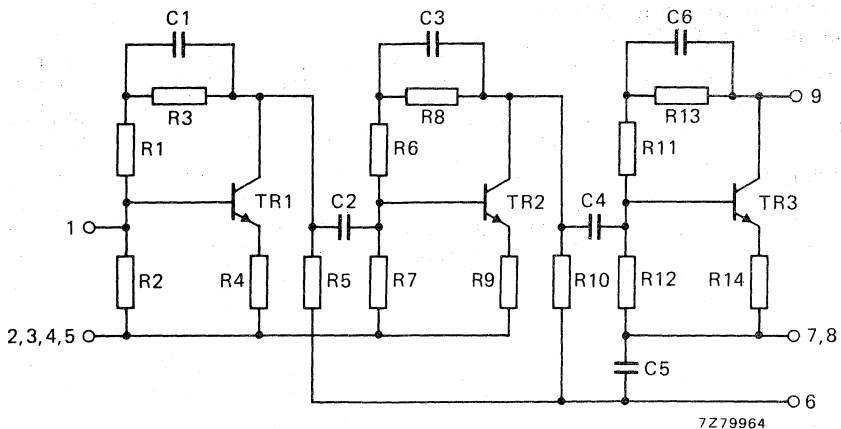


Fig. 1 Circuit diagram.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

| | | | |
|--------------------------------------|--------------------|------|----------------|
| Operating ambient temperature | T_{amb} | | -20 to +70 °C |
| Storage temperature | T_{stg} | | -40 to +125 °C |
| D.C. supply voltage | V_B | max. | 15 V |
| Peak incident powers on pins 1 and 8 | P_{11M}, P_{18M} | max. | 100 mW |

CHARACTERISTICS

Measuring conditions

| | | | |
|--|------------|---|---------------|
| Ambient temperature | T_{amb} | = | 25 °C |
| D.C. supply voltage | V_B | = | 12 V |
| Source impedance and load impedance | R_s, R_l | = | 75 Ω |
| Characteristic impedance of h.f. connections | Z_o | = | 75 Ω |
| Frequency range | f | = | 40 to 860 MHz |

Performance

| | | | |
|---|----------------------|-----------|----------------------------------|
| Supply current | I_B | typ. | 105 mA |
| Transducer gain | $G_{tr} = s_f ^2$ | typ. | 28 dB 26 to 31 dB |
| Flatness of frequency response | $\pm \Delta s_f ^2$ | typ. | 1 dB |
| Individual maximum v.s.w.r. | | | |
| input | VSWR _(i) | typ. | 2,3 * |
| output | VSWR _(o) | typ. | 1,9 * |
| Back attenuation | | | |
| f = 100 MHz | $ s_r ^2$ | typ. | 45 dB |
| f = 860 MHz | $ s_r ^2$ | typ. | 35 dB |
| Output voltage | | | |
| at -60 dB intermodulation distortion (DIN 45004, par. 6,3; 3-tone) | | | |
| VHF | $V_{o(rms)}$ | > typ. | 111 dB μ V 113 dB μ V |
| UHF | $V_{o(rms)}$ | > typ. | 110 dB μ V 112 dB μ V |
| Noise figure | F | typ. | 7 dB |

| |
|--|
| s-parameters: $s_f = s_{21}$ $s_i = s_{11}$ $s_r = s_{12}$ $s_o = s_{22}$ |
|--|

* Highest value, for a sample, occurring in the frequency range.

OPERATING CONDITIONS

Ambient temperature range

D.C. supply voltage

Frequency range

Source impedance and load impedance

 $T_{amb} = -20 \text{ to } +70 \text{ } ^\circ\text{C}$ $V_B = 12 \text{ V} \pm 10\%$ $f = 40 \text{ to } 860 \text{ MHz}$ $R_{S'} R_{\ell} = 75 \text{ } \Omega$ **MECHANICAL DATA**

The device is resin coated.

Dimensions in mm

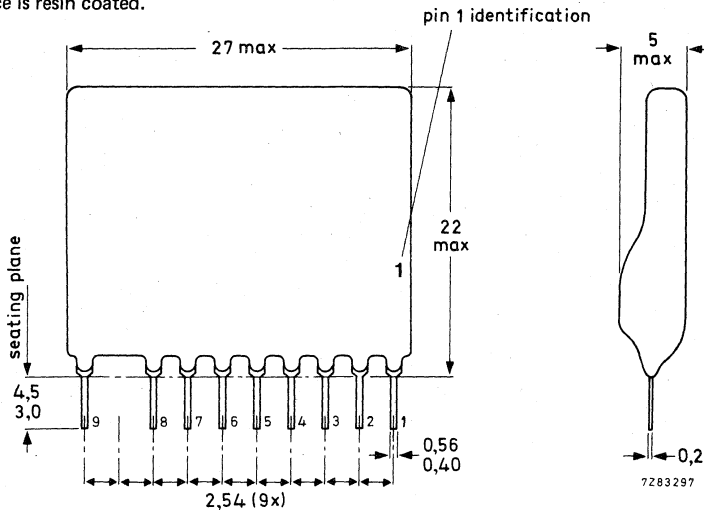


Fig. 2 Encapsulation.

Terminal connections

- 1 = input
- 2, 3, 4, 5 and 7, 8 = common
- 6 = supply (+)
- 9 = output/supply (+)

Soldering recommendations*Hand soldering*Maximum contact time for a soldering-iron temperature of $260 \text{ } ^\circ\text{C}$ up to the seating plane is 5 s.*Dip or wave soldering*

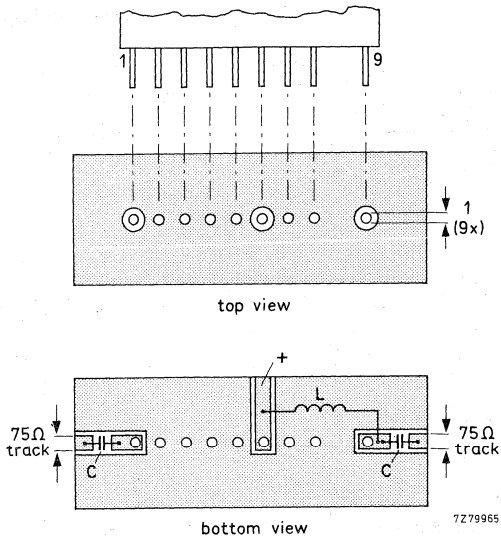
$260 \text{ } ^\circ\text{C}$ is the maximum permissible temperature of the solder; it must not be in contact with the joint for more than 5 seconds. The total contact time of successive solder waves must not exceed 5 seconds. The device may be mounted against the printed-circuit board, but the temperature of the device must not exceed $125 \text{ } ^\circ\text{C}$. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature below the allowable limit.

Mounting recommendations

The module should preferably be mounted on double-sided printed-circuit board, see the example shown below.

Input and output should be connected to 75 Ω tracks.

The connections to the 'common' pins should be as close to the seating plane as possible.



$L > 5 \mu\text{H}$; e.g. catalogue no. 3122 108
 20150 or 27 turns enamelled Cu wire
 (0,3 mm) wound on a ferrite core
 (material 4B1; catalogue no. 3122 104
 91110) with a diameter of 1,6 mm.
 $C > 220 \text{ pF}$ ceramic capacitor.

Fig. 3 Printed-circuit board holes and tracks.

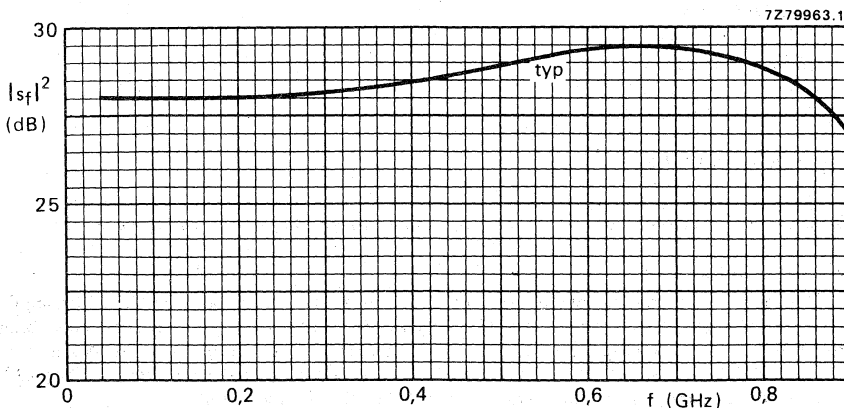


Fig. 4 Transducer gain as a function of frequency; $Z_0 = 75 \Omega$.

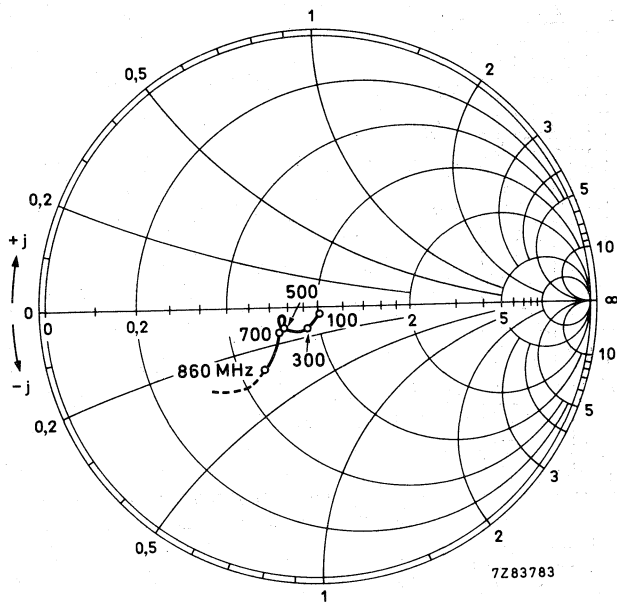


Fig. 5 Input impedance derived from input reflection coefficient s_i , co-ordinates in ohm x 75; typical values.

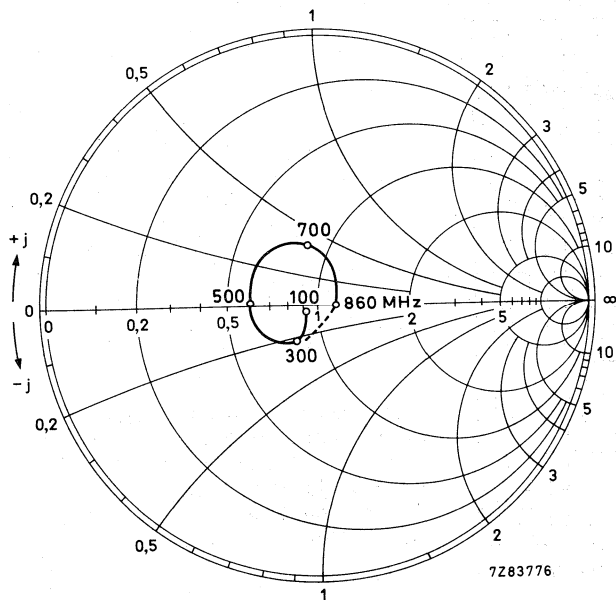


Fig. 6 Output impedance derived from output reflection coefficient s_o , co-ordinates in ohm x 75; typical values.

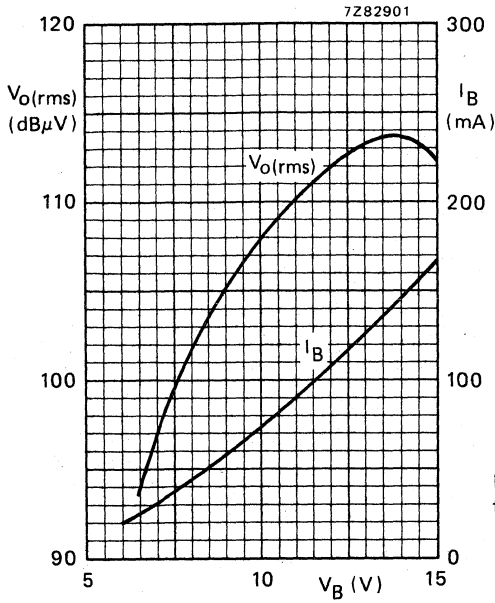


Fig. 7 Output voltage and supply current as a function of the supply voltage; typical values.

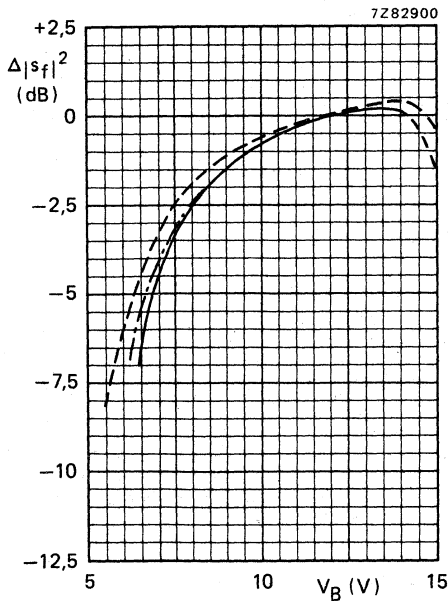


Fig. 8 Variation of transducer gain with supply voltage; reference 0 dB at 12 V;
 — $f = 500$ MHz;
 - - - $f = 100$ MHz;
 - · - $f = 860$ MHz;
 typical values.



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